

12GSPS DAC / 3GSPS ADC 搭載、AFE7950-x 4T6R RF サンプリング AFE

1 特長

- データシート全体のご請求
- 放射線耐性保証 AFE7950-SP:
 - シングル イベント ラッチアップ (SEL): 70MeV-cm²/mg
 - RLAT 吸収線量 (TID): 100krad (Si)
- 耐放射線特性 AFE7950-SEP:
 - シングル イベント ラッチアップ (SEL): 43MeV-cm²/mg
 - RLAT 吸収線量 (TID): 30krad (Si)
- 4 個の RF サンプリング 12GSPS TX DAC
- 6 個の RF サンプリング 3GSPS RX ADC
- 最大 RF 信号帯域幅: 1200MHz (または 2TX の場合は 2400MHz)
- RF 周波数範囲:
 - TX: 600MHz ~ 12GHz
 - RX: 5MHz ~ 12GHz
- デジタル ステップ アッテネータ (DSA):
 - TX: 40dB レンジ、0.125dB ステップ
 - RX または FB: 25dB レンジ、0.5dB ステップ
- TX と RX 向けにシングルバンドまたはデュアルバンド DUC または DDC を搭載
- SerDes データ インターフェイス:
 - 8 つの SerDes トランシーバ (最大 24.75Gbps)
 - JESD204B/C サブクラス 1 互換
- パッケージ: 17mm × 17mm FCBGA、0.8mm ピッチ
- スクリーニング:
 - 単一の製造、アセンブリ、テスト施設
 - 製品のトレーサビリティ
 - 長期にわたる製品ライフ サイクル
 - 長期にわたる製品変更通知
 - ベンダー品目の図面
 - 放射線ロット受け入れ試験 (RLAT) (AFE7950-Sx のみ)
 - ASTM E595 OUT ガス仕様に適合 (AFE7950-Sx のみ)
 - 量産時のバーンイン (AFE7950-SP のみ)

2 アプリケーション

- 衛星通信ペイロードのダウンリンク
- 衛星テレメトリ ペイロードのダウンリンク

3 概要

AFE7950-x は、高性能で広帯域幅のマルチチャネル トランシーバで、4 つの RF サンプリング トランスミッタ チェーン、4 つの RF サンプリング レシーバ チェーン、2 つの RF サンプリング フィードバック チェーン (合計 6 つの RF サンプリング ADC) を統合しています。このデバイスは、最大 12GHz で動作するため、追加の周波数変換段を必要とせず、L、S、C、X バンドの周波数範囲について直接 RF サンプリングが可能です。この密度と柔軟性の向上により、多くのチャネル数を持つマルチミッション システムが可能になります。

TX 信号パスは、4 個の TX で最大 1200MHz の信号帯域幅、または 2 個の TX で 2400MHz を実現する、補間およびデジタル アップコンバージョン オプションをサポートしています。DUC の出力は、2 次ナイキスト動作を拡張する混在モード出力方式で 12GSPS の DAC (D/A コンバータ) を駆動します。DAC 出力は、40dB レンジ、1dB アナログ ステップ、0.125dB デジタル ステップの可変ゲイン アンプ (TX DSA) を内蔵しています。

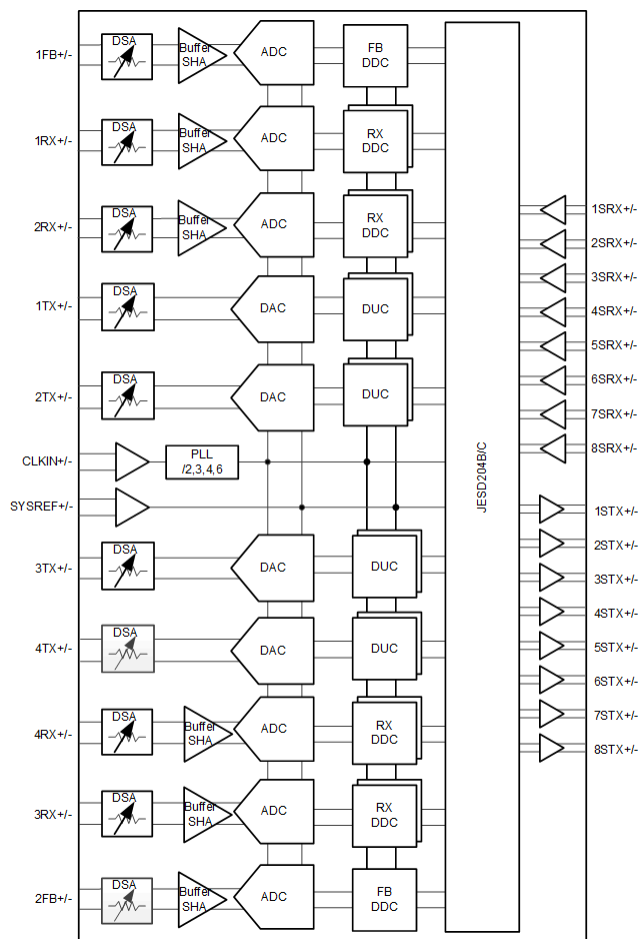
各レシーバ チェーンは、3GSPS の ADC (A/D コンバータ) に接続された 25dB レンジのデジタル ステップ アッテネータ (DSA) を備えています。各レシーバ チェーンは、外部または内部の自律的な AGC (自動ゲイン制御) を補助するためのアナログ ピーク電力検出器とさまざまなデジタル電力検出器、およびデバイスの信頼性を確保するための RF 過負荷検出器を備えています。柔軟なデシメーション オプションによりデータ帯域幅を最適化でき、FB パスなしの 4 つの RX では最高 1200MHz、2 つの FB パス付き (それぞれ 1200MHz の帯域幅) では最高 600MHz が得られます。

製品情報

部品番号	グレード	パッケージ サイズ ⁽¹⁾ (2)
AFE7950-SP	放射線耐性保証宇宙 (RHA)	17mm × 17mm プラスチック サブストレート
AFE7950-SEP ⁽³⁾	耐放射線特性の宇宙用エンハンスト製品	FC-BGA
AFE7950-EP ⁽³⁾	エンハンスト製品	400 SnPb ボール 0.8mm ピッチ

- 詳細については、[セクション 7](#) を参照してください。
- パッケージ サイズ (長さ × 幅) は公称値であり、該当する場合はピンも含まれます。
- 製品プレビュー





機能ブロック図

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4 Specifications

4.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)⁽¹⁾

		MIN	MAX	UNIT
Supply Voltage Range	DVDD0P9, VDDT0P9	−0.3	1.2	V
	VDD1P2RX, VDD1P2TXCLK, VDD1P2TXENC, VDD1P2PLL, VDD1P2PLLCLKREF, VDD1P2FB, VDD1P2FBCML, VDD1P2RXCML	−0.3	1.4	V
	VDD1P8RX, VDD1P8RXCLK, VDD1P8TX, VDD1P8TXDAC, VDD1P8TXENC, VDD1P8PLL, VDD1P8PLLVC0, VDD1P8FB, VDD1P8FBCML, VDD1P8GPIO, VDDA1P8	−0.5	2.1	V
Pin Voltage Range	{1/2/3/4}RXIN+/-	−0.5	VDDR1P8+0.3	V
	1FBIN+/-, 2FB+/-	−0.5	VDDFB1P8+0.3	V
	{1/2/3/4}TXOUT+/-	−0.5	VDDTX1P8+0.3	V
	REFCLK+/-, SYSREF+/-	−0.3	1.4	V
	{1:8}SRX+/-	−0.3	1.4	V
	{1:8}STX+/-	−0.3	1.4	V
	GPIO{B/C/D/E}x, SPICLK, SPISDIO, SPISDO, SPISEN, RESETZ, BISTB0, BISTB1	−0.5	VDD1P8GPIO + 0.3	V
	IFORCE, VSENSE	−0.3	VDDCLK1P8 + 0.3	V
	SRDAMUX1, SRDAMUX2	−0.3	VDDA1P8+0.3	V
Peak Input Current	any input		20	mA
T _J	Junction temperature		150	°C
T _{stg}	Storage temperature	−65	150	°C

- (1) Stresses beyond those listed under *Absolute Maximum Rating* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Condition*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

4.2 ESD Ratings

			VALUE	UNIT
V _(ESD)	Electrostatic discharge	Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins ⁽¹⁾	1000	V
		Charged device model (CDM), per ANSI/ESDA/JEDEC JS-002, all pins	150	

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

4.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

		MIN	NOM	MAX	UNIT
DVDD0P9, VDDT0P9	Supply voltage 0.9V	0.9	0.925	0.95	V
VDD1P2{RX/TXCLK/TXENC/FB/PLL/ PLLCLKREF/FBCML/RXCML}	Supply voltage 1.2V	1.15	1.2	1.25	V
VDD1P8{RX/RXCLK/TX/TXDAC/ TXENC/PLL/PLLVCO/FB/FBCLK/ GPIO}, VDDA1P8	Supply voltage 1.8V	1.75	1.8	1.85	V
T _A	Ambient temperature	–45		85	°C
T _J	Operating Junction Temperature			105	°C

4.4 Thermal Information

THERMAL METRIC ⁽¹⁾		FC-BGA	UNIT
		400 PINS	
R _{θJA}	Junction-to-ambient thermal resistance	15.3	°C/W
R _{θJC(top)}	Junction-to-case (top) thermal resistance	0.44	°C/W
R _{θJB}	Junction-to-board thermal resistance	4.8	°C/W
Ψ _{JB}	Junction-to-board characterization parameter	4.5	°C/W

- (1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report.

4.5 Transmitter Electrical Characteristics

Typical values at $T_A = +25^\circ\text{C}$, full temperature range is $T_{A,\text{MIN}} = -40^\circ\text{C}$ to $T_{J,\text{MAX}} = +110^\circ\text{C}$; TX Input Rate = 491.52MSPS below 6GHz and 1474.56MSPS above 6GHz, $f_{\text{DAC}} = 11796.48\text{MSPS}$; PLL clock mode below 6GHz output frequency and External clock mode above 6GHz output frequency; interleave mode for 1st Nyquist, non-interleave mix mode for 2nd Nyquist, nominal power supplies; 1 tone at -1 dBFS; DSA Attenuation = 0dB; SerDes rate = 16.22Gbps, unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
DAC _{RES}	DAC resolution			14		bits
F _{DAC}	DAC Sample Rate		9		12	GSPS
f _{RFout_MIN}	RF output frequency range	Requires PCB matching based on frequency range		600		MHz
f _{RFout_MAX}	RF output frequency range	Requires PCB matching based on frequency range		12000		MHz
P _{max_FS}	Max Full Scale Output Power, max gain 1 tone, at device pins	f _{out} = 850 MHz, f _{DAC} = 5898.24 MSPS, -0.5dBFS		4.2		dBm
		f _{out} = 1800 MHz, f _{DAC} = 5898.24 MSPS, -0.5dBFS		4.6		dBm
		f _{out} = 2600 MHz, f _{DAC} = 8847.36 MSPS, -0.5dBFS		4.0		dBm
		f _{out} = 3500 MHz, -0.5dBFS		3.9		dBm
		f _{out} = 4900 MHz, -0.5dBFS		3.1		dBm
		f _{out} = 3500 MHz, f _{DAC} = 5898.24 MSPS, -0.5dBFS, straight mode		1.0		dBm
		f _{out} = 4900 MHz, f _{DAC} = 5898.24 MSPS, -0.5dBFS, straight mode		0.1		dBm
		f _{out} = 4900 MHz, f _{DAC} = 8847.36 MSPS, -0.5dBFS, straight mode		-0.7		dBm
		f _{out} = 8100 MHz, -0.1dBFS, mixed mode		-2.8		dBm
		f _{out} = 9600 MHz, -0.1dBFS, mixed mode		-4.3		dBm
R _{TERM}	Output termination resistor	Default setting		50		Ω
ATT _{range}	DSA Attenuation range			40		dB
ATT _{step}	DSA Analog Attenuation step			1.0		dB
	DSA Attenuation step accuracy (DNL)	0 < Atten < 40dB, before calibration		±0.2		dB
	DSA Attenuation step accuracy (DNL)	0 < Atten < 40dB, after calibration		±0.1		dB
ATT _{phase-err}	DSA Gain Steps Phase accuracy, any 8dB range	f _{out} = 850MHz ⁽²⁾		±1		deg
		f _{out} = 1800MHz ⁽²⁾		±1		deg
		f _{out} = 2600MHz ⁽²⁾		±1		deg
		f _{out} = 3500MHz ⁽²⁾		±1		deg
		f _{out} = 4900MHz ⁽²⁾		±1		deg
		f _{out} = 8100MHz ⁽²⁾		±2		deg
		f _{out} = 9600MHz ⁽²⁾		±2		deg
G _{flat}	Gain flatness	any 20MHz		0.1		dB
		600MHz BW, F _{out} < 4.9G		1.2		

Typical values at $T_A = +25^{\circ}\text{C}$, full temperature range is $T_{A,\text{MIN}} = -40^{\circ}\text{C}$ to $T_{J,\text{MAX}} = +110^{\circ}\text{C}$; TX Input Rate = 491.52MSPS below 6GHz and 1474.56MSPS above 6GHz, $f_{\text{DAC}} = 11796.48\text{MSPS}$; PLL clock mode below 6GHz output frequency and External clock mode above 6GHz output frequency; interleave mode for 1st Nyquist, non-interleave mix mode for 2nd Nyquist, nominal power supplies; 1 tone at -1 dBFS; DSA Attenuation = 0dB; SerDes rate = 16.22Gbps, unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
IMD3	3rd Order Intermodulation distortion, 2 tones at $f_{\text{IF}} \pm 10\text{ MHz}$	$f_{\text{out}} = 850\text{MHz}$, -7dBFS each tone		-66		dBc
		$f_{\text{out}} = 1800\text{MHz}$, -7dBFS each tone		-63		dBc
		$f_{\text{out}} = 2600\text{MHz}$, -7dBFS each tone		-62		dBc
		$f_{\text{out}} = 3500\text{MHz}$, -7dBFS each tone		-61		dBc
		$f_{\text{out}} = 4900\text{MHz}$, -7dBFS each tone		-57		dBc
		$f_{\text{out}} = 8100\text{MHz}$, -7dBFS each tone		-55		dBc
		$f_{\text{out}} = 9600\text{MHz}$, -7dBFS each tone		-52		dBc
		$f_{\text{out}} = 850\text{MHz}$, -13dBFS each tone		-74		dBc
		$f_{\text{out}} = 1800\text{MHz}$, -13dBFS each tone		-71		dBc
		$f_{\text{out}} = 2501\text{MHz}$, -12dBFS each tone		-67	-60	dBc
		$f_{\text{out}} = 2600\text{MHz}$, -13dBFS each tone		-73		dBc
		$f_{\text{out}} = 3500\text{MHz}$, -13dBFS each tone		-72		dBc
		$f_{\text{out}} = 4900\text{MHz}$, -13dBFS each tone		-68		dBc
		$f_{\text{out}} = 8100\text{MHz}$, -13dBFS each tone		-64		dBc
		$f_{\text{out}} = 9600\text{MHz}$, -13dBFS each tone		-68		dBc
SFDR	Spurious Free Dynamic Range (within Nyquist zone)	$f_{\text{out}} = 850\text{ MHz}$		51		dBc
		$f_{\text{out}} = 1800\text{ MHz}$		52		dBc
		$f_{\text{out}} = 2600\text{ MHz}$		42		dBc
		$f_{\text{out}} = 3500\text{ MHz}$		44		dBc
		$f_{\text{out}} = 4900\text{ MHz}$		46		dBc
$f_{\text{S}}/2 - f_{\text{OUT}}$	Interleaving Image	$f_{\text{DAC}} = 5898.24\text{MSPS}$, interleave mode		-52		dBc
		$f_{\text{DAC}} = 8847.36\text{ MSPS}$, interleave mode		-46		dBc
		$f_{\text{DAC}} = 11796.48\text{MSPS}$, interleave mode		-42		dBc
HD2	2nd Harmonic Distortion (within Nyquist zone)	$f_{\text{out}} = 850\text{ MHz}$		-49		dBc
		$f_{\text{out}} = 1800\text{ MHz}$		-53		dBc
		$f_{\text{out}} = 2600\text{ MHz}$		-50		dBc
		$f_{\text{out}} = 3500\text{ MHz}$		-48		dBc
		$f_{\text{out}} = 4900\text{ MHz}$		-47		dBc
		$f_{\text{out}} = 8100\text{ MHz}$		-50		dBc
		$f_{\text{out}} = 9600\text{ MHz}$		-53		dBc
		$f_{\text{out}} = 850\text{ MHz}$, $A_{\text{OUT}} = -12\text{dBFS}$		-60		dBc
		$f_{\text{out}} = 1800\text{ MHz}$, $A_{\text{OUT}} = -12\text{dBFS}$		-64		dBc
		$f_{\text{out}} = 2600\text{ MHz}$, $A_{\text{OUT}} = -12\text{dBFS}$		-45		dBc
		$f_{\text{out}} = 3500\text{ MHz}$, $A_{\text{OUT}} = -12\text{dBFS}$		-57		dBc
		$f_{\text{out}} = 4900\text{ MHz}$, $A_{\text{OUT}} = -12\text{dBFS}$		-58		dBc
		$f_{\text{out}} = 8100\text{ MHz}$, $A_{\text{OUT}} = -12\text{dBFS}$		-60		dBc
		$f_{\text{out}} = 9600\text{ MHz}$, $A_{\text{OUT}} = -12\text{dBFS}$		-62		dBc

Typical values at $T_A = +25^{\circ}\text{C}$, full temperature range is $T_{A,\text{MIN}} = -40^{\circ}\text{C}$ to $T_{A,\text{MAX}} = +110^{\circ}\text{C}$; TX Input Rate = 491.52MSPS below 6GHz and 1474.56MSPS above 6GHz, $f_{\text{DAC}} = 11796.48\text{MSPS}$; PLL clock mode below 6GHz output frequency and External clock mode above 6GHz output frequency; interleave mode for 1st Nyquist, non-interleave mix mode for 2nd Nyquist, nominal power supplies; 1 tone at -1 dBFS; DSA Attenuation = 0dB; SerDes rate = 16.22Gbps, unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
HD3	3rd Harmonic Distortion (within Nyquist zone)	$f_{\text{out}} = 850 \text{ MHz}$		-62		dBc
		$f_{\text{out}} = 1800 \text{ MHz}$		-55		dBc
		$f_{\text{out}} = 2600 \text{ MHz}$		-57		dBc
		$f_{\text{out}} = 3500 \text{ MHz}$		-60		dBc
		$f_{\text{out}} = 4900 \text{ MHz}$		-54		dBc
		$f_{\text{out}} = 8100 \text{ MHz}$		-54		dBc
		$f_{\text{out}} = 9600 \text{ MHz}$		-56		dBc
		$f_{\text{out}} = 850 \text{ MHz}, A_{\text{OUT}} = -12\text{dBFS}$		-80		dBc
		$f_{\text{out}} = 1800 \text{ MHz}, A_{\text{OUT}} = -12\text{dBFS}$		-79		dBc
		$f_{\text{out}} = 2600 \text{ MHz}, A_{\text{OUT}} = -12\text{dBFS}$		-77		dBc
		$f_{\text{out}} = 3500 \text{ MHz}, A_{\text{OUT}} = -12\text{dBFS}$		-77		dBc
		$f_{\text{out}} = 4900 \text{ MHz}, A_{\text{OUT}} = -12\text{dBFS}$		-78		dBc
		$f_{\text{out}} = 8100 \text{ MHz}, A_{\text{OUT}} = -12\text{dBFS}$		-82		dBc
		$f_{\text{out}} = 9600 \text{ MHz}, A_{\text{OUT}} = -12\text{dBFS}$		-80		dBc
HDn, n >= 4	Harmonic Distortion n >= 4 (within Nyquist zone)	$f_{\text{out}} = 850 \text{ MHz}$		-81		dBc
		$f_{\text{out}} = 1800 \text{ MHz}$		-88		dBc
		$f_{\text{out}} = 2600 \text{ MHz}$		-86		dBc
		$f_{\text{out}} = 3500 \text{ MHz}$		-79		dBc
		$f_{\text{out}} = 4900 \text{ MHz}$		-86		dBc
		$f_{\text{out}} = 8100 \text{ MHz}$		-87		dBc
		$f_{\text{out}} = 9600 \text{ MHz}$		-85		dBc
		$f_{\text{out}} = 850 \text{ MHz}, A_{\text{OUT}} = -12\text{dBFS}$		-93		dBc
		$f_{\text{out}} = 1800 \text{ MHz}, A_{\text{OUT}} = -12\text{dBFS}$		-98		dBc
		$f_{\text{out}} = 2600 \text{ MHz}, A_{\text{OUT}} = -12\text{dBFS}$		-84		dBc
		$f_{\text{out}} = 3500 \text{ MHz}, A_{\text{OUT}} = -12\text{dBFS}$		-87		dBc
		$f_{\text{out}} = 4900 \text{ MHz}, A_{\text{OUT}} = -12\text{dBFS}$		-87		dBc
		$f_{\text{out}} = 8100 \text{ MHz}, A_{\text{OUT}} = -12\text{dBFS}$		-87		dBc
		$f_{\text{out}} = 9600 \text{ MHz}, A_{\text{OUT}} = -12\text{dBFS}$		-87		dBc
SFDR +/- 250 MHz	Spurious Free Dynamic Range within +/- 250 MHz	$f_{\text{out}} = 850 \text{ MHz}$		69		dBc
		$f_{\text{out}} = 1800 \text{ MHz}$		79		dBc
		$f_{\text{out}} = 2600 \text{ MHz}$		77		dBc
		$f_{\text{out}} = 3500 \text{ MHz}$		75		dBc
		$f_{\text{out}} = 4900 \text{ MHz}$		76		dBc
		$f_{\text{out}} = 8100 \text{ MHz}$		61		dBc
		$f_{\text{out}} = 9600 \text{ MHz}$		64		dBc
$f_s/4$	Fixed Spur	$f_{\text{DAC}} = 5898.24\text{MSPS}$		-64		dBFS
		$f_{\text{DAC}} = 8847.36\text{MSPS}$		-75		dBFS
		$f_{\text{DAC}} = 11796.48\text{MSPS}$		-67		dBFS
$f_s/2$	Fixed Spur	$f_{\text{DAC}} = 5898.24\text{MSPS}$		-49		dBFS
		$f_{\text{DAC}} = 8847.36\text{MSPS}$		-48		dBFS
		$f_{\text{DAC}} = 11796.48 \text{ MSPS}$		-48		dBFS

Typical values at $T_A = +25^{\circ}\text{C}$, full temperature range is $T_{A,\text{MIN}} = -40^{\circ}\text{C}$ to $T_{J,\text{MAX}} = +110^{\circ}\text{C}$; TX Input Rate = 491.52MSPS below 6GHz and 1474.56MSPS above 6GHz, $f_{\text{DAC}} = 11796.48\text{MSPS}$; PLL clock mode below 6GHz output frequency and External clock mode above 6GHz output frequency; interleave mode for 1st Nyquist, non-interleave mix mode for 2nd Nyquist, nominal power supplies; 1 tone at -1 dBFS; DSA Attenuation = 0dB; SerDes rate = 16.22Gbps, unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
$3 \cdot f_s/4$	Fixed Spur	2nd Nyquist, $f_{\text{DAC}} = 5898.24\text{MSPS}$		-76		dBFS
		2nd Nyquist, $f_{\text{DAC}} = 8847.36\text{MSPS}$		-89		dBFS
		2nd Nyquist, $f_{\text{DAC}} = 11796.48\text{MSPS}$		-63		dBFS
ACPR _{1xcarr}	ACPR - 1 carrier, LTE 20MHz E-TM1.1 carrier $f_{\text{out}} = 0.85\text{ GHz}$	Atten=0dB, Pout=-13dBFS		-68.5		dBc
		Atten=20dB, Pout=-13dBFS		-67.2		dBc
		Atten=28dB, Pout=-13dBFS		-64.5		dBc
		Atten=39dB, Pout=-13dBFS		-53.9		dBc
ACPR _{1xcarr}	ACPR - 1 carrier, LTE 20MHz E-TM1.1 carrier $f_{\text{out}} = 1.8425\text{ GHz}$	Atten=0dB, Pout=-13dBFS		-70.7		dBc
		Atten=20dB, Pout=-13dBFS		-68.3		dBc
		Atten=28dB, Pout=-13dBFS		-62.9		dBc
		Atten=39dB, Pout=-13dBFS		-52.0		dBc
ACPR _{1xcarr}	ACPR - 1 carrier, LTE 20MHz E-TM1.1 carrier $f_{\text{out}} = 2.6\text{ GHz}$	Atten=0dB, Pout=-13dBFS		-71		dBc
		Atten=20dB, Pout=-13dBFS		-68		dBc
		Atten=28dB, Pout=-13dBFS		-62		dBc
		Atten=39dB, Pout=-13dBFS		-51.3		dBc
ACPR _{1xcarr}	ACPR - 1 carrier, LTE 20MHz E-TM1.1 carrier $f_{\text{out}} = 3.5\text{ GHz}$	Atten=0dB, Pout=-13dBFS		-70		dBc
		Atten=20dB, Pout=-13dBFS		-67		dBc
		Atten=28dB, Pout=-13dBFS		-60		dBc
		Atten=39dB, Pout=-13dBFS		-49.8		dBc
ACPR _{1xcarr}	ACPR - 1 carrier, LTE 20MHz E-TM1.1 carrier $f_{\text{out}} = 4.9\text{ GHz}$	Atten=0dB, Pout=-13dBFS		-68.8		dBc
		Atten=20dB, Pout=-13dBFS		-65.9		dBc
		Atten=28dB, Pout=-13dBFS		-60.6		dBc
		Atten=39dB, Pout=-13dBFS		-49.5		dBc
ACPR _{1xcarr}	ACPR - 1 carrier, NR 100MHz E-TM1.1 carrier $f_{\text{out}} = 2.6\text{ GHz}$	Atten=0dB, Pout=-13dBFS		-65		dBc
		Atten=20dB, Pout=-13dBFS		-62		dBc
		Atten=20dB, Pout=-13dBFS		-55		dBc
		Atten=39dB, Pout=-13dBFS		-44.3		dBc
ACPR _{1xcarr}	ACPR - 1 carrier, NR 100MHz E-TM1.1 carrier $f_{\text{out}} = 3.5\text{ GHz}$	Atten=0dB, Pout=-13dBFS		-64		dBc
		Atten=20dB, Pout=-13dBFS		-59		dBc
		Atten=28dB, Pout=-13dBFS		-52		dBc
		Atten=39dB, Pout=-13dBFS		-41.1		dBc
ACPR _{1xcarr}	ACPR - 1 carrier, NR 100MHz E-TM1.1 carrier $f_{\text{out}} = 4.9\text{ GHz}$	Atten=0dB, Pout=-13dBFS		-64.1		dBc
		Atten=20dB, Pout=-13dBFS		-60.4		dBc
		Atten=28dB, Pout=-13dBFS		-53.5		dBc
		Atten=39dB, Pout=-13dBFS		-42.5		dBc
ACPR _{1xcarr}	ACPR - 1 carrier, NR 100MHz E-TM1.1 carrier $f_{\text{out}} = 8.1\text{ GHz}$	Atten=0dB, Pout=-13dBFS		-58		dBc
		Atten=20dB, Pout=-13dBFS		-53		dBc
		Atten=28dB, Pout=-13dBFS		-46		dBc
		Atten=39dB, Pout=-13dBFS		-36		dBc
ACPR _{1xcarr}	ACPR - 1 carrier, NR 100MHz E-TM1.1 carrier $f_{\text{out}} = 9.6\text{ GHz}$	Atten=0dB, Pout=-13dBFS		-57		dBc
		Atten=20dB, Pout=-13dBFS		-50		dBc
		Atten=28dB, Pout=-13dBFS		-42		dBc
		Atten=39dB, Pout=-13dBFS		-31		dBc

Typical values at $T_A = +25^{\circ}\text{C}$, full temperature range is $T_{A,\text{MIN}} = -40^{\circ}\text{C}$ to $T_{A,\text{MAX}} = +110^{\circ}\text{C}$; TX Input Rate = 491.52MSPS below 6GHz and 1474.56MSPS above 6GHz, $f_{\text{DAC}} = 11796.48\text{MSPS}$; PLL clock mode below 6GHz output frequency and External clock mode above 6GHz output frequency; interleave mode for 1st Nyquist, non-interleave mix mode for 2nd Nyquist, nominal power supplies; 1 tone at -1 dBFS; DSA Attenuation = 0dB; SerDes rate = 16.22Gbps, unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
EVM	Error Vector Magnitude, 1x 20MHz E-TM3.1/3.1a, no ref. clock noise	$F_{\text{out}} = 0.85\text{ GHz}$, $P_{\text{OUT}} = -13\text{ dBFS}$		0.16		%
		$F_{\text{out}} = 1.8425\text{ GHz}$, $P_{\text{OUT}} = -13\text{ dBFS}$		0.29		%
		$F_{\text{out}} = 2.6\text{ GHz}$, $P_{\text{OUT}} = -13\text{ dBFS}$		0.28		%
		$F_{\text{out}} = 3.5\text{ GHz}$, $P_{\text{OUT}} = -13\text{ dBFS}$		0.38		%
		$F_{\text{out}} = 4.9\text{ GHz}$, $P_{\text{OUT}} = -13\text{ dBFS}$		0.43		%
NSD _{dBFS}	Noise Spectral Density 20MHz offset $f_{\text{OUT}} = 0.85\text{ GHz}$	Atten=0dB, $f_{\text{DAC}} = 5898.24\text{MSPS}$, $P_{\text{out}} = -13\text{ dBFS}$		-156		dBFS/ Hz
		Atten=20dB, $f_{\text{DAC}} = 5898.24\text{MSPS}$, $P_{\text{out}} = -13\text{ dBFS}$		-151		dBFS/ Hz
		Atten=28dB, $f_{\text{DAC}} = 5898.24\text{MSPS}$, $P_{\text{out}} = -13\text{ dBFS}$		-145		dBFS/ Hz
		Atten=39dB, $f_{\text{DAC}} = 5898.24\text{MSPS}$, $P_{\text{out}} = -13\text{ dBFS}$		-134		dBFS/ Hz
NSD _{dBFS}	Noise Spectral Density 20MHz offset $f_{\text{OUT}} = 1.8\text{ GHz}$	Atten=0dB, $f_{\text{DAC}} = 5898.24\text{MSPS}$, $P_{\text{out}} = -13\text{ dBFS}$		-158		dBFS/ Hz
		Atten=20dB, $f_{\text{DAC}} = 5898.24\text{MSPS}$, $P_{\text{out}} = -13\text{ dBFS}$		-152		dBFS/ Hz
		Atten=28dB, $f_{\text{DAC}} = 5898.24\text{MSPS}$, $P_{\text{out}} = -13\text{ dBFS}$		-146		dBFS/ Hz
		Atten=39dB, $f_{\text{DAC}} = 5898.24\text{MSPS}$, $P_{\text{out}} = -13\text{ dBFS}$		-135		dBFS/ Hz
NSD _{dBFS}	Noise Spectral Density 20MHz offset $f_{\text{OUT}} = 2.6\text{ GHz}$	Atten=0dB, $f_{\text{DAC}} = 8847.36\text{MSPS}$, $P_{\text{out}} = -13\text{ dBFS}$		-157		dBFS/ Hz
		Atten=20dB, $f_{\text{DAC}} = 8847.36\text{MSPS}$, $P_{\text{out}} = -13\text{ dBFS}$		-151		dBFS/ Hz
		Atten=28dB, $f_{\text{DAC}} = 8847.36\text{MSPS}$, $P_{\text{out}} = -13\text{ dBFS}$		-144		dBFS/ Hz
		Atten=39dB, $f_{\text{DAC}} = 8847.36\text{MSPS}$, $P_{\text{out}} = -13\text{ dBFS}$		-133		dBFS/ Hz
NSD _{dBFS}	Noise Spectral Density 20MHz offset $F_{\text{out}} = 3.5\text{ GHz}$	Atten=0dB, $P_{\text{out}} = -13\text{ dBFS}$		-158		dBFS/ Hz
		Atten=20dB, $P_{\text{out}} = -13\text{ dBFS}$		-150		dBFS/ Hz
		Atten=28dB, $P_{\text{out}} = -13\text{ dBFS}$		-143		dBFS/ Hz
		Atten=39dB, $P_{\text{out}} = -13\text{ dBFS}$		-132		dBFS/ Hz
NSD _{dBFS}	Noise Spectral Density 20MHz offset $F_{\text{out}} = 4.9\text{ GHz}$	Atten=0dB, $P_{\text{out}} = -13\text{ dBFS}$		-155		dBFS/ Hz
		Atten=20dB, $P_{\text{out}} = -13\text{ dBFS}$		-148		dBFS/ Hz
		Atten=28dB, $P_{\text{out}} = -13\text{ dBFS}$		-141		dBFS/ Hz
		Atten=39dB, $P_{\text{out}} = -13\text{ dBFS}$		-130		dBFS/ Hz

Typical values at $T_A = +25^\circ\text{C}$, full temperature range is $T_{A,\text{MIN}} = -40^\circ\text{C}$ to $T_{J,\text{MAX}} = +110^\circ\text{C}$; TX Input Rate = 491.52MSPS below 6GHz and 1474.56MSPS above 6GHz, $f_{\text{DAC}} = 11796.48\text{MSPS}$; PLL clock mode below 6GHz output frequency and External clock mode above 6GHz output frequency; interleave mode for 1st Nyquist, non-interleave mix mode for 2nd Nyquist, nominal power supplies; 1 tone at -1 dBFS; DSA Attenuation = 0dB; SerDes rate = 16.22Gbps, unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
NSD _{dBFS}	Noise Spectral Density 50MHz offset $F_{\text{out}} = 8.1\text{ GHz}$	Atten=0dB, Pout=-13dBFS		-149		dBFS/ Hz
		Atten=20dB, Pout=-13dBFS		-147		dBFS/ Hz
		Atten=28dB, Pout=-13dBFS		-141		dBFS/ Hz
		Atten=39dB, Pout=-13dBFS		-130		dBFS/ Hz
NSD _{dBFS}	Noise Spectral Density 50MHz offset $F_{\text{out}} = 9.6\text{ GHz}$	Atten=0dB, Pout=-13dBFS		-148		dBFS/ Hz
		Atten=20dB, Pout=-13dBFS		-144		dBFS/ Hz
		Atten=28dB, Pout=-13dBFS		-137		dBFS/ Hz
		Atten=39dB, Pout=-13dBFS		-126		dBFS/ Hz
S22	Output Return Loss, <6GHz, +/- fc * 10%	with matching		-17		dB
	Output Return Loss, >8GHz, +/- fc * 10%	with matching		-13		dB
Isolation	Near Channel: 1TXOUT to 2TXOUT or 3TXOUT to 4TXOUT ⁽¹⁾	$f_{\text{out}} = 900\text{ MHz}$, $f_{\text{DAC}} = 8847.36\text{MSPS}$, straight mode		-49		dB
		$f_{\text{out}} = 1850\text{ MHz}$, $f_{\text{DAC}} = 8847.36\text{MSPS}$, straight mode		-59		dB
		$f_{\text{out}} = 2600\text{ MHz}$, $f_{\text{DAC}} = 8847.36\text{MSPS}$, straight mode		-64		dB
		$f_{\text{out}} = 3500\text{ MHz}$, $f_{\text{DAC}} = 8847.36\text{MSPS}$, straight mode		-66		dB
		$f_{\text{out}} = 4900\text{ MHz}$, $f_{\text{DAC}} = 8847.36\text{MSPS}$, straight mode		-60		dB
		$f_{\text{out}} = 900\text{ MHz}$, $f_{\text{DAC}} = 8847.36\text{MSPS}$, straight mode		-90		dB
		$f_{\text{out}} = 1850\text{ MHz}$, $f_{\text{DAC}} = 8847.36\text{MSPS}$, straight mode		-91		dB
		$f_{\text{out}} = 2600\text{ MHz}$, $f_{\text{DAC}} = 8847.36\text{MSPS}$, straight mode		-93		dB
		$f_{\text{out}} = 3500\text{ MHz}$, $f_{\text{DAC}} = 8847.36\text{MSPS}$, straight mode		-94		dB
		$f_{\text{out}} = 4900\text{ MHz}$, $f_{\text{DAC}} = 8847.36\text{MSPS}$, straight mode		-83		dB
		$f_{\text{out}} = 8100\text{ MHz}$		-47		dB
		$f_{\text{out}} = 9600\text{ MHz}$		-60		dB
	Far Channel: 1/2TXOUT to 3/4TXOUT	$f_{\text{out}} = 8100\text{ MHz}$		-80		dB

Typical values at $T_A = +25^\circ\text{C}$, full temperature range is $T_{A,\text{MIN}} = -40^\circ\text{C}$ to $T_{J,\text{MAX}} = +110^\circ\text{C}$; TX Input Rate = 491.52MSPS below 6GHz and 1474.56MSPS above 6GHz, $f_{\text{DAC}} = 11796.48\text{MSPS}$; PLL clock mode below 6GHz output frequency and External clock mode above 6GHz output frequency; interleave mode for 1st Nyquist, non-interleave mix mode for 2nd Nyquist, nominal power supplies; 1 tone at -1 dBFS; DSA Attenuation = 0dB; SerDes rate = 16.22Gbps, unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
PN _{TXADD}	Additive Phase Noise External Clock Mode ⁽³⁾	$f_{\text{out}} = 9.6\text{GHz}$, $f_{\text{OFFSET}} = 100\text{Hz}$		-88		dBc/Hz
		$f_{\text{out}} = 9.6\text{GHz}$, $f_{\text{OFFSET}} = 1\text{kHz}$		-102		dBc/Hz
		$f_{\text{out}} = 9.6\text{GHz}$, $f_{\text{OFFSET}} = 10\text{kHz}$		-110		dBc/Hz
		$f_{\text{out}} = 9.6\text{GHz}$, $f_{\text{OFFSET}} = 100\text{kHz}$		-123		dBc/Hz
		$f_{\text{out}} = 9.6\text{GHz}$, $f_{\text{OFFSET}} = 1\text{MHz}$		-136		dBc/Hz
		$f_{\text{out}} = 9.6\text{GHz}$, $f_{\text{OFFSET}} = 10\text{MHz}$		-143		dBc/Hz
		$f_{\text{out}} = 9.6\text{GHz}$, $f_{\text{OFFSET}} = 100\text{MHz}$		-146		dBc/Hz

- (1) Measured with differential 50 ohm across TxP/M. The DC bias to 1.8V to each TxP/M at each pin remains and is not removed. Other external components on the TX paths are disconnected.
- (2) After DSA calibration procedure
- (3) Single side band, input clock phase noise subtracted.

4.6 RF ADC Electrical Characteristics

Typical values at $T_A = +25^\circ\text{C}$, full temperature range is $T_{A,\text{MIN}} = -40^\circ\text{C}$ to $T_{J,\text{MAX}} = +110^\circ\text{C}$; RX Output Rate = 491.52MSPS below 6GHz input frequency and 1474.56MSPS above 6GHz input frequency, $f_{\text{ADC}} = 2949.12\text{MSPS}$; PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$ below 6GHz input frequency and External clock mode with $f_{\text{CLK}} = 11796.48\text{MHz}$ above 6GHz input frequency; nominal power supplies; DSA Setting = 4dB below 6GHz and 3dB above 6GHz; SerDes rate = 24.33Gbps; unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
ADC _{RES}	ADC resolution			14		bits
F _{ADC}	ADC Sample Rate		1.5		3	GSPS
F _{RFin_MAX}	RF input frequency range	Requires PCB matching based on frequency range		12000		MHz
F _{RFin_MIN}	RF input frequency range	Requires PCB matching based on frequency range		5		MHz
P _{FS_CW,min}	Min Full scale input power, at device pins (1)	$f_{\text{IN}} = 830\text{ MHz}$, DSA=0dB		-2.9		dBm
		$f_{\text{IN}} = 1760\text{ MHz}$, DSA=0dB		-2.8		dBm
		$f_{\text{IN}} = 2610\text{ MHz}$, DSA=0dB		-1.8		dBm
		$f_{\text{IN}} = 3610\text{ MHz}$, DSA=0dB		-0.4		dBm
		$f_{\text{IN}} = 4910\text{ MHz}$, DSA=0dB		0.1		dBm
		$f_{\text{IN}} = 8150\text{ MHz}$, DSA=0dB		2.1		dBm
		$f_{\text{IN}} = 9610\text{ MHz}$, DSA=0dB		4.3		dBm
P _{FS_CW,MAX}	MAX Full scale input power - reliability limited, at device pins	$f_{\text{IN}} = 830\text{ MHz}$, DSA = 20dB		16.7		dBm
		$f_{\text{IN}} = 1760\text{ MHz}$, DSA = 20dB		17.0		dBm
		$f_{\text{IN}} = 2610\text{ MHz}$, DSA = 20dB		18		dBm
		$f_{\text{IN}} = 3610\text{ MHz}$, DSA = 20dB		18.5		dBm
		$f_{\text{IN}} = 4910\text{ MHz}$, DSA = 20dB		19.3		dBm
		$f_{\text{IN}} = 8150\text{ MHz}$, DSA = 20dB		21.3		dBm
		$f_{\text{IN}} = 9610\text{ MHz}$, DSA = 20dB		23.5		dBm
S11	Input Return Loss	with matching network		-12		dB
ATT _{range}	DSA Attenuation range			25		dB
ATT _{step}	DSA Attenuation step			0.5		dB
	DSA Attenuation step accuracy	$\Delta = \text{Gatt}(\text{X}) - \text{Gatt}(\text{X}-1)$, $F_{\text{in}} = 3610\text{MHz}$, after calibration		± 0.1		dB
	DSA Gain Steps Phase accuracy any 8dB range	$F_{\text{in}} = 3610\text{MHz}$, after calibration		± 0.9		deg
	DSA Gain Steps Phase accuracy any 8dB range	$F_{\text{in}} = 4910\text{MHz}$, after calibration		± 1.8		deg

Typical values at $T_A = +25^\circ\text{C}$, full temperature range is $T_{A,\text{MIN}} = -40^\circ\text{C}$ to $T_{J,\text{MAX}} = +110^\circ\text{C}$; RX Output Rate = 491.52MSPS below 6GHz input frequency and 1474.56MSPS above 6GHz input frequency, $f_{\text{ADC}} = 2949.12\text{MSPS}$; PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$ below 6GHz input frequency and External clock mode with $f_{\text{CLK}} = 11796.48\text{MHz}$ above 6GHz input frequency; nominal power supplies; DSA Setting = 4dB below 6GHz and 3dB above 6GHz; SerDes rate = 24.33Gbps; unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
NSD	Noise Density (small signal)	$f_{\text{IN}} = 830\text{ MHz}$, DSA = 3dB ⁽³⁾		-155.2		dBFS/Hz
		$f_{\text{IN}} = 1760\text{ MHz}$, DSA = 3dB ⁽³⁾		-155.0		dBFS/Hz
		$f_{\text{IN}} = 2610\text{ MHz}$, DSA = 3dB ⁽³⁾		-154.4		dBFS/Hz
		$f_{\text{IN}} = 3610\text{ MHz}$, DSA = 3dB ⁽³⁾		-154.1		dBFS/Hz
		$f_{\text{IN}} = 4910\text{ MHz}$, DSA = 3dB ⁽³⁾		-155.1		dBFS/Hz
		$f_{\text{IN}} = 8150\text{ MHz}$, DSA = 3dB ⁽³⁾		-150		dBFS/Hz
		$f_{\text{IN}} = 9610\text{ MHz}$, DSA = 3dB ⁽³⁾		-151		dBFS/Hz
		$f_{\text{IN}} = 830\text{ MHz}$, 3<=Atten<=22		-156.0		dBFS/Hz
		$f_{\text{IN}} = 1760\text{ MHz}$, 3<=Atten<=25		-155.8		dBFS/Hz
		$f_{\text{IN}} = 2610\text{ MHz}$, 3<=Atten<=25		-155.7		dBFS/Hz
		$f_{\text{IN}} = 3610\text{ MHz}$, 3<=Atten<=25		-155.4		dBFS/Hz
		$f_{\text{IN}} = 4910\text{ MHz}$, 3<=Atten<=25		-155.8		dBFS/Hz
		$f_{\text{IN}} = 8150\text{ MHz}$, 3<=Atten<=25		-152.5		dBFS/Hz
		$f_{\text{IN}} = 9610\text{ MHz}$, 3<=Atten<=25		-152.5		dBFS/Hz
NF _{min}	Noise Figure min DSA Atten=0 - 3dB	$f_{\text{IN}} = 830\text{ MHz}$		19.1		dB
		$f_{\text{IN}} = 1760\text{ MHz}$		19.0		dB
		$f_{\text{IN}} = 2610\text{ MHz}$		20.9		dB
		$f_{\text{IN}} = 3610\text{ MHz}$		22.8		dB
		$f_{\text{IN}} = 4910\text{ MHz}$		22.4		dB
		$f_{\text{IN}} = 8150\text{ MHz}$		27.3		dB
		$f_{\text{IN}} = 9610\text{ MHz}$		30		dB
NF	Noise Figure DSA Atten=4dB	$f_{\text{IN}} = 830\text{ MHz}$ ⁽⁴⁾		20.0		dB
		$f_{\text{IN}} = 1760\text{ MHz}$ ⁽⁴⁾		20.6		dB
		$f_{\text{IN}} = 2610\text{ MHz}$ ⁽⁴⁾		21.9		dB
		$f_{\text{IN}} = 3610\text{ MHz}$ ⁽⁴⁾		23.5		dB
		$f_{\text{IN}} = 4910\text{ MHz}$ ⁽⁴⁾		22.3		dB
		$f_{\text{IN}} = 8150\text{ MHz}$ ⁽⁴⁾		27.9		dB
		$f_{\text{IN}} = 9610\text{ MHz}$ ⁽⁴⁾		30.7		dB
NF _{max}	Noise Figure DSA Atten=20dB	$f_{\text{IN}} = 830\text{ MHz}$		34.7		dB
		$f_{\text{IN}} = 1760\text{ MHz}$		35.2		dB
		$f_{\text{IN}} = 2610\text{ MHz}$		36.0		dB
		$f_{\text{IN}} = 3610\text{ MHz}$		37.3		dB
		$f_{\text{IN}} = 4910\text{ MHz}$		37.6		dB
		$f_{\text{IN}} = 8150\text{ MHz}$		42.8		dB
		$f_{\text{IN}} = 9610\text{ MHz}$		45		dB

Typical values at $T_A = +25^\circ\text{C}$, full temperature range is $T_{A,\text{MIN}} = -40^\circ\text{C}$ to $T_{J,\text{MAX}} = +110^\circ\text{C}$; RX Output Rate = 491.52MSPS below 6GHz input frequency and 1474.56MSPS above 6GHz input frequency, $f_{\text{ADC}} = 2949.12\text{MSPS}$; PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$ below 6GHz input frequency and External clock mode with $f_{\text{CLK}} = 11796.48\text{MHz}$ above 6GHz input frequency; nominal power supplies; DSA Setting = 4dB below 6GHz and 3dB above 6GHz; SerDes rate = 24.33Gbps; unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
IMD3	3 rd order intermodulation 2 tones at at $f_{\text{IN}} \pm 10\text{MHz}$ -7dBFS each tone	$f_{\text{IN}} = 840\text{ MHz}, 3 \leq \text{Atten} \leq 12$		-82		dBc
		$f_{\text{IN}} = 1770\text{ MHz}, 3 \leq \text{Atten} \leq 12$		-84		dBc
		$f_{\text{IN}} = 2610\text{ MHz}, 3 \leq \text{Atten} \leq 12$		-74		dBc
		$f_{\text{IN}} = 3610\text{ MHz}, 3 \leq \text{Atten} \leq 12$		-77		dBc
		$f_{\text{IN}} = 4920\text{ MHz}, 3 \leq \text{Atten} \leq 12$		-76		dBc
		$f_{\text{IN}} = 8150\text{ MHz}, 3 \leq \text{Atten} \leq 12$, 25MHz tone spacing		-55		dBc
		$f_{\text{IN}} = 9610\text{ MHz}, 3 \leq \text{Atten} \leq 12$, 25MHz tone spacing		-60		dBc
SFDR	Spurious Free Dynamic Range within output bandwidth, $A_{\text{IN}} = -3$ dBFS	$f_{\text{IN}} = 830\text{ MHz}$		88		dBFS
		$f_{\text{IN}} = 1760\text{ MHz}$		81		dBFS
		$f_{\text{IN}} = 2610\text{ MHz}$		88		dBFS
		$f_{\text{IN}} = 3610\text{ MHz}$		84		dBFS
		$f_{\text{IN}} = 4910\text{ MHz}$		79		dBFS
		$f_{\text{IN}} = 8150\text{ MHz}$		78		dBFS
		$f_{\text{IN}} = 9610\text{ MHz}$		71		dBFS
HD2	2nd Harmonic Distortion $A_{\text{IN}} = -3\text{ dBFS}^{(2)}$	$f_{\text{IN}} = 830\text{ MHz}$		-86		dBFS
		$f_{\text{IN}} = 1760\text{ MHz}$		-91		dBFS
		$f_{\text{IN}} = 2610\text{ MHz}$		-88		dBFS
		$f_{\text{IN}} = 3610\text{ MHz}$		-87		dBFS
		$f_{\text{IN}} = 4910\text{ MHz}$		-84		dBFS
		$f_{\text{IN}} = 8150\text{ MHz}$		-70		dBFS
		$f_{\text{IN}} = 9610\text{ MHz}$		-70		dBFS
HD3	3rd Harmonic Distortion $A_{\text{IN}} = -3\text{ dBFS}$	$f_{\text{IN}} = 830\text{ MHz}$		-80		dBFS
		$f_{\text{IN}} = 1760\text{ MHz}$		-85		dBFS
		$f_{\text{IN}} = 2501\text{ MHz}$		-80	-58	dBFS
		$f_{\text{IN}} = 2610\text{ MHz}$		-85		dBFS
		$f_{\text{IN}} = 3610\text{ MHz}$		-78		dBFS
		$f_{\text{IN}} = 4910\text{ MHz}$		-75		dBFS
		$f_{\text{IN}} = 8150\text{ MHz}$		-70		dBFS
		$f_{\text{IN}} = 9610\text{ MHz}$		-70		dBFS
HDn, n>3	SFDR excl. HD2 and HD3 $A_{\text{IN}} = -3\text{ dBFS}$	$f_{\text{IN}} = 830\text{ MHz}$		-88		dBFS
		$f_{\text{IN}} = 1760\text{ MHz}$		-81		dBFS
		$f_{\text{IN}} = 2610\text{ MHz}$		-88		dBFS
		$f_{\text{IN}} = 3610\text{ MHz}$		-84		dBFS
		$f_{\text{IN}} = 4910\text{ MHz}$		-82		dBFS
		$f_{\text{IN}} = 8150\text{ MHz}$		-78		dBFS
		$f_{\text{IN}} = 9610\text{ MHz}$		-78		dBFS

Typical values at $T_A = +25^\circ\text{C}$, full temperature range is $T_{A,\text{MIN}} = -40^\circ\text{C}$ to $T_{J,\text{MAX}} = +110^\circ\text{C}$; RX Output Rate = 491.52MSPS below 6GHz input frequency and 1474.56MSPS above 6GHz input frequency, $f_{\text{ADC}} = 2949.12\text{MSPS}$; PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$ below 6GHz input frequency and External clock mode with $f_{\text{CLK}} = 11796.48\text{MHz}$ above 6GHz input frequency; nominal power supplies; DSA Setting = 4dB below 6GHz and 3dB above 6GHz; SerDes rate = 24.33Gbps; unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
SFDR	Spurious Free Dynamic Range $A_{\text{IN}} = -13\text{ dBFS}$ $0 \leq \text{Atten} \leq 16$	$f_{\text{IN}} = 830\text{ MHz}$		89		dBFS
		$f_{\text{IN}} = 1760\text{ MHz}$		89		dBFS
		$f_{\text{IN}} = 2610\text{ MHz}$		95		dBFS
		$f_{\text{IN}} = 3610\text{ MHz}$		90		dBFS
		$f_{\text{IN}} = 4910\text{ MHz}$		90		dBFS
		$f_{\text{IN}} = 8150\text{ MHz}$		83		dBFS
		$f_{\text{IN}} = 9610\text{ MHz}$		80		dBFS
HD2	2nd Harmonic Distortion $A_{\text{IN}} = -13\text{ dBFS}$ $0 \leq \text{Atten} \leq 16$	$f_{\text{IN}} = 830\text{ MHz}$, with board trim		-79		dBFS
		$f_{\text{IN}} = 1760\text{ MHz}$, with board trim		-102		dBFS
		$f_{\text{IN}} = 2610\text{ MHz}$, with board trim		-100		dBFS
		$f_{\text{IN}} = 3610\text{ MHz}$, with board trim		-101		dBFS
		$f_{\text{IN}} = 4910\text{ MHz}$, with board trim		-99		dBFS
		$f_{\text{IN}} = 8150\text{ MHz}$, with board trim		-107		dBFS
		$f_{\text{IN}} = 9610\text{ MHz}$, with board trim		-107		dBFS
HD3	3rd Harmonic Distortion $A_{\text{IN}} = -13\text{ dBFS}$ $0 \leq \text{Atten} \leq 16$	$f_{\text{IN}} = 830\text{ MHz}$		-95		dBFS
		$f_{\text{IN}} = 1760\text{ MHz}$		-95		dBFS
		$f_{\text{IN}} = 2610\text{ MHz}$		-98		dBFS
		$f_{\text{IN}} = 3610\text{ MHz}$		-97		dBFS
		$f_{\text{IN}} = 4910\text{ MHz}$		-94		dBFS
		$f_{\text{IN}} = 8150\text{ MHz}$		-100		dBFS
		$f_{\text{IN}} = 9610\text{ MHz}$		-102		dBFS
HDn, n>3	SFDR excl. HD2 and HD3 $A_{\text{IN}} = -13\text{ dBFS}$ $0 \leq \text{Atten} \leq 16$	$f_{\text{IN}} = 830\text{ MHz}$		-89		dBFS
		$f_{\text{IN}} = 1760\text{ MHz}$		-89		dBFS
		$f_{\text{IN}} = 2610\text{ MHz}$		-95		dBFS
		$f_{\text{IN}} = 3610\text{ MHz}$		-90		dBFS
		$f_{\text{IN}} = 4910\text{ MHz}$		-90		dBFS
		$f_{\text{IN}} = 8150\text{ MHz}$		-83		dBFS
		$f_{\text{IN}} = 9610\text{ MHz}$		-80		dBFS
RX-RX Isolation	Near Channel: 1RXIN to 2RXIN 3RXIN to 4RXIN	$f_{\text{IN}} = 830\text{ MHz}$		-77		dBc
		$f_{\text{IN}} = 1760\text{ MHz}$		-71		dBc
		$f_{\text{IN}} = 2610\text{ MHz}$		-74		dBc
		$f_{\text{IN}} = 3610\text{ MHz}$		-77		dBc
		$f_{\text{IN}} = 4910\text{ MHz}$		-65		dBc
		$f_{\text{IN}} = 8150\text{ MHz}$		-64		dBc
		$f_{\text{IN}} = 9610\text{ MHz}$		-60		dBc
TX-FB Isolation	Near Channel: 2TXOUT to 1FBIN 4TXOUT to 2FBIN	$f_{\text{IN}} = 830\text{ MHz}$		-84		dBc
		$f_{\text{IN}} = 1760\text{ MHz}$		-88		dBc
		$f_{\text{IN}} = 2610\text{ MHz}$		-85		dBc
		$f_{\text{IN}} = 3610\text{ MHz}$		-75		dBc
		$f_{\text{IN}} = 4910\text{ MHz}$		-82		dBc
		$f_{\text{IN}} = 8150\text{ MHz}$		-71		dBc
		$f_{\text{IN}} = 9610\text{ MHz}$		-69		dBc

Typical values at $T_A = +25^\circ\text{C}$, full temperature range is $T_{A,\text{MIN}} = -40^\circ\text{C}$ to $T_{J,\text{MAX}} = +110^\circ\text{C}$; RX Output Rate = 491.52MSPS below 6GHz input frequency and 1474.56MSPS above 6GHz input frequency, $f_{\text{ADC}} = 2949.12\text{MSPS}$; PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$ below 6GHz input frequency and External clock mode with $f_{\text{CLK}} = 11796.48\text{MHz}$ above 6GHz input frequency; nominal power supplies; DSA Setting = 4dB below 6GHz and 3dB above 6GHz; SerDes rate = 24.33Gbps; unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
TX-RX Isolation	Far Channel: 2TXOUT to 1RXIN 4TXOUT to 3RXIN	$f_{\text{IN}} = 830\text{ MHz}$		-86		dBc
		$f_{\text{IN}} = 1760\text{ MHz}$		-87		dBc
		$f_{\text{IN}} = 2610\text{ MHz}$		-91		dBc
		$f_{\text{IN}} = 3610\text{ MHz}$		-83		dBc
		$f_{\text{IN}} = 4910\text{ MHz}$		-82		dBc
		$f_{\text{IN}} = 8150\text{ MHz}$		-68		dBc
		$f_{\text{IN}} = 9610\text{ MHz}$		-68		dBc

- (1) The input fullscale at minimum attenuation can be reduce by adding a digital gain range to the DSA, extending the useful range of the DSA. The noise figure remains constant over the digital gain range.
- (2) NLE correction of HD2
- (3) From DSA = 3dB down to 0dB, NSD increases 1dB per DSA dB
- (4) NF increase 1dB per DSA 1dB above DSA = 3dB

4.7 PLL/VCO/Clock Electrical Characteristics

Typical values at $T_A = +25^{\circ}\text{C}$, full temperature range is $T_{A,\text{MIN}} = -40^{\circ}\text{C}$ to $T_{J,\text{MAX}} = +110^{\circ}\text{C}$; Reference clock input frequency 491.52MHz (unless otherwise noted), $f_{\text{DAC}} = f_{\text{VCO}}$, $f_{\text{OUT}} = f_{\text{DAC}}/4$, normalized to f_{VCO} .

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
f_{VCO1}	VCO1 min frequency				7.2	GHz
	VCO1 max frequency		7.68			GHz
f_{VCO2}	VCO2 min frequency				8.8	GHz
	VCO2 max frequency		9.1			GHz
f_{VCO3}	VCO3 min frequency				9.7	GHz
	VCO3 max frequency		10.24			GHz
f_{VCO4}	VCO4 min frequency				11.6	GHz
	VCO4 max frequency		12.08			GHz
DIV_{DAC}	DAC sample rate divider		1, 2 or 3			
$\text{DIV}_{\text{FBAD C}}$	ADC sample rate divider from DAC sample rate		1, 2, 3, 4, 6 or 8			
$\text{DIV}_{\text{RXAD C}}$	ADC sample rate divider		1, 2, 3, 4, 6 or 8			
PN_{VCO}	Closed Loop Phase Noise $F_{\text{PLL}} = 11.79848 \text{ GHz}$ $F_{\text{REF}} = 491.52 \text{ MHz}$	600kHz		-113		dBc/Hz
		800kHz		-116		dBc/Hz
		1MHz		-119		dBc/Hz
		1.8MHz		-125		dBc/Hz
		5MHz		-133		dBc/Hz
		50MHz		-141		dBc/Hz
	Closed Loop Phase Noise $F_{\text{PLL}} = 8.84736 \text{ GHz}$ $F_{\text{REF}} = 491.52 \text{ MHz}$	600kHz		-114		dBc/Hz
		800kHz		-118		dBc/Hz
		1MHz		-120		dBc/Hz
		1.8MHz		-127		dBc/Hz
		5MHz		-135		dBc/Hz
		50MHz		-142		dBc/Hz
	Closed Loop Phase Noise $F_{\text{PLL}} = 9.8403 \text{ GHz}$ $F_{\text{REF}} = 491.52 \text{ MHz}$	600kHz		-113		dBc/Hz
		800kHz		-116		dBc/Hz
		1MHz		-119		dBc/Hz
		1.8MHz		-125		dBc/Hz
		5MHz		-134		dBc/Hz
		50MHz		-140		dBc/Hz
	Closed Loop Phase Noise $F_{\text{PLL}} = 7.86432 \text{ GHz}$ $F_{\text{REF}} = 491.52 \text{ MHz}$	600kHz		-116		dBc/Hz
		800kHz		-119		dBc/Hz
		1MHz		-122		dBc/Hz
		1.8MHz		-127		dBc/Hz
		5MHz		-136		dBc/Hz
		50MHz		-143		dBc/Hz
F_{rms}	Clock PLL integrated phase error ⁽¹⁾	$f_{\text{PLL}} = 11.79848 \text{ GHz}$, [1KHz, 100MHz]		-43.4		dBc/Hz
		$f_{\text{PLL}} = 8.8536 \text{ GHz}$, [1KHz, 100MHz]		-47.6		dBc/Hz
		$f_{\text{PLL}} = 9.8304 \text{ GHz}$, [1KHz, 100MHz]		-46.2		dBc/Hz
f_{PFD}	PFD frequency		100		500	MHz
F_{REF}	Input clock minimum frequency			0.1		GHz
F_{REF}	Input Clock maximum frequency			12		GHz

Typical values at $T_A = +25^{\circ}\text{C}$, full temperature range is $T_{A,\text{MIN}} = -40^{\circ}\text{C}$ to $T_{J,\text{MAX}} = +110^{\circ}\text{C}$; Reference clock input frequency 491.52MHz (unless otherwise noted), $f_{\text{DAC}} = f_{\text{VCO}}$, $f_{\text{OUT}} = f_{\text{DAC}}/4$, normalized to f_{VCO} .

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
V_{CLKMIN}	Input clock minimum level			0.6		Vppdiff
V_{CLKMAX}	Input Clock maximum level			1.8		Vppdiff
$\text{PN}_{\text{pll_flat}}$	Normalized PLL flat Noise	$f_{\text{VCO}} = 11796.48\text{MHz}$		-226.5		dBc/Hz
Coupling				AC Coupling Only		
	REFCLK input impedance ⁽²⁾	Parallel resistance		100		Ω
		Parallel capacitance		0.5		pF

(1) Single Sideband, not including the reference clock contribution

(2) Refer to S11 data available from TI for impedance vs frequency

4.8 Digital Electrical Characteristics

Typical values at TA = +25°C, full temperature range is T_{A,MIN} = -40°C to T_{J,MAX} = +110°C (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
CML SerDes Inputs [8:1]SRX+/-						
V _{SRDIFF}	SerDes Receiver Minimum Input Amplitude			100		mVpp
V _{SRDIFF}	SerDes Receiver Maximum Input Amplitude			1200		mVpp
V _{SRCOM}	SerDes Minimum Input Common Mode			0.5		V
V _{SRCOM}	SerDes Maximum Input Common Mode			0.6		V
Z _{SRdiff}	SerDes Internal Differential Termination ⁽¹⁾			115		Ω
F _{SerDes}	SerDes Bit Rate	Minimum full rate mode		19		Gbps
F _{SerDes}	SerDes Bit Rate	Maximum full rate mode		24.75		Gbps
F _{SerDes}	SerDes Bit Rate	Minimum half rate mode		9.5		Gbps
F _{SerDes}	SerDes Bit Rate	Maximum half rate mode		16.25		Gbps
F _{SerDes}	SerDes Bit Rate	Minimum quarter rate mode		4.75		Gbps
F _{SerDes}	SerDes Bit Rate	Maximum quarter rate mode		8.125		Gbps
	Insertion Loss Tolerance ⁽²⁾	Serdes supply = 1.8V		25		dB
TJ	Total Jitter Tolerance			0.42		UI
CML SerDes Outputs [8:1]STX+/-						
V _{STDIFF}	SerDes Transmitter Minimum Output Amplitude	differential		500		mVpp
V _{STDIFF}	SerDes Transmitter Maximum Output Amplitude	differential		1000		mVpp
V _{STCOM}	SerDes Output Minimum Common Mode			0.5		V
V _{STCOM}	SerDes Output Common Mode			0.6		V
Z _{STdiff}	SerDes Output Impedance			115		Ω
TRF	Output rise and fall time	20-80%		8		ps
TEQS	Equalization range			7		dB
TTJ	Output total jitter			0.21		UI
CMOS I/O: GPIO{B/C/D/E}x, SPICLK, SPISDIO, SPISDO, SPISEN, RESETZ, BISTB0, BISTB1						
V _{IH}	High-Level Input Voltage		0.6×VDD1 P8GPIO			V
V _{IL}	Low-Level Input Voltage			0.4×VDD1 P8GPIO		V
V _{OH}	High-Level Output Voltage		VDD1P8G PIO–0.2			V
V _{OL}	Low-Level Output Voltage			0.2		V
Differential Inputs: SYSREF+/- Mode A						
F _{SYSREFMAX}	SYSREF Input Frequency Maximum			40		MHz
V _{SWINGSRMAX}	SYSREF Input Swing Maximum			1.8		Vppdiff ⁽³⁾
V _{SWINGSRMIN}	SYSREF Input Swing Minimum	f _{REF} < 500MHz		0.3		Vppdiff ⁽³⁾
V _{SWINGSRMIN}	SYSREF Input Swing Minimum	f _{REF} > 500MHz		0.6		Vppdiff ⁽³⁾
V _{COMSRMAX}	SYSREF Input Common Mode Voltage Maximum			0.8		V
V _{COMSRMIN}	SYSREF Input Common Mode Voltage Minimum			0.6		V
Z _T	Input termination	differential		108 ⁽¹⁾		Ω

Typical values at $T_A = +25^\circ\text{C}$, full temperature range is $T_{A,\text{MIN}} = -40^\circ\text{C}$ to $T_{J,\text{MAX}} = +110^\circ\text{C}$ (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
C_L	Input capacitance	Each pin to GND		0.5		pF
LVDS Inputs: 0SYNCIN+/- and 1SYNCIN+/-						
V_{ICOM}	Input Common Voltage			1.2		V
V_{ID}	Differential Input Voltage swing			450		mVppdiff ⁽³⁾
Z_T	Input termination	differential		100		Ω
LVDS Outputs: 0SYNCOUT+/- and 1SYNCOUT+/-						
V_{OCOM}	Output Common Voltage			1.2		V
V_{OD}	Differential Output Voltage swing			355		mVppdiff ⁽³⁾

- (1) Default setting. SYSREF termination is programmable between nominally 100 Ω , 150 Ω and 300 Ω
(2) Loss tolerance is bump to bump from STX to SRX
(3) Vppdiff is the difference between the maximum differential voltage (positive value) and minimum differential voltage (negative value).

4.9 Power Supply Electrical Characteristics

Typical values at $T_A = +25^\circ\text{C}$, full temperature range is $T_{A,\text{MIN}} = -40^\circ\text{C}$ to $T_{J,\text{MAX}} = +110^\circ\text{C}$; TX Input Rate = 491.52MSPS, $f_{\text{DAC}} = 8847.36\text{MSPS}$ interleave mode; $f_{\text{ADC}} = 2949.12\text{MSPS}$; nominal power supplies; 1 tone at -1 dBFS; DSA Attenuation = 0dB; SerDes rate = 24.33Gbps; unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
I_{VDD1P8}	Group 3A: VDD1P8FB + VDD1P8RX + VDD1P8TX	Mode 1: 4T2F - FDD FB 100% on, no RX TX/FB Rate: 491.52 MspS Single Band: 12x Int, FB 6x Dec $f_{\text{DAC}} = 5898.24$ SPS $f_{\text{ADC}} = 2949.12\text{MSPS}$ $f_{\text{TX}} = 1.85$ GHz 64/66 coding, 16.22Gbps TX: 4-8-4-1, FB: 2-4-4-1		948.2		mA
	Group 3B: VDD1P8FBCLK + VDD1P8RXCLK + VDD1P8TXDAC+ VDD1P8GPIO + VDDA1P8			533.7		mA
	Group 3C: VDD1P8PLL + VDD1P8PLLVC0			77.3		mA
I_{VDD1P2}	Group 2A: VDD1P2FB + VDD1P2RX			299.4		mA
	Group 2B: VDD1P2TXCLK + VDD1P2TXENC			804.5		mA
	Group 2C: VDD1P2FBCML + VDD1P2RXCML + VDD1P2PLLCLKREF			49.1		mA
I_{VDD0P9}	Group 1A: DVDD0P9 + VDDT0P9			2041.3		mA
P_{diss}	Power Dissipation			6027.1		mW
I_{VDD1P8}	Group 3A: VDD1P8FB + VDD1P8RX + VDD1P8TX	Mode 2: 4T4R - TDD 1F shared with RX TX 75%, RX 25%, FB 75% Dual Band: 12x Int, FB 6x Dec, RX 24x Dec TX/FB Rate 491.52 MspS RX Rate 122.88 MspS $f_{\text{DAC}} = 8847.36\text{MSPS}$ $f_{\text{ADC}} = 2949.12\text{MSPS}$ $f_{\text{OUT}} = f_{\text{IN}} = 1.9, 2.6$ GHz 64/66 coding, 16.22Gbps TX: 8-16-4-1, FB: 2-4-4-1, RX: 2-16-16-1		820.4		mA
	Group 3B: VDD1P8FBCLK + VDD1P8RXCLK + VDD1P8TXDAC+ VDD1P8GPIO + VDDA1P8			735.2		mA
	Group 3C: VDD1P8PLL + VDD1P8PLLVC0			74.4		mA
I_{VDD1P2}	Group 2A: VDD1P2FB + VDD1P2RX			289.0		mA
	Group 2B: VDD1P2TXCLK + VDD1P2TXENC			822.0		mA
	Group 2C: VDD1P2FBCML + VDD1P2RXCML + VDD1P2PLLCLKREF			45.6		mA
I_{VDD0P9}	Group 1A: DVDD0P9 + VDDT0P9			2263.8		mA
P_{diss}	Power Dissipation			6359.2		mW

Typical values at $T_A = +25^{\circ}\text{C}$, full temperature range is $T_{A,\text{MIN}} = -40^{\circ}\text{C}$ to $T_{A,\text{MAX}} = +110^{\circ}\text{C}$; TX Input Rate = 491.52MSPS, $f_{\text{DAC}} = 8847.36\text{MSPS}$ interleave mode; $f_{\text{ADC}} = 2949.12\text{MSPS}$; nominal power supplies; 1 tone at -1 dBFS; DSA Attenuation = 0dB; SerDes rate = 24.33Gbps; unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
I_{VDD1P8}	Group 3A: VDD1P8FB + VDD1P8RX + VDD1P8TX	Mode 3: 4T4R2F - FDD FB 100% on TX Dual Band: 12x Int, FB 6x Dec RX Dual Band: RX 24x TX/FB Rate 491.52 Msps RX Rate 122.88 Msps $f_{\text{DAC}} = 11796.48\text{ MSPS}$ $f_{\text{ADC}} = 2949.12\text{ MSPS}$ $f_{\text{TX}} = 1.85 + 2.15\text{ GHz}$ $f_{\text{RX}} = 1.75 + 1.88\text{ GHz}$ 64/66 coding, 16.22Gbps TX: 8-16-4-1, FB: 2-4-4-1, RX: 2-16-16-1	1668.6			mA
	Group 3B: VDD1P8FBCLK + VDD1P8RXCLK + VDD1P8TXDAC + VDD1P8GPIO + VDDA1P8		965.1			mA
	Group 3C: VDD1P8PLL + VDD1P8PLLVC0		77.6			mA
I_{VDD1P2}	Group 2A: VDD1P2FB + VDD1P2RX		893.4			mA
	Group 2B: VDD1P2TXCLK + VDD1P2TXENC		879.5			mA
	Group 2C: VDD1P2FBCML + VDD1P2RXCML + VDD1P2PLLCLKREF		50.7			mA
I_{VDD0P9}	Group 1A: DVDD0P9 + VDDT0P9		3826.9			mA
P_{diss}	Power Dissipation		10513.0			mW
I_{VDD1P8}	Group 3A: VDD1P8FB + VDD1P8RX + VDD1P8TX	Mode 4: 4T4R2F - FDD FB 100% on 7.5 GSPS DAC, 2.5 GSPS ADC Single Band: 15x Int, FB 5x Dec Dual Band: RX 20x TX/FB Rate 491.52 Msps RX Rate 122.88 Msps $f_{\text{DAC}} = 7372.8\text{ MSPS}$ $f_{\text{ADC}} = 2457.6\text{ MSPS}$ $f_{\text{TX}} = 1.85 + 2.15\text{ GHz}$ $f_{\text{RX}} = 1.75 + 1.88\text{ GHz}$ 64/66 coding, 16.22Gbps TX: 4-8-4-1, FB: 2-4-4-1, RX: 2-16-16-1	1611.5			mA
	Group 3B: VDD1P8FBCLK + VDD1P8RXCLK + VDD1P8TXDAC + VDD1P8GPIO + VDDA1P8		694.5			mA
	Group 3C: VDD1P8PLL + VDD1P8PLLVC0		72.8			mA
I_{VDD1P2}	Group 2A: VDD1P2FB + VDD1P2RX		768.5			mA
	Group 2B: VDD1P2TXCLK + VDD1P2TXENC		940.5			mA
	Group 2C: VDD1P2FBCML + VDD1P2RXCML + VDD1P2PLLCLKREF		45.5			mA
I_{VDD0P9}	Group 1A: DVDD0P9 + VDDT0P9		3000.5			mA
P_{diss}	Power Dissipation		9087.4			mW
I_{VDD1P8}	Group 3A: VDD1P8FB + VDD1P8RX + VDD1P8TX	Mode 5: 4T4R - TDD 1F shared with RX TX 75%, RX 25%, FB 75% Single Band: 12x Int, FB 3x Dec, RX 6x Dec TX/FB Rate = 983.04 Msps RX Rate 491.52 Msps $f_{\text{DAC}} = 11796.48\text{ MSPS}$ $f_{\text{ADC}} = 2949.12\text{ MSPS}$ $f_{\text{TX}} = 3.5\text{ GHz}$ $f_{\text{RX}} = 3.5\text{ GHz}$ 64/66 coding, 16.22Gbps TX: 8-8-2-1, FB: 4-4-4-2, RX: 4-8-4-1	821.8			mA
	Group 3B: VDD1P8FBCLK + VDD1P8RXCLK + VDD1P8TXDAC + VDD1P8GPIO + VDDA1P8		808.5			mA
	Group 3C: VDD1P8PLL + VDD1P8PLLVC0		77.4			mA
I_{VDD1P2}	Group 2A: VDD1P2FB + VDD1P2RX		289.5			mA
	Group 2B: VDD1P2TXCLK + VDD1P2TXENC		682.0			mA
	Group 2C: VDD1P2FBCML + VDD1P2RXCML + VDD1P2PLLCLKREF		49.0			mA
I_{VDD0P9}	Group 1A: DVDD0P9 + VDDT0P9		2123.3			mA
P_{diss}	Power Dissipation		6209.3			mW

Typical values at $T_A = +25^{\circ}\text{C}$, full temperature range is $T_{A,\text{MIN}} = -40^{\circ}\text{C}$ to $T_{A,\text{MAX}} = +110^{\circ}\text{C}$; TX Input Rate = 491.52MSPS, $f_{\text{DAC}} = 8847.36\text{MSPS}$ interleave mode; $f_{\text{ADC}} = 2949.12\text{MSPS}$; nominal power supplies; 1 tone at -1 dBFS; DSA Attenuation = 0dB; SerDes rate = 24.33Gbps; unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
I_{VDD1P8}	Group 3A: VDD1P8FB + VDD1P8RX + VDD1P8TX	Mode 7a: TDD 4T1FB (RX iin Standby) TX 9G and FB 3G -16bit: 368.64M; DSA = 6dB, non-interleave mode RX 3G : 368.64M. 16 bit, Standby Serdes: 25gbps) -> 2 lanes for Rx/FB (lane shared) and 2lanes for Tx	658.1			mA
	Group 3B: VDD1P8FBCLK + VDD1P8RXCLK + VDD1P8TXDAC+ VDD1P8GPIO + VDDA1P8		431.1			mA
	Group 3C: VDD1P8PLL + VDD1P8PLLVC0		75.3			mA
I_{VDD1P2}	Group 2A: VDD1P2FB + VDD1P2RX		189.2			mA
	Group 2B: VDD1P2TXCLK + VDD1P2TXENC		1041.1			mA
	Group 2C: VDD1P2FBCML + VDD1P2RXCML + VDD1P2PLLCLKREF		39.0			mA
I_{VDD0P9}	Group 1A: DVDD0P9 + VDDT0P9		2208.7			mA
P_{diss}	Power Dissipation		5607.0			mW
I_{VDD1P8}	Group 3A: VDD1P8FB + VDD1P8RX + VDD1P8TX	Mode 7b: TDD 4R (TX in Standby) TX 9G and FB 3G -16bit: 368.64M; DSA = 6dB, , non-interleave mode, Standby RX 3G : 368.64M. 16 bit Serdes: 25gbps) -> 2 lanes for Rx/FB (lane shared) and 2lanes for Tx	789.5			mA
	Group 3B: VDD1P8FBCLK + VDD1P8RXCLK + VDD1P8TXDAC+ VDD1P8GPIO + VDDA1P8		471.3			mA
	Group 3C: VDD1P8PLL + VDD1P8PLLVC0		73.4			mA
I_{VDD1P2}	Group 2A: VDD1P2FB + VDD1P2RX		599.3			mA
	Group 2B: VDD1P2TXCLK + VDD1P2TXENC		169.6			mA
	Group 2C: VDD1P2FBCML + VDD1P2RXCML + VDD1P2PLLCLKREF		39.1			mA
I_{VDD0P9}	Group 1A: DVDD0P9 + VDDT0P9		1645.3			mA
P_{diss}	Power Dissipation		4851.9			mW
I_{VDD1P8}	Group 3A: VDD1P8FB + VDD1P8RX + VDD1P8TX	Mode 7c: TDD 4T4R1FB TX 9G and FB 3G -16bit: 368.64M; DSA = 6dB, , non-interleave mode, 75% on RX 3G : 368.64M. 16 bit 25% on Serdes: 25gbps) -> 2 lanes for Rx/FB (lane shared) and 2lanes for Tx	691.0			mA
I_{VDD1P8}	Group 3B: VDD1P8FBCLK + VDD1P8RXCLK + VDD1P8TXDAC+ VDD1P8GPIO + VDDA1P8		441.2			mA
I_{VDD1P8}	Group 3C: VDD1P8PLL + VDD1P8PLLVC0		74.8			mA
I_{VDD1P2}	Group 2A: VDD1P2FB + VDD1P2RX		291.7			mA
I_{VDD1P2}	Group 2B: VDD1P2TXCLK + VDD1P2TXENC		823.2			mA
I_{VDD1P2}	Group 2C: VDD1P2FBCML + VDD1P2RXCML + VDD1P2PLLCLKREF		39.0			mA
I_{VDD0P9}	Group 1A: DVDD0P9 + VDDT0P9		2067.9			mA
P_{diss}	Power Dissipation		5418.2			mW

Typical values at $T_A = +25^\circ\text{C}$, full temperature range is $T_{A,\text{MIN}} = -40^\circ\text{C}$ to $T_{A,\text{MAX}} = +110^\circ\text{C}$; TX Input Rate = 491.52MSPS, $f_{\text{DAC}} = 8847.36\text{MSPS}$ interleave mode; $f_{\text{ADC}} = 2949.12\text{MSPS}$; nominal power supplies; 1 tone at -1 dBFS; DSA Attenuation = 0dB; SerDes rate = 24.33Gbps; unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
I_{VDD1P8}	Group 3A: VDD1P8FB + VDD1P8RX + VDD1P8TX	Mode 7d: FDD 4T4R1FB TX 9G and FB 3G -16bit: 368.64M; DSA = 6dB, , non-interleave mode, RX 3G : 368.64M. 16 bit Serdes: 25gbps) -> 2 lanes for Rx/FB (lane shared) and 2lanes for Tx		1283.8		mA
I_{VDD1P8}	Group 3B: VDD1P8FBCLK + VDD1P8RXCLK + VDD1P8TXDAC+ VDD1P8GPIO + VDDA1P8			752.0		mA
I_{VDD1P8}	Group 3C: VDD1P8PLL + VDD1P8PLLCO			74.6		mA
I_{VDD1P2}	Group 2A: VDD1P2FB + VDD1P2RX			750.5		mA
I_{VDD1P2}	Group 2B: VDD1P2TXCLK + VDD1P2TXENC			1077.6		mA
I_{VDD1P2}	Group 2C: VDD1P2FBCML + VDD1P2RXCML + VDD1P2PLLCLKREF			47.7		mA
I_{VDD0P9}	Group 1A: DVDD0P9 + VDDT0P9			2695.5		mA
P_{diss}	Power Dissipation			8475.5		mW
I_{VDD1P8}	Group 3A: VDD1P8FB + VDD1P8RX + VDD1P8TX	Mode 8: same configuration as mode 7, Sleep Mode. SLEEP pin is pull high.		20.3		mA
	Group 3B: VDD1P8FBCLK + VDD1P8RXCLK + VDD1P8TXDAC+ VDD1P8GPIO + VDDA1P8			292.8		mA
	Group 3C: VDD1P8PLL + VDD1P8PLLCO			12.6		mA
I_{VDD1P2}	Group 2A: VDD1P2FB + VDD1P2RX			4.6		mA
	Group 2B: VDD1P2TXCLK + VDD1P2TXENC			54.3		mA
	Group 2C: VDD1P2FBCML + VDD1P2RXCML + VDD1P2PLLCLKREF			15.3		mA
I_{VDD0P9}	Group 1A: DVDD0P9 + VDDT0P9			313.1		mA
P_{diss}	Power Dissipation			956.8		mW
I_{VDD1P8}	Group 3A: VDD1P8FB + VDD1P8RX + VDD1P8TX	Mode 9: 4T4R2F - FDD FB 100% on TX Single Band: 24x Int, FB 12x Dec RX Single Band: RX 24x TX/FB Rate 245.76 Msps RX Rate 122.88 Msps $f_{\text{DAC}} = 5898.24\text{ MSPS}$ $f_{\text{ADC}} = 2949.12\text{ MSPS}$ $f_{\text{TX}} = 0.85\text{ GHz}$ $f_{\text{RX}} = 0.8\text{ GHz}$ 8/10 coding, 9.8304Gbps TX: 4-8-4-1, FB: 2-4-4-1, RX: 2-8-8-1		1593.2		mA
	Group 3B: VDD1P8FBCLK + VDD1P8RXCLK + VDD1P8TXDAC+ VDD1P8GPIO + VDDA1P8			840.6		mA
	Group 3C: VDD1P8PLL + VDD1P8PLLCO			77.3		mA
I_{VDD1P2}	Group 2A: VDD1P2FB + VDD1P2RX			905.0		mA
	Group 2B: VDD1P2TXCLK + VDD1P2TXENC			817.7		mA
	Group 2C: VDD1P2FBCML + VDD1P2RXCML + VDD1P2PLLCLKREF			52.1		mA
I_{VDD0P9}	Group 1A: DVDD0P9 + VDDT0P9			2405.2		mA
P_{diss}	Power Dissipation			8814.3		mW

Typical values at $T_A = +25^\circ\text{C}$, full temperature range is $T_{A,\text{MIN}} = -40^\circ\text{C}$ to $T_{A,\text{MAX}} = +110^\circ\text{C}$; TX Input Rate = 491.52MSPS, $f_{\text{DAC}} = 8847.36\text{MSPS}$ interleave mode; $f_{\text{ADC}} = 2949.12\text{MSPS}$; nominal power supplies; 1 tone at -1 dBFS; DSA Attenuation = 0dB; SerDes rate = 24.33Gbps; unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
I_{VDD1P8}	Group 3A: VDD1P8FB + VDD1P8RX + VDD1P8TX	Mode 10: 4T4R2F - FDD FB 100% on TX Single Band: 18x Int, FB 6x Dec RX Single Band: RX 12x TX/FB Rate 491.52 Msps RX Rate 245.76 Msps $f_{\text{DAC}} = 8847.36\text{MSPS}$ $f_{\text{ADC}} = 2949.12\text{MSPS}$ $f_{\text{TX}} = 1.85\text{GHz}$ $f_{\text{RX}} = 1.75\text{GHz}$ 8/10 coding, 9.8304Gbps TX: 8-8-2-1, FB: 4-4-2-1, RX: 4-8-4-1	1626.2			mA
	Group 3B: VDD1P8FBCLK + VDD1P8RXCLK + VDD1P8TXDAC + VDD1P8GPIO + VDDA1P8		976.4			mA
	Group 3C: VDD1P8PLL + VDD1P8PLLVC0		74.6			mA
I_{VDD1P2}	Group 2A: VDD1P2FB + VDD1P2RX		902.7			mA
	Group 2B: VDD1P2TXCLK + VDD1P2TXENC		1111.9			mA
	Group 2C: VDD1P2FBCML + VDD1P2RXCML + VDD1P2PLLCLKREF		48.0			mA
I_{VDD0P9}	Group 1A: DVDD0P9 + VDDT0P9		3578.9			mA
P_{diss}	Power Dissipation		10515.0			mW
I_{VDD1P8}	Group 3A: VDD1P8FB + VDD1P8RX + VDD1P8TX	Mode 11a: TDD 4T1FB (RX in Standby) Single Band: 8x Int, FB 2x Dec, RX uses FB TX/FB/RX Rate = 1474.56 Msps $f_{\text{DAC}} = 11796.48\text{MSPS}$ $f_{\text{ADC}} = 2949.12\text{MSPS}$ $f_{\text{TX}} = f_{\text{RX}} = 8\text{GHz}$ 64/66 coding, 24.33 Gbps TX: 8-8-2-1, FB/RX: 4-4-4-2	800			mA
	Group 3B: VDD1P8FBCLK + VDD1P8RXCLK + VDD1P8TXDAC + VDD1P8GPIO + VDDA1P8		840			mA
	Group 3C: VDD1P8PLL + VDD1P8PLLVC0		73			mA
I_{VDD1P2}	Group 2A: VDD1P2FB + VDD1P2RX		190			mA
	Group 2B: VDD1P2TXCLK + VDD1P2TXENC		1440			mA
	Group 2C: VDD1P2FBCML + VDD1P2RXCML + VDD1P2PLLCLKREF		75			mA
I_{VDD0P9}	Group 1A: DVDD0P9 + VDDT0P9		3070			mA
P_{diss}	Power Dissipation		8010			mW
I_{VDD1P8}	Group 3A: VDD1P8FB + VDD1P8RX + VDD1P8TX	Mode 11b: TDD 4R (TX in Standby) Single Band: 8x Int, FB 2x Dec, RX uses FB TX/FB/RX Rate = 1474.56 Msps $f_{\text{DAC}} = 11796.48\text{MSPS}$ $f_{\text{ADC}} = 2949.12\text{MSPS}$ $f_{\text{TX}} = f_{\text{RX}} = 8\text{GHz}$ 64/66 coding, 24.33 Gbps TX: 8-8-2-1, FB/RX: 4-4-4-2	750			mA
	Group 3B: VDD1P8FBCLK + VDD1P8RXCLK + VDD1P8TXDAC + VDD1P8GPIO + VDDA1P8		890			mA
	Group 3C: VDD1P8PLL + VDD1P8PLLVC0		72			mA
I_{VDD1P2}	Group 2A: VDD1P2FB + VDD1P2RX		610			mA
	Group 2B: VDD1P2TXCLK + VDD1P2TXENC		280			mA
	Group 2C: VDD1P2FBCML + VDD1P2RXCML + VDD1P2PLLCLKREF		72			mA
I_{VDD0P9}	Group 1A: DVDD0P9 + VDDT0P9		2360			mA
P_{diss}	Power Dissipation		6460			mW

Typical values at $T_A = +25^\circ\text{C}$, full temperature range is $T_{A,\text{MIN}} = -40^\circ\text{C}$ to $T_{A,\text{MAX}} = +110^\circ\text{C}$; TX Input Rate = 491.52MSPS, $f_{\text{DAC}} = 8847.36\text{MSPS}$ interleave mode; $f_{\text{ADC}} = 2949.12\text{MSPS}$; nominal power supplies; 1 tone at -1 dBFS; DSA Attenuation = 0dB; SerDes rate = 24.33Gbps; unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
I_{VDD1P8}	Group 3A: VDD1P8FB + VDD1P8RX + VDD1P8TX	Mode 11c: TDD 4T4R1FB average TX/FB: 75%, RX 25% Single Band: 8x Int, FB 2x Dec, RX uses FB TX/FB/RX Rate = 1474.56 Msps $f_{\text{DAC}} = 11796.48\text{ MSPS}$ $f_{\text{ADC}} = 2949.12\text{ MSPS}$ $f_{\text{TX}} = f_{\text{RX}} = 8\text{ GHz}$ 64/66 coding, 24.33 Gbps TX: 8-8-2-1, FB/RX: 4-4-4-2		790		mA
	Group 3B: VDD1P8FBCLK + VDD1P8RXCLK + VDD1P8TXDAC + VDD1P8GPIO + VDDA1P8			850		mA
	Group 3C: VDD1P8PLL + VDD1P8PLLVC0			73		mA
I_{VDD1P2}	Group 2A: VDD1P2FB + VDD1P2RX			300		mA
	Group 2B: VDD1P2TXCLK + VDD1P2TXENC			1150		mA
	Group 2C: VDD1P2FBCML + VDD1P2RXCML + VDD1P2PLLCLKREF			75		mA
I_{VDD0P9}	Group 1A: DVDD0P9 + VDDT0P9			2890		mA
P_{diss}	Power Dissipation			7620		mW
I_{VDD1P8}	Group 3A: VDD1P8FB + VDD1P8RX + VDD1P8TX	Mode 11d: FDD 4T4R Single Band: 8x Int, RX uses FB TX/FB/RX Rate = 1474.56 Msps $f_{\text{DAC}} = 11796.48\text{ MSPS}$ $f_{\text{ADC}} = 2949.12\text{ MSPS}$ $f_{\text{TX}} = f_{\text{RX}} = 8\text{ GHz}$ 64/66 coding, 24.33 Gbps TX: 8-8-2-1, FB/RX: 4-4-4-2		1260		mA
	Group 3B: VDD1P8FBCLK + VDD1P8RXCLK + VDD1P8TXDAC + VDD1P8GPIO + VDDA1P8			940		mA
	Group 3C: VDD1P8PLL + VDD1P8PLLVC0			73		mA
I_{VDD1P2}	Group 2A: VDD1P2FB + VDD1P2RX			630		mA
	Group 2B: VDD1P2TXCLK + VDD1P2TXENC			1480		mA
	Group 2C: VDD1P2FBCML + VDD1P2RXCML + VDD1P2PLLCLKREF			78		mA
I_{VDD0P9}	Group 1A: DVDD0P9 + VDDT0P9			4200		mA
P_{diss}	Power Dissipation			10640		mW

4.10 Timing Requirements

Typical values at $T_A = +25^\circ\text{C}$, full temperature range is $T_{A,\text{MIN}} = -40^\circ\text{C}$ to $T_{J,\text{MAX}} = +110^\circ\text{C}$; TX Input Rate = 491.52MSPS, $f_{\text{DAC}} = 8847.36\text{MSPS}$; $f_{\text{ADC}} = 2949.12\text{MSPS}$; nominal power supplies; 1 tone at -1 dBFS; DSA Attenuation = 0dB; SerDes rate = 24.33Gbps; unless otherwise noted.

		MIN	NOM	MAX	UNIT
Timing: SYSREF+/-					
$t_{\text{s(SYSREF)}}$	Setup Time, SYSREF+/- Valid to Rising Edge of CLK+/-		50		ps
$t_{\text{h(SYSREF)}}$	Hold Time, SYSREF+/- Valid after Rising Edge of CLK+/-		50		ps
Timing: Serial ports					
$t_{\text{s(SEN B)}}$	Setup Time, SENB to Rising Edge of SCLK		15		ns
$t_{\text{h(SEN B)}}$	Hold Time, SENB after last Rising Edge of SCLK ⁽¹⁾		$5 + t_{\text{sCLK}}$		ns
$t_{\text{s(SDIO)}}$	Setup Time, SDIO valid to Rising Edge of SCLK		15		ns
$t_{\text{h(SDIO)}}$	Hold Time, SDIO valid after Rising Edge of SCLK		5		ns
$t_{\text{(SCLK)_W}}$	Minimum SCLK period: registers write		25		ns
$t_{\text{(SCLK)_R}}$	Minimum SCLK period: registers read		50		ns
$t_{\text{(SCLK)_R}}$	SCLK period: temp sensor ⁽²⁾		1000		ns
$t_{\text{d(data_out)}}$	Minimum Data Output delay after Falling Edge of SCLK		0		ns
	Maximum Data Output delay after Falling Edge of SCLK		15		ns
t_{RESET}	Minimum RESETZ Pulse Width		1		ms

(1) SDEN\ need to be held one more extra clock cycle with the last SCLK edge

(2) Temp sensor requires a maximum of 1MHz SCLK cycle.

4.11 Switching Characteristics

Typical values at $T_A = +25^\circ\text{C}$, full temperature range is $T_{A,\text{MIN}} = -40^\circ\text{C}$ to $T_{A,\text{MAX}} = +110^\circ\text{C}$; TX Input Rate = 491.52MSPS, $f_{\text{DAC}} = 8847.36\text{MSPS}$; $f_{\text{ADC}} = 2949.12\text{MSPS}$; nominal power supplies; 1 tone at -1 dBFS; DSA Attenuation = 0dB; SerDes rate = 24.33Gbps; unless otherwise noted.

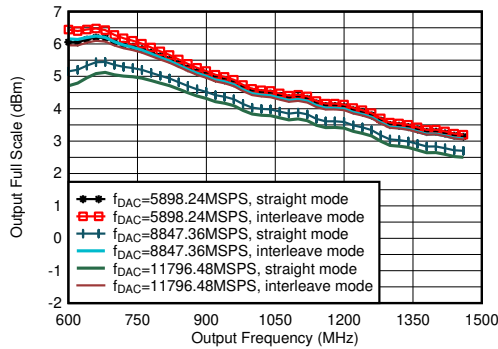
PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
TX Channel Latency						
t _{JESD TX}	JESD to TX output Latency	LMFSHd=2-8-8-1, 368.64 MSPS input rate, 24x Interpolation, Serdes rate = 16.22Gbps (JESD204C)		152		interface clock cycles ⁽¹⁾
		LMFSHd=8-16-4-1, 491.52 MSPS 24x Interpolation, Serdes rate = 16.22Gbps (JESD204C)		176		
		LMFSHd=4-16-8-1, 245.76 MSPS 48x Interpolation, Serdes rate = 16.22Gbps (JESD204C)		124		
		LMFSHd=2-16-16-1, 122.88 MSPS 96x Interpolation, Serdes rate = 16.22Gbps (JESD204C)		97		
RX Channel Latency						
	SerDes Transmitter Analog Delay			3.6		ns
t _{JESD RX}	RX input to JESD output Latency	LMFS=2-16-16-1, 122.88 MSPS, 24x Decimation, Serdes rate = 16.22Gbps (JESD204C)		92		interface clock cycles ⁽¹⁾
		LMFS=4-16-8-1, 245.76 MSPS, 12x Decimation, Serdes rate = 16.22Gbps (JESD204C)		108		
		LMFS=4-8-4-1, 491.52 MSPS, 6x Decimation, Serdes rate = 16.22Gbps (JESD204C)		153		
FB Channel Latency						
	SerDes Transmitter Analog Delay			3.6		ns
t _{JESD FB}	FB input to JESD output Latency	LMFS=1-2-8-1, 368.64 MSPS, 8x Decimation		151		interface clock cycles ⁽¹⁾
		LMFS=2-4-4-1, 491.52 MSPS, 6x Decimation		177		

(1) Interface clock cycles is the period of the digital interface sample rate, e.g. 1GSPS = 1ns.

4.12 Typical Characteristics

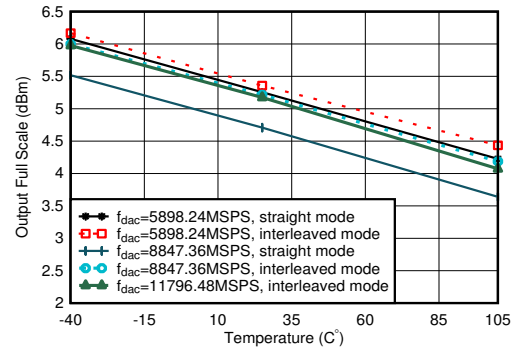
4.12.1 TX Typical Characteristics 800MHz

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48\text{MSPS}$ (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1\text{dBFS}$, DSA = 0dB, Sin(x)/x enabled, DSA calibrated



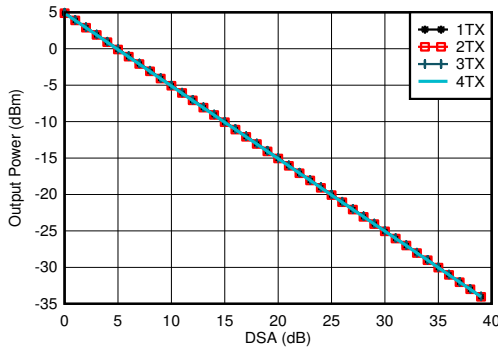
including PCB and cable losses, $A_{\text{out}} = -0.5\text{dBFS}$, DSA = 0, 0.8GHz matching

Figure 4-1. TX Output Fullscale vs Output Frequency



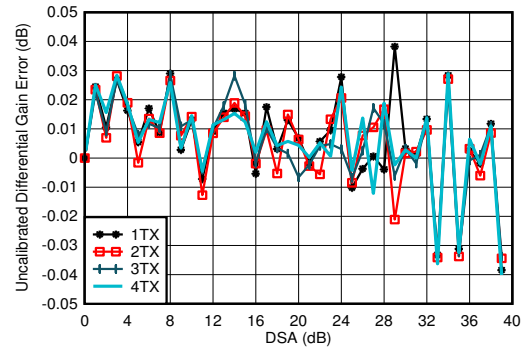
including PCB and cable losses, $A_{\text{out}} = -0.5\text{dBFS}$, DSA = 0, 0.8GHz matching

Figure 4-2. TX Output Fullscale vs Temperature



$f_{\text{DAC}} = 11796.48\text{MSPS}$, interleaved mode, $A_{\text{out}} = -0.5\text{dBFS}$, matching 0.8GHz

Figure 4-3. TX Output Power vs DSA Setting and Channel at 0.85GHz

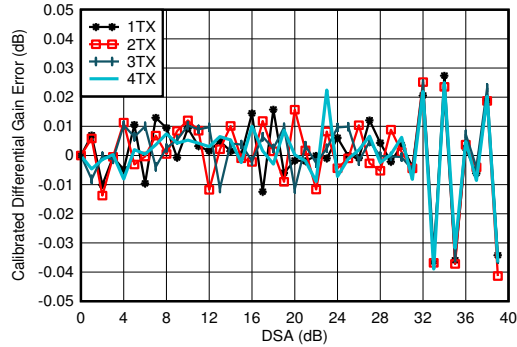


$f_{\text{DAC}} = 5898.24\text{MSPS}$, interleaved mode, matching at 0.8GHz
Differential Gain Error = $P_{\text{OUT}}(\text{DSA Setting} - 1) - P_{\text{OUT}}(\text{DSA Setting}) + 1$

Figure 4-4. TX Uncalibrated Differential Gain Error vs DSA Setting and Channel at 0.85GHz

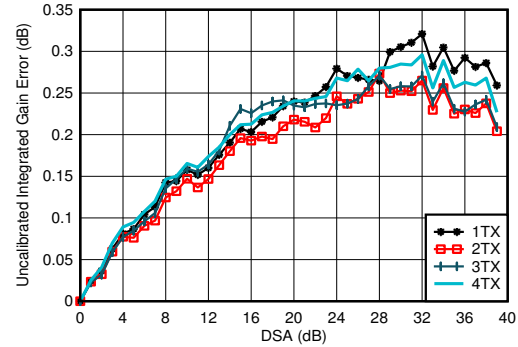
4.12.1 TX Typical Characteristics 800MHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48\text{MSPS}$ (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1\text{dBFS}$, DSA = 0dB, Sin(x)/x enabled, DSA calibrated



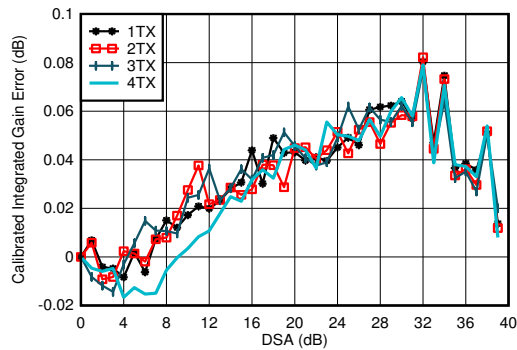
$f_{\text{DAC}} = 5898.24\text{MSPS}$, interleave mode, matching at 0.8GHz
 Differential Gain Error = $P_{\text{OUT}}(\text{DSA Setting} - 1) - P_{\text{OUT}}(\text{DSA Setting}) + 1$

図 4-5. TX Calibrated Differential Gain Error vs DSA Setting and Channel at 0.85GHz



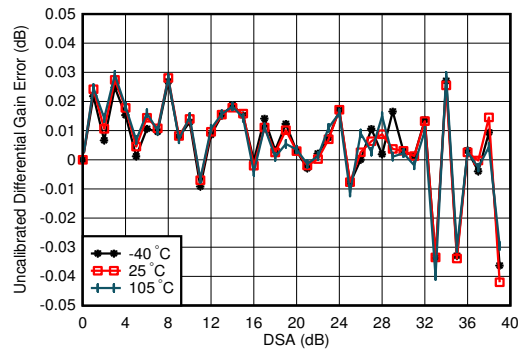
$f_{\text{DAC}} = 5898.24\text{MSPS}$, interleave mode, matching at 0.8GHz
 Integrated Gain Error = $P_{\text{OUT}}(\text{DSA Setting}) - P_{\text{OUT}}(\text{DSA Setting} = 0) + \text{DSA Settings}$

図 4-6. TX Uncalibrated Integrated Gain Error vs DSA Setting and Channel at 0.85GHz



$f_{\text{DAC}} = 5898.24\text{MSPS}$, interleave mode, matching at 0.8GHz
 Integrated Gain Error = $P_{\text{OUT}}(\text{DSA Setting}) - P_{\text{OUT}}(\text{DSA Setting} = 0) + \text{DSA Setting}$

図 4-7. TX Calibrated Integrated Gain Error vs DSA Setting and Channel at 0.85GHz

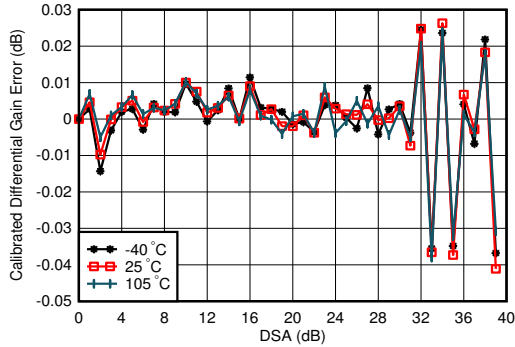


$f_{\text{DAC}} = 5898.24\text{MSPS}$, interleave mode, matching at 0.8GHz
 Differential Gain Error = $P_{\text{OUT}}(\text{DSA Setting} - 1) - P_{\text{OUT}}(\text{DSA Setting}) + 1$

図 4-8. TX Uncalibrated Differential Gain Error vs DSA Setting and Temperature at 0.85GHz

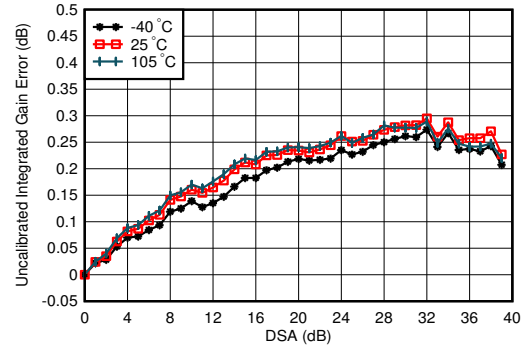
4.12.1 TX Typical Characteristics 800MHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48\text{MSPS}$ (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1\text{dBFS}$, DSA = 0dB, Sin(x)/x enabled, DSA calibrated



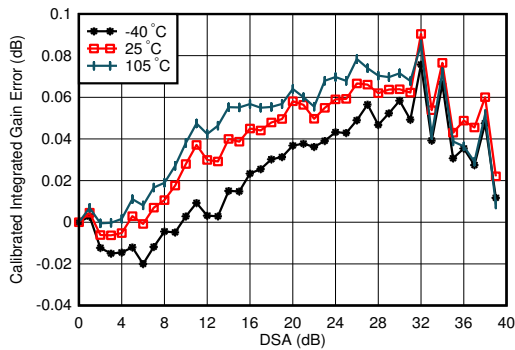
$f_{\text{DAC}} = 5898.24\text{MSPS}$, interleave mode, matching at 0.8GHz
Differential Gain Error = $P_{\text{OUT}}(\text{DSA Setting} - 1) - P_{\text{OUT}}(\text{DSA Setting}) + 1$

図 4-9. TX Calibrated Differential Gain Error vs DSA Setting and Temperature at 0.85GHz



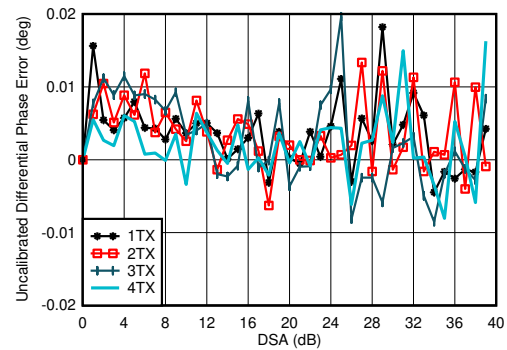
$f_{\text{DAC}} = 5898.24\text{MSPS}$, interleave mode, matching at 0.8GHz
Integrated Gain Error = $P_{\text{OUT}}(\text{DSA Setting}) - P_{\text{OUT}}(\text{DSA Setting} = 0) + \text{DSA Setting}$

図 4-10. TX Uncalibrated Integrated Gain Error vs DSA Setting and Temperature at 0.85GHz



$f_{\text{DAC}} = 5898.24\text{MSPS}$, interleave mode, matching at 0.8GHz
Integrated Gain Error = $P_{\text{OUT}}(\text{DSA Setting}) - P_{\text{OUT}}(\text{DSA Setting} = 0) + \text{DSA Setting}$

図 4-11. TX Calibrated Integrated Gain Error vs DSA Setting and Temperature at 0.85GHz

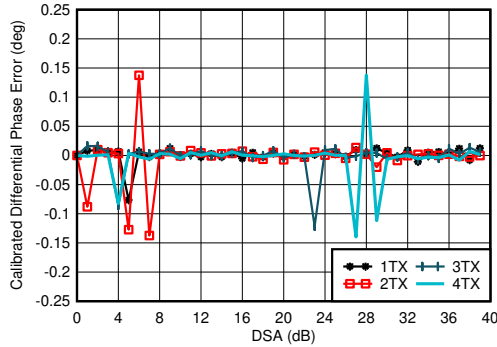


$f_{\text{DAC}} = 5898.24\text{MSPS}$, interleave mode, matching at 0.8GHz
Differential Phase Error = $\text{Phase}_{\text{OUT}}(\text{DSA Setting} - 1) - \text{Phase}_{\text{OUT}}(\text{DSA Setting})$

図 4-12. TX Uncalibrated Differential Phase Error vs DSA Setting and Channel at 0.85GHz

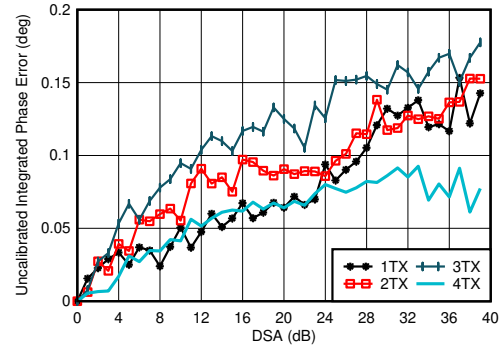
4.12.1 TX Typical Characteristics 800MHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48\text{MSPS}$ (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1\text{dBFS}$, DSA = 0dB, Sin(x)/x enabled, DSA calibrated



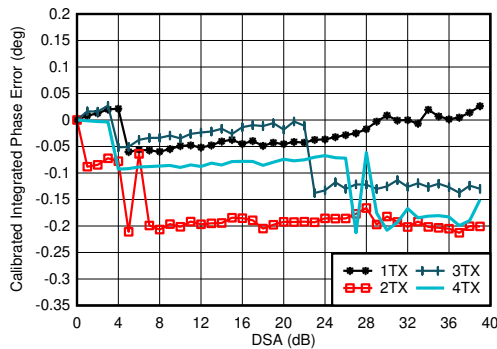
$f_{\text{DAC}} = 5898.24\text{MSPS}$, interleave mode, matching at 0.8GHz
Differential Phase Error = $\text{Phase}_{\text{OUT}}(\text{DSA Setting} - 1) - \text{Phase}_{\text{OUT}}(\text{DSA Setting})$
Phase DNL spike may occur at any DSA setting.

図 4-13. TX Calibrated Differential Phase Error vs DSA Setting and Channel at 0.85GHz



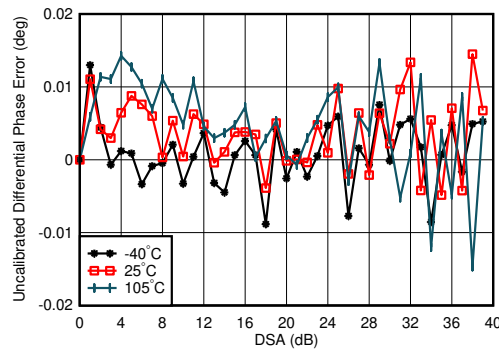
$f_{\text{DAC}} = 5898.24\text{MSPS}$, interleave mode, matching at 0.8GHz
Integrated Phase Error = $\text{Phase}_{\text{OUT}}(\text{DSA Setting}) - \text{Phase}_{\text{OUT}}(\text{DSA Setting} = 0)$

図 4-14. TX Uncalibrated Integrated Phase Error vs DSA Setting and Channel at 0.85GHz



$f_{\text{DAC}} = 5898.24\text{MSPS}$, interleave mode, matching at 0.8GHz
Integrated Phase Error = $\text{Phase}_{\text{OUT}}(\text{DSA Setting}) - \text{Phase}_{\text{OUT}}(\text{DSA Setting} = 0)$

図 4-15. TX Calibrated Integrated Phase Error vs DSA Setting and Channel at 0.85GHz

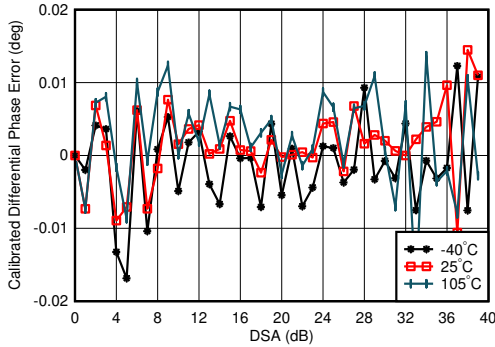


$f_{\text{DAC}} = 5898.24\text{MSPS}$, interleave mode, matching at 0.8GHz
Differential Phase Error = $\text{Phase}_{\text{OUT}}(\text{DSA Setting} - 1) - \text{Phase}_{\text{OUT}}(\text{DSA Setting}) + 1$

図 4-16. TX Uncalibrated Differential Phase Error vs DSA Setting and Temperature at 0.85GHz

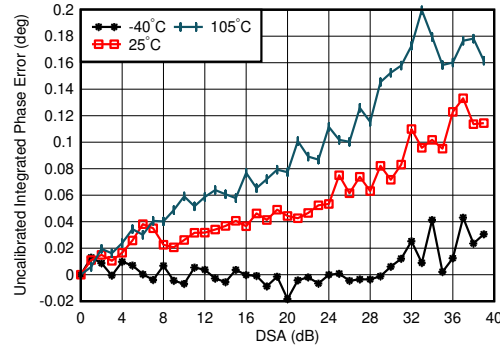
4.12.1 TX Typical Characteristics 800MHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48\text{MSPS}$ (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1\text{dBFS}$, DSA = 0dB, Sin(x)/x enabled, DSA calibrated



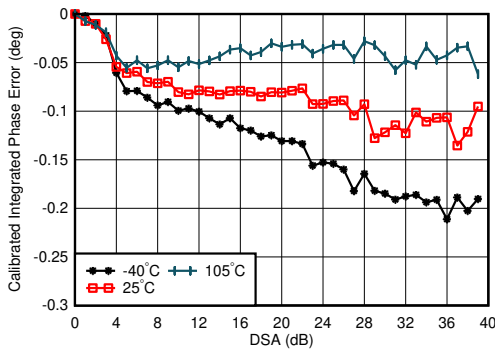
$f_{\text{DAC}} = 5898.24\text{MSPS}$, interleave mode, matching at 0.8GHz, channel with the median variation over DSA setting at 25°C
Differential Phase Error = $\text{Phase}_{\text{OUT}}(\text{DSA Setting} - 1) - \text{Phase}_{\text{OUT}}(\text{DSA Setting}) + 1$

図 4-17. TX Calibrated Differential Phase Error vs DSA Setting and Temperature at 0.85GHz



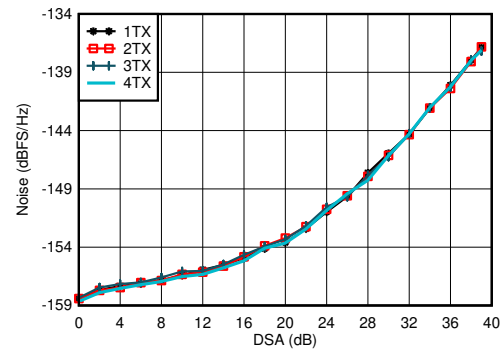
$f_{\text{DAC}} = 5898.24\text{MSPS}$, interleave mode, matching at 0.8GHz
Integrated Phase Error = $\text{Phase}_{\text{OUT}}(\text{DSA Setting}) - \text{Phase}_{\text{OUT}}(\text{DSA Setting} = 0)$

図 4-18. TX Uncalibrated Integrated Phase Error vs DSA Setting and Temperature at 0.85GHz



$f_{\text{DAC}} = 5898.24\text{MSPS}$, interleave mode, matching at 0.8GHz
Integrated Phase Error = $\text{Phase}_{\text{OUT}}(\text{DSA Setting}) - \text{Phase}_{\text{OUT}}(\text{DSA Setting} = 0)$

図 4-19. TX Calibrated Integrated Phase Error vs DSA Setting and Temperature at 0.85GHz

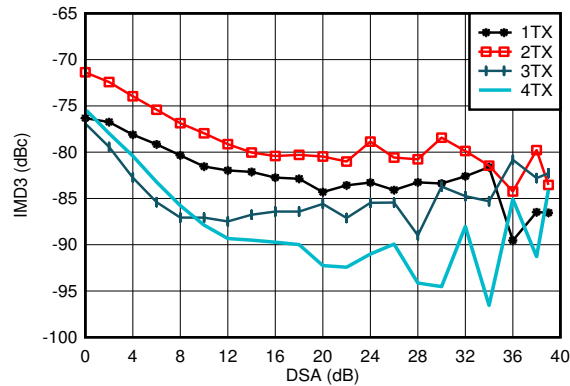


$f_{\text{DAC}} = 5898.24\text{MSPS}$, interleave mode, matching at 0.8GHz, $P_{\text{OUT}} = -13\text{ dBFS}$

図 4-20. TX Output Noise vs Channel and Attenuation at 0.85GHz

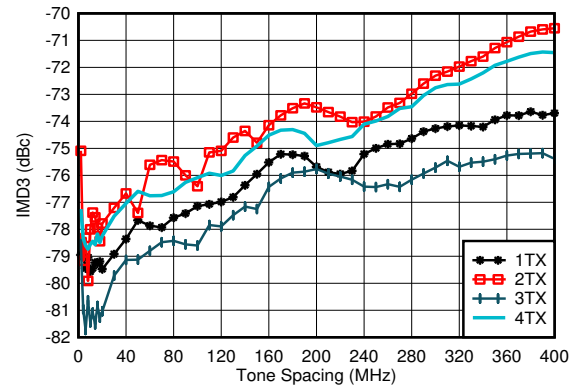
4.12.1 TX Typical Characteristics 800MHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48\text{MSPS}$ (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1\text{dBFS}$, DSA = 0dB, Sin(x)/x enabled, DSA calibrated



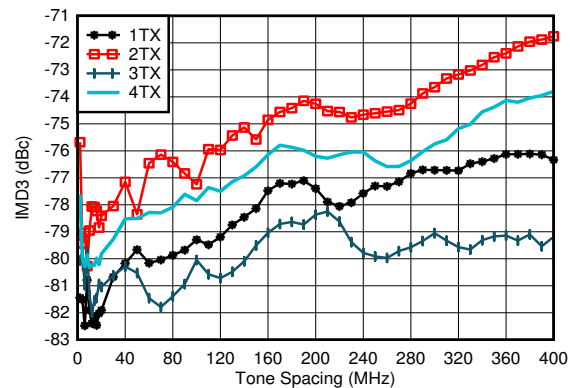
$f_{\text{DAC}} = 11796.48\text{MSPS}$, interleave mode, $f_{\text{CENTER}} = 0.85\text{GHz}$, matching at 0.8 GHz, -13dBFS each tone

図 4-21. TX IMD3 vs DSA Setting at 0.85GHz



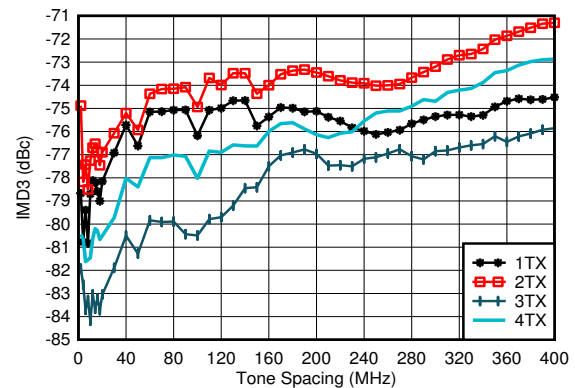
$f_{\text{DAC}} = 5898.24\text{MSPS}$, straight mode, $f_{\text{CENTER}} = 0.85\text{GHz}$, matching at 0.8GHz, -13dBFS each tone

図 4-22. TX IMD3 vs Tone Spacing and Channel at 0.85GHz



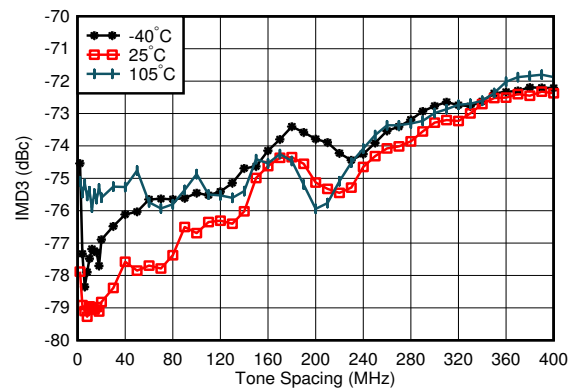
$f_{\text{DAC}} = 8847.36\text{MSPS}$, straight mode, $f_{\text{CENTER}} = 0.85\text{GHz}$, matching at 0.8GHz, -13dBFS each tone

図 4-23. TX IMD3 vs Tone Spacing and Channel at 0.85GHz



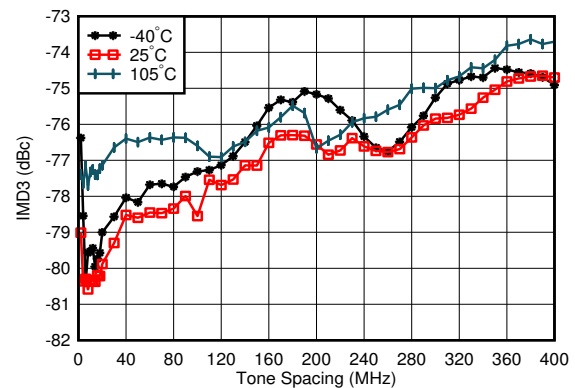
$f_{\text{DAC}} = 11796.48\text{MSPS}$, interleave mode, $f_{\text{CENTER}} = 0.85\text{GHz}$, matching at 0.8GHz, -13dBFS each tone

図 4-24. TX IMD3 vs Tone Spacing and Channel at 0.85GHz



$f_{\text{DAC}} = 5898.24\text{MSPS}$, straight mode, $f_{\text{CENTER}} = 0.85\text{GHz}$, matching at 0.8GHz, -13dBFS each tone, worst channel

図 4-25. TX IMD3 vs Tone Spacing and Temperature at 0.85GHz

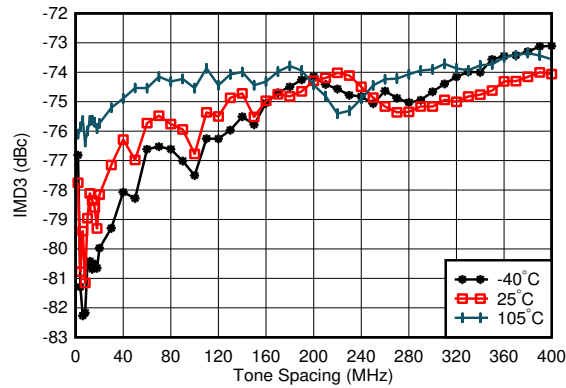


$f_{\text{DAC}} = 8847.3\text{MSPS}$, straight mode, $f_{\text{CENTER}} = 0.85\text{GHz}$, matching at 0.8 GHz, -13dBFS each tone, worst channel

図 4-26. TX IMD3 vs Tone Spacing and Temperature at 0.85GHz

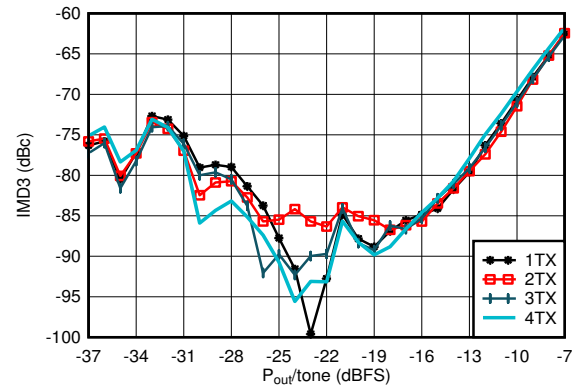
4.12.1 TX Typical Characteristics 800MHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{DAC} = 11796.48\text{MSPS}$ (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{REF} = 491.52\text{MHz}$, $A_{OUT} = -1\text{dBFS}$, DSA = 0dB, Sin(x)/x enabled, DSA calibrated



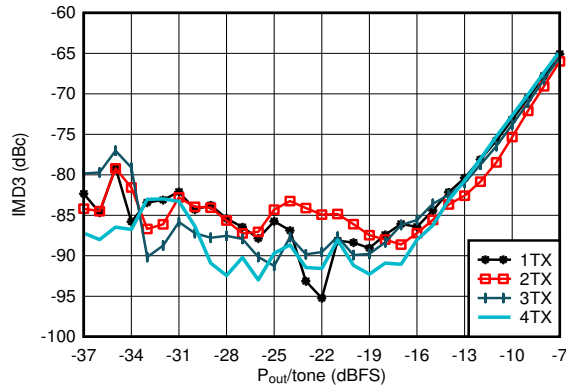
$f_{DAC} = 11796.48\text{MSPS}$, straight mode, $f_{CENTER} = 0.85\text{GHz}$, matching at 0.8GHz, -13dBFS each tone, worst channel

図 4-27. TX IMD3 vs Tone Spacing and Temperature at 0.85GHz



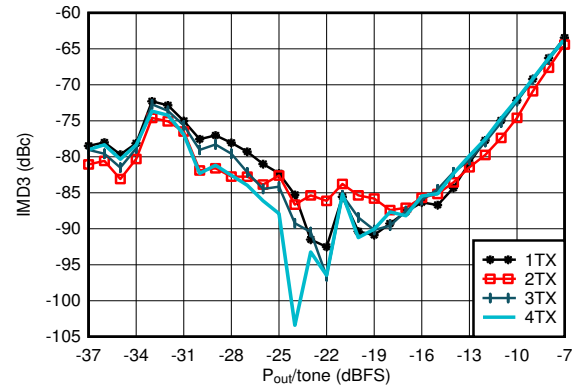
$f_{DAC} = 5898.24\text{MSPS}$, straight mode, $f_{CENTER} = 0.85\text{GHz}$, $f_{SPACING} = 20\text{MHz}$, matching at 0.8GHz

図 4-28. TX IMD3 vs Digital Level at 0.85GHz



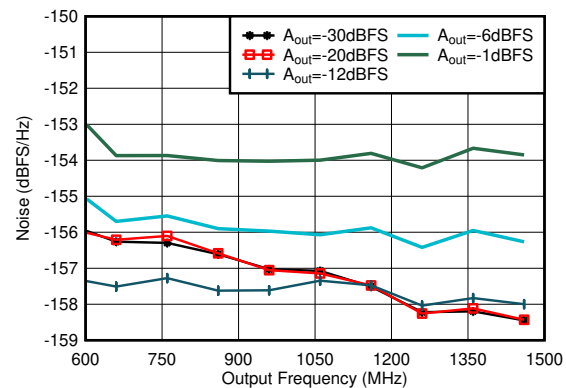
$f_{DAC} = 8847.36\text{MSPS}$, straight mode, $f_{CENTER} = 0.85\text{GHz}$, $f_{SPACING} = 20\text{MHz}$, matching at 0.8GHz

図 4-29. TX IMD3 vs Digital Level at 0.85GHz



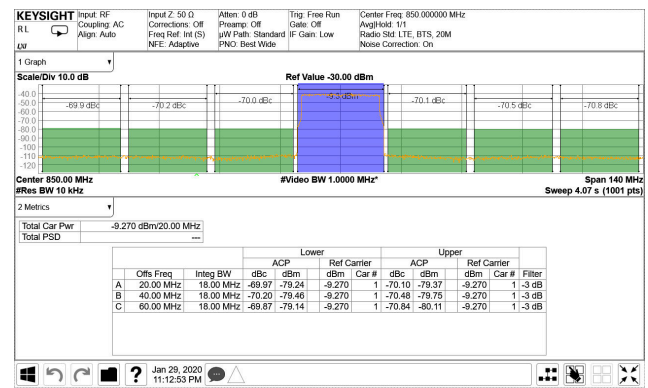
$f_{DAC} = 11796.48\text{MSPS}$, interleave mode, $f_{CENTER} = 0.85\text{GHz}$, $f_{SPACING} = 20\text{MHz}$, matching at 0.8GHz

図 4-30. TX IMD3 vs Digital Level at 0.85GHz



Matching at 2.6GHz, Single tone, $f_{DAC} = 11.79648\text{GSPS}$, interleave mode, 40MHz offset, DSA = 0dB

図 4-31. TX Single Tone Output Noise vs Frequency and Amplitude at 0.85GHz

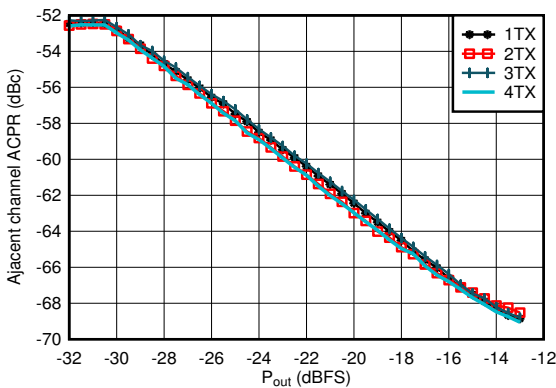


TM1.1, $P_{OUT_RMS} = -13\text{dBFS}$

図 4-32. TX 20-MHz LTE Output Spectrum at 0.85 GHz

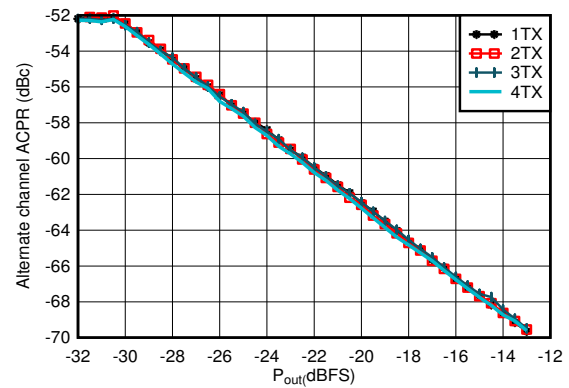
4.12.1 TX Typical Characteristics 800MHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48\text{MSPS}$ (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1\text{dBFS}$, DSA = 0dB, Sin(x)/x enabled, DSA calibrated



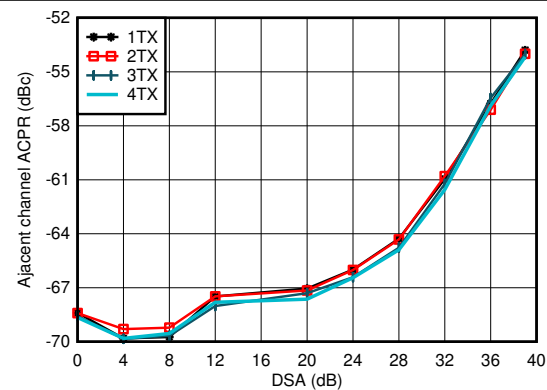
Matching at 0.8GHz, single carrier 20MHz BW TM1.1 LTE

FIG 4-33. TX 20-MHz LTE ACPR vs Digital Level at 0.85GHz



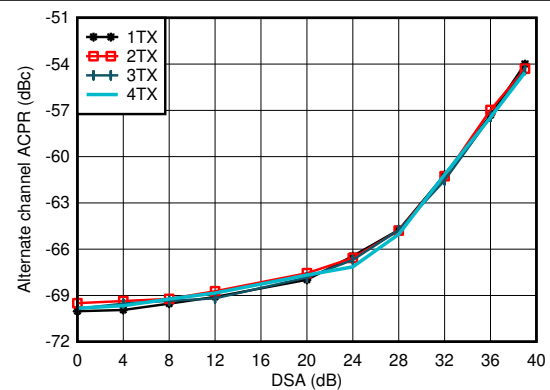
Matching at 0.8GHz, single carrier 20MHz BW TM1.1 LTE

FIG 4-34. TX 20MHz LTE alt-ACPR vs Digital Level at 0.85GHz



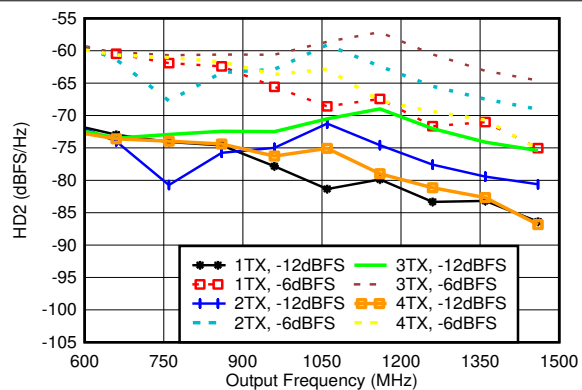
Matching at 0.8GHz, single carrier 20MHz BW TM1.1 LTE

FIG 4-35. TX 20MHz LTE ACPR vs DSA at 0.85GHz



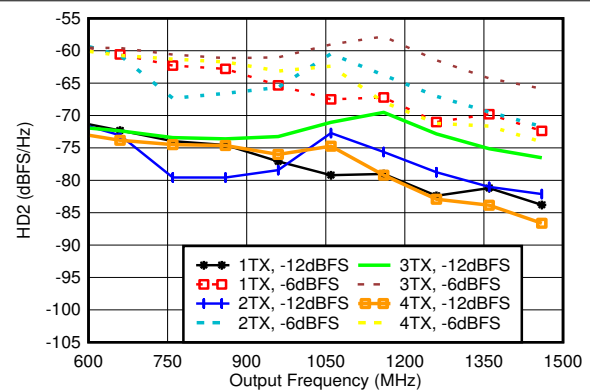
Matching at 0.8GHz, single carrier 20MHz BW TM1.1 LTE

FIG 4-36. TX 20-MHz LTE alt-ACPR vs DSA at 0.85GHz



Matching at 0.8GHz, $f_{\text{DAC}} = 5898.2\text{GSPS}$, straight mode

FIG 4-37. TX HD2 vs Digital Amplitude and Output Frequency at 0.85GHz

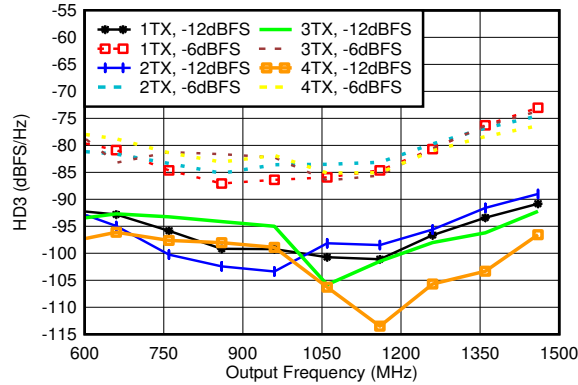


Matching at 0.8GHz, $f_{\text{DAC}} = 8847.36\text{GSPS}$, straight mode

FIG 4-38. TX HD2 vs Digital Amplitude and Output Frequency at 0.85GHz

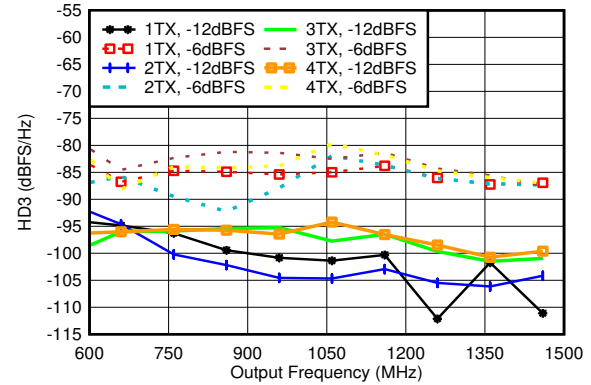
4.12.1 TX Typical Characteristics 800MHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48\text{MSPS}$ (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1\text{dBFS}$, DSA = 0dB, Sin(x)/x enabled, DSA calibrated



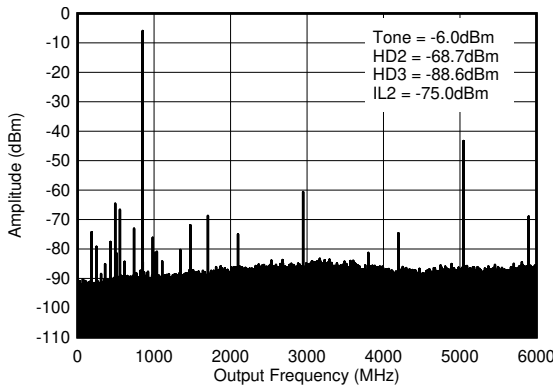
Matching at 0.8GHz, $f_{\text{DAC}} = 5898.24\text{MSPS}$, straight mode, normalized to output power at harmonic frequency

FIG 4-39. TX HD3 vs Digital Amplitude and Output Frequency at 0.85GHz



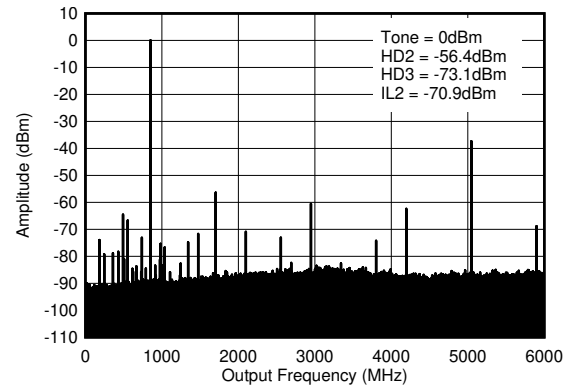
Matching at 0.8GHz, $f_{\text{DAC}} = 8847.36\text{MSPS}$, straight mode, normalized to output power at harmonic frequency

FIG 4-40. TX HD3 vs Digital Amplitude and Output Frequency at 0.85GHz



$f_{\text{DAC}} = 5898.24\text{MSPS}$, interleave mode, 0.8GHz matching, includes PCB and cable losses. $ILn = f_S/n \pm f_{\text{OUT}}$.

FIG 4-41. TX Single Tone (-12 dBFS) Output Spectrum at 0.85GHz ($0-f_{\text{DAC}}$)

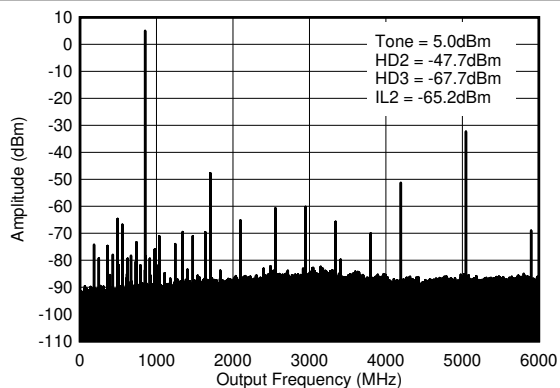


$f_{\text{DAC}} = 5898.2\text{MSPS}$, interleave mode, 0.8GHz matching, includes PCB and cable losses. $ILn = f_S/n \pm f_{\text{OUT}}$.

FIG 4-42. TX Single Tone (-6dBFS) Output Spectrum at 0.85GHz ($0-f_{\text{DAC}}$)

4.12.1 TX Typical Characteristics 800MHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48\text{MSPS}$ (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1\text{dBFS}$, DSA = 0dB, Sin(x)/x enabled, DSA calibrated

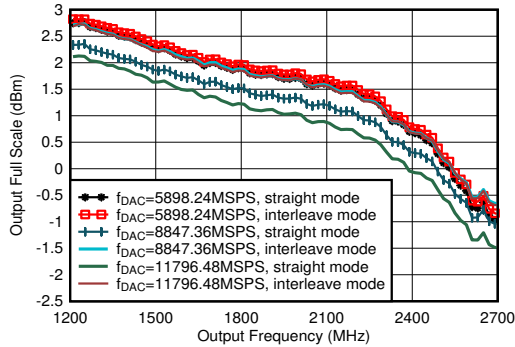


$f_{\text{DAC}} = 5898.24\text{MSPS}$, interleave mode, 0.8GHz matching, includes PCB and cable losses. $IL_n = f_s/n \pm f_{\text{OUT}}$.

図 4-43. TX Single Tone (-1dBFS) Output Spectrum at 0.85GHz (0- f_{DAC})

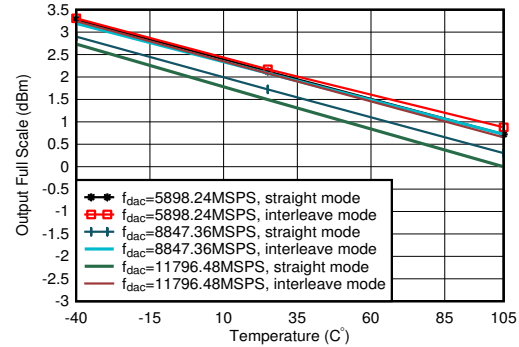
4.12.2 TX Typical Characteristics at 1.8GHz

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48\text{MSPS}$ (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1\text{dBFS}$, DSA = 0dB, $\text{Sin}(x)/x$ enabled, DSA calibrated



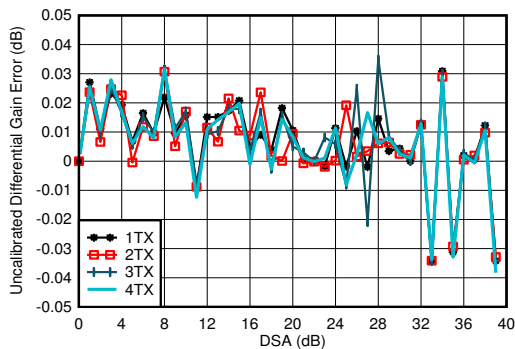
including PCB and cable losses, $A_{\text{out}} = -0.5\text{dBFS}$, DSA = 0, 1.8GHz matching

FIG 4-44. TX Output Fullscale vs Output Frequency



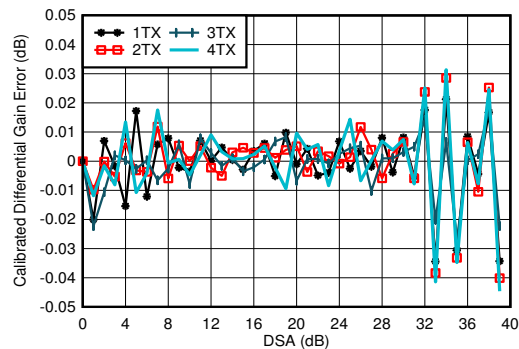
$A_{\text{out}} = -0.5\text{dBFS}$, matching 1.8GHz

FIG 4-45. TX Output Power vs Temperature at 1.8GHz



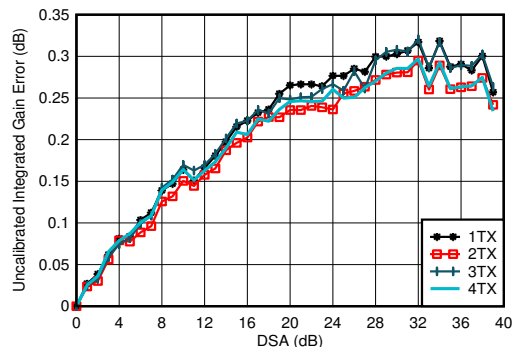
$f_{\text{DAC}} = 5898.24\text{MSPS}$, interleave mode, matching at 1.8GHz
Differential Gain Error = $P_{\text{OUT}}(\text{DSA Setting} - 1) - P_{\text{OUT}}(\text{DSA Setting}) + 1$

FIG 4-46. TX Uncalibrated Differential Gain Error vs DSA Setting and Channel at 1.8GHz



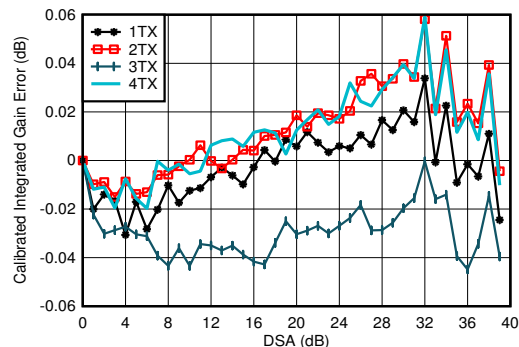
$f_{\text{DAC}} = 5898.24\text{MSPS}$, interleave mode, matching at 1.8GHz
Differential Gain Error = $P_{\text{OUT}}(\text{DSA Setting} - 1) - P_{\text{OUT}}(\text{DSA Setting}) + 1$

FIG 4-47. TX Calibrated Differential Gain Error vs DSA Setting and Channel at 1.8GHz



$f_{\text{DAC}} = 5898.24\text{MSPS}$, interleave mode, matching at 1.8GHz
Integrated Gain Error = $P_{\text{OUT}}(\text{DSA Setting}) - P_{\text{OUT}}(\text{DSA Setting} = 0) + (\text{DSA Setting})$

FIG 4-48. TX Uncalibrated Integrated Gain Error vs DSA Setting and Channel at 1.8GHz

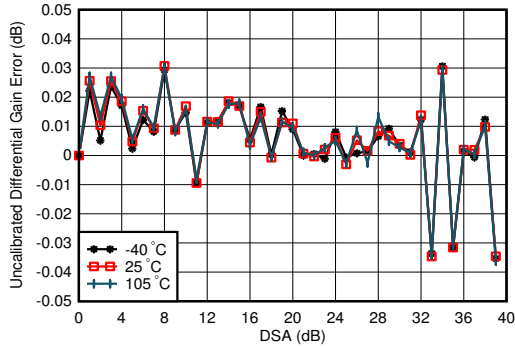


$f_{\text{DAC}} = 5898.24\text{MSPS}$, interleave mode, matching at 1.8GHz
Integrated Gain Error = $P_{\text{OUT}}(\text{DSA Setting}) - P_{\text{OUT}}(\text{DSA Setting} = 0) + (\text{DSA Setting})$

FIG 4-49. TX Calibrated Integrated Gain Error vs DSA Setting and Channel at 1.8GHz

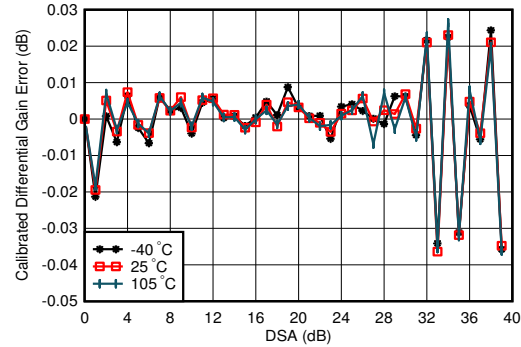
4.12.2 TX Typical Characteristics at 1.8GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48\text{MSPS}$ (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1\text{ dBFS}$, DSA = 0dB, Sin(x)/x enabled, DSA calibrated



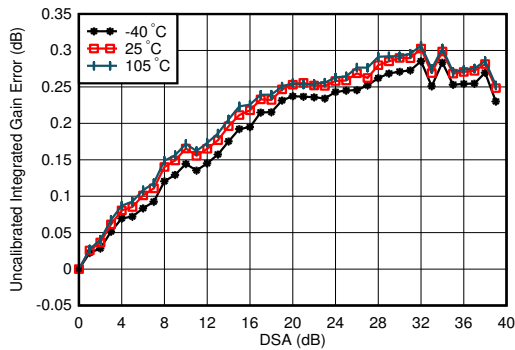
$f_{\text{DAC}} = 5898.24\text{MSPS}$, interleave mode, matching at 1.8GHz
 Differential Gain Error = $P_{\text{OUT}}(\text{DSA Setting} - 1) - P_{\text{OUT}}(\text{DSA Setting}) + 1$

図 4-50. TX Uncalibrated Differential Gain Error vs DSA Setting and Temperature at 1.8GHz



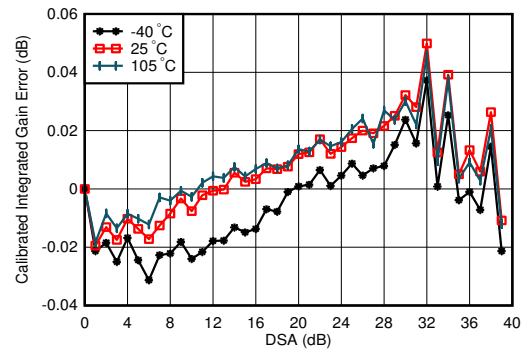
$f_{\text{DAC}} = 5898.24\text{MSPS}$, interleave mode, matching at 1.8GHz
 Differential Gain Error = $P_{\text{OUT}}(\text{DSA Setting} - 1) - P_{\text{OUT}}(\text{DSA Setting}) + 1$

図 4-51. TX Calibrated Differential Gain Error vs DSA Setting and Temperature at 1.8GHz



$f_{\text{DAC}} = 5898.24\text{MSPS}$, interleave mode, matching at 1.8GHz
 Integrated Gain Error = $P_{\text{OUT}}(\text{DSA Setting}) - P_{\text{OUT}}(\text{DSA Setting} = 0) + (\text{DSA Setting})$

図 4-52. TX Uncalibrated Integrated Gain Error vs DSA Setting and Temperature at 1.8GHz

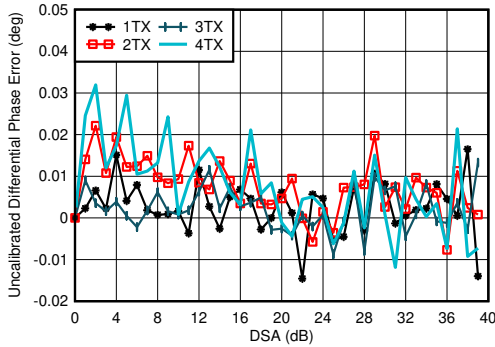


$f_{\text{DAC}} = 5898.24\text{MSPS}$, interleave mode, matching at 1.8GHz
 Integrated Gain Error = $P_{\text{OUT}}(\text{DSA Setting}) - P_{\text{OUT}}(\text{DSA Setting} = 0) + (\text{DSA Setting})$

図 4-53. TX Calibrated Integrated Gain Error vs DSA Setting and Temperature at 1.8GHz

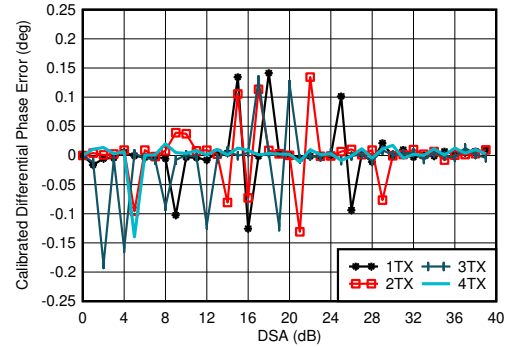
4.12.2 TX Typical Characteristics at 1.8GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48\text{MSPS}$ (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1\text{ dBFS}$, DSA = 0dB, Sin(x)/x enabled, DSA calibrated



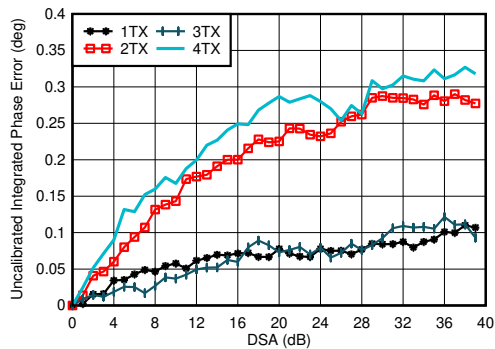
$f_{\text{DAC}} = 5898.24\text{MSPS}$, interleave mode, matching at 1.8GHz
Differential Phase Error = $\text{Phase}_{\text{OUT}}(\text{DSA Setting} - 1) - \text{Phase}_{\text{OUT}}(\text{DSA Setting})$

図 4-54. TX Uncalibrated Differential Phase Error vs DSA Setting and Channel at 1.8GHz



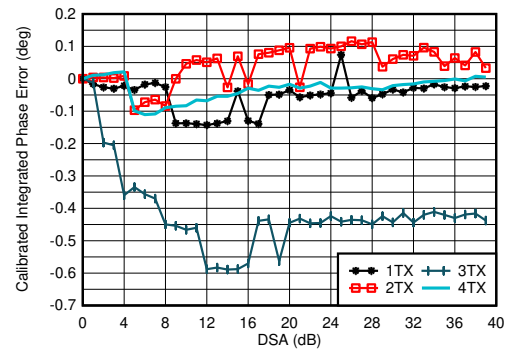
$f_{\text{DAC}} = 8847.36\text{MSPS}$, straight mode, matching at 2.6GHz
Differential Phase Error = $\text{Phase}_{\text{OUT}}(\text{DSA Setting} - 1) - \text{Phase}_{\text{OUT}}(\text{DSA Setting})$
Phase DNL spike may occur at any DSA setting.

図 4-55. TX Calibrated Differential Phase Error vs DSA Setting and Channel at 1.8GHz



$f_{\text{DAC}} = 5898.24\text{MSPS}$, interleave mode, matching at 1.8GHz
Integrated Phase Error = $\text{Phase}(\text{DSA Setting}) - \text{Phase}(\text{DSA Setting} = 0)$

図 4-56. TX Uncalibrated Integrated Phase Error vs DSA Setting and Channel at 1.8GHz

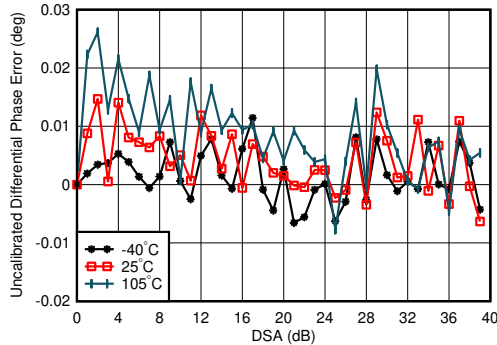


$f_{\text{DAC}} = 5898.24\text{MSPS}$, interleave mode, matching at 1.8GHz
Integrated Phase Error = $\text{Phase}(\text{DSA Setting}) - \text{Phase}(\text{DSA Setting} = 0)$

図 4-57. TX Calibrated Integrated Phase Error vs DSA Setting and Channel at 1.8GHz

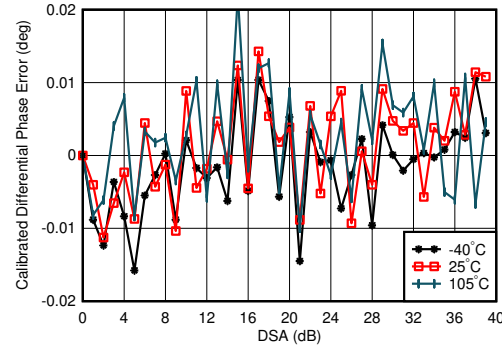
4.12.2 TX Typical Characteristics at 1.8GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48\text{MSPS}$ (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1\text{ dBFS}$, DSA = 0dB, $\text{Sin}(x)/x$ enabled, DSA calibrated



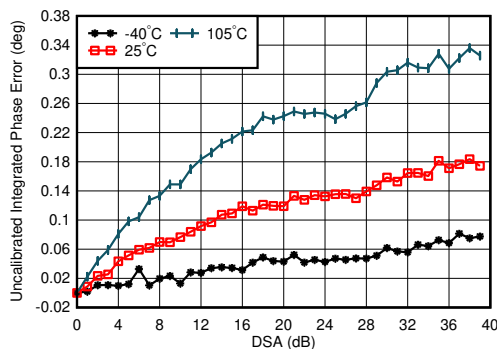
$f_{\text{DAC}} = 5898.24\text{MSPS}$, interleave mode, matching at 1.8GHz
 Differential Phase Error = $\text{Phase}_{\text{OUT}}(\text{DSA Setting} - 1) - \text{Phase}_{\text{OUT}}(\text{DSA Setting})$

図 4-58. TX Uncalibrated Differential Phase Error vs DSA Setting and Temperature at 1.8GHz



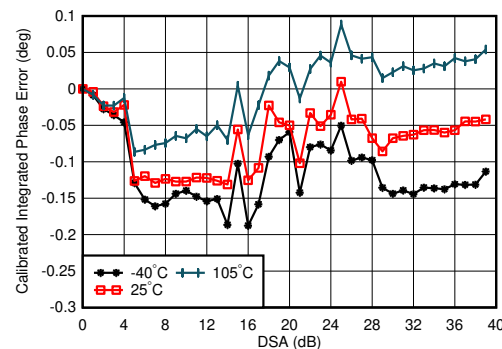
$f_{\text{DAC}} = 5898.24\text{MSPS}$, interleave mode, matching at 1.8GHz, channel with the median variation over DSA setting at 25°C
 Differential Phase Error = $\text{Phase}_{\text{OUT}}(\text{DSA Setting} - 1) - \text{Phase}_{\text{OUT}}(\text{DSA Setting})$

図 4-59. TX Calibrated Differential Phase Error vs DSA Setting and Temperature at 1.8GHz



$f_{\text{DAC}} = 5898.24\text{MSPS}$, interleave mode, matching at 1.8GHz, channel with the median variation over DSA setting at 25°C
 Integrated Phase Error = $\text{Phase}(\text{DSA Setting}) - \text{Phase}(\text{DSA Setting} = 0)$

図 4-60. TX Uncalibrated Integrated Phase Error vs DSA Setting and Temperature at 1.8GHz

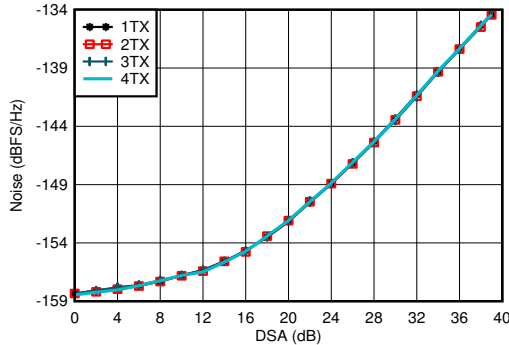


$f_{\text{DAC}} = 5898.24\text{MSPS}$, interleave mode, matching at 1.8GHz, channel with the median variation over DSA setting at 25°C
 Integrated Phase Error = $\text{Phase}(\text{DSA Setting}) - \text{Phase}(\text{DSA Setting} = 0)$

図 4-61. TX Calibrated Integrated Phase Error vs DSA Setting and Temperature at 1.8GHz

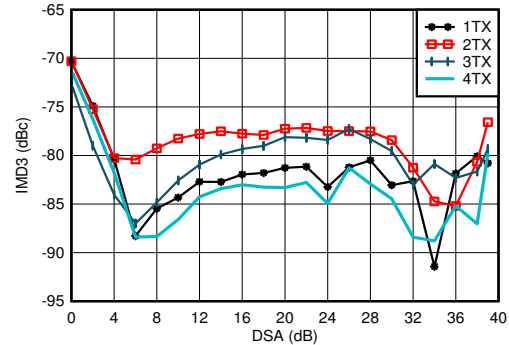
4.12.2 TX Typical Characteristics at 1.8GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48\text{MSPS}$ (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1\text{ dBFS}$, DSA = 0dB, Sin(x)/x enabled, DSA calibrated



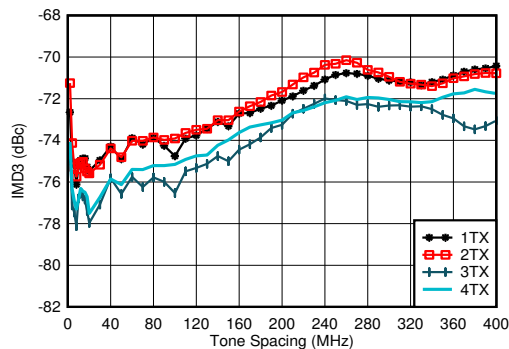
$f_{\text{DAC}} = 5898.24\text{MSPS}$, interleave mode, matching at 1.8GHz,
 $P_{\text{OUT}} = -13\text{dBFS}$

図 4-62. TX Output Noise vs Channel and Attenuation at 1.8GHz



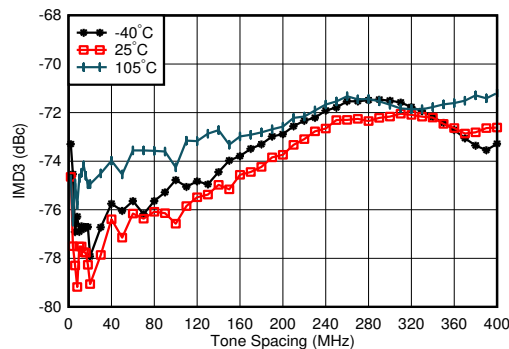
$f_{\text{DAC}} = 11796.48\text{MSPS}$, interleave mode, $f_{\text{CENTER}} = 1.8\text{GHz}$,
matching at 1.8GHz, -13dBFS each tone

図 4-63. TX IMD3 vs DSA Setting at 1.8GHz



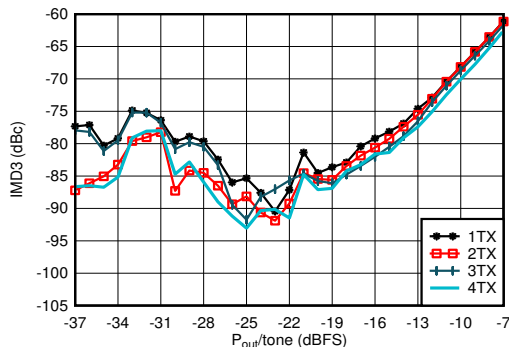
$f_{\text{DAC}} = 11796.48\text{MSPS}$, interleave mode, $f_{\text{CENTER}} = 1.8\text{GHz}$,
matching at 1.8GHz, -13dBFS each tone

図 4-64. TX IMD3 vs Tone Spacing and Channel at 1.8GHz



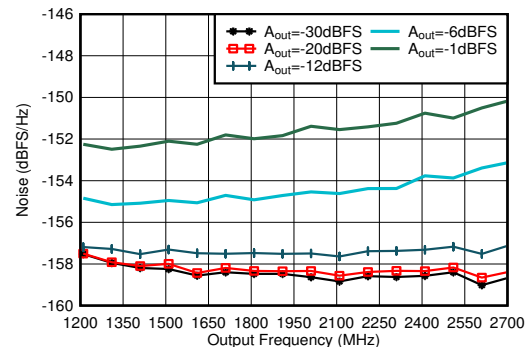
$f_{\text{DAC}} = 11796.48\text{MSPS}$, interleave mode, $f_{\text{CENTER}} = 1.8\text{GHz}$,
matching at 1.8GHz, -13dBFS each tone, worst channel

図 4-65. TX IMD3 vs Tone Spacing and Temperature at 1.8GHz



$f_{\text{DAC}} = 11796.48\text{MSPS}$, interleave mode, $f_{\text{CENTER}} = 1.8\text{GHz}$,
 $f_{\text{SPACING}} = 20\text{MHz}$, matching at 1.8GHz

図 4-66. TX IMD3 vs Digital Level at 1.8GHz

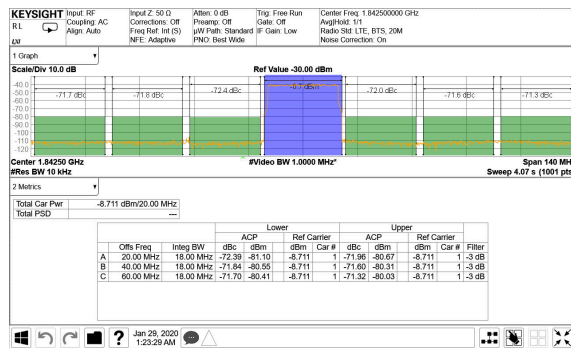


Matching at 2.6GHz, Single tone, $f_{\text{DAC}} = 11.79648\text{GSPS}$,
interleave mode, 40MHz offset

図 4-67. TX Single Tone Output Noise vs Frequency and Amplitude at 1.8GHz

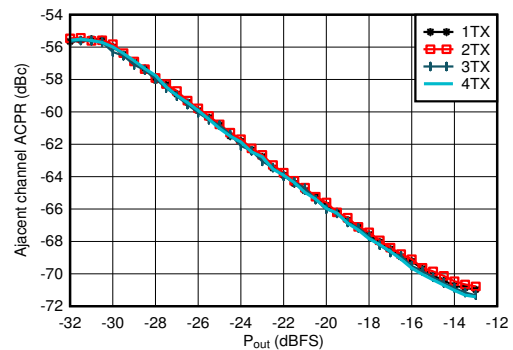
4.12.2 TX Typical Characteristics at 1.8GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48\text{MSPS}$ (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1\text{ dBFS}$, DSA = 0dB, $\text{Sin}(x)/x$ enabled, DSA calibrated



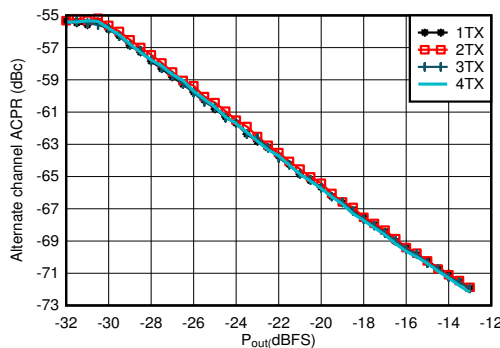
TM1.1, $P_{\text{OUT_RMS}} = -13\text{dBFS}$

FIG 4-68. TX 20-MHz LTE Output Spectrum at 1.8425GHz



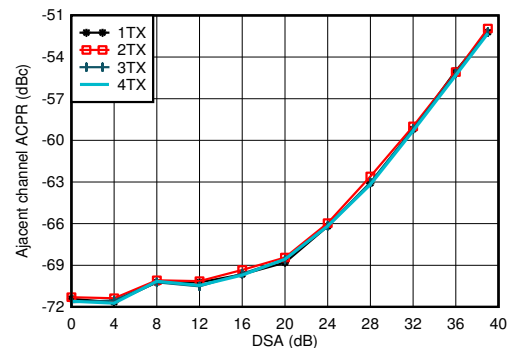
Matching at 1.8GHz, single carrier 20MHz BW TM1.1 LTE

FIG 4-69. TX 20MHz LTE ACPR vs Digital Level at 1.8425GHz



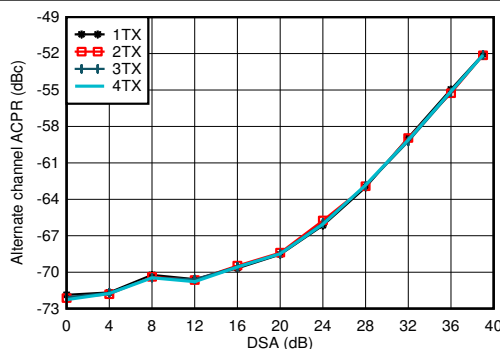
Matching at 1.8GHz, single carrier 20MHz BW TM1.1 LTE

FIG 4-70. TX 20MHz LTE alt-ACPR vs Digital Level at 1.8425GHz



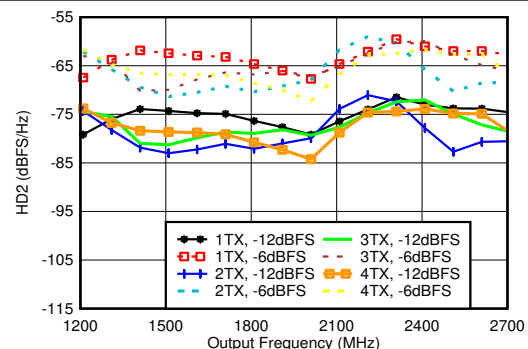
Matching at 1.8GHz, single carrier 20MHz BW TM1.1 LTE

FIG 4-71. TX 20MHz LTE ACPR vs DSA at 1.8GHz



Matching at 1.8GHz, single carrier 20MHz BW TM1.1 LTE

FIG 4-72. TX 20MHz LTE alt-ACPR vs DSA at 1.8GHz

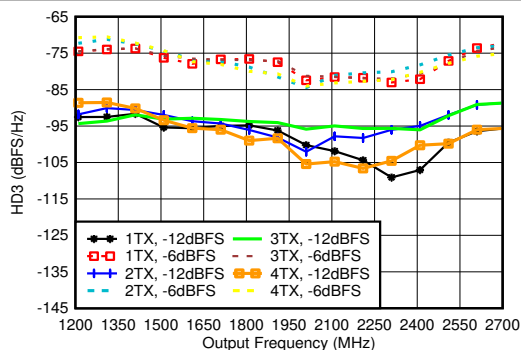


Matching at 1.8GHz, $f_{\text{DAC}} = 11.79648\text{GSPS}$, interleave mode, normalized to output power at harmonic frequency

FIG 4-73. TX HD2 vs Digital Amplitude and Output Frequency at 1.8GHz

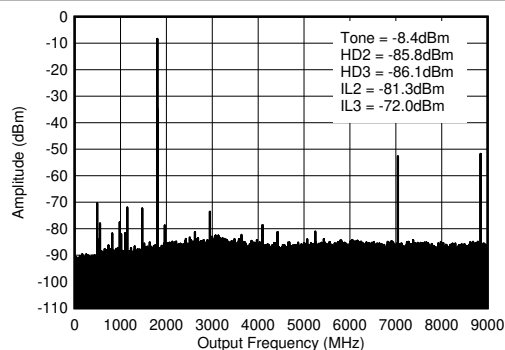
4.12.2 TX Typical Characteristics at 1.8GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48\text{MSPS}$ (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1\text{ dBFS}$, DSA = 0dB, Sin(x)/x enabled, DSA calibrated



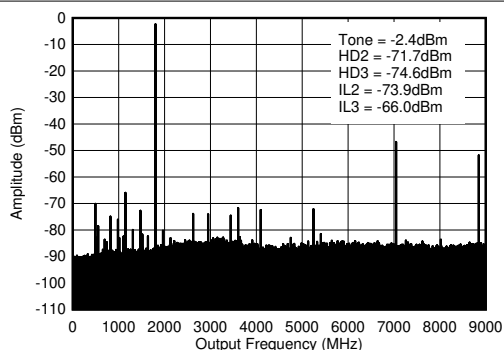
Matching at 1.8GHz, $f_{\text{DAC}} = 11.79648\text{GSPS}$, interleave mode, normalized to output power at harmonic frequency

図 4-74. TX HD3 vs Digital Amplitude and Output Frequency at 1.8GHz



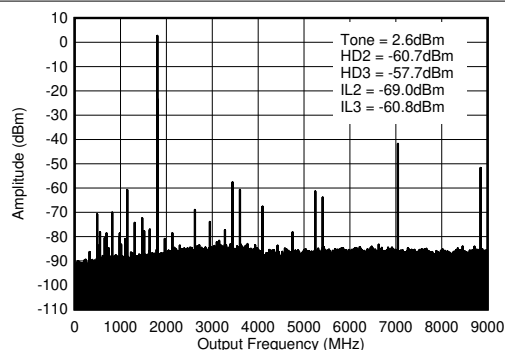
$f_{\text{DAC}} = 8847.36\text{MSPS}$, straight mode, 1.8GHz matching, includes PCB and cable losses. $\text{ILn} = f_{\text{S}}/n \pm f_{\text{OUT}}$ and is due to mixing with digital clocks.

図 4-75. TX Single Tone (-12 dBFS) Output Spectrum at 1.8GHz ($0-f_{\text{DAC}}$)



$f_{\text{DAC}} = 8847.36\text{MSPS}$, straight mode, 1.8GHz matching, includes PCB and cable losses. $\text{ILn} = f_{\text{S}}/n \pm f_{\text{OUT}}$ and is due to mixing with digital clocks.

図 4-76. TX Single Tone (-6 dBFS) Output Spectrum at 1.8GHz ($0-f_{\text{DAC}}$)

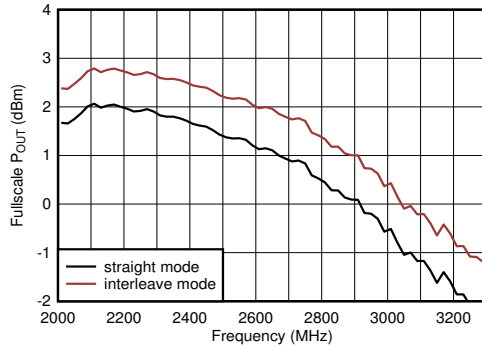


$f_{\text{DAC}} = 8847.36\text{MSPS}$, straight mode, 1.8GHz matching, includes PCB and cable losses. $\text{ILn} = f_{\text{S}}/n \pm f_{\text{OUT}}$ and is due to mixing with digital clocks.

図 4-77. TX Single Tone (-1dBFS) Output Spectrum at 1.8GHz ($0-f_{\text{DAC}}$)

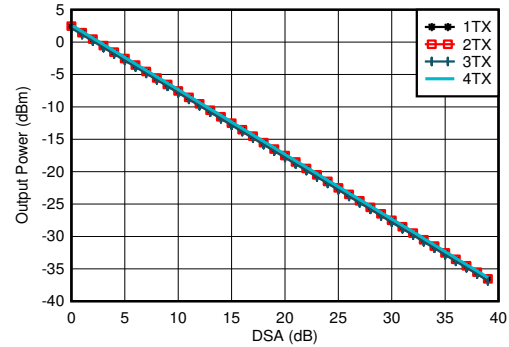
4.12.3 TX Typical Characteristics at 2.6GHz

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48\text{MSPS}$ (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1\text{dBFS}$, DSA = 0dB, Sin(x)/x enabled, DSA calibrated



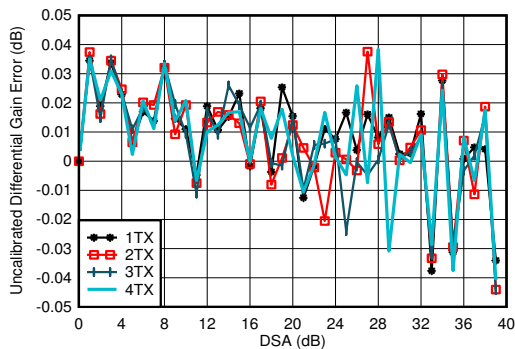
Including PCB and cable losses, $A_{\text{out}} = -0.5\text{dBFS}$, DSA = 0, 2.6GHz matching

FIG 4-78. TX Full Scale vs RF Frequency at 11796.48MSPS



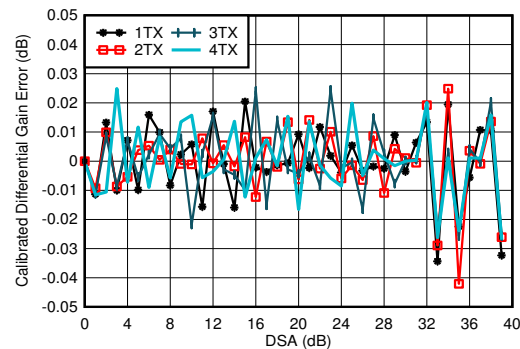
$f_{\text{DAC}} = 8847.36\text{MSPS}$, $A_{\text{out}} = -0.5\text{dBFS}$, matching 2.6GHz

FIG 4-79. TX Output Power vs DSA Setting and Channel at 2.6GHz



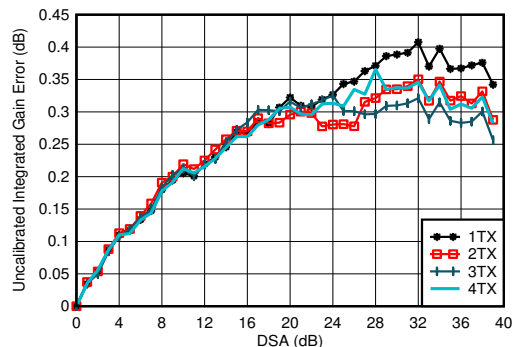
$f_{\text{DAC}} = 8847.36\text{MSPS}$, straight mode, matching at 2.6GHz
Differential Gain Error = $P_{\text{OUT}}(\text{DSA Setting} - 1) - P_{\text{OUT}}(\text{DSA Setting}) + 1$

FIG 4-80. TX Uncalibrated Differential Gain Error vs DSA Setting and Channel at 2.6GHz



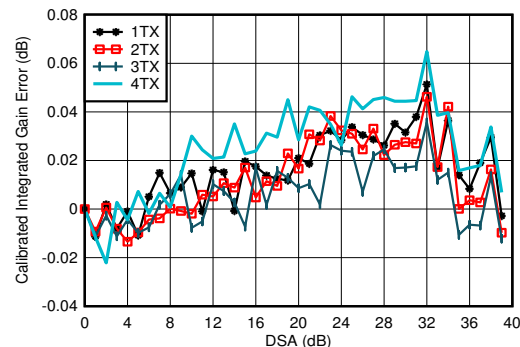
$f_{\text{DAC}} = 8847.36\text{MSPS}$, straight mode, matching at 2.6GHz
Differential Gain Error = $P_{\text{OUT}}(\text{DSA Setting} - 1) - P_{\text{OUT}}(\text{DSA Setting}) + 1$

FIG 4-81. TX Calibrated Differential Gain Error vs DSA Setting and Channel at 2.6GHz



$f_{\text{DAC}} = 8847.36\text{MSPS}$, straight mode, matching at 2.6GHz
Integrated Gain Error = $P_{\text{OUT}}(\text{DSA Setting}) - P_{\text{OUT}}(\text{DSA Setting} = 0) + (\text{DSA Setting})$

FIG 4-82. TX Uncalibrated Integrated Gain Error vs DSA Setting and Channel at 2.6GHz

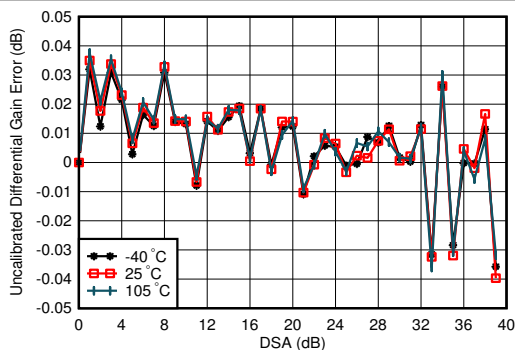


$f_{\text{DAC}} = 8847.36\text{MSPS}$, straight mode, matching at 2.6GHz
Integrated Gain Error = $P_{\text{OUT}}(\text{DSA Setting}) - P_{\text{OUT}}(\text{DSA Setting} = 0) + (\text{DSA Setting})$

FIG 4-83. TX Calibrated Integrated Gain Error vs DSA Setting and Channel at 2.6GHz

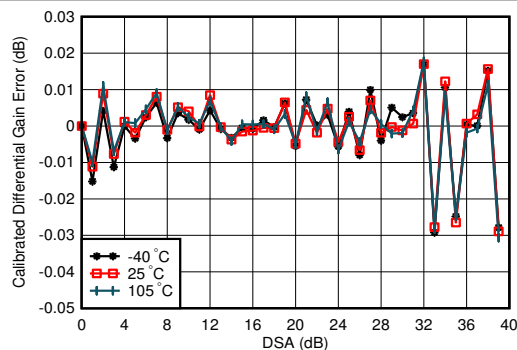
4.12.3 TX Typical Characteristics at 2.6GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48\text{MSPS}$ (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1\text{dBFS}$, DSA = 0dB, Sin(x)/x enabled, DSA calibrated



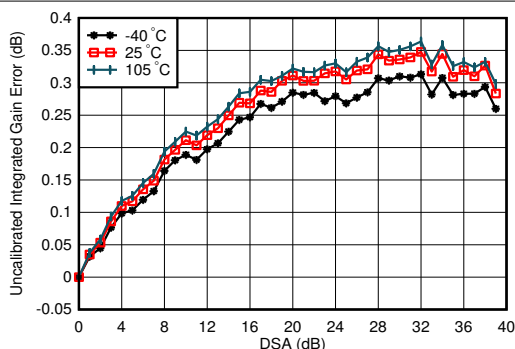
$f_{\text{DAC}} = 8847.36\text{MSPS}$, straight mode, matching at 2.6GHz, channel with the median variation over DSA setting at 25°C
Differential Gain Error = $P_{\text{OUT}}(\text{DSA Setting} - 1) - P_{\text{OUT}}(\text{DSA Setting}) + 1$

図 4-84. TX Uncalibrated Differential Gain Error vs DSA Setting and Temperature at 2.6GHz



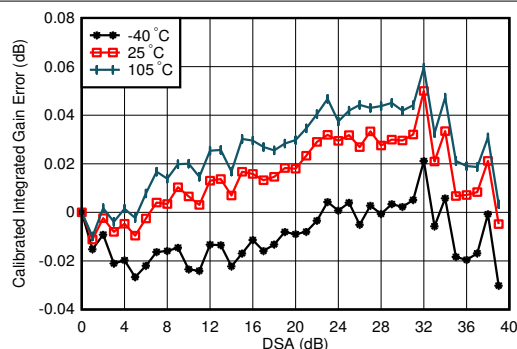
$f_{\text{DAC}} = 8847.36\text{MSPS}$, straight mode, matching at 2.6GHz, channel with the median variation over DSA setting at 25°C
Differential Gain Error = $P_{\text{OUT}}(\text{DSA Setting} - 1) - P_{\text{OUT}}(\text{DSA Setting}) + 1$

図 4-85. TX Calibrated Differential Gain Error vs DSA Setting and Temperature at 2.6GHz



$f_{\text{DAC}} = 8847.36\text{MSPS}$, straight mode, matching at 2.6GHz, channel with the median variation over DSA setting at 25°C
Integrated Gain Error = $P_{\text{OUT}}(\text{DSA Setting}) - P_{\text{OUT}}(\text{DSA Setting} = 0) + (\text{DSA Setting})$

図 4-86. TX Uncalibrated Integrated Gain Error vs DSA Setting and Temperature at 2.6GHz

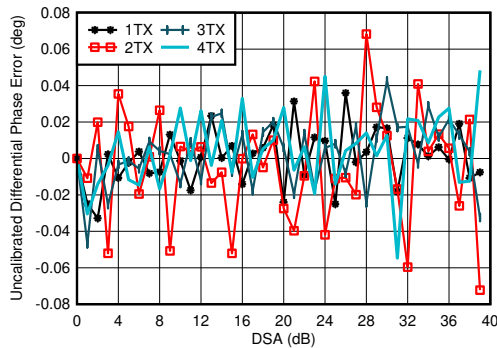


$f_{\text{DAC}} = 8847.36\text{MSPS}$, straight mode, matching at 2.6GHz, channel with the median variation over DSA setting at 25°C
Integrated Gain Error = $P_{\text{OUT}}(\text{DSA Setting}) - P_{\text{OUT}}(\text{DSA Setting} = 0) + (\text{DSA Setting})$

図 4-87. TX Calibrated Integrated Gain Error vs DSA Setting and Temperature at 2.6GHz

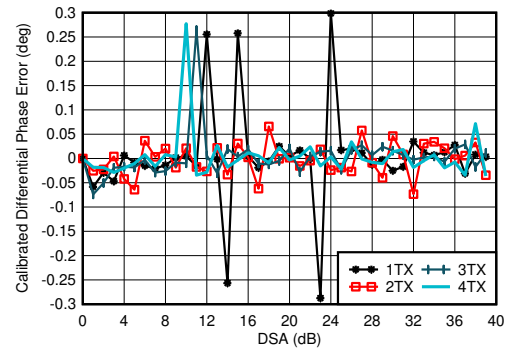
4.12.3 TX Typical Characteristics at 2.6GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48\text{MSPS}$ (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1\text{dBFS}$, DSA = 0dB, Sin(x)/x enabled, DSA calibrated



$f_{\text{DAC}} = 8847.36\text{MSPS}$, straight mode, matching at 2.6GHz
 Differential Phase Error = $\text{Phase}_{\text{OUT}}(\text{DSA Setting} - 1) - \text{Phase}_{\text{OUT}}(\text{DSA Setting})$

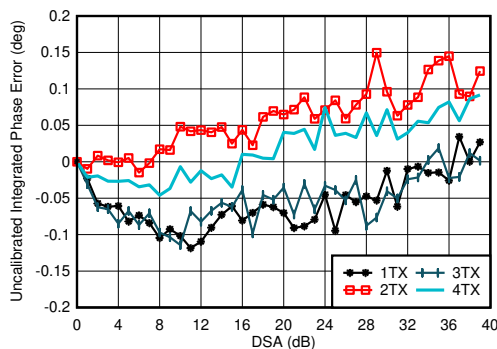
図 4-88. TX Uncalibrated Differential Phase Error vs DSA Setting and Channel at 2.6GHz



$f_{\text{DAC}} = 8847.36\text{MSPS}$, straight mode, matching at 2.6GHz
 Differential Phase Error = $\text{Phase}_{\text{OUT}}(\text{DSA Setting} - 1) - \text{Phase}_{\text{OUT}}(\text{DSA Setting})$

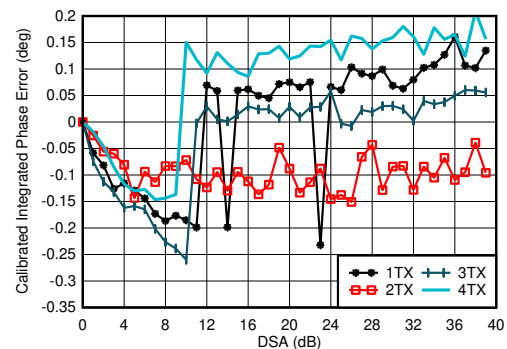
Phase DNL spike may occur at any DSA setting.

図 4-89. TX Calibrated Differential Phase Error vs DSA Setting and Channel at 2.6GHz



$f_{\text{DAC}} = 8847.36\text{MSPS}$, straight mode, matching at 2.6GHz
 Integrated Phase Error = $\text{Phase}(\text{DSA Setting}) - \text{Phase}(\text{DSA Setting} = 0)$

図 4-90. TX Uncalibrated Integrated Phase Error vs DSA Setting and Channel at 2.6GHz

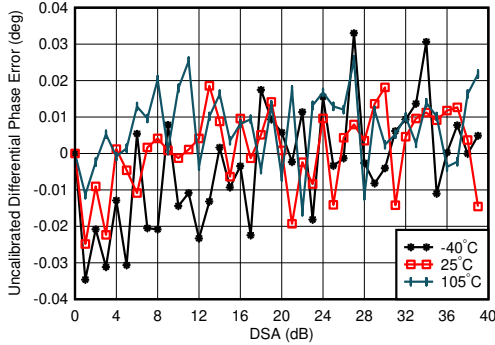


$f_{\text{DAC}} = 8847.36\text{MSPS}$, straight mode, matching at 2.6GHz
 Integrated Phase Error = $\text{Phase}(\text{DSA Setting}) - \text{Phase}(\text{DSA Setting} = 0)$

図 4-91. TX Calibrated Integrated Phase Error vs DSA Setting and Channel at 2.6GHz

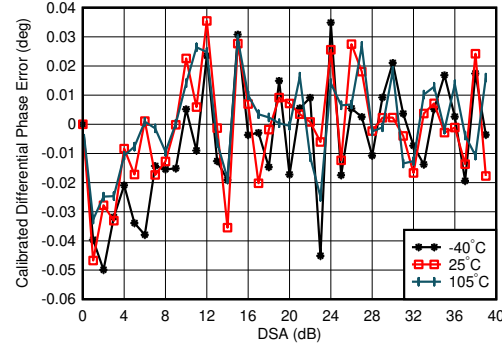
4.12.3 TX Typical Characteristics at 2.6GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48\text{MSPS}$ (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1\text{dBFS}$, DSA = 0dB, Sin(x)/x enabled, DSA calibrated



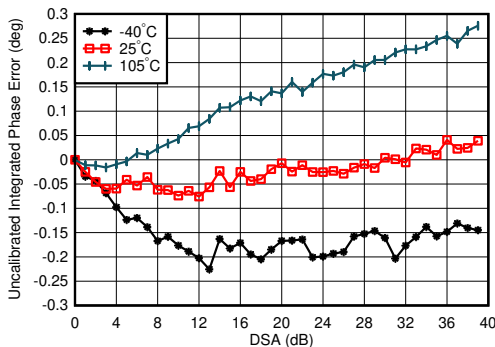
$f_{\text{DAC}} = 8847.36\text{MSPS}$, straight mode, matching at 2.6GHz, channel with the median variation over DSA setting at 25°C
Differential Phase Error = $\text{Phase}_{\text{OUT}}(\text{DSA Setting} - 1) - \text{Phase}_{\text{OUT}}(\text{DSA Setting})$

図 4-92. TX Uncalibrated Differential Phase Error vs DSA Setting and Temperature at 2.6GHz



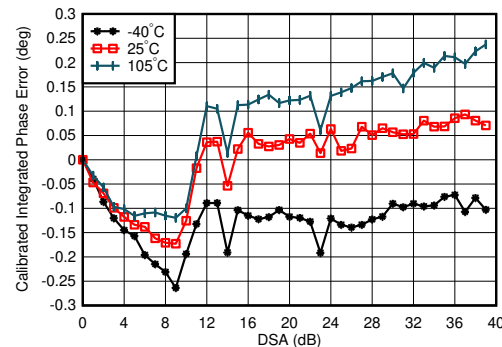
$f_{\text{DAC}} = 8847.36\text{MSPS}$, straight mode, matching at 2.6GHz, channel with the median variation over DSA setting at 25°C
Differential Phase Error = $\text{Phase}_{\text{OUT}}(\text{DSA Setting} - 1) - \text{Phase}_{\text{OUT}}(\text{DSA Setting})$

図 4-93. TX Calibrated Differential Phase Error vs DSA Setting and Temperature at 2.6GHz



$f_{\text{DAC}} = 8847.36\text{MSPS}$, straight mode, matching at 2.6GHz, channel with the medium variation over DSA setting at 25°C
Integrated Phase Error = $\text{Phase}(\text{DSA Setting}) - \text{Phase}(\text{DSA Setting} = 0)$

図 4-94. TX Uncalibrated Integrated Phase Error vs DSA Setting and Temperature at 2.6GHz

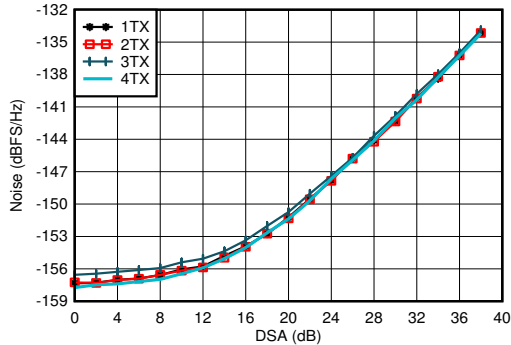


$f_{\text{DAC}} = 8847.36\text{MSPS}$, straight mode, matching at 2.6GHz, channel with the median variation over DSA setting at 25°C
Integrated Phase Error = $\text{Phase}(\text{DSA Setting}) - \text{Phase}(\text{DSA Setting} = 0)$

図 4-95. TX Calibrated Integrated Phase Error vs DSA Setting and Temperature at 2.6GHz

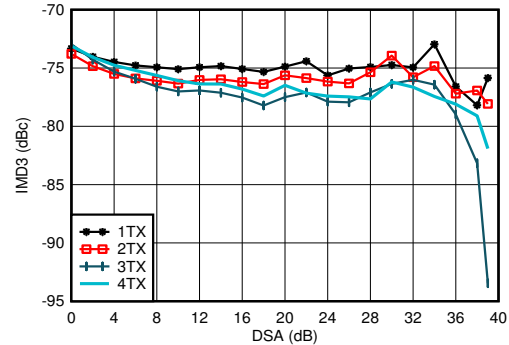
4.12.3 TX Typical Characteristics at 2.6GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48\text{MSPS}$ (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1\text{dBFS}$, DSA = 0dB, Sin(x)/x enabled, DSA calibrated



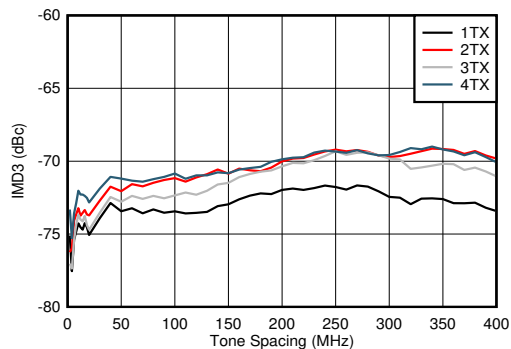
$f_{\text{DAC}} = 8847.36\text{MSPS}$, straight mode, matching at 2.6GHz,
 $P_{\text{OUT}} = -13\text{ dBFS}$

FIG 4-96. TX Output Noise vs Channel and Attenuation at 2.6GHz



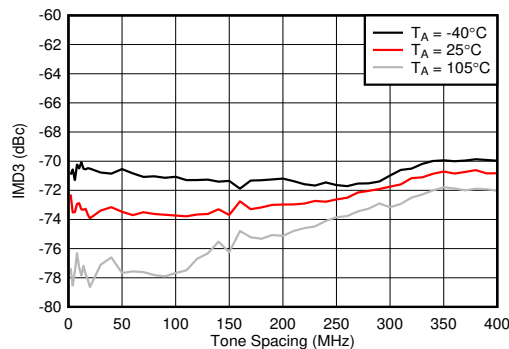
$f_{\text{DAC}} = 8847.36\text{MSPS}$, straight mode, $f_{\text{CENTER}} = 2.6\text{GHz}$,
 matching at 2.6GHz, -13 dBFS each tone

FIG 4-97. TX IMD3 vs DSA Setting at 2.6GHz



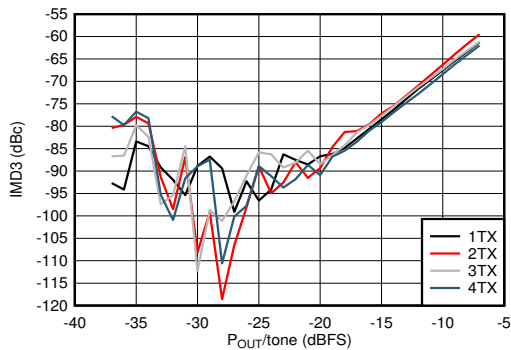
$f_{\text{DAC}} = 8847.36\text{MSPS}$, straight mode, $f_{\text{CENTER}} = 2.6\text{GHz}$,
 matching at 2.6GHz, -13 dBFS each tone

FIG 4-98. TX IMD3 vs Tone Spacing and Channel at 2.6GHz



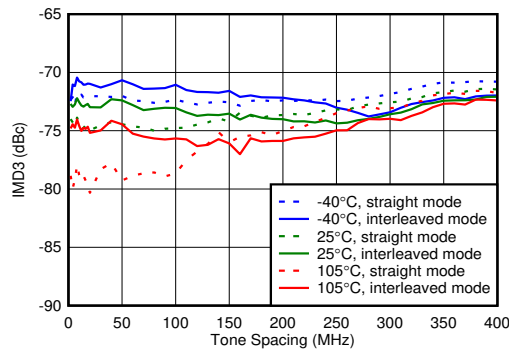
$f_{\text{DAC}} = 8847.36\text{MSPS}$, straight mode, $f_{\text{CENTER}} = 2.6\text{GHz}$,
 matching at 2.6GHz, -13 dBFS each tone, worst channel.

FIG 4-99. TX IMD3 vs Tone Spacing and Temperature at 2.6GHz



$f_{\text{DAC}} = 8847.36\text{MSPS}$, straight mode, $f_{\text{CENTER}} = 2.6\text{GHz}$,
 $f_{\text{SPACING}} = 20\text{ MHz}$, matching at 2.6GHz

FIG 4-100. TX IMD3 vs Digital Level at 2.6GHz

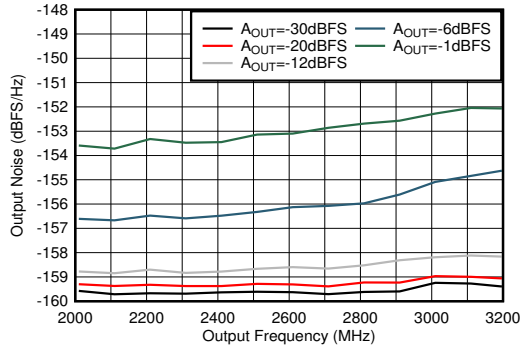


$f_{\text{DAC}} = 8847.36\text{MSPS}$, straight mode, $f_{\text{CENTER}} = 2.6\text{GHz}$,
 matching at 2.6GHz, -13 dBFS each tone

FIG 4-101. TX IMD3 vs Tone Spacing and Temperature

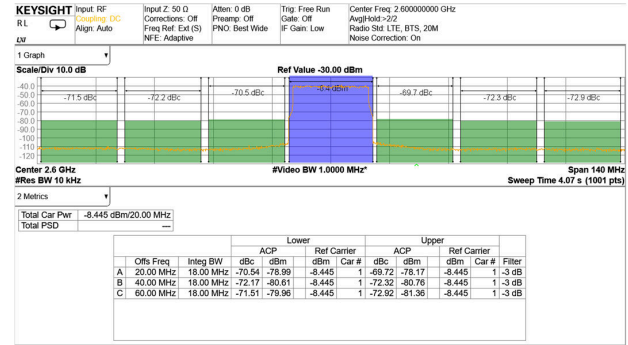
4.12.3 TX Typical Characteristics at 2.6GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48\text{MSPS}$ (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1\text{dBFS}$, DSA = 0dB, Sin(x)/x enabled, DSA calibrated



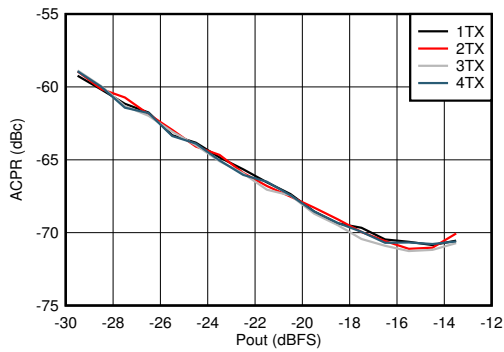
Matching at 2.6GHz, Single tone, $f_{\text{DAC}} = 11.79648\text{GSPS}$, interleave mode, 40-MHz offset

FIG 4-102. TX Single Tone Output Noise vs Frequency and Amplitude at 2.6GHz



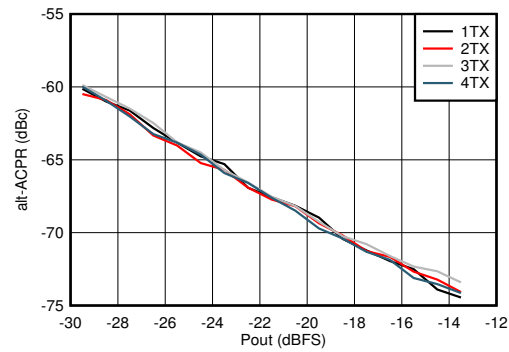
TM1.1, $P_{\text{OUT_RMS}} = -13\text{dBFS}$

FIG 4-103. TX 20-MHz LTE Output Spectrum at 2.6GHz (Band 41)



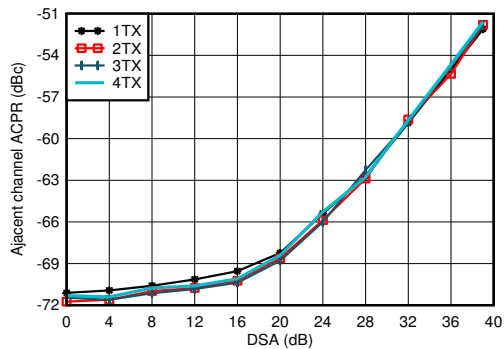
Matching at 2.6GHz, single carrier 20MHz BW TM1.1 LTE

FIG 4-104. TX 20-MHz LTE ACPR vs Digital Level at 2.6GHz



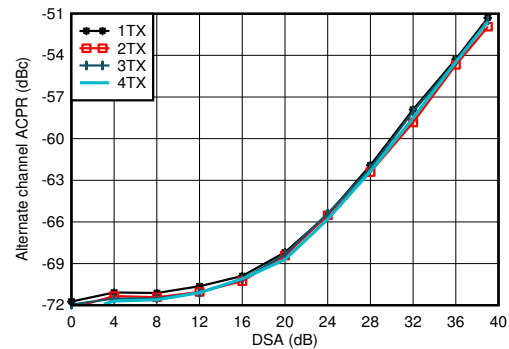
Matching at 2.6GHz, single carrier 20MHz BW TM1.1 LTE

FIG 4-105. TX 20-MHz LTE alt-ACPR vs Digital Level at 2.6GHz



Matching at 2.6GHz, single carrier 20MHz BW TM1.1 LTE

FIG 4-106. TX 20-MHz LTE ACPR vs DSA at 2.6GHz

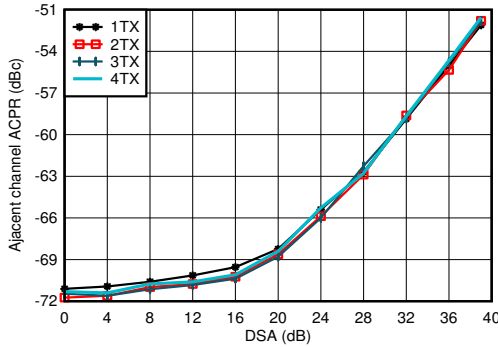


Matching at 2.6GHz, single carrier 20MHz BW TM1.1 LTE

FIG 4-107. TX 20-MHz LTE alt-ACPR vs DSA at 2.6GHz

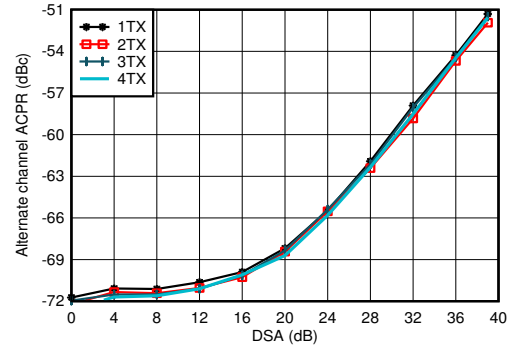
4.12.3 TX Typical Characteristics at 2.6GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48\text{MSPS}$ (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1\text{dBFS}$, DSA = 0dB, Sin(x)/x enabled, DSA calibrated



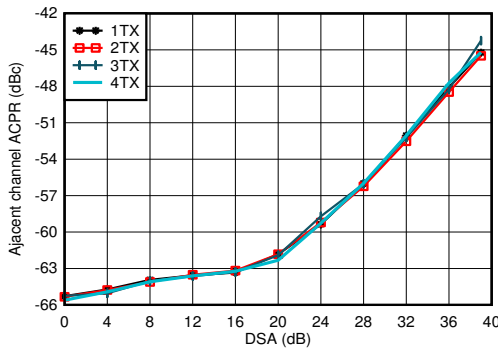
Matching at 2.6GHz, single carrier 20MHz BW TM1.1 LTE

FIG 4-108. TX 20-MHz LTE ACPR vs DSA at 2.6GHz



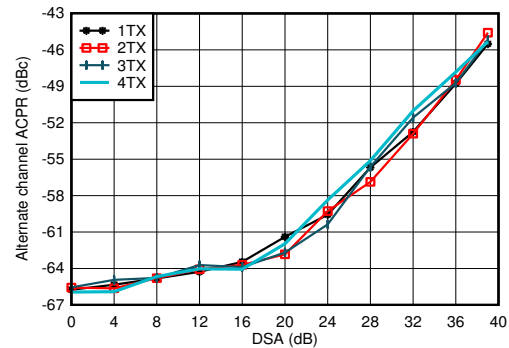
Matching at 2.6GHz, single carrier 20MHz BW TM1.1 LTE

FIG 4-109. TX 20-MHz LTE alt-ACPR vs DSA at 2.6GHz



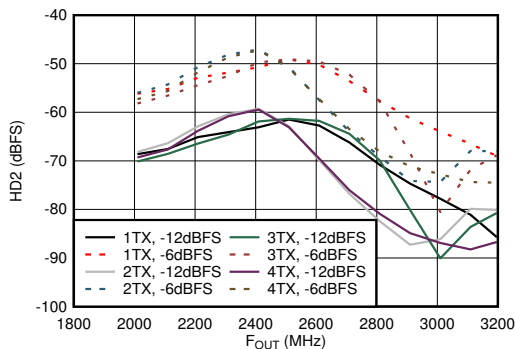
Matching at 2.6GHz, single carrier 100MHz BW TM1.1 NR

FIG 4-110. TX 100-MHz NR ACPR vs DSA at 2.6GHz



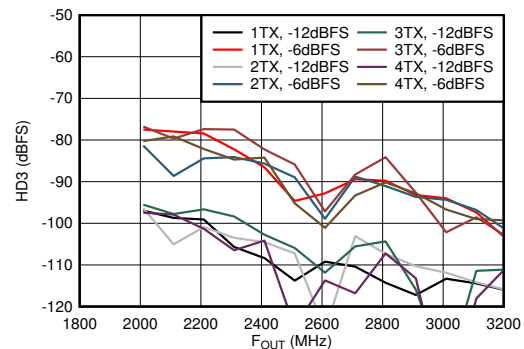
Matching at 2.6GHz, single carrier 100MHz BW TM1.1 NR

FIG 4-111. TX 100-MHz NR alt-ACPR vs DSA at 2.6GHz



Matching at 2.6GHz, $f_{\text{DAC}} = 11.79648\text{GSPS}$, interleave mode, normalized to output power at harmonic frequency

FIG 4-112. TX HD2 vs Digital Amplitude and Output Frequency at 2.6GHz

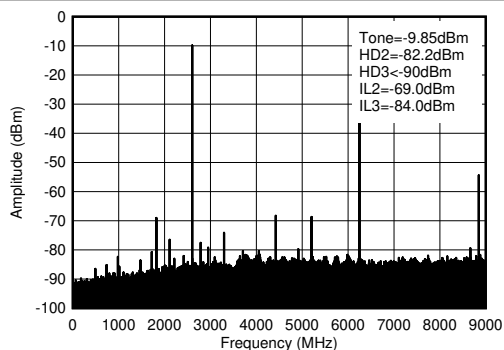


Matching at 2.6GHz, $f_{\text{DAC}} = 11.79648\text{GSPS}$, interleave mode, normalized to output power at harmonic frequency

FIG 4-113. TX HD3 vs Digital Amplitude and Output Frequency at 2.6GHz

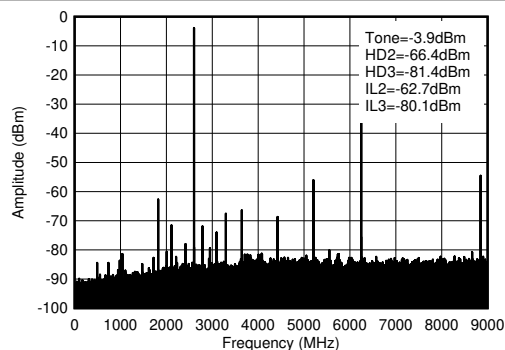
4.12.3 TX Typical Characteristics at 2.6GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48\text{MSPS}$ (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1\text{dBFS}$, DSA = 0dB, Sin(x)/x enabled, DSA calibrated



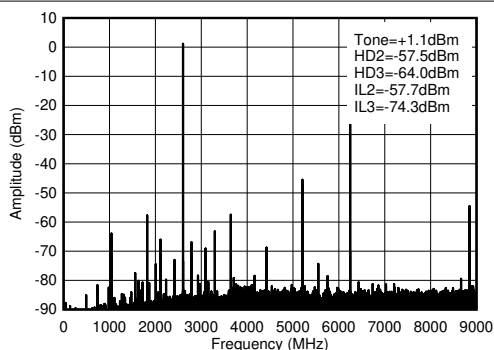
$f_{\text{DAC}} = 8847.36\text{MSPS}$, straight mode, 2.6GHz matching, includes PCB and cable losses. $\text{ILn} = f_{\text{S}}/n \pm f_{\text{OUT}}$ and is due to mixing with digital clocks.

図 4-114. TX Single Tone (-12dBFS) Output Spectrum at 2.6GHz ($0-f_{\text{DAC}}$)



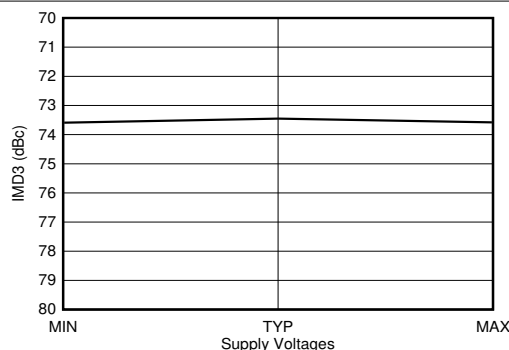
$f_{\text{DAC}} = 8847.36\text{MSPS}$, straight mode, 2.6GHz matching, includes PCB and cable losses. $\text{ILn} = f_{\text{S}}/n \pm f_{\text{OUT}}$ and is due to mixing with digital clocks.

図 4-115. TX Single Tone (-6dBFS) Output Spectrum at 2.6GHz ($0-f_{\text{DAC}}$)



$f_{\text{DAC}} = 8847.36\text{MSPS}$, straight mode, 2.6GHz matching, includes PCB and cable losses. $\text{ILn} = f_{\text{S}}/n \pm f_{\text{OUT}}$ and is due to mixing with digital clocks.

図 4-116. TX Single Tone (-1dBFS) Output Spectrum at 2.6GHz ($0-f_{\text{DAC}}$)

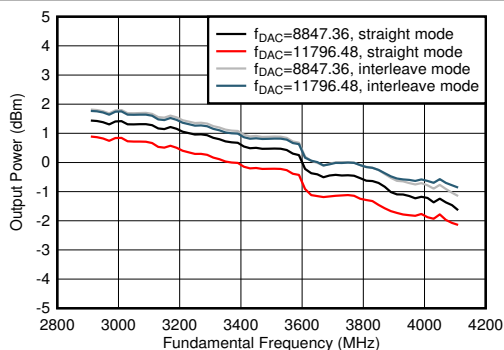


$f_{\text{DAC}} = 11796.48\text{MSPS}$, interleave mode, 2.6GHz matching. 40MHz offset from tone. Output Power = -13dBFS. All supplies simultaneously at MIN, TYP, or MAX voltages.

図 4-117. TX IMD3 vs Supply Voltage at 2.6GHz

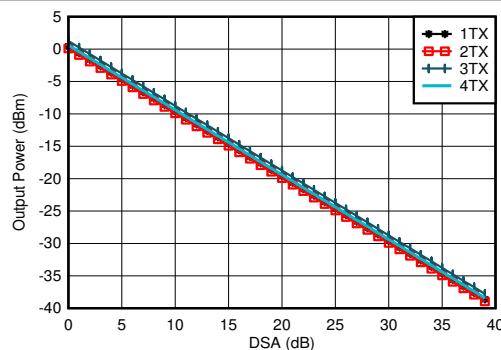
4.12.4 TX Typical Characteristics at 3.5GHz

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48\text{MSPS}$ (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1\text{dBFS}$, DSA = 0dB, Sin(x)/x enabled, DSA calibrated



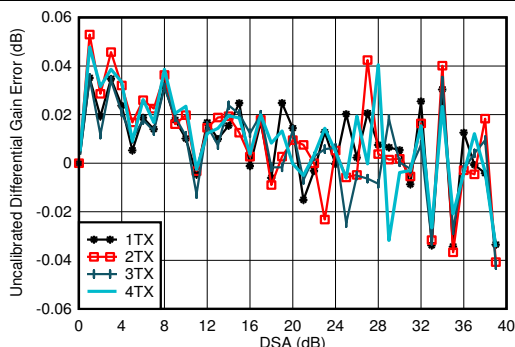
$A_{\text{out}} = -0.5\text{dBFS}$, 3.5GHz Matching, included PCB and cable losses

Figure 4-118. TX Output Power vs Frequency



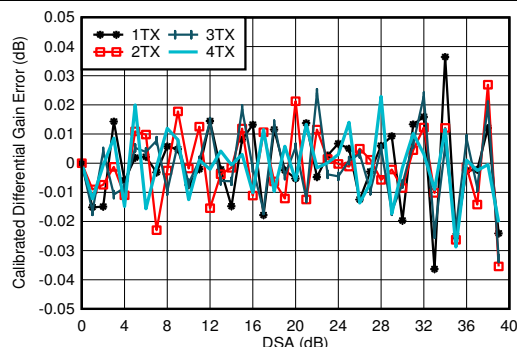
$A_{\text{out}} = -0.5\text{dBFS}$, 3.5GHz Matching, included PCB and cable losses

Figure 4-119. TX Output Power vs DSA Setting at 3.5GHz



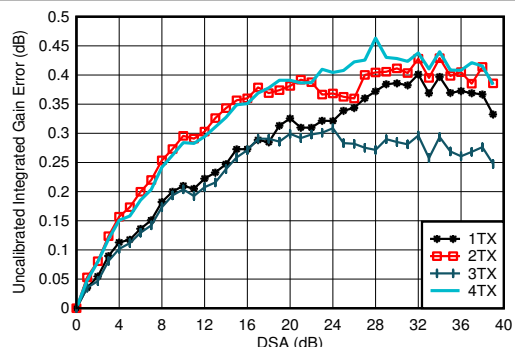
3.5GHz Matching, included PCB and cable losses
Differential Gain Error = $P_{\text{OUT}}(\text{DSA Setting} - 1) - P_{\text{OUT}}(\text{DSA Setting}) + 1$

Figure 4-120. TX Uncalibrated Differential Gain Error vs DSA Setting and Channel at 3.5GHz



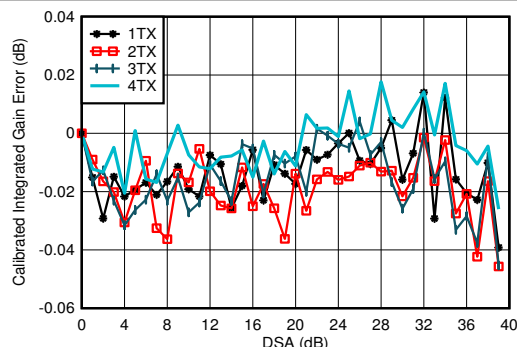
3.5GHz Matching, included PCB and cable losses
Differential Gain Error = $P_{\text{OUT}}(\text{DSA Setting} - 1) - P_{\text{OUT}}(\text{DSA Setting}) + 1$

Figure 4-121. TX Calibrated Differential Gain Error vs DSA Setting and Channel at 3.5GHz



3.5GHz Matching, included PCB and cable losses
Integrated Gain Error = $P_{\text{OUT}}(\text{DSA Setting}) - P_{\text{OUT}}(\text{DSA Setting} = 0) + (\text{DSA Setting})$

Figure 4-122. TX Uncalibrated Integrated Gain Error vs DSA Setting and Channel at 3.5GHz

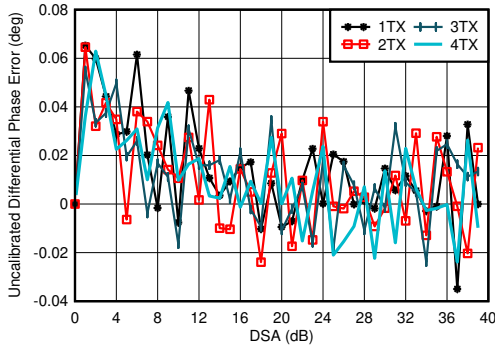


3.5GHz Matching, included PCB and cable losses
Integrated Gain Error = $P_{\text{OUT}}(\text{DSA Setting}) - P_{\text{OUT}}(\text{DSA Setting} = 0) + (\text{DSA Setting})$

Figure 4-123. TX Calibrated Integrated Gain Error vs DSA Setting and Channel at 3.5GHz

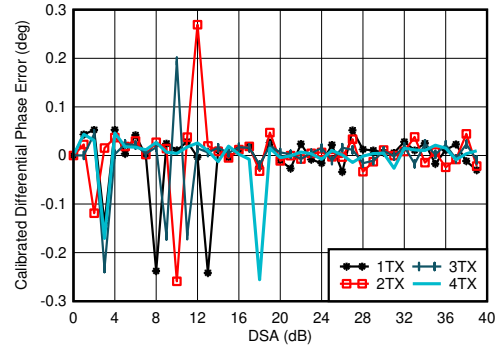
4.12.4 TX Typical Characteristics at 3.5GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48\text{MSPS}$ (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1\text{dBFS}$, DSA = 0dB, Sin(x)/x enabled, DSA calibrated



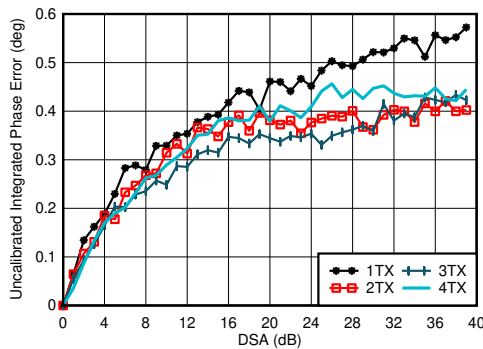
3.5GHz Matching, included PCB and cable losses

FIG 4-124. TX Uncalibrated Differential Phase Error vs DSA Setting and Channel at 3.5GHz



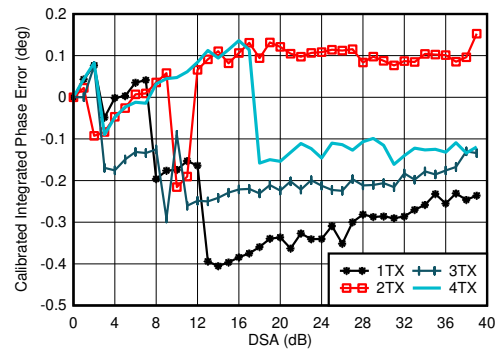
3.5GHz Matching, included PCB and cable losses
Phase DNL spike may occur at any DSA setting.

FIG 4-125. TX Calibrated Differential Phase Error vs DSA Setting and Channel at 3.5GHz



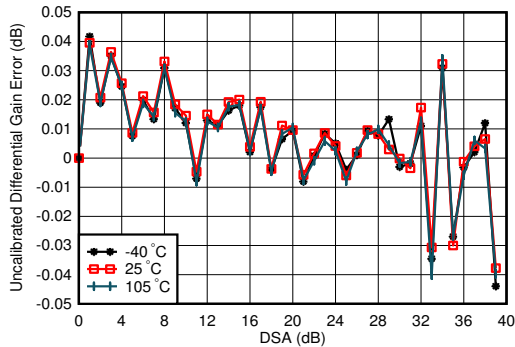
3.5GHz Matching, included PCB and cable losses

FIG 4-126. TX Uncalibrated Integrated Phase Error vs DSA Setting and Channel at 3.5GHz



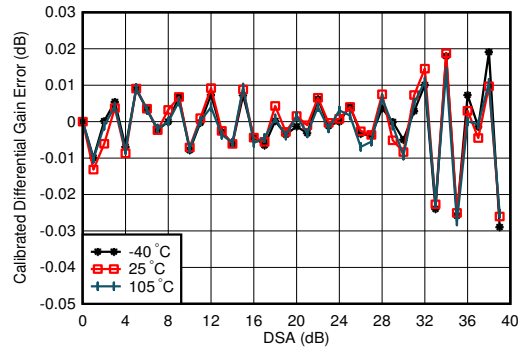
3.5GHz Matching, included PCB and cable losses

FIG 4-127. TX Calibrated Integrated Phase Error vs DSA Setting and Channel at 3.5GHz



3.5GHz Matching, 1TX

FIG 4-128. TX Uncalibrated Differential Gain Error vs DSA Setting and Temperature at 3.5GHz

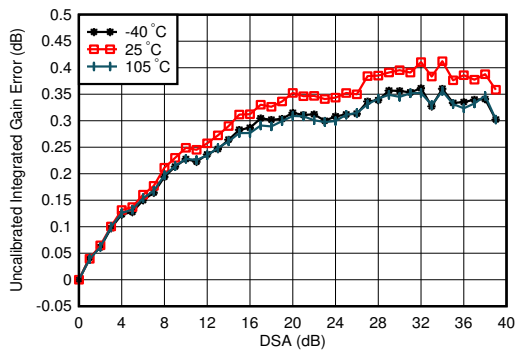


3.5GHz Matching, 1TX, Calibrated at 25°C

FIG 4-129. TX Calibrated Differential Gain Error vs DSA Setting and Temperature at 3.5GHz

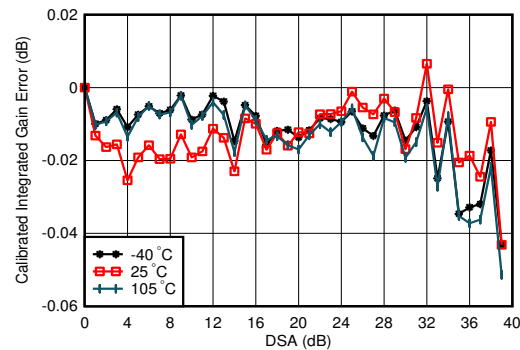
4.12.4 TX Typical Characteristics at 3.5GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48\text{MSPS}$ (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1\text{dBFS}$, DSA = 0dB, Sin(x)/x enabled, DSA calibrated



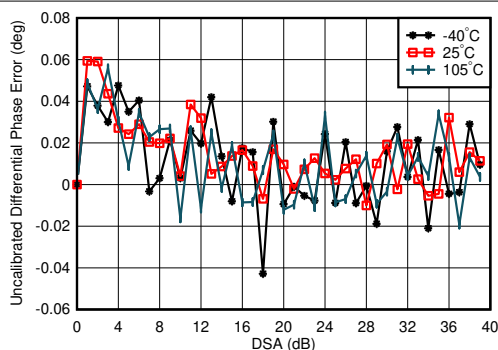
3.5GHz Matching, 1TX

图 4-130. TX Uncalibrated Integrated Gain Error vs DSA Setting and Temperature at 3.5GHz



3.5GHz Matching, 1TX, Calibrated at 25°C

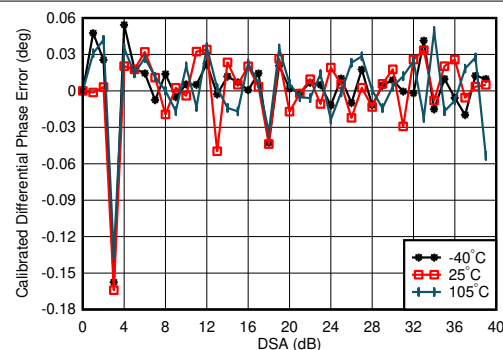
图 4-131. TX Calibrated Integrated Gain Error vs DSA Setting and Temperature at 3.5GHz



3.5GHz Matching, 1TX

Differential Phase Error = $\text{Phase}_{\text{OUT}}(\text{DSA Setting} - 1) - \text{Phase}_{\text{OUT}}(\text{DSA Setting})$

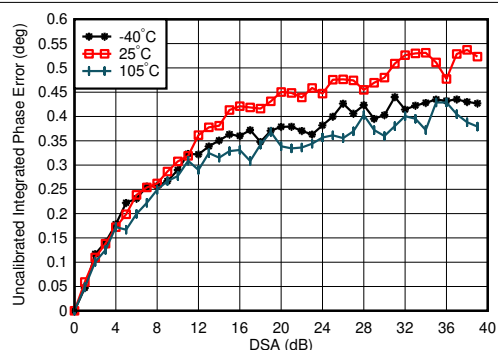
图 4-132. TX Uncalibrated Differential Phase Error vs DSA setting and Temperature at 3.5GHz



3.5GHz Matching, 1TX, Calibrated at 25°C

Differential Phase Error = $\text{Phase}_{\text{OUT}}(\text{DSA Setting} - 1) - \text{Phase}_{\text{OUT}}(\text{DSA Setting})$

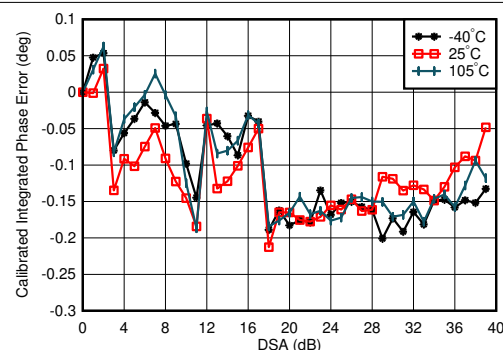
图 4-133. TX Calibrated Differential Phase Error vs DSA Setting and Temperature at 3.5GHz



3.5GHz Matching, 1TX

Integrated Phase Error = $\text{Phase}(\text{DSA Setting}) - \text{Phase}(\text{DSA Setting}=0)$

图 4-134. TX Uncalibrated Integrated Phase Error vs DSA Setting and Temperature at 3.5GHz



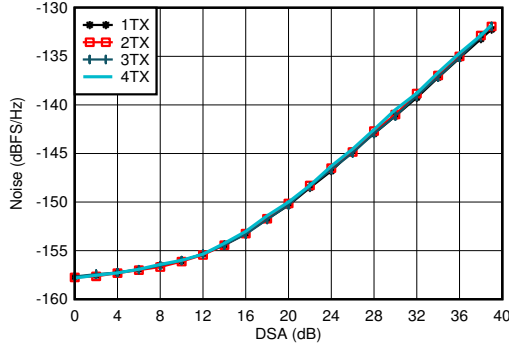
3.5GHz Matching, 1TX, Calibrated at 25°C

Integrated Phase Error = $\text{Phase}(\text{DSA Setting}) - \text{Phase}(\text{DSA Setting} = 0)$

图 4-135. TX Calibrated Integrated Phase Error vs DSA Setting and Temperature at 3.5GHz

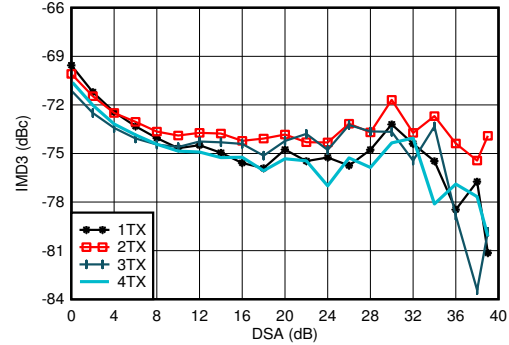
4.12.4 TX Typical Characteristics at 3.5GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48\text{MSPS}$ (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1\text{dBFS}$, DSA = 0dB, Sin(x)/x enabled, DSA calibrated



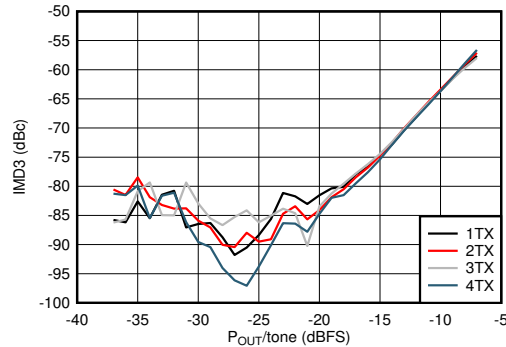
A. $f_{\text{DAC}} = 11796.48\text{MSPS}$, interleave mode, matching at 3.5GHz, $A_{\text{out}} = -13\text{ dBFS}$.

FIG 4-136. TX NSD vs DSA Setting at 3.5GHz



20MHz tone spacing, 3.5GHz Matching, -13 dBFS each tone, included PCB and cable losses

FIG 4-137. TX IMD3 vs DSA Setting at 3.5GHz



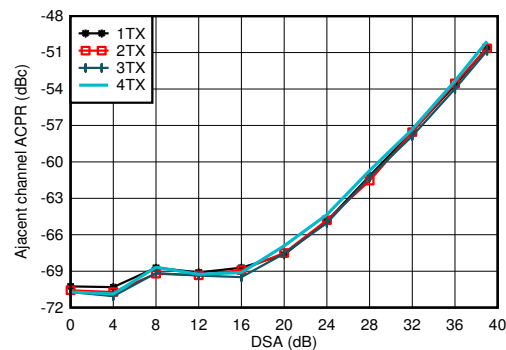
20MHz tone spacing, 3.5GHz Matching

FIG 4-138. TX IMD3 vs Digital Amplitude and Channel at 3.5GHz



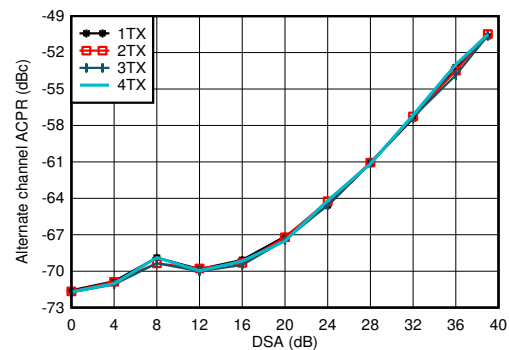
3.5GHz Matching, single carrier 20MHz BW TM1.1 LTE

FIG 4-139. TX 20MHz LTE Output Spectrum at 3.5GHz (Band 42)



3.5GHz Matching, single carrier 20MHz BW TM1.1 LTE

FIG 4-140. TX 20MHz LTE ACPR vs DSA Setting at 3.5GHz

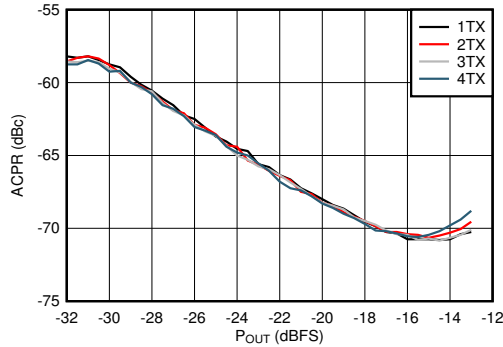


3.5GHz Matching, single carrier 20MHz BW TM1.1 LTE

FIG 4-141. TX 20MHz LTE alt-ACPR vs DSA Setting at 3.5GHz

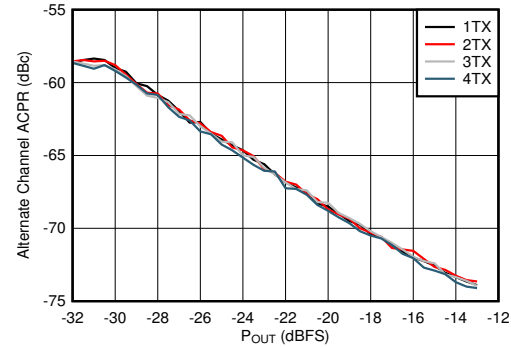
4.12.4 TX Typical Characteristics at 3.5GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48\text{MSPS}$ (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1\text{dBFS}$, DSA = 0dB, Sin(x)/x enabled, DSA calibrated



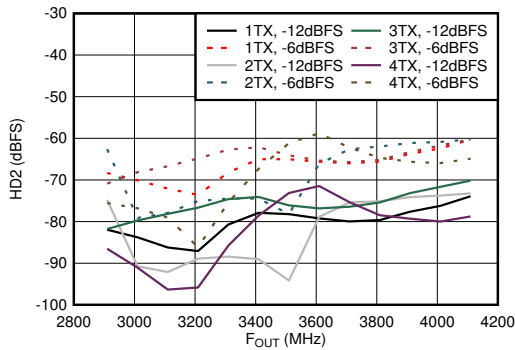
3.5GHz Matching, single carrier 20MHz BW TM1.1 LTE

Figure 4-142. TX 20MHz LTE ACPR vs Digital Level at 3.5GHz



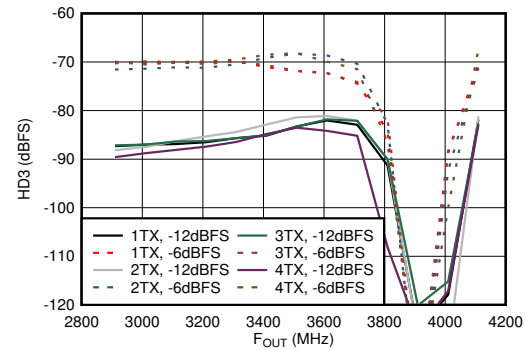
3.5GHz Matching, single carrier 20MHz BW TM1.1 LTE

Figure 4-143. TX 20MHz LTE alt-ACPR vs Digital Level at 3.5GHz



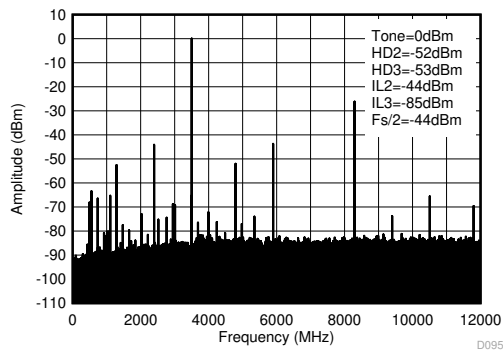
Matching at 3.5GHz, $f_{\text{DAC}} = 11.79648\text{GSPS}$, interleave mode, normalized to output power at harmonic frequency

Figure 4-144. TX Single Tone HD2 vs Frequency and Digital Level at 3.5GHz



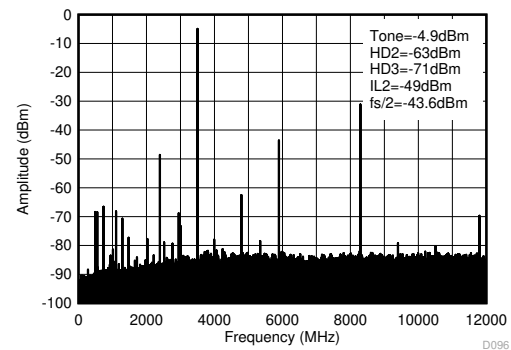
Matching at 3.5GHz, $f_{\text{DAC}} = 11.79648\text{GSPS}$, interleave mode, normalized to output power at harmonic frequency. Dip is due to HD3 falling near DC.

Figure 4-145. TX Single Tone HD3 vs Frequency and Digital Level at 3.5GHz



Matching at 3.5GHz, $f_{\text{DAC}} = 11.79648\text{GSPS}$, interleave mode.

Figure 4-146. TX Single Tone (-1dBFS) Output Spectrum at 3.5GHz (0 - f_{DAC})

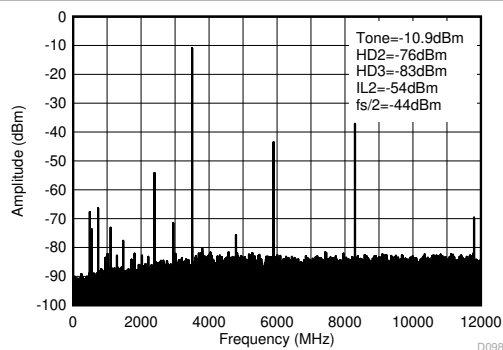


Matching at 3.5GHz, $f_{\text{DAC}} = 11.79648\text{GSPS}$, interleave mode.

Figure 4-147. TX Single Tone (-6dBFS) Output Spectrum at 3.5GHz (0 - f_{DAC})

4.12.4 TX Typical Characteristics at 3.5GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48\text{MSPS}$ (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1\text{dBFS}$, DSA = 0dB, Sin(x)/x enabled, DSA calibrated

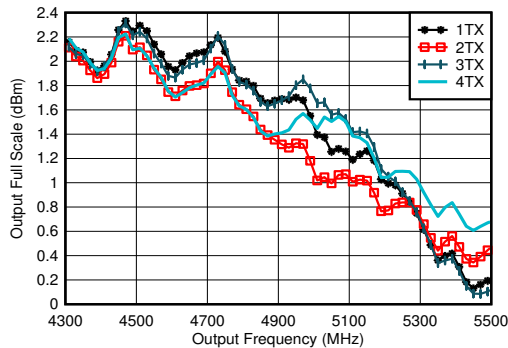


Matching at 3.5GHz, $f_{\text{DAC}} = 11.79648\text{GSPS}$, interleave mode.

4-148. TX Single Tone (–12dBFS) Output Spectrum at 3.5GHz (0- f_{DAC})

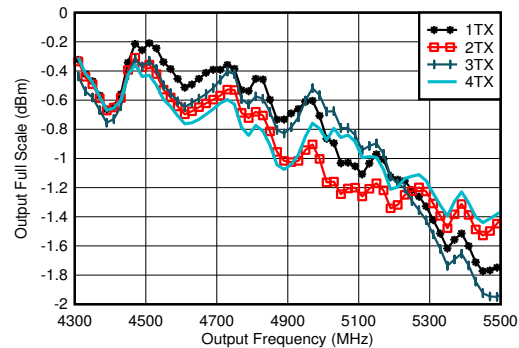
4.12.5 TX Typical Characteristics at 4.9GHz

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48\text{MSPS}$ (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1\text{dBFS}$, DSA = 0dB, Sin(x)/x enabled, DSA calibrated



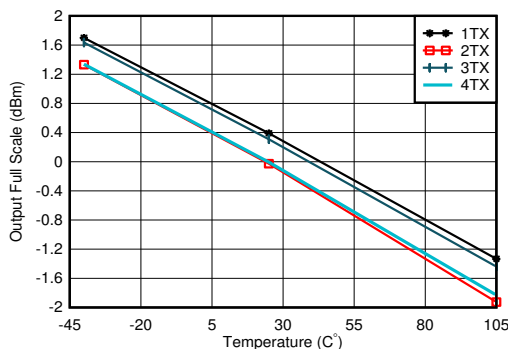
Excluding PCB and cable losses, $A_{\text{out}} = -0.5\text{ dBFS}$, DSA = 0, 4.9GHz matching

図 4-149. TX Full Scale vs RF Frequency and Channel at 11796.48MSPS



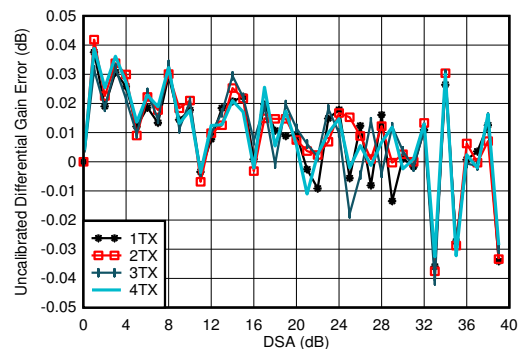
Excluding PCB and cable losses, $A_{\text{out}} = -0.5\text{ dBFS}$, DSA = 0, 4.9GHz matching

図 4-150. TX Full Scale vs RF Frequency and Channel at 5898.24 MSPS, Straight Mode, 2nd Nyquist Zone



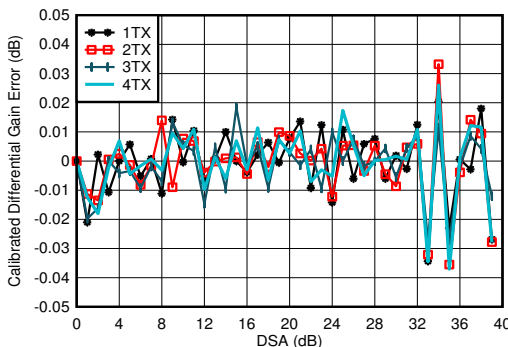
$f_{\text{DAC}} = 11796.48\text{MSPS}$, $A_{\text{out}} = -0.5\text{dBFS}$, matching 4.9GHz

図 4-151. TX Output Power vs DSA Setting and Channel at 4.9GHz



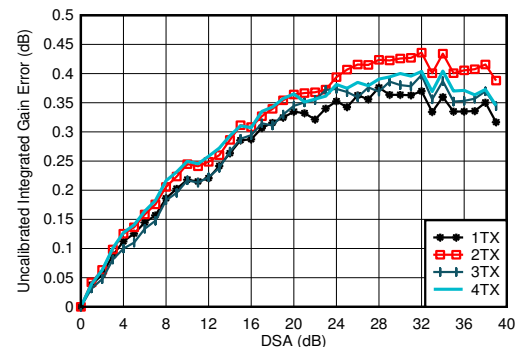
$f_{\text{DAC}} = 11796.48\text{MSPS}$, interleave mode, matching at 4.9GHz
Differential Gain Error = $P_{\text{OUT}}(\text{DSA Setting} - 1) - P_{\text{OUT}}(\text{DSA Setting}) + 1$

図 4-152. TX Uncalibrated Differential Gain Error vs DSA Setting and Channel at 4.9GHz



$f_{\text{DAC}} = 11796.48\text{MSPS}$, interleave mode, matching at 4.9GHz
Differential Gain Error = $P_{\text{OUT}}(\text{DSA Setting} - 1) - P_{\text{OUT}}(\text{DSA Setting}) + 1$

図 4-153. TX Calibrated Differential Gain Error vs DSA Setting and Channel at 4.9GHz

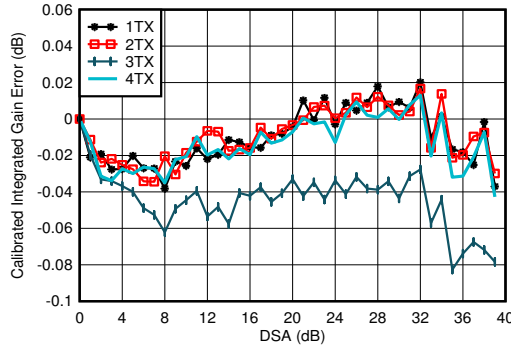


$f_{\text{DAC}} = 11796.48\text{MSPS}$, interleave mode, matching at 4.9GHz
Integrated Gain Error = $P_{\text{OUT}}(\text{DSA Setting}) - P_{\text{OUT}}(\text{DSA Setting} = 0) + (\text{DSA Setting})$

図 4-154. TX Uncalibrated Integrated Gain Error vs DSA Setting and Channel at 4.9GHz

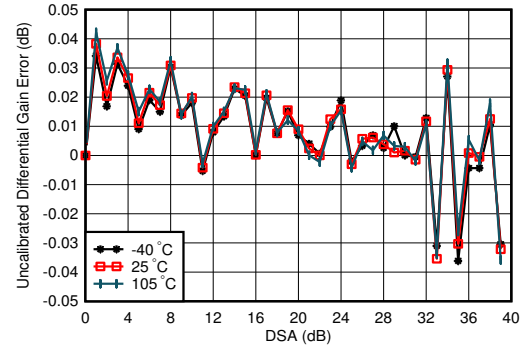
4.12.5 TX Typical Characteristics at 4.9GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48\text{MSPS}$ (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1\text{dBFS}$, DSA = 0dB, Sin(x)/x enabled, DSA calibrated



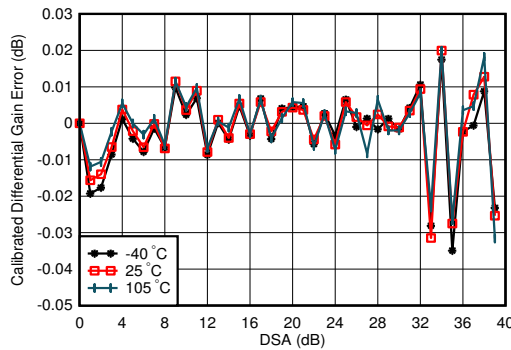
$f_{\text{DAC}} = 11796.48\text{MSPS}$, interleave mode, matching at 4.9GHz
Integrated Gain Error = $P_{\text{OUT}}(\text{DSA Setting}) - P_{\text{OUT}}(\text{DSA Setting} = 0) + (\text{DSA Setting})$

図 4-155. TX Calibrated Integrated Gain Error vs DSA Setting and Channel at 4.9GHz



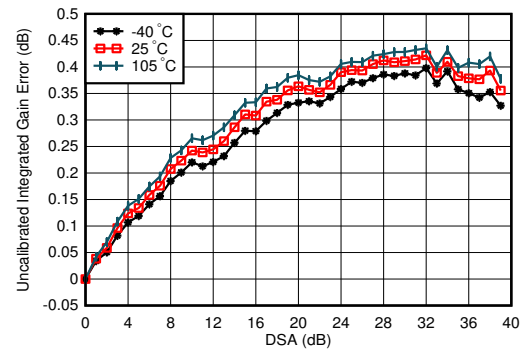
$f_{\text{DAC}} = 11796.48\text{MSPS}$, interleaved mode, matching at 4.9GHz
Differential Gain Error = $P_{\text{OUT}}(\text{DSA Setting} - 1) - P_{\text{OUT}}(\text{DSA Setting}) + 1$

図 4-156. TX Uncalibrated Differential Gain Error vs DSA Setting and Temperature at 4.9GHz



$f_{\text{DAC}} = 11796.48\text{MSPS}$, interleaved mode, matching at 4.9GHz
Differential Gain Error = $P_{\text{OUT}}(\text{DSA Setting} - 1) - P_{\text{OUT}}(\text{DSA Setting}) + 1$

図 4-157. TX Calibrated Differential Gain Error vs DSA Setting and Temperature at 4.9GHz

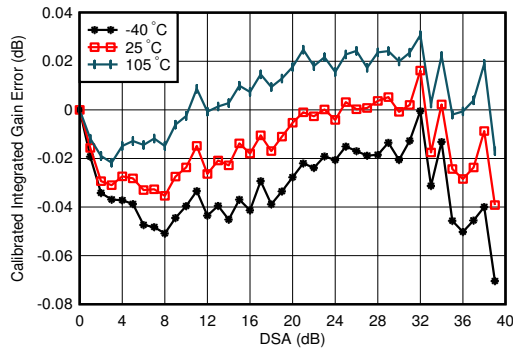


$f_{\text{DAC}} = 11796.48\text{MSPS}$, interleaved mode, matching at 4.9GHz
Integrated Gain Error = $P_{\text{OUT}}(\text{DSA Setting}) - P_{\text{OUT}}(\text{DSA Setting} = 0) + (\text{DSA Setting})$

図 4-158. TX Uncalibrated Integrated Gain Error vs DSA Setting and Temperature at 4.9GHz

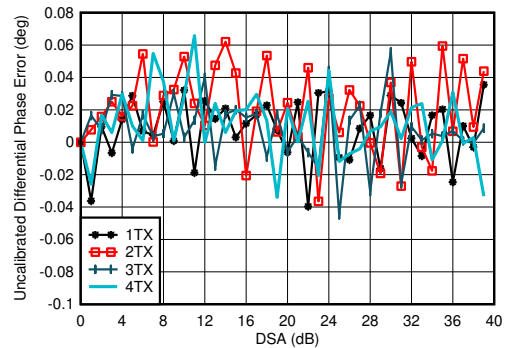
4.12.5 TX Typical Characteristics at 4.9GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48\text{MSPS}$ (24x interpolation), interleaved mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1\text{dBFS}$, DSA = 0dB, Sin(x)/x enabled, DSA calibrated



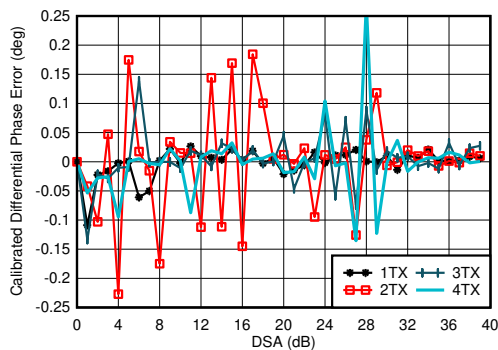
$f_{\text{DAC}} = 11796.48\text{MSPS}$, interleaved mode, matching at 4.9GHz
Integrated Gain Error = $P_{\text{OUT}}(\text{DSA Setting}) - P_{\text{OUT}}(\text{DSA Setting} = 0) + (\text{DSA Setting})$

FIG 4-159. TX Calibrated Integrated Gain Error vs DSA Setting and Temperature at 4.9GHz



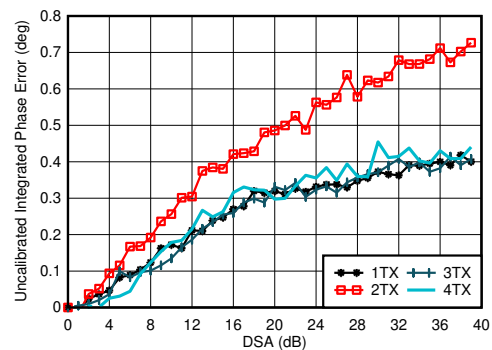
$f_{\text{DAC}} = 11796.48\text{MSPS}$, interleaved mode, matching at 4.9GHz
Differential Phase Error = $\text{Phase}_{\text{OUT}}(\text{DSA Setting} - 1) - \text{Phase}_{\text{OUT}}(\text{DSA Setting})$

FIG 4-160. TX Uncalibrated Differential Phase Error vs DSA Setting and Channel at 4.9GHz



$f_{\text{DAC}} = 11796.48\text{MSPS}$, interleaved mode, matching at 4.9GHz
Differential Phase Error = $\text{Phase}_{\text{OUT}}(\text{DSA Setting} - 1) - \text{Phase}_{\text{OUT}}(\text{DSA Setting})$
Phase DNL spike may occur at any DSA setting.

FIG 4-161. TX Calibrated Differential Phase Error vs DSA Setting and Channel at 4.9GHz

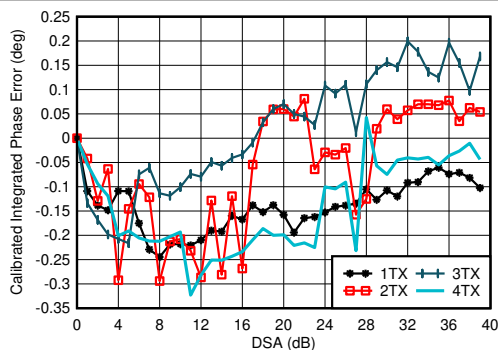


$f_{\text{DAC}} = 11796.48\text{MSPS}$, interleaved mode, matching at 4.9GHz
Integrated Phase Error = $\text{Phase}(\text{DSA Setting}) - \text{Phase}(\text{DSA Setting} = 0)$

FIG 4-162. TX Uncalibrated Integrated Phase Error vs DSA Setting and Channel at 4.9GHz

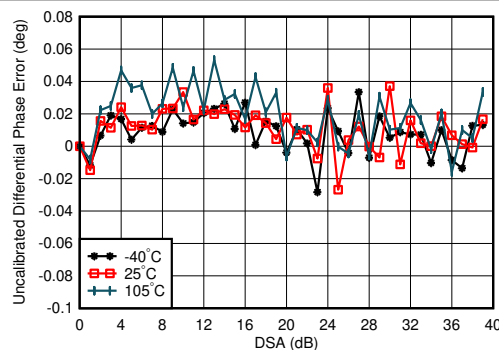
4.12.5 TX Typical Characteristics at 4.9GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48\text{MSPS}$ (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1\text{dBFS}$, DSA = 0dB, Sin(x)/x enabled, DSA calibrated



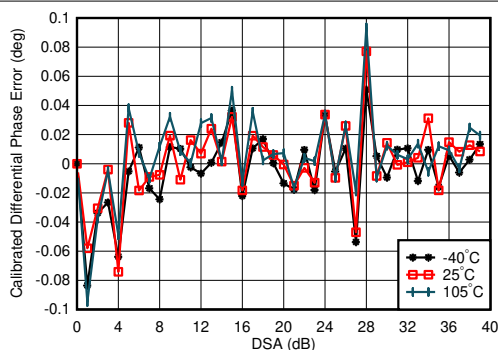
$f_{\text{DAC}} = 11796.48\text{MSPS}$, interleaved mode, matching at 4.9GHz
Integrated Phase Error = Phase(DSA Setting) – Phase(DSA Setting = 0)

図 4-163. TX Calibrated Integrated Phase Error vs DSA Setting and Channel at 4.9GHz



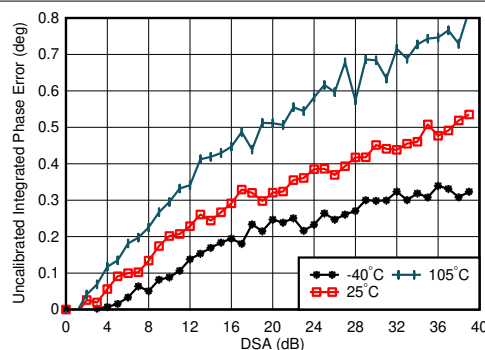
$f_{\text{DAC}} = 11796.48\text{MSPS}$, interleaved mode, matching at 4.9GHz
Differential Phase Error = Phase_{OUT}(DSA Setting – 1) – Phase_{OUT}(DSA Setting)

図 4-164. TX Uncalibrated Differential Phase Error vs DSA Setting and Temperature at 4.9GHz



$f_{\text{DAC}} = 11796.48\text{MSPS}$, interleaved mode, matching at 4.9GHz
Differential Phase Error = Phase_{OUT}(DSA Setting – 1) – Phase_{OUT}(DSA Setting)

図 4-165. TX Calibrated Differential Phase Error vs DSA Setting and Temperature at 4.9GHz

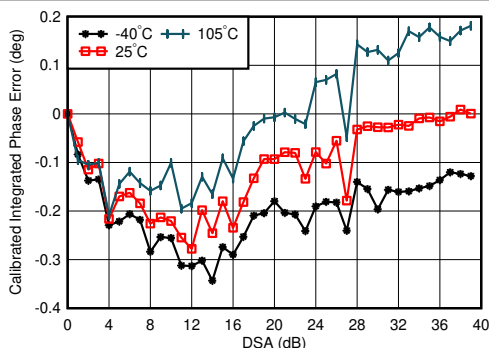


$f_{\text{DAC}} = 11796.48\text{MSPS}$, interleaved mode, matching at 4.9GHz
Integrated Phase Error = Phase(DSA Setting) – Phase(DSA Setting = 0)

図 4-166. TX Uncalibrated Integrated Phase Error vs DSA Setting and Temperature at 4.9GHz

4.12.5 TX Typical Characteristics at 4.9GHz (continued)

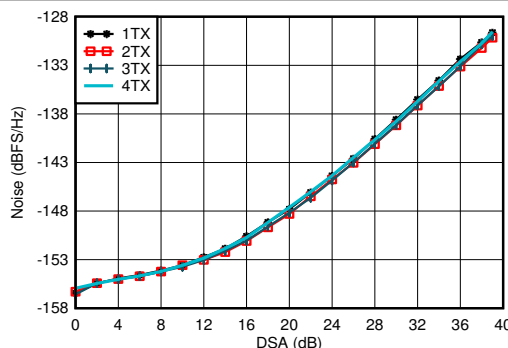
Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48\text{MSPS}$ (24x interpolation), interleaved mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1\text{dBFS}$, DSA = 0dB, Sin(x)/x enabled, DSA calibrated



$f_{\text{DAC}} = 11796.48\text{MSPS}$, interleaved mode, matching at 4.9GHz, channel with the median variation over DSA setting at 25°C

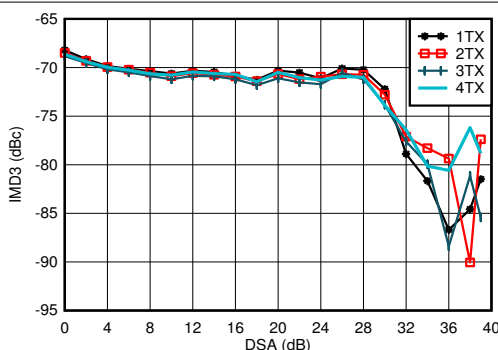
Integrated Phase Error = Phase(DSA Setting) – Phase(DSA Setting = 0)

FIG 4-167. TX Calibrated Integrated Phase Error vs DSA Setting and Temperature at 4.9GHz



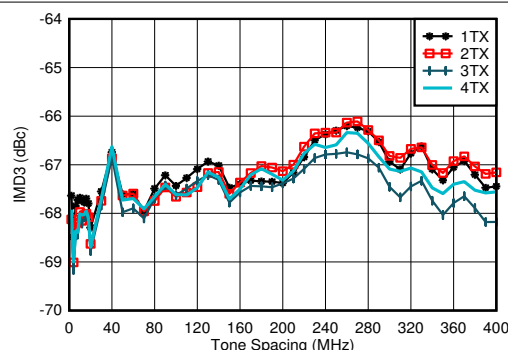
$f_{\text{DAC}} = 11796.48\text{MSPS}$, interleaved mode, matching at 4.9GHz, $P_{\text{OUT}} = -13\text{ dBFS}$

FIG 4-168. TX Output Noise vs Channel and Attenuation at 2.6GHz



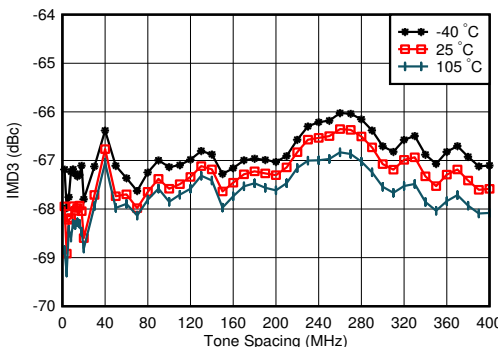
$f_{\text{DAC}} = 11796.48\text{MSPS}$, interleaved mode, matching at 4.9GHz, $f_{\text{CENTER}} = 4.9\text{GHz}$, -13 dBFS each tone

FIG 4-169. TX IMD3 vs DSA Setting at 4.9GHz



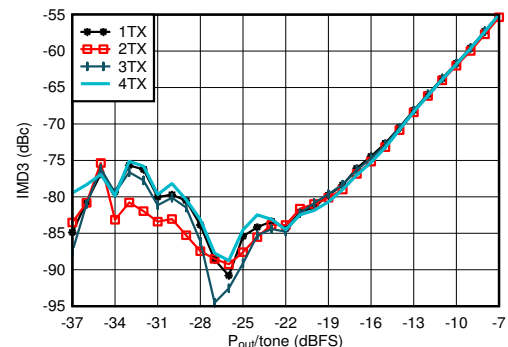
$f_{\text{DAC}} = 11796.48\text{MSPS}$, interleaved mode, matching at 4.9GHz, $f_{\text{CENTER}} = 4.9\text{GHz}$, -13 dBFS each tone

FIG 4-170. TX IMD3 vs Tone Spacing and Channel at 4.9GHz



$f_{\text{DAC}} = 11796.48\text{MSPS}$, interleaved mode, matching at 4.9GHz, $f_{\text{CENTER}} = 4.9\text{GHz}$, -13 dBFS each tone, worst channel

FIG 4-171. TX IMD3 vs Tone Spacing and Temperature at 4.9GHz

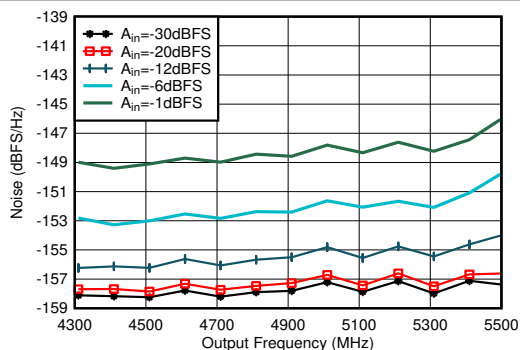


$f_{\text{DAC}} = 11796.48\text{MSPS}$, interleaved mode, matching at 4.9GHz, $f_{\text{CENTER}} = 4.9\text{GHz}$, $f_{\text{SPACING}} = 20\text{MHz}$

FIG 4-172. TX IMD3 vs Digital Level at 4.9GHz

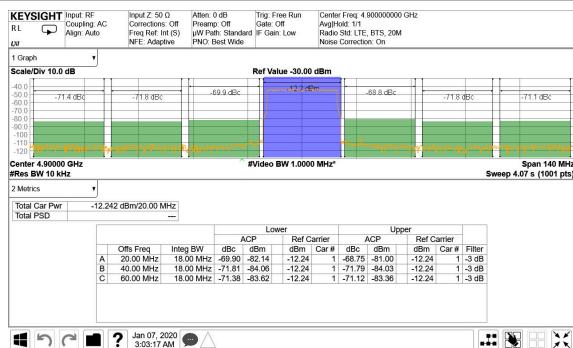
4.12.5 TX Typical Characteristics at 4.9GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48\text{MSPS}$ (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1\text{dBFS}$, DSA = 0dB, Sin(x)/x enabled, DSA calibrated



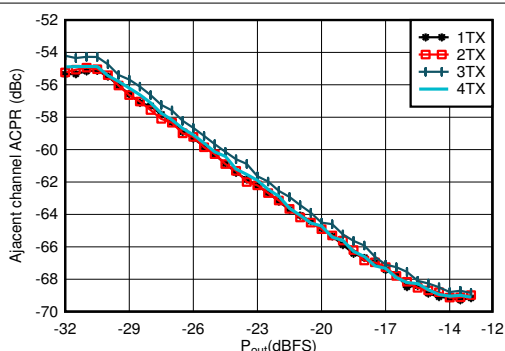
Matching at 4.9GHz, Single tone, $f_{\text{DAC}} = 11.79648\text{GSPS}$, interleave mode, 40MHz offset, DSA = 0dB

4-173. TX Single Tone Output Noise vs Frequency and Amplitude at 4.9GHz



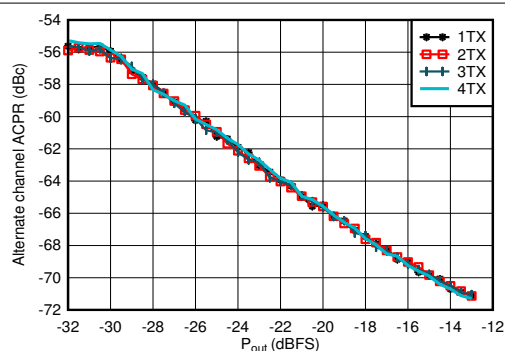
TM1.1, $P_{\text{OUT_RMS}} = -13\text{dBFS}$

4-174. TX 20MHz LTE Output Spectrum at 4.9GHz



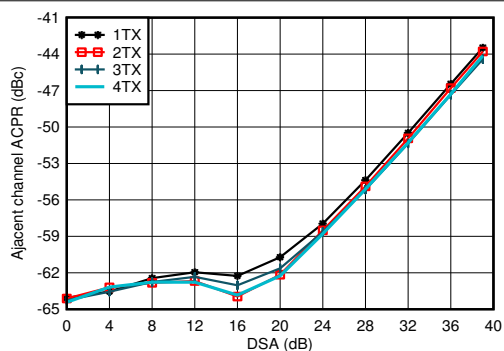
Matching at 4.9GHz, single carrier 20MHz BW TM1.1 LTE

4-175. TX 20MHz LTE ACPR vs Digital Level at 4.9GHz



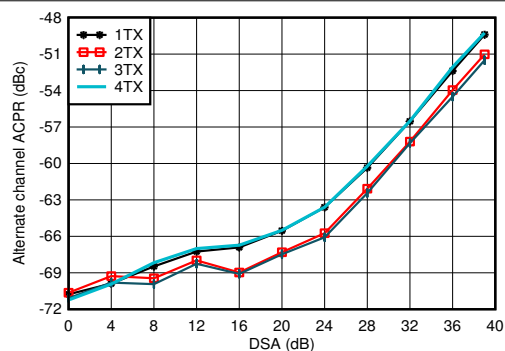
Matching at 4.9GHz, single carrier 20MHz BW TM1.1 LTE

4-176. TX 20MHz LTE alt-ACPR vs Digital Level at 4.9GHz



Matching at 4.9GHz, single carrier 20MHz BW TM1.1 LTE

4-177. TX 20MHz LTE ACPR vs DSA at 4.9GHz

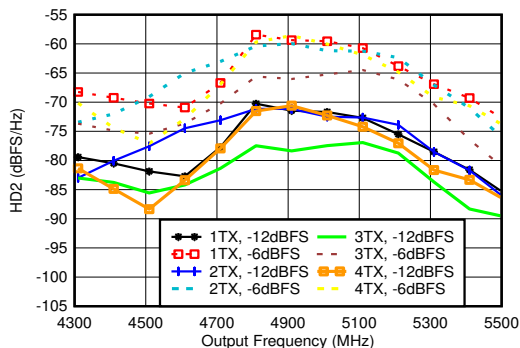


Matching at 4.9GHz, single carrier 20MHz BW TM1.1 LTE

4-178. TX 20MHz LTE alt-ACPR vs DSA at 4.9GHz

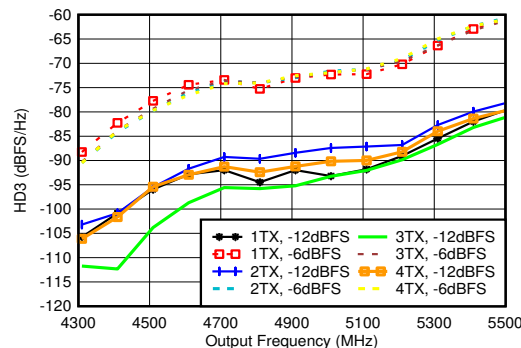
4.12.5 TX Typical Characteristics at 4.9GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48\text{MSPS}$ (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1\text{dBFS}$, DSA = 0dB, $\text{Sin}(x)/x$ enabled, DSA calibrated



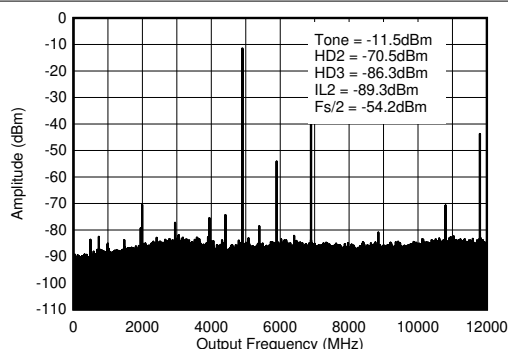
Matching at 4.9GHz, $f_{\text{DAC}} = 11.79648\text{GSPS}$, interleave mode, normalized to output power at harmonic frequency

図 4-179. TX HD2 vs Digital Amplitude and Output Frequency at 4.9GHz



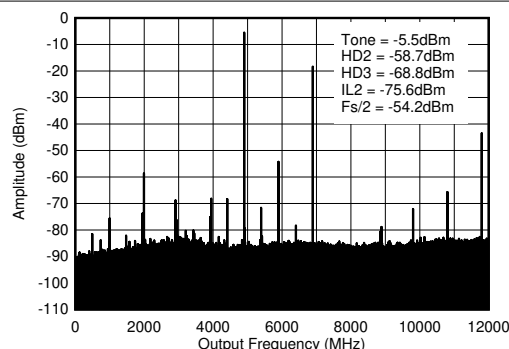
Matching at 4.9GHz, $f_{\text{DAC}} = 11.79648\text{GSPS}$, interleave mode, normalized to output power at harmonic frequency

図 4-180. TX HD3 vs Digital Amplitude and Output Frequency at 4.9GHz



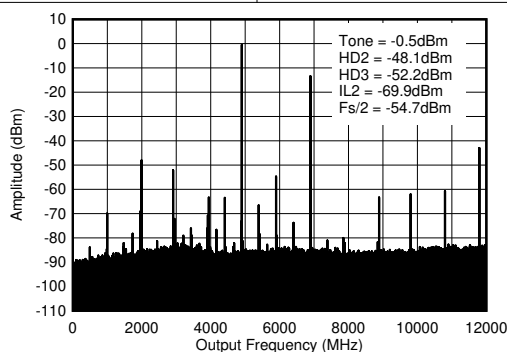
$f_{\text{DAC}} = 11796.48\text{MSPS}$, interleave mode, 4.9GHz matching, includes PCB and cable losses. $\text{ILn} = f_{\text{S}}/n \pm f_{\text{OUT}}$.

図 4-181. TX Single Tone (-12 dBFS) Output Spectrum at 4.9GHz ($0-f_{\text{DAC}}$)



$f_{\text{DAC}} = 11796.48\text{MSPS}$, interleave mode, 4.9GHz matching, includes PCB and cable losses. $\text{ILn} = f_{\text{S}}/n \pm f_{\text{OUT}}$.

図 4-182. TX Single Tone (-6 dBFS) Output Spectrum at 4.9GHz ($0-f_{\text{DAC}}$)

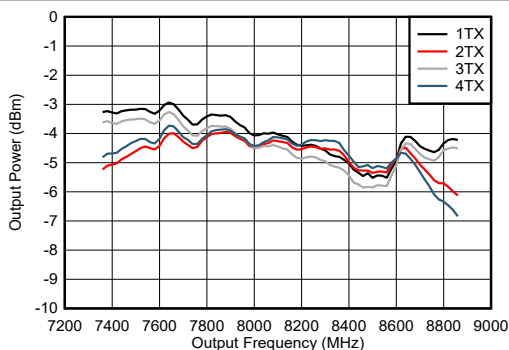


$f_{\text{DAC}} = 11796.48\text{MSPS}$, interleave mode, 4.9GHz matching, includes PCB and cable losses. $\text{ILn} = f_{\text{S}}/n \pm f_{\text{OUT}}$.

図 4-183. TX Single Tone (-1 dBFS) Output Spectrum at 4.9GHz ($0-f_{\text{DAC}}$)

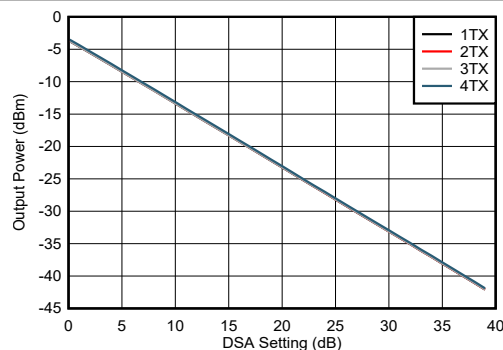
4.12.6 TX Typical Characteristics at 8.1GHz

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48$ MSPS (24x interpolation), mixed mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, 8.1GHz matching



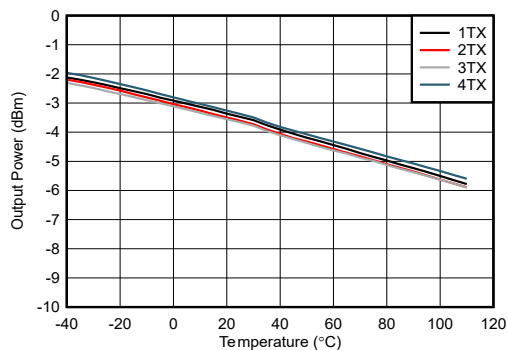
includes PCB and cable losses.

FIG 4-184. TX Output Power vs Frequency at 8.1GHz



includes PCB and cable losses.

FIG 4-185. TX Output Power vs DSA Setting at 8.1GHz



includes PCB and cable losses.

FIG 4-186. TX Output Power vs Temperature at 8.1GHz

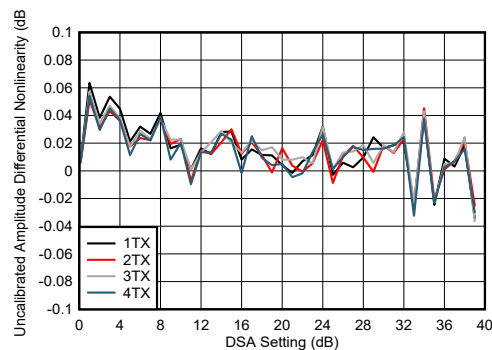


FIG 4-187. TX DSA Uncalibrated Amplitude Differential Nonlinearity at 8.1GHz

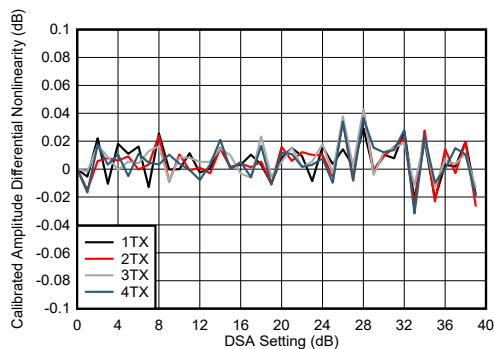


FIG 4-188. TX DSA Calibrated Amplitude Differential Nonlinearity at 8.1GHz

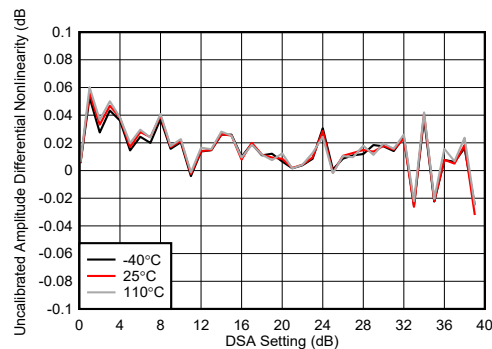
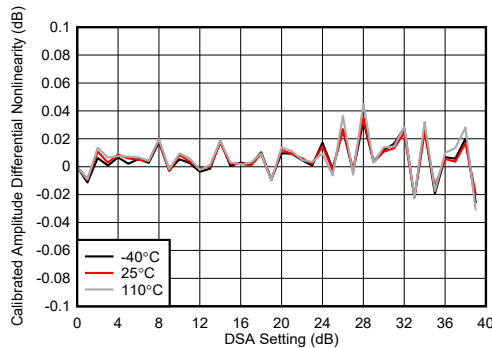


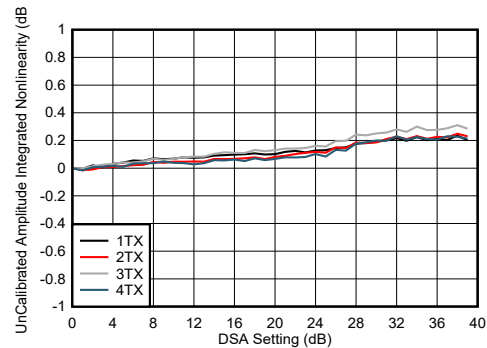
FIG 4-189. TX DSA Uncalibrated Amplitude Differential Nonlinearity at 8.1GHz

4.12.6 TX Typical Characteristics at 8.1GHz (continued)

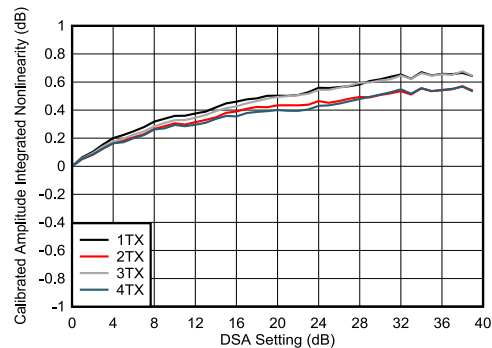
Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48$ MSPS (24x interpolation), mixed mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, 8.1GHz matching



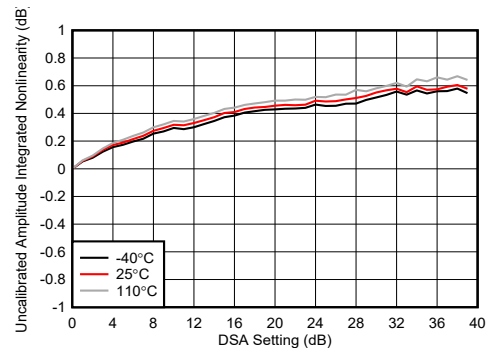
4-190. TX DSA Calibrated Amplitude Differential Nonlinearity at 8.1GHz



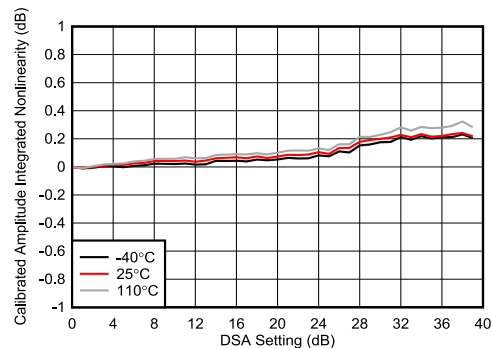
4-191. TX DSA Uncalibrated Amplitude Integrated Nonlinearity at 8.1GHz



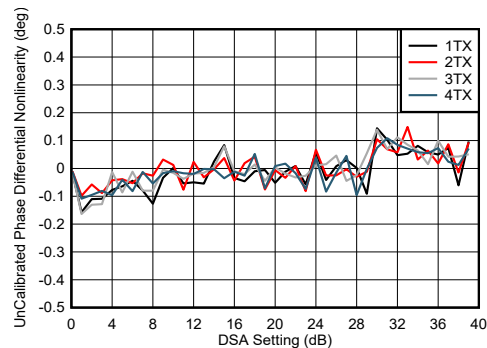
4-192. TX DSA Calibrated Amplitude Integrated Nonlinearity at 8.1GHz



4-193. TX DSA Uncalibrated Amplitude Integrated Nonlinearity at 8.1GHz



4-194. TX DSA Calibrated Amplitude Integrated Nonlinearity at 8.1GHz



4-195. TX DSA Uncalibrated Phase Differential Nonlinearity at 8.1GHz

4.12.6 TX Typical Characteristics at 8.1GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48$ MSPS (24x interpolation), mixed mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, 8.1GHz matching

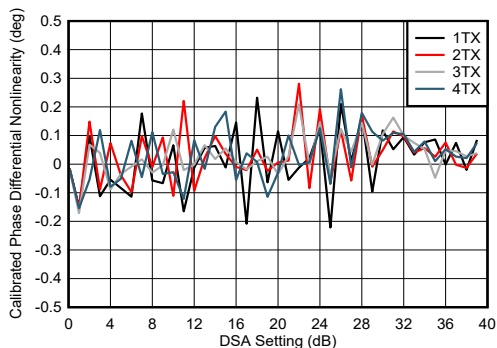


FIG 4-196. TX DSA Calibrated Phase Differential Nonlinearity at 8.1GHz

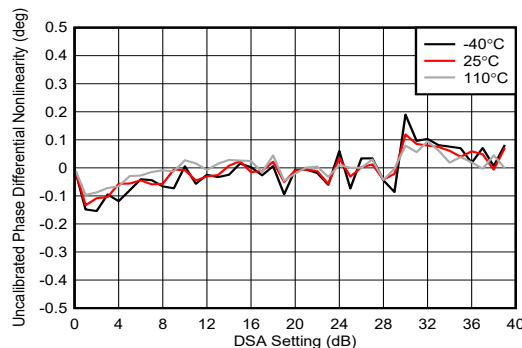


FIG 4-197. TX DSA Uncalibrated Phase Differential Nonlinearity at 8.1GHz

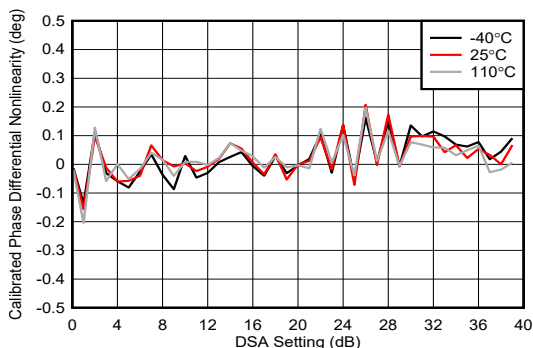


FIG 4-198. TX DSA Calibrated Phase Differential Nonlinearity at 8.1GHz

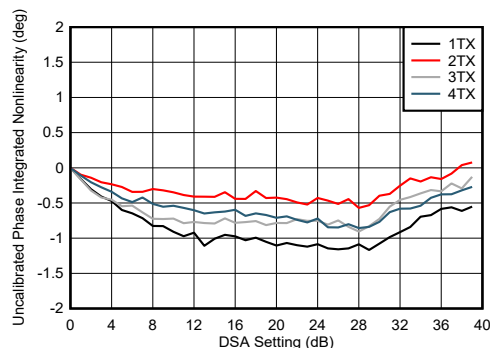


FIG 4-199. TX DSA Uncalibrated Phase Integrated Nonlinearity at 8.1GHz

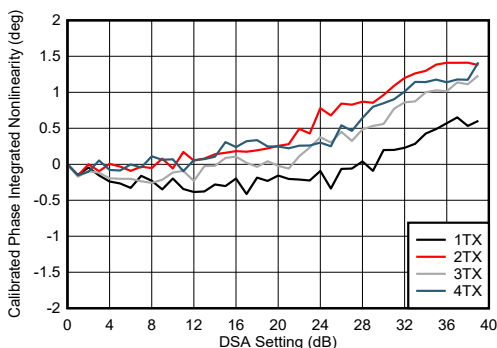


FIG 4-200. TX DSA Calibrated Phase Integrated Nonlinearity at 8.1GHz

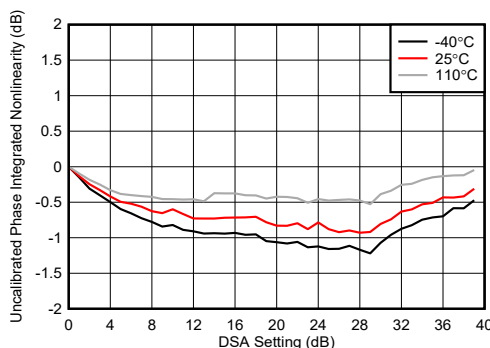


FIG 4-201. TX DSA Uncalibrated Phase Integrated Nonlinearity at 8.1GHz

4.12.6 TX Typical Characteristics at 8.1GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48$ MSPS (24x interpolation), mixed mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, 8.1GHz matching

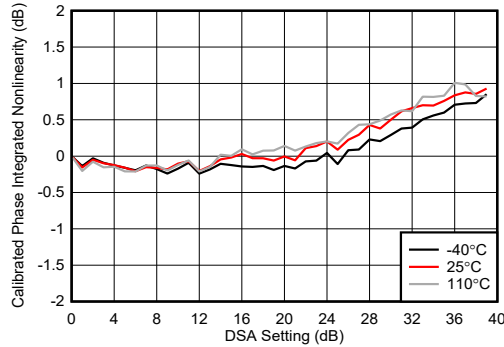
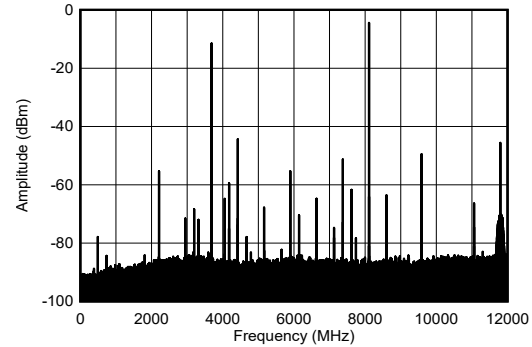
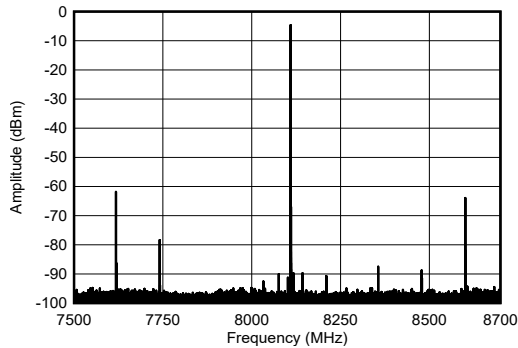


FIG 4-202. TX DSA Calibrated Phase Integrated Nonlinearity at 8.1GHz



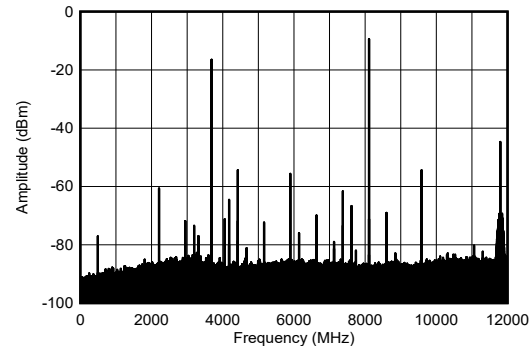
-1dBFS

FIG 4-203. TX Single Tone Output Spectrum at 8.1GHz



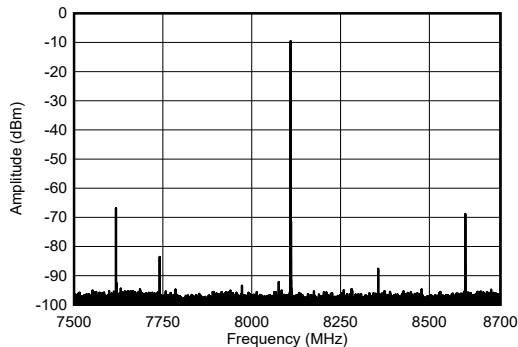
-1dBFS

FIG 4-204. TX Single Tone Output Spectrum at 8.1GHz



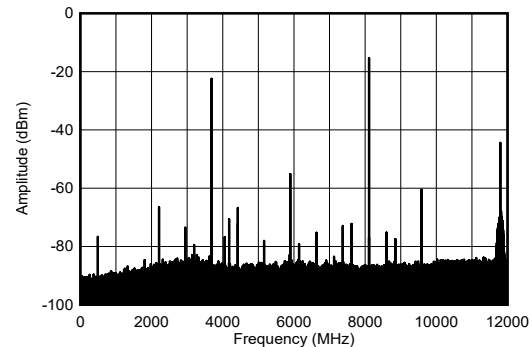
-6dBFS

FIG 4-205. TX Single Tone Output Spectrum at 8.1GHz



-6dBFS

FIG 4-206. TX Single Tone Output Spectrum at 8.1GHz

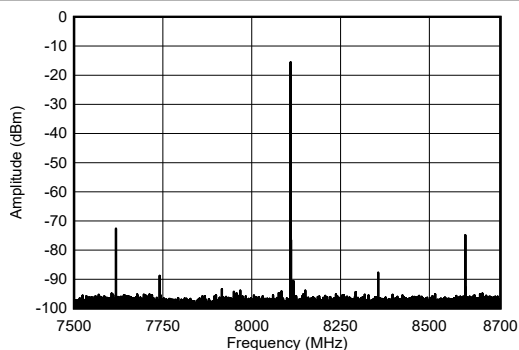


-12dBFS

FIG 4-207. TX Single Tone Output Spectrum at 8.1GHz

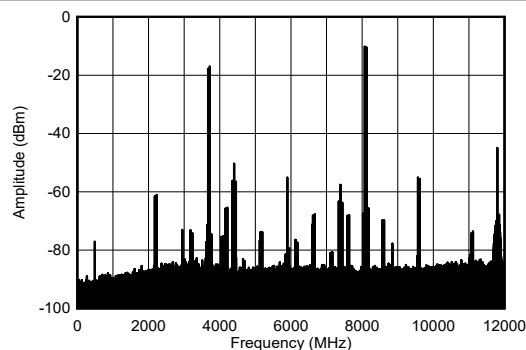
4.12.6 TX Typical Characteristics at 8.1GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48$ MSPS (24x interpolation), mixed mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, 8.1GHz matching



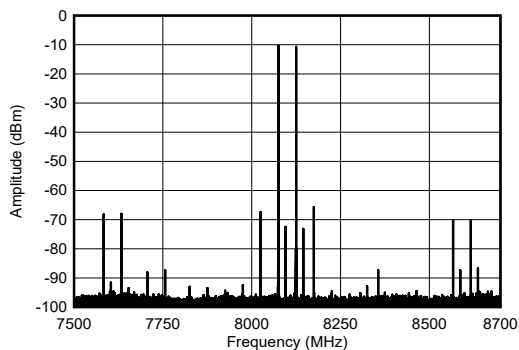
-12dBFS

FIG 4-208. TX Single Tone Output Spectrum at 8.11GHz



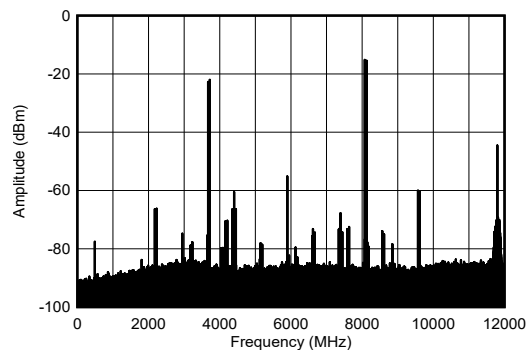
50MHz tone spacing, -7dBFS each tone

FIG 4-209. TX Dual Tone Output Spectrum at 8.11GHz



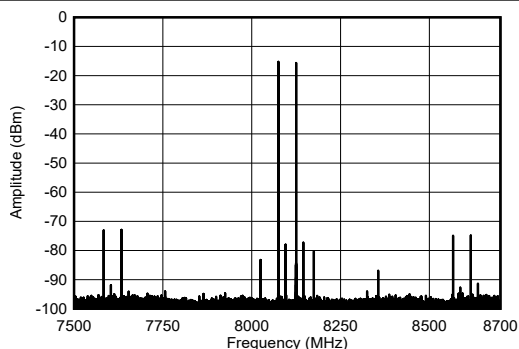
50MHz tone spacing, -7dBFS each tone

FIG 4-210. TX Dual Tone Output Spectrum at 8.11GHz



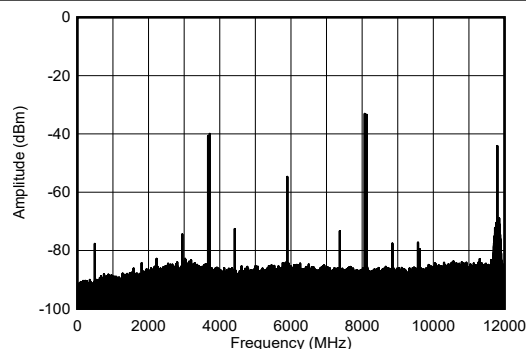
50MHz tone spacing, -12dBFS each tone

FIG 4-211. TX Dual Tone Output Spectrum at 8.11GHz



50MHz tone spacing, -12dBFS each tone

FIG 4-212. TX Dual Tone Output Spectrum at 8.11GHz

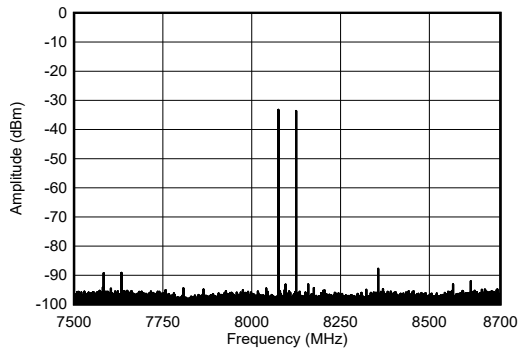


50MHz tone spacing, -30dBFS each tone

FIG 4-213. TX Dual Tone Output Spectrum at 8.11GHz

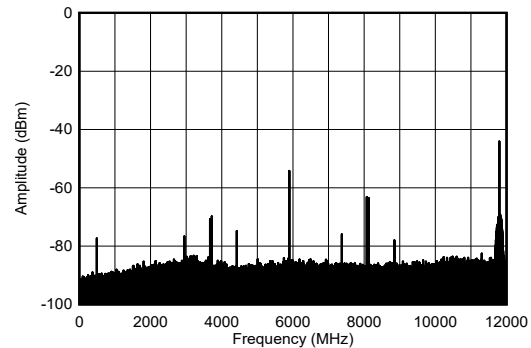
4.12.6 TX Typical Characteristics at 8.1GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48$ MSPS (24x interpolation), mixed mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, 8.1GHz matching



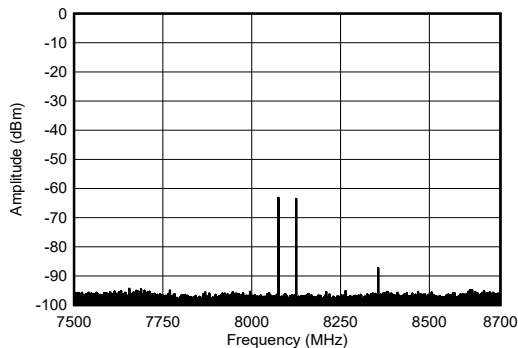
50MHz tone spacing, -30dBFS each tone

FIG 4-214. TX Dual Tone Output Spectrum at 8.11GHz



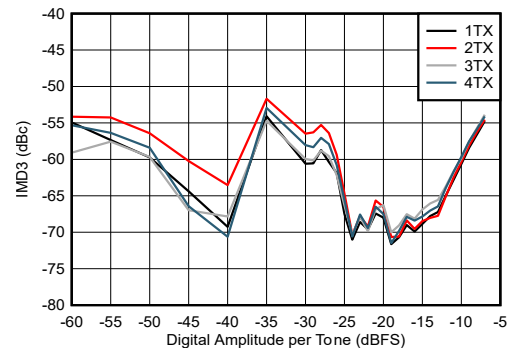
50MHz tone spacing, -60dBFS each tone

FIG 4-215. TX Dual Tone Output Spectrum at 8.11GHz



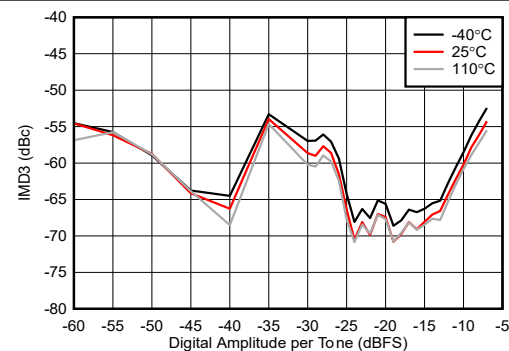
50MHz tone spacing, -60dBFS each tone

FIG 4-216. TX Dual Tone Output Spectrum at 8.11GHz



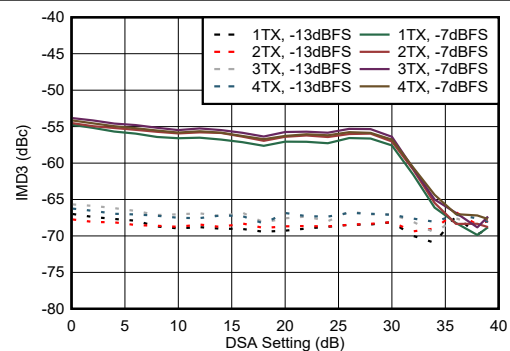
-7dBFS each tone, 50MHz tone spacing

FIG 4-217. TX IMD3 vs Digital Amplitude at 8.11GHz



-7dBFS each tone, 50MHz tone spacing

FIG 4-218. TX IMD3 vs Digital Amplitude at 8.11GHz

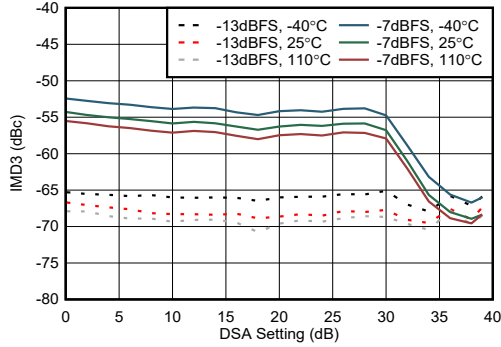


50MHz tone spacing

FIG 4-219. TX IMD3 vs DSA Setting at 8.11GHz

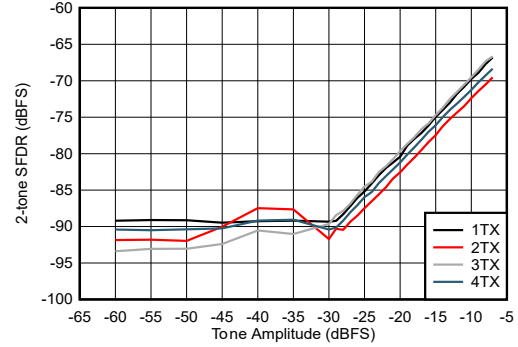
4.12.6 TX Typical Characteristics at 8.1GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48$ MSPS (24x interpolation), mixed mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, 8.1GHz matching



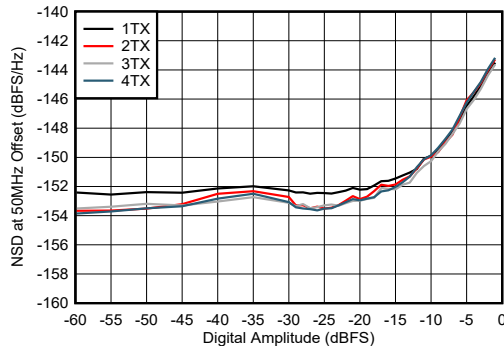
50 MHz tone spacing

図 4-220. TX IMD3 vs DSA Setting at 8.11GHz



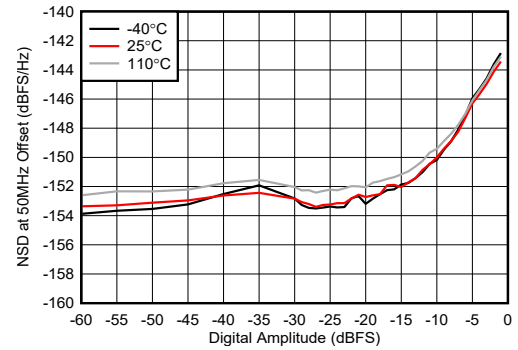
50 MHz tone spacing

図 4-221. TX 2-Tone SFDR vs Digital Amplitude at 8.11GHz



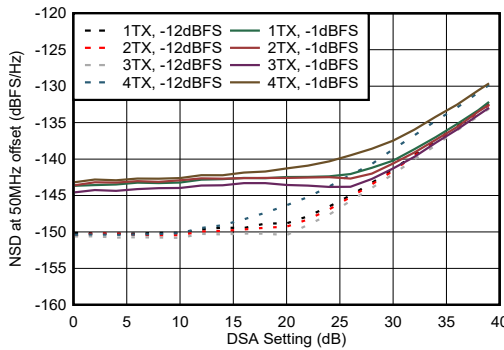
50 MHz offset

図 4-222. TX NSD vs Digital Amplitude at 8.11GHz



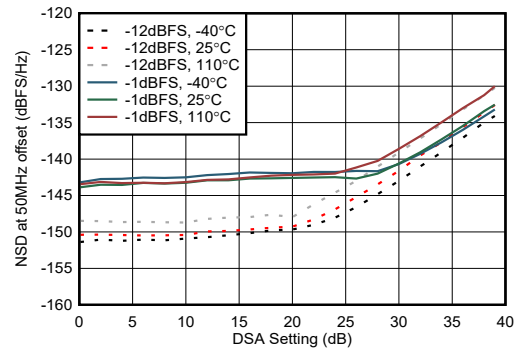
50 MHz offset

図 4-223. TX NSD vs Digital Amplitude at 8.11GHz



50 MHz offset

図 4-224. TX NSD vs DSA Setting at 8.11GHz



50 MHz offset

図 4-225. TX NSD vs DSA Setting at 8.11GHz

4.12.6 TX Typical Characteristics at 8.1GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48$ MSPS (24x interpolation), mixed mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, 8.1GHz matching

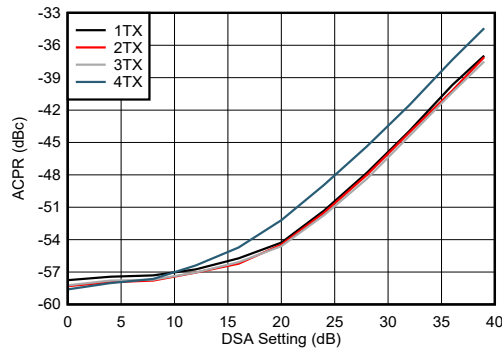


FIG 4-226. TX NR100MHz ACPR vs DSA Setting 8.1GHz

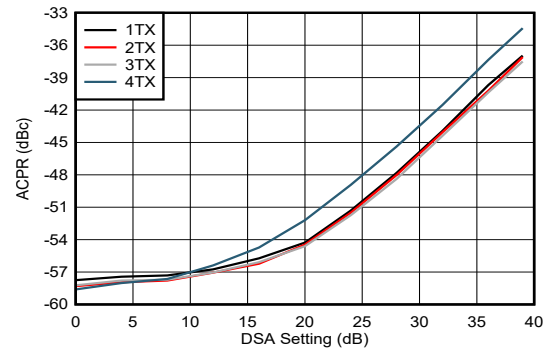


FIG 4-227. TX NR100MHz alt-ACPR vs DSA Setting 8.1GHz

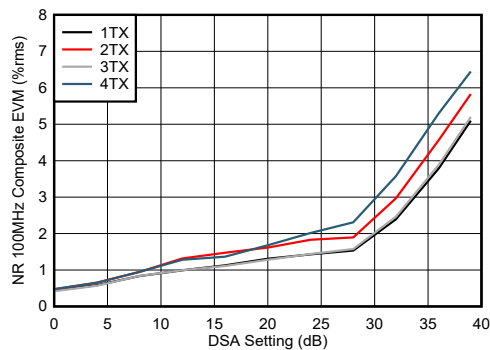


FIG 4-228. TX NR100MHz EVM vs DSA Setting 8.1GHz

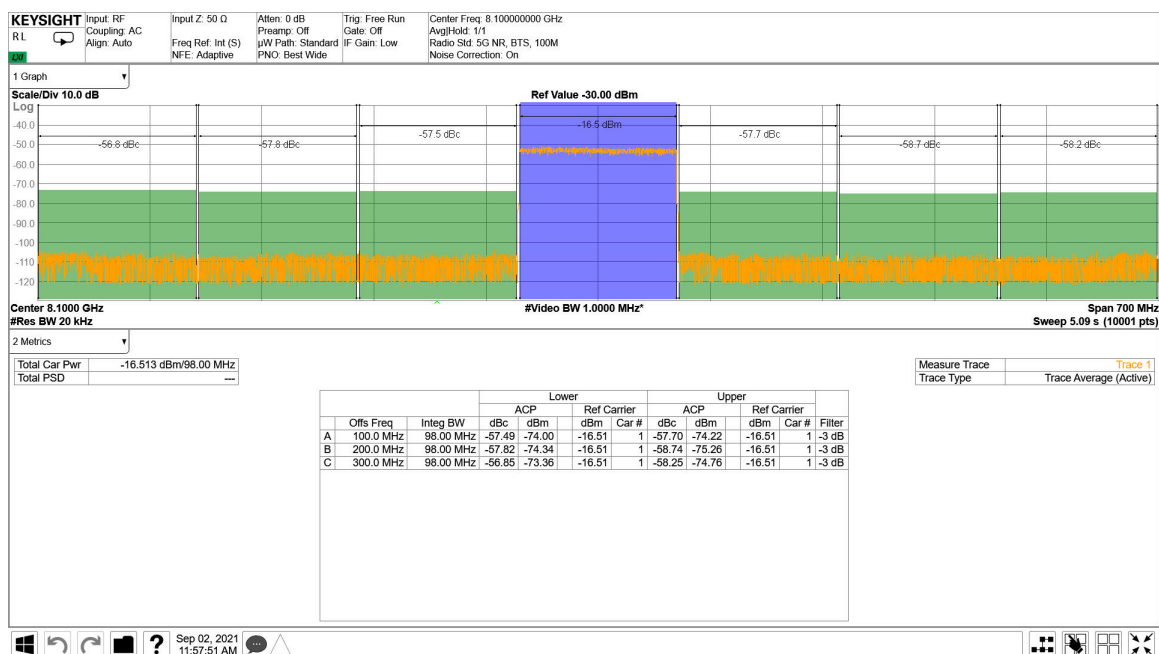
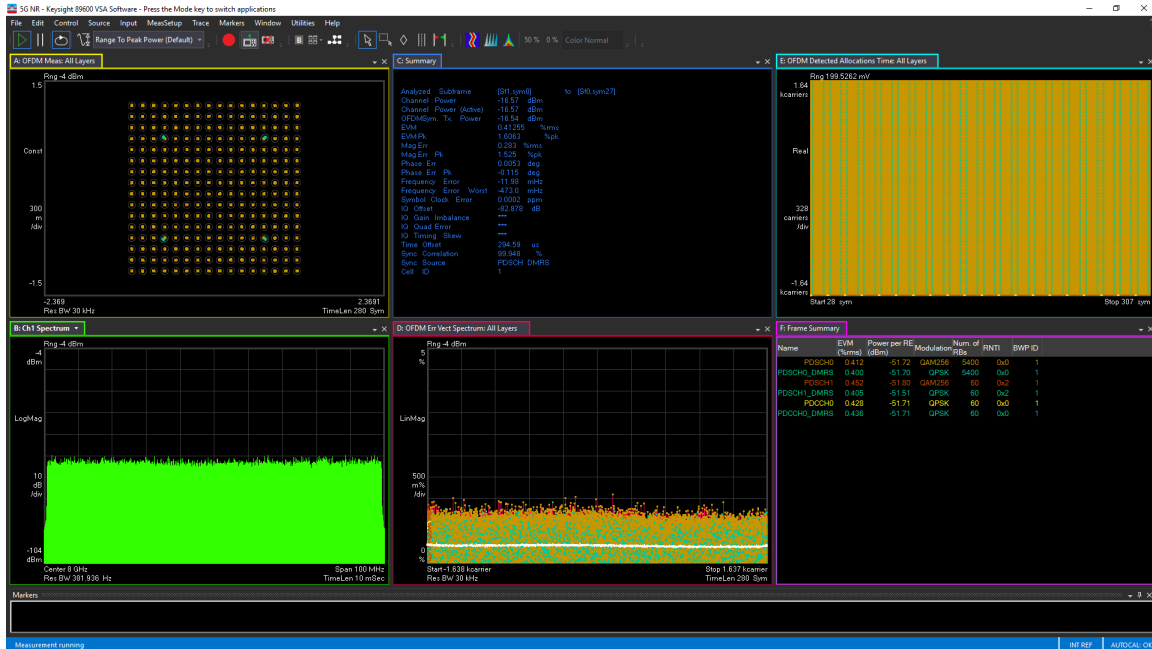


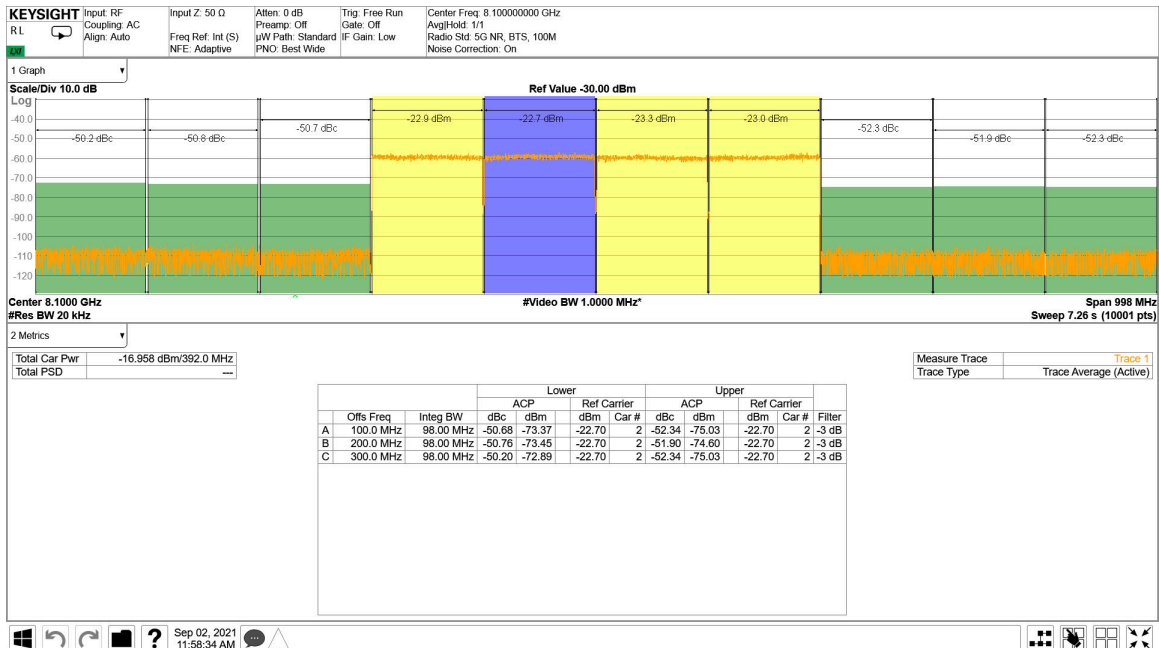
FIG 4-229. TX 100MHz NR Output Spectrum at 8.1GHz

4.12.6 TX Typical Characteristics at 8.1GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48$ MSPS (24x interpolation), mixed mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, 8.1GHz matching



4-230. TX 100MHz NR EVM at 8.1GHz



4-231. TX 4x100MHz NR Output Spectrum 8.1GHz

4.12.6 TX Typical Characteristics at 8.1GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48$ MSPS (24x interpolation), mixed mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, 8.1GHz matching

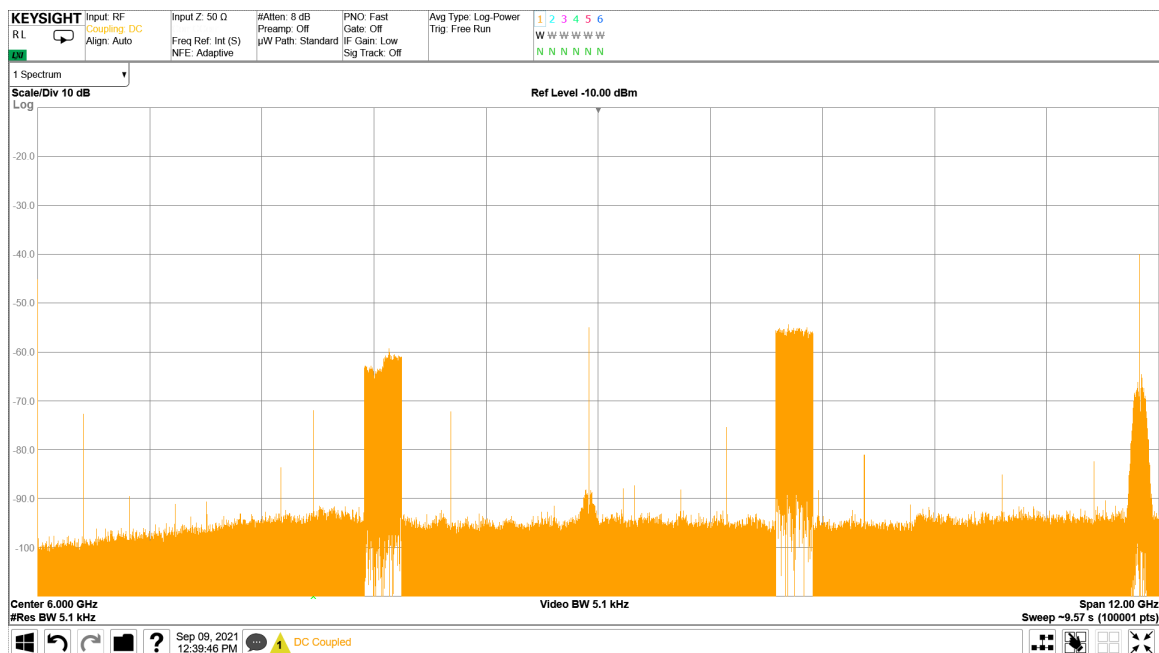
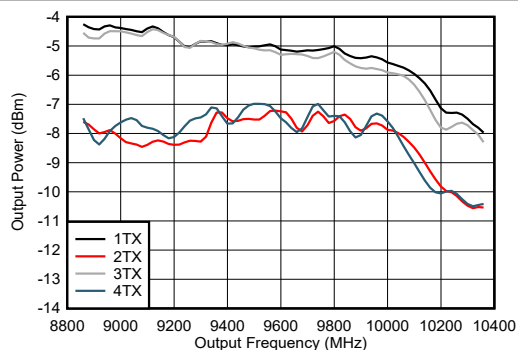


図 4-232. TX 4x100MHz NR Output Spectrum 8.1GHz

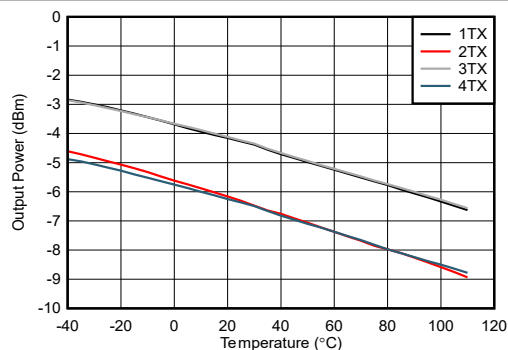
4.12.7 TX Typical Characteristics at 9.6GHz

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 1474.56MSPS, $f_{\text{DAC}} = 11796.48\text{MSPS}$ (8x interpolation), Mixed mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1\text{dBFS}$, DSA = 0dB, Sin(x)/x enabled, DSA calibrated, 9.6GHz matching



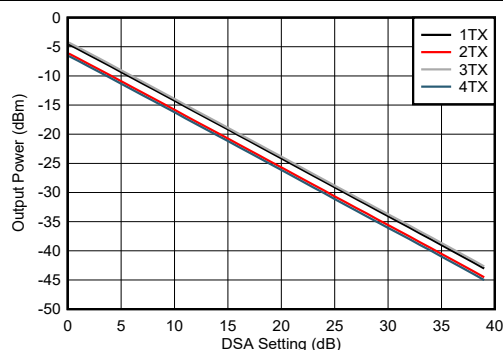
Includes PCB and cable losses.

FIG 4-233. TX Output Power vs Frequency at 9.61GHz



Includes PCB and cable losses.

FIG 4-234. TX Output Power vs Frequency at 9.61GHz



Includes PCB and cable losses.

FIG 4-235. TX Output Power vs DSA Setting at 9.61GHz

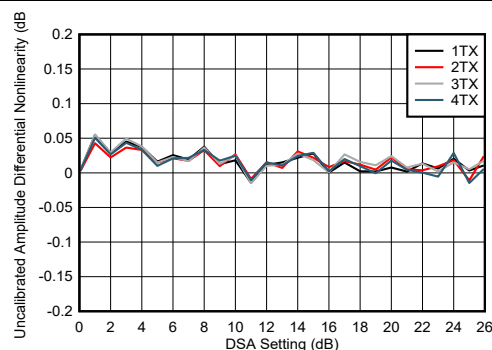


FIG 4-236. TX DSA Uncalibrated Amplitude Differential Nonlinearity

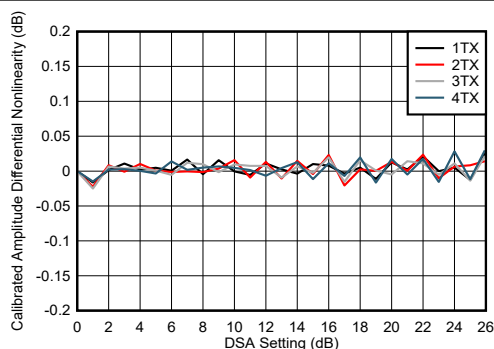


FIG 4-237. TX DSA Calibrated Amplitude Differential Nonlinearity

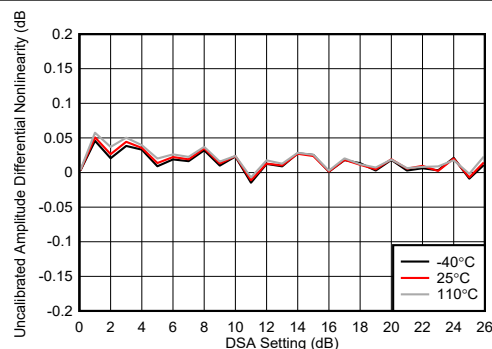


FIG 4-238. TX DSA Uncalibrated Amplitude Differential Nonlinearity

4.12.7 TX Typical Characteristics at 9.6GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 1474.56MSPS, $f_{\text{DAC}} = 11796.48\text{MSPS}$ (8x interpolation), Mixed mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1\text{dBFS}$, DSA = 0dB, Sin(x)/x enabled, DSA calibrated, 9.6GHz matching

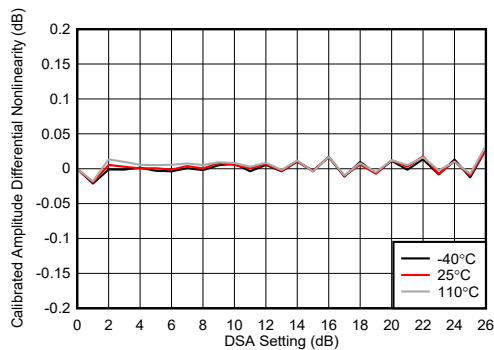


Figure 4-239. TX DSA Calibrated Amplitude Differential Nonlinearity

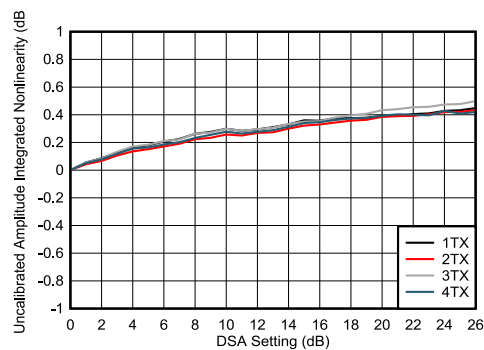


Figure 4-240. TX DSA Uncalibrated Amplitude Integrated Nonlinearity

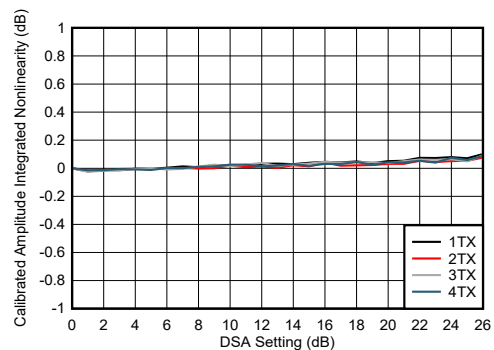


Figure 4-241. TX DSA Calibrated Amplitude Integrated Nonlinearity

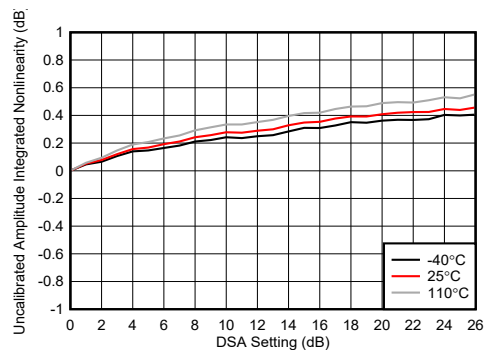


Figure 4-242. TX DSA Uncalibrated Amplitude Integrated Nonlinearity

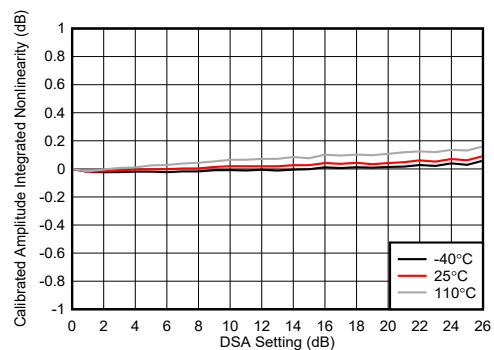


Figure 4-243. TX DSA Calibrated Amplitude Integrated Nonlinearity

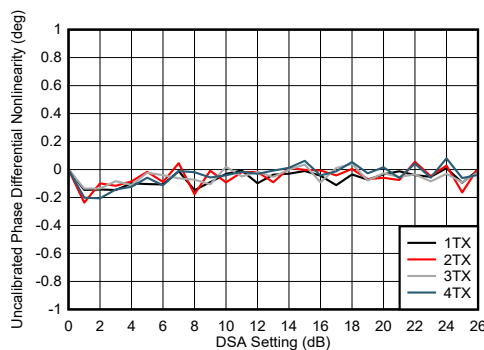
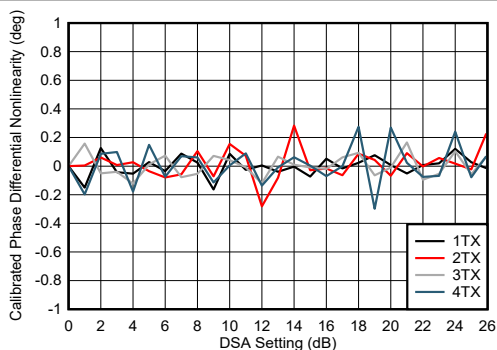


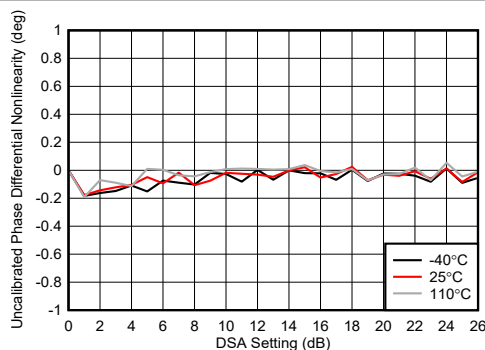
Figure 4-244. TX DSA Uncalibrated Phase Differential Nonlinearity

4.12.7 TX Typical Characteristics at 9.6GHz (continued)

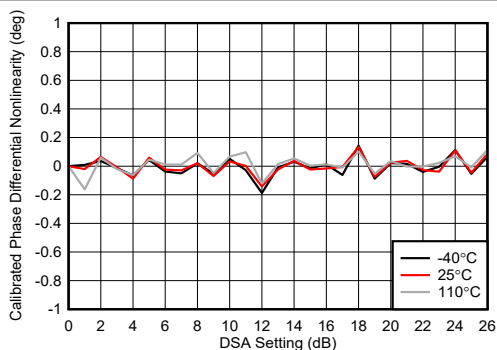
Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 1474.56MSPS, $f_{\text{DAC}} = 11796.48\text{MSPS}$ (8x interpolation), Mixed mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1\text{dBFS}$, DSA = 0dB, Sin(x)/x enabled, DSA calibrated, 9.6GHz matching



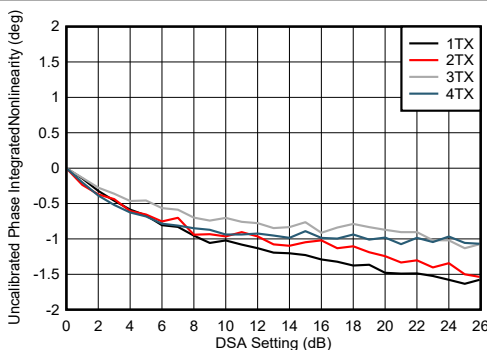
4-245. TX DSA Calibrated Phase Differential Nonlinearity



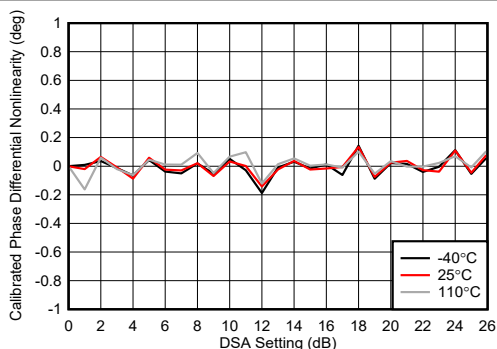
4-246. TX DSA Uncalibrated Phase Differential Nonlinearity



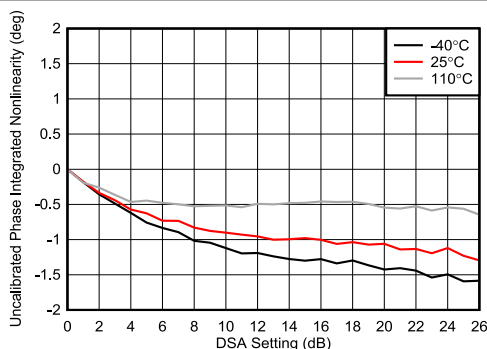
4-247. TX DSA Calibrated Phase Differential Nonlinearity



4-248. TX DSA Uncalibrated Phase Integrated Nonlinearity



4-249. TX DSA Calibrated Phase Integrated Nonlinearity



4-250. TX DSA Uncalibrated Phase Integrated Nonlinearity

4.12.7 TX Typical Characteristics at 9.6GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 1474.56MSPS, $f_{\text{DAC}} = 11796.48\text{MSPS}$ (8x interpolation), Mixed mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1\text{dBFS}$, DSA = 0dB, Sin(x)/x enabled, DSA calibrated, 9.6GHz matching

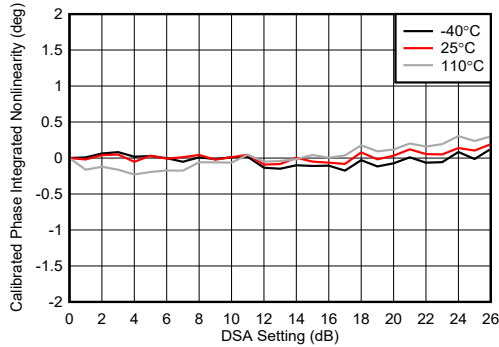
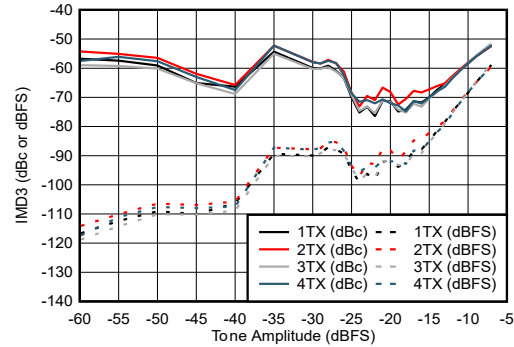
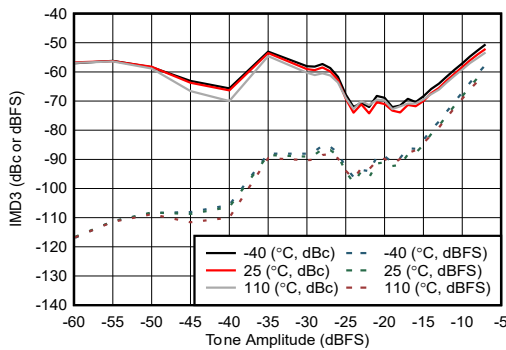


FIG 4-251. TX DSA Calibrated Amplitude Integrated Nonlinearity



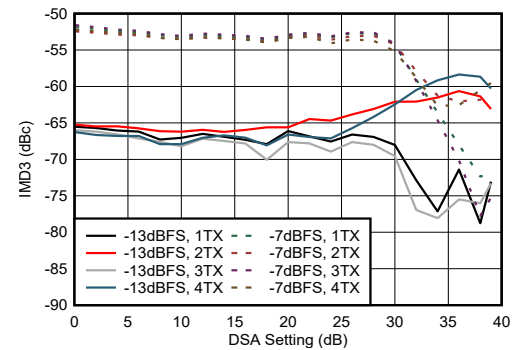
50MHz tone spacing

FIG 4-252. TX IMD3 vs Digital Amplitude at 9.61GHz



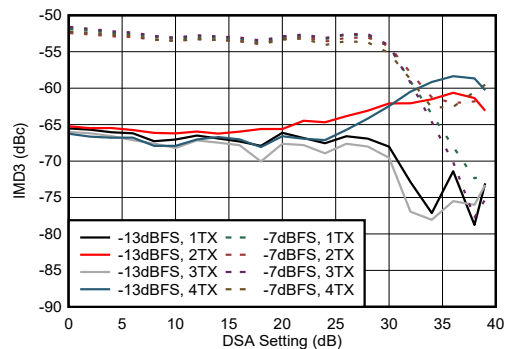
50MHz tone spacing

FIG 4-253. TX IMD3 vs Digital Amplitude at 9.61GHz



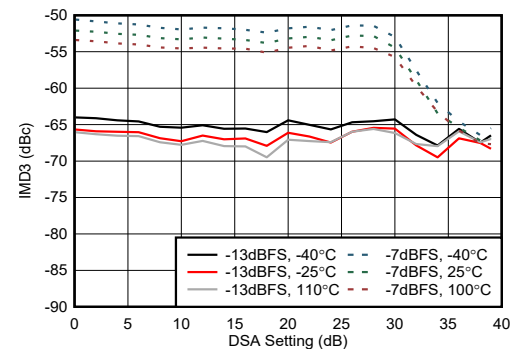
50MHz tone spacing

FIG 4-254. TX IMD3 vs DSA Setting at 9.61GHz



50MHz tone spacing

FIG 4-255. TX IMD3 vs DSA Setting at 9.61GHz



50MHz tone spacing

FIG 4-256. TX IMD3 vs DSA Setting at 9.61GHz

4.12.7 TX Typical Characteristics at 9.6GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 1474.56MSPS, $f_{\text{DAC}} = 11796.48\text{MSPS}$ (8x interpolation), Mixed mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1\text{dBFS}$, DSA = 0dB, Sin(x)/x enabled, DSA calibrated, 9.6GHz matching

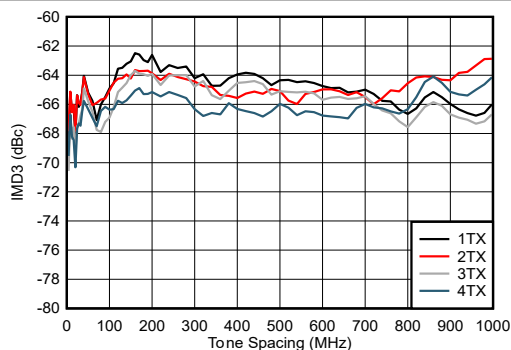


FIG 4-257. TX IMD3 vs Tone Spacing at 9.61GHz

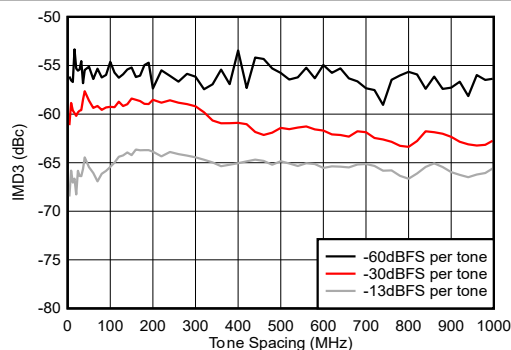


FIG 4-258. TX IMD3 vs Tone Spacing at 9.61GHz

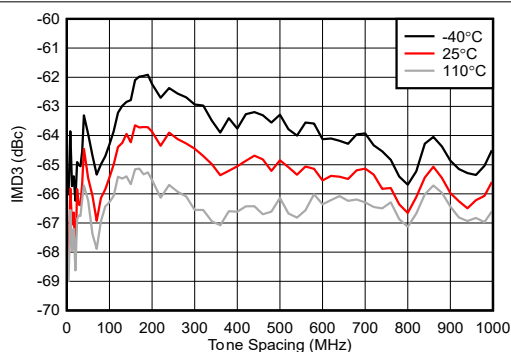


FIG 4-259. TX IMD3 vs Tone Spacing at 9.61GHz

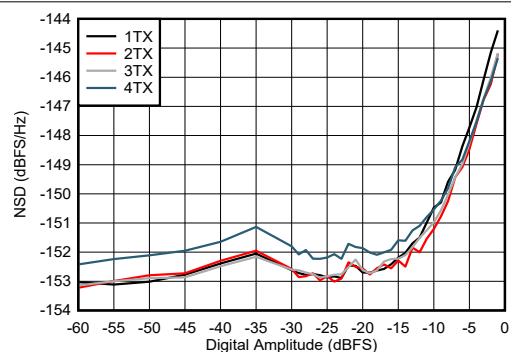


FIG 4-260. TX NSD vs Digital Amplitude at 9.61GHz

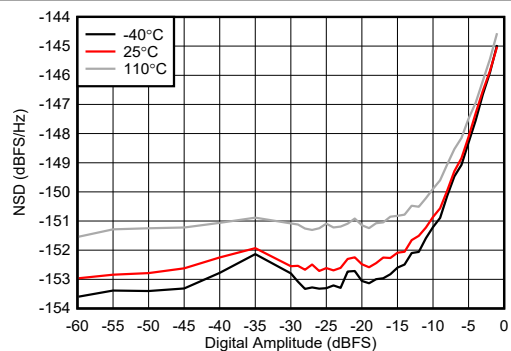


FIG 4-261. TX NSD vs Digital Amplitude at 9.61GHz

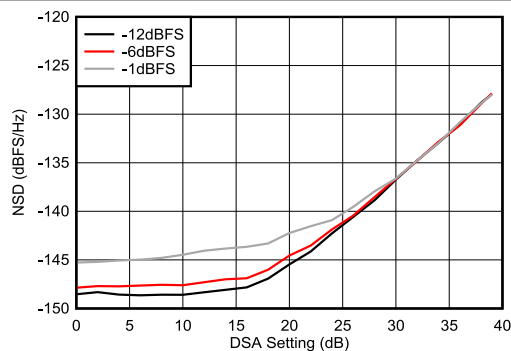


FIG 4-262. TX NSD vs DSA Setting at 9.61GHz

4.12.7 TX Typical Characteristics at 9.6GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 1474.56MSPS, $f_{\text{DAC}} = 11796.48\text{MSPS}$ (8x interpolation), Mixed mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1\text{dBFS}$, DSA = 0dB, Sin(x)/x enabled, DSA calibrated, 9.6GHz matching

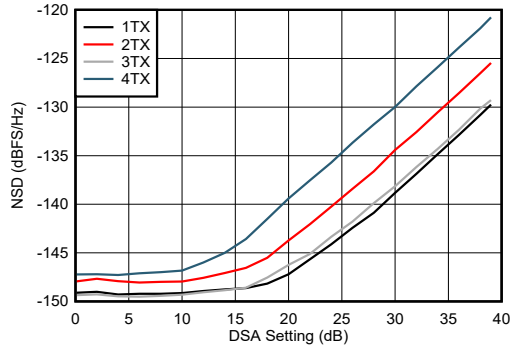


Figure 4-263. TX NSD vs DSA Setting at 9.61GHz

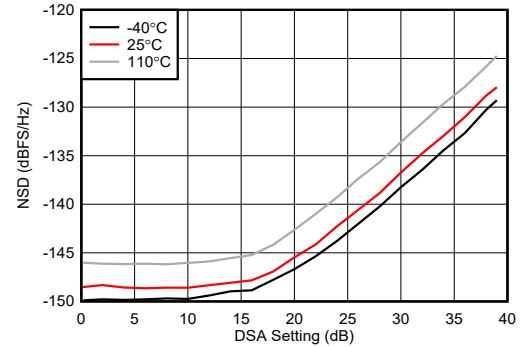
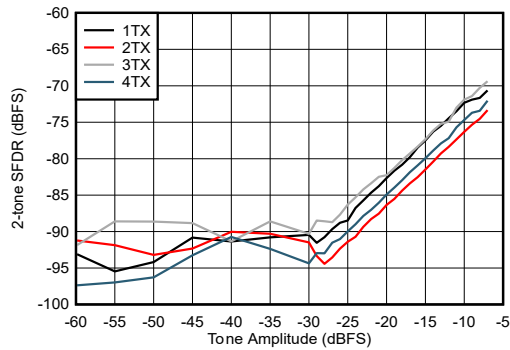
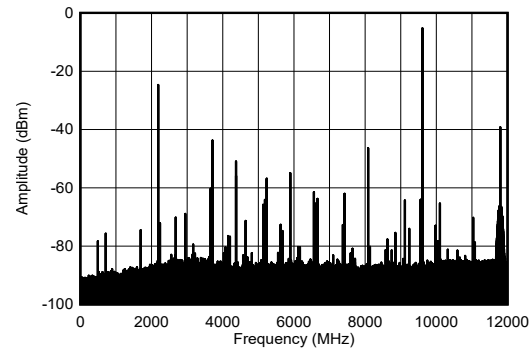


Figure 4-264. TX NSD vs DSA Setting at 9.61GHz



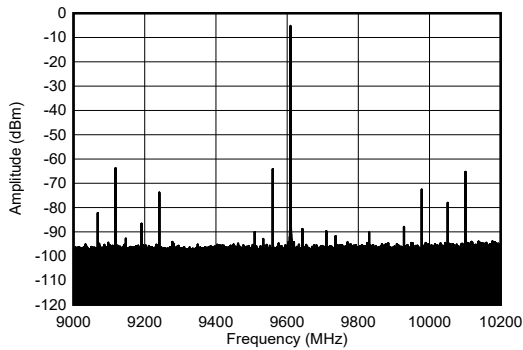
50 MHz tone spacing

Figure 4-265. TX 2-tone SFDR vs Digital Amplitude at 9.61GHz



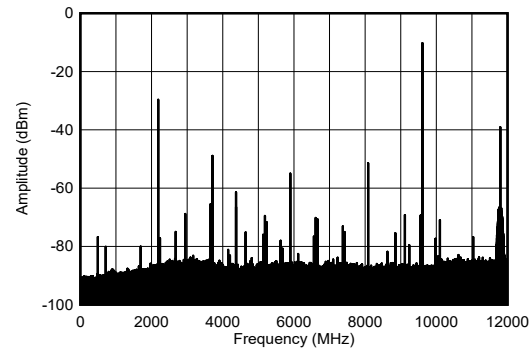
Includes PCB and cable losses.

Figure 4-266. TX Single Tone Spectrum at 9.61GHz and -1dBFS (wideband)



Includes PCB and cable losses.

Figure 4-267. TX Single Tone Spectrum at 9.61GHz and -1dBFS (1.2GHz BW)

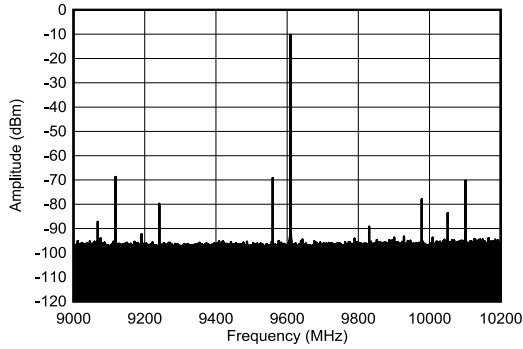


Includes PCB and cable losses.

Figure 4-268. TX Single Tone Spectrum at 9.61GHz and -6dBFS (wideband)

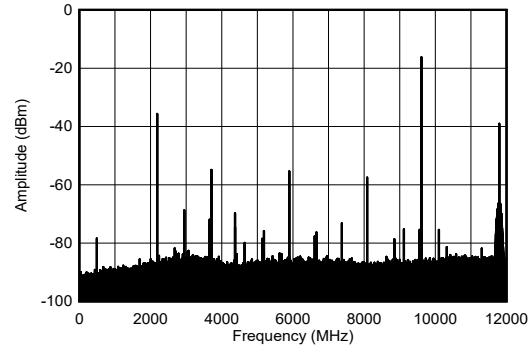
4.12.7 TX Typical Characteristics at 9.6GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 1474.56MSPS, $f_{\text{DAC}} = 11796.48\text{MSPS}$ (8x interpolation), Mixed mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1\text{dBFS}$, DSA = 0dB, Sin(x)/x enabled, DSA calibrated, 9.6GHz matching



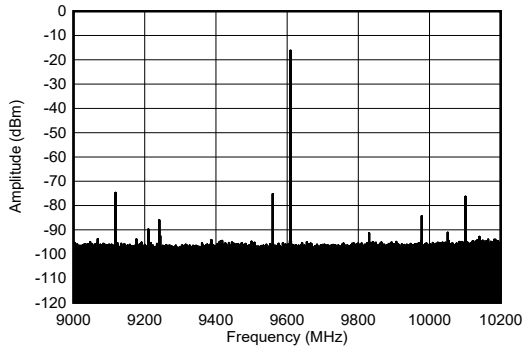
Includes PCB and cable losses.

図 4-269. TX Single Tone Spectrum at 9.61GHz and -6dBFS (1.2GHz BW)



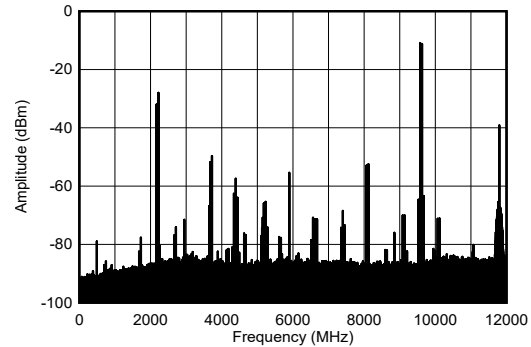
Includes PCB and cable losses.

図 4-270. TX Single Tone Spectrum at 9.61GHz and -12dBFS (wideband)



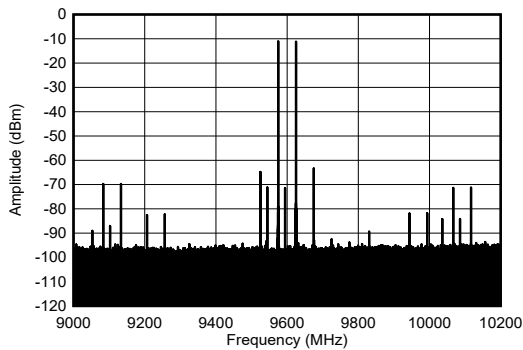
Includes PCB and cable losses.

図 4-271. TX Single Tone Spectrum at 9.61GHz and -12dBFS (1.2GHz BW)



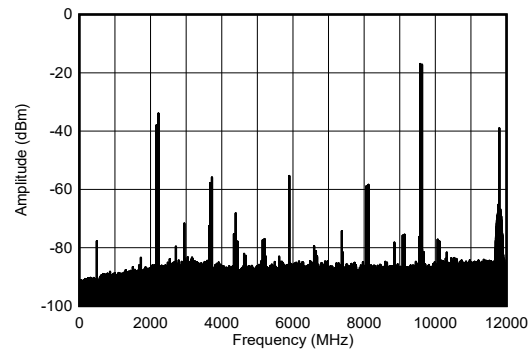
Includes PCB and cable losses, 50MHz tone spacing.

図 4-272. TX 2-Tone Spectrum at 9.61GHz and -7dBFS (wideband)



Includes PCB and cable losses, 50MHz tone spacing.

図 4-273. TX 2-Tone Spectrum at 9.61GHz and -7dBFS (1.2GHz BW)

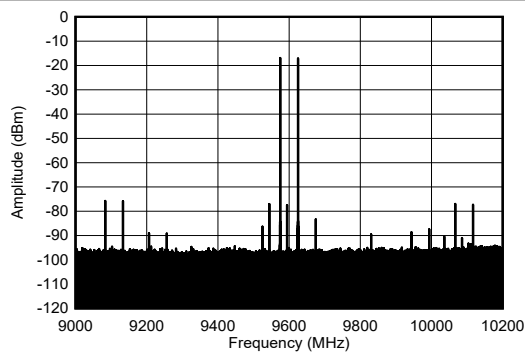


Includes PCB and cable losses, 50MHz tone spacing.

図 4-274. TX 2-Tone Spectrum at 9.61GHz and -13dBFS (wideband)

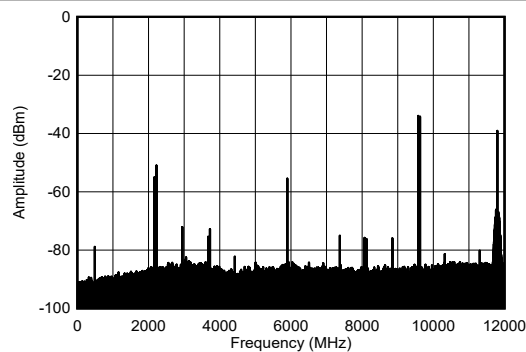
4.12.7 TX Typical Characteristics at 9.6GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 1474.56MSPS, $f_{\text{DAC}} = 11796.48\text{MSPS}$ (8x interpolation), Mixed mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1\text{dBFS}$, DSA = 0dB, Sin(x)/x enabled, DSA calibrated, 9.6GHz matching



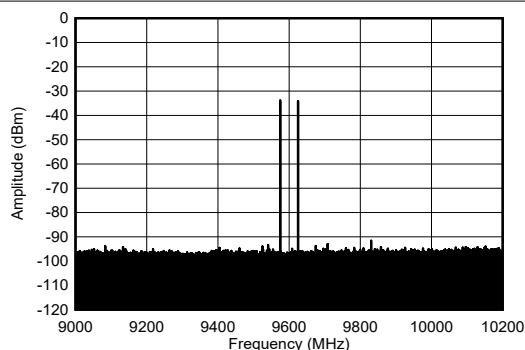
Includes PCB and cable losses, 50MHz tone spacing.

图 4-275. TX 2-Tone Spectrum at 9.61GHz and -13dBFS (1.2GHz BW)



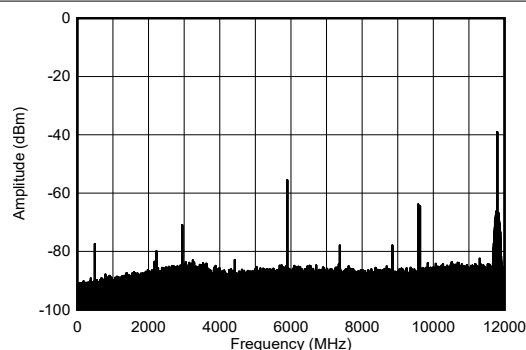
Includes PCB and cable losses, 50MHz tone spacing.

图 4-276. TX 2-Tone Spectrum at 9.61GHz and -30dBFS Each (wideband)



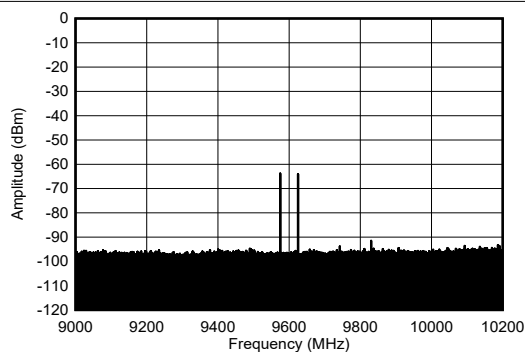
Includes PCB and cable losses, 50MHz tone spacing.

图 4-277. TX 2-Tone Spectrum at 9.61GHz and -30dBFS Each (1.2GHz BW)



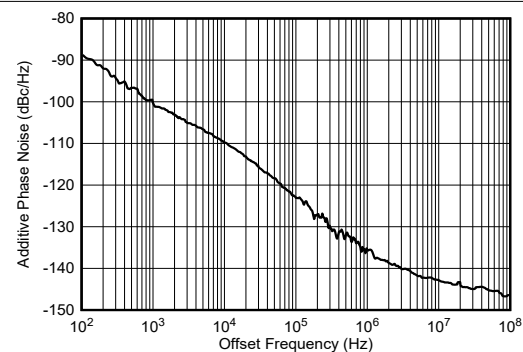
Includes PCB and cable losses, 50MHz tone spacing.

图 4-278. TX 2-Tone Spectrum at 9.61GHz and -60dBFS Each (wideband)



Includes PCB and cable losses, 50MHz tone spacing.

图 4-279. TX 2-Tone Spectrum at 9.61GHz and -60dBFS Each (1.2GHz BW)

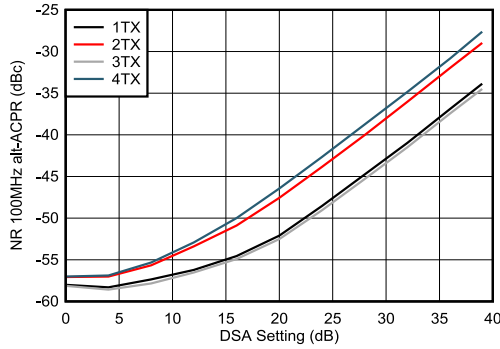


Single sideband, external clock mode, input clock phase noise removed

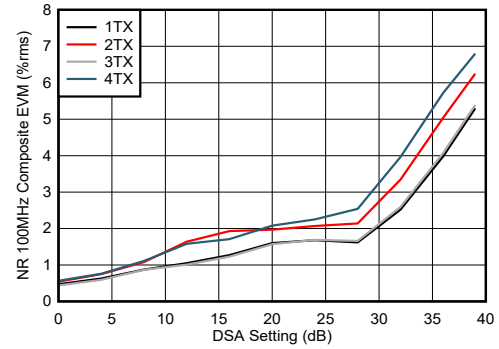
图 4-280. TX Additive Phase Noise vs Offset Frequency at 9.61GHz

4.12.7 TX Typical Characteristics at 9.6GHz (continued)

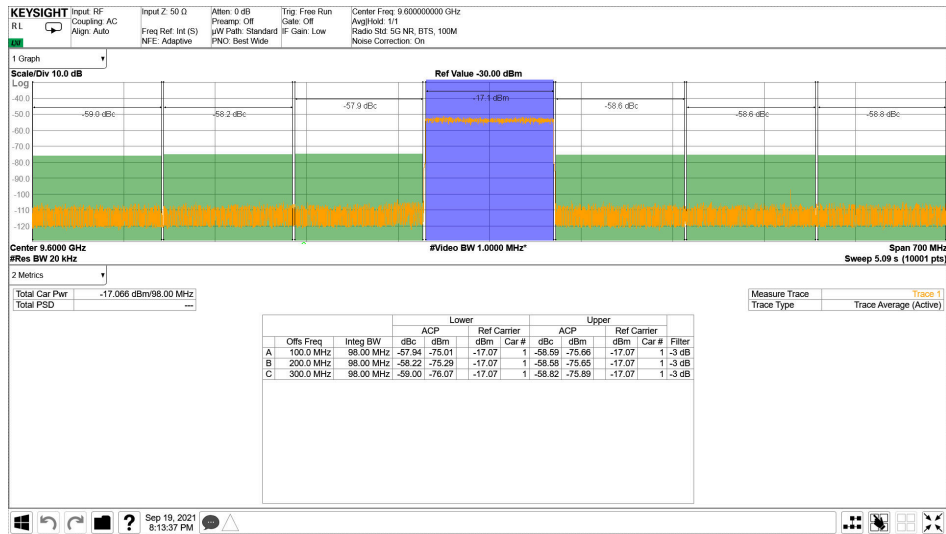
Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 1474.56MSPS, $f_{\text{DAC}} = 11796.48\text{MSPS}$ (8x interpolation), Mixed mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1\text{dBFS}$, DSA = 0dB, Sin(x)/x enabled, DSA calibrated, 9.6GHz matching



4-281. TX NR100MHz ACPR vs DSA Setting at 9.61GHz
NR100MHz alt-ACPR vs DSA Setting at 9.61GHz



4-282. TX NR100MHz EVM vs DSA Setting at 9.61GHz

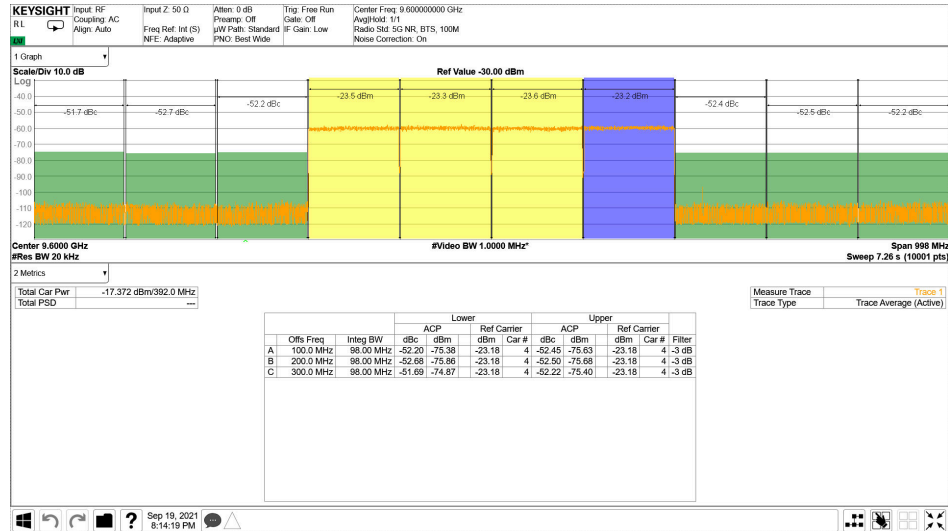


Includes PCB and cable losses.

4-283. TX NR100MHz Output Spectrum at 9.61GHz

4.12.7 TX Typical Characteristics at 9.6GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 1474.56MSPS, $f_{\text{DAC}} = 11796.48\text{MSPS}$ (8x interpolation), Mixed mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{OUT}} = -1\text{dBFS}$, DSA = 0dB, Sin(x)/x enabled, DSA calibrated, 9.6GHz matching

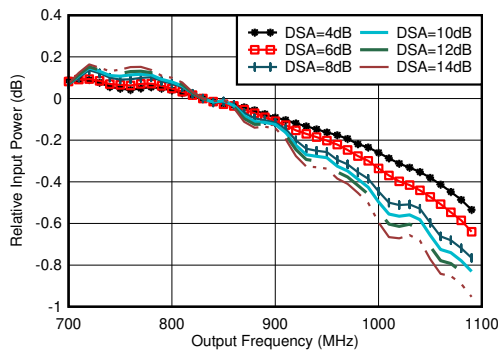


Includes PCB and cable losses.

4-284. TX 4xNR100MHz Output Spectrum at 9.61GHz

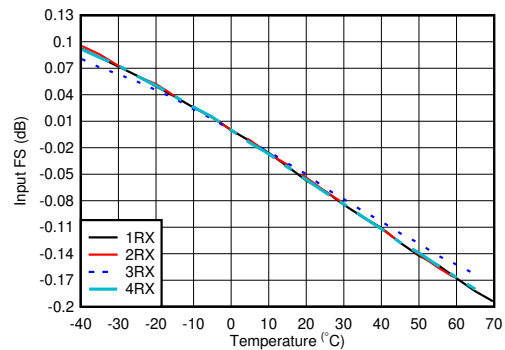
4.12.8 RX Typical Characteristics at 800MHz

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12GHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{IN}} = -3\text{dBFS}$, DSA setting = 4dB.



With 0.8GHz matching, normalized to 830MHz

4-285. RX In-Band Gain Flatness for Channel 1RX, $f_{\text{IN}} = 830\text{MHz}$

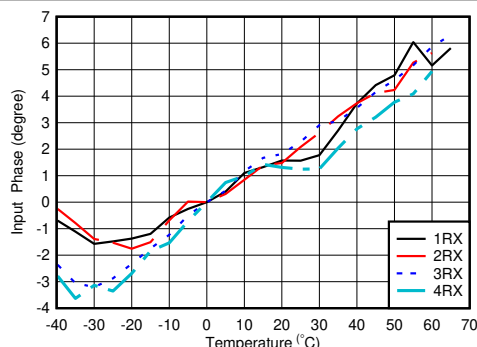


With 0.8GHz matching, normalized to fullscale at 25°C for each channel

4-286. RX Input Fullscale vs Temperature and Channel at 800MHz

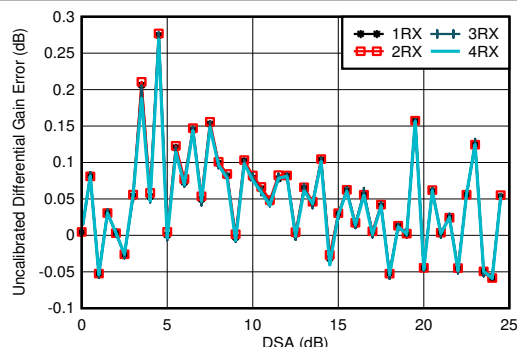
4.12.8 RX Typical Characteristics at 800MHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12GHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{IN}} = -3\text{dBFS}$, DSA setting = 4dB.



With 0.8GHz matching, normalized to phase at 25°C

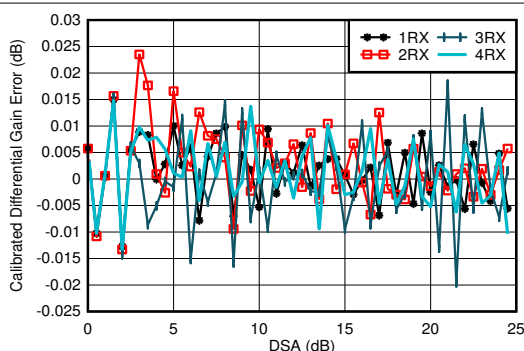
FIG 4-287. RX Input Phase vs Temperature and DSA at $f_{\text{OUT}} = 0.8\text{GHz}$



With 0.8GHz matching

Differential Amplitude Error = $P_{\text{IN}}(\text{DSA Setting} - 1) - P_{\text{IN}}(\text{DSA Setting}) + 1$

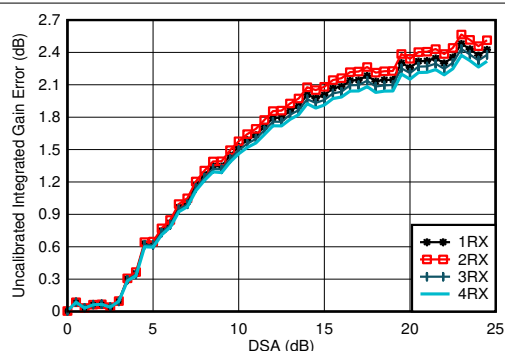
FIG 4-288. RX Uncalibrated Differential Amplitude Error vs DSA Setting at 0.8GHz



With 0.8GHz matching

Differential Amplitude Error = $P_{\text{IN}}(\text{DSA Setting} - 1) - P_{\text{IN}}(\text{DSA Setting}) + 1$

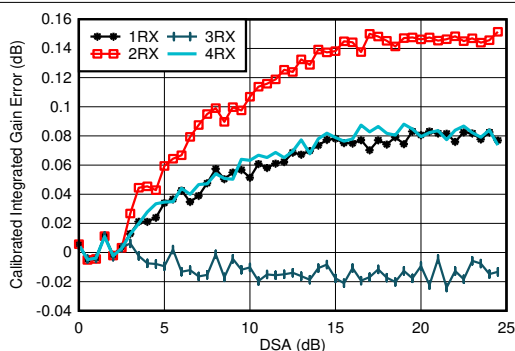
FIG 4-289. RX Calibrated Differential Amplitude Error vs DSA Setting at 0.8GHz



With 0.8GHz matching

Integrated Amplitude Error = $P_{\text{IN}}(\text{DSA Setting}) - P_{\text{IN}}(\text{DSA Setting} = 0) + (\text{DSA Setting})$

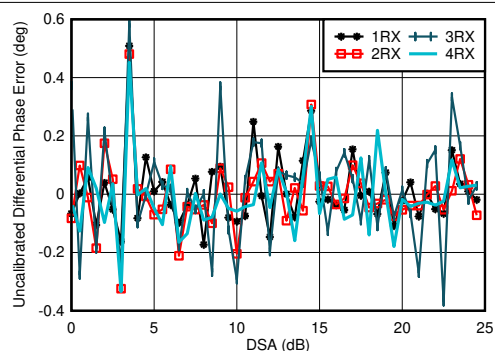
FIG 4-290. RX Uncalibrated Integrated Amplitude Error vs DSA Setting at 0.8GHz



With 0.8GHz matching

Integrated Amplitude Error = $P_{\text{IN}}(\text{DSA Setting}) - P_{\text{IN}}(\text{DSA Setting} = 0) + (\text{DSA Setting})$

FIG 4-291. RX Calibrated Integrated Amplitude Error vs DSA Setting at 2.6GHz



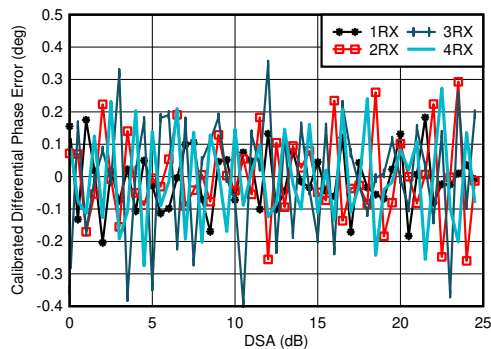
With 0.8GHz matching

Differential Phase Error = $\text{Phase}_{\text{IN}}(\text{DSA Setting} - 1) - \text{Phase}_{\text{IN}}(\text{DSA Setting})$

FIG 4-292. RX Uncalibrated Differential Phase Error vs DSA Setting at 0.8GHz

4.12.8 RX Typical Characteristics at 800MHz (continued)

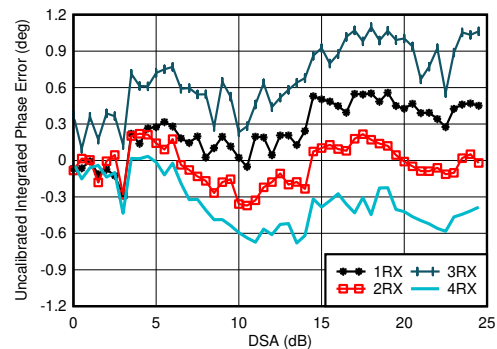
Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12GHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{IN}} = -3\text{dBFS}$, DSA setting = 4dB.



With 0.8GHz matching

Differential Phase Error = $\text{Phase}_{\text{IN}}(\text{DSA Setting} - 1) - \text{Phase}_{\text{IN}}(\text{DSA Setting})$

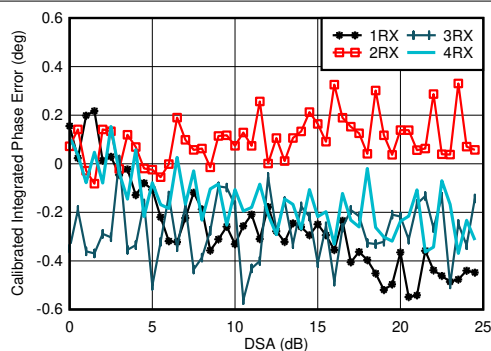
図 4-293. RX Calibrated Differential Phase Error vs DSA Setting at 0.8GHz



With 0.8GHz matching

Integrated Phase Error = $\text{Phase}(\text{DSA Setting}) - \text{Phase}(\text{DSA Setting} = 0)$

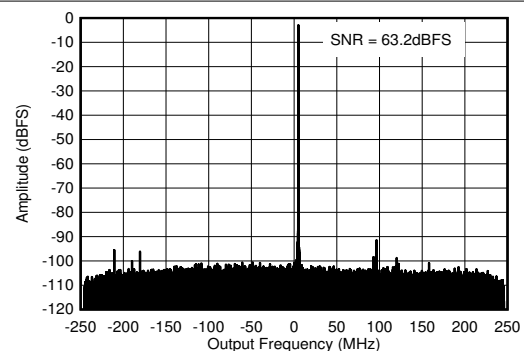
図 4-294. RX Uncalibrated Integrated Phase Error vs DSA Setting at 0.8GHz



With 0.8GHz matching

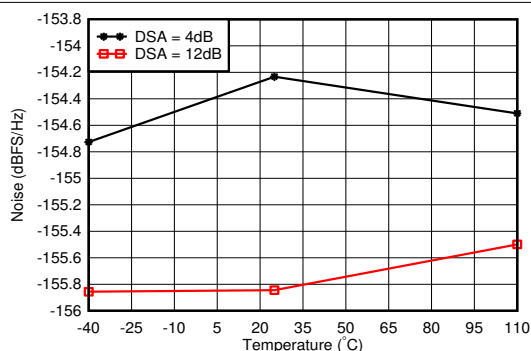
Integrated Phase Error = $\text{Phase}(\text{DSA Setting}) - \text{Phase}(\text{DSA Setting} = 0)$

図 4-295. RX Calibrated Integrated Phase Error vs DSA Setting at 0.8GHz



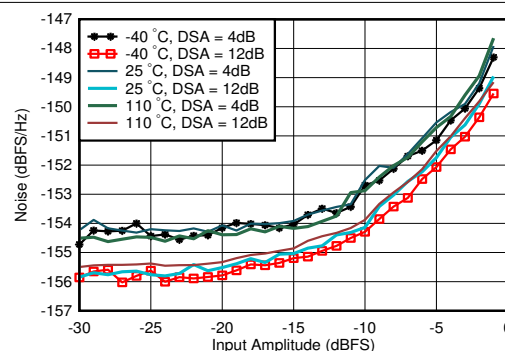
With 0.8GHz matching, $f_{\text{IN}} = 840\text{MHz}$, $A_{\text{IN}} = -3\text{dBFS}$

図 4-296. RX Output FFT at 0.8GHz



With 0.8GHz matching, 12.5MHz offset from tone

図 4-297. RX Noise Spectral Density vs Temperature at 0.8GHz

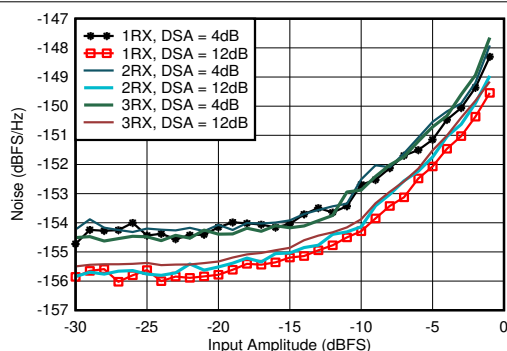


With 0.8GHz matching, DSA Setting = 12dB, 12.5MHz offset from tone

図 4-298. RX Noise Spectral Density vs Input Amplitude and Temperature at 0.8GHz

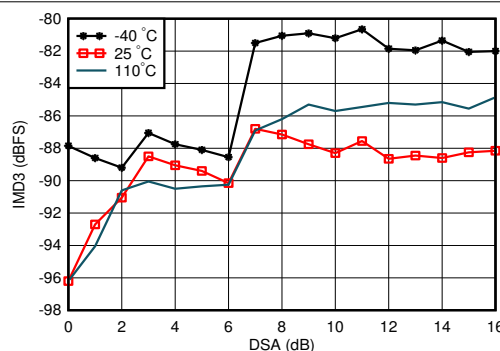
4.12.8 RX Typical Characteristics at 800MHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12GHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{IN}} = -3\text{dBFS}$, DSA setting = 4dB.



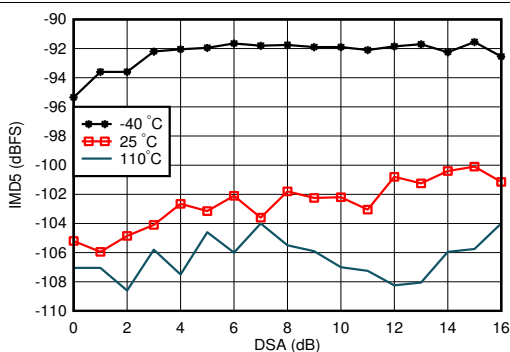
With 0.8GHz matching, 12.5MHz offset from tone

FIG 4-299. RX Noise Spectral Density vs Input Amplitude and Channel at 0.8GHz



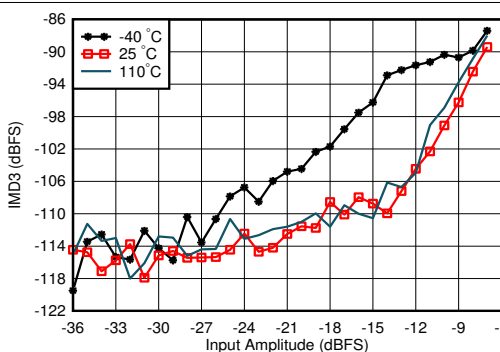
A. With 0.8GHz matching, each tone -7dBFS , tone spacing = 20MHz

FIG 4-300. RX IMD3 vs DSA Setting and Temperature at 0.8GHz



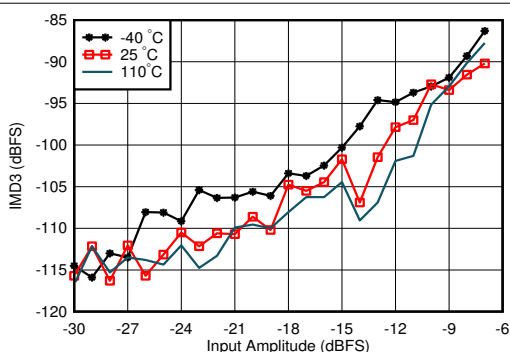
With 0.8GHz matching, each tone -7dBFS , tone spacing = 20MHz

FIG 4-301. RX IMD5 vs DSA Setting and Temperature at 0.8GHz



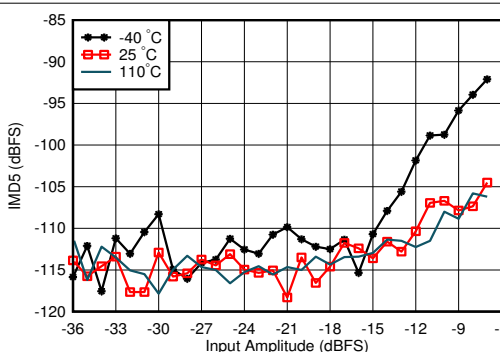
With 0.8GHz matching, tone spacing = 20MHz, DSA = 4dB

FIG 4-302. RX IMD3 vs Input Level and Temperature at 0.8GHz



With 0.8GHz matching, tone spacing = 20MHz, DSA = 12dB

FIG 4-303. RX IMD3 vs Input Level and Temperature at 0.8GHz

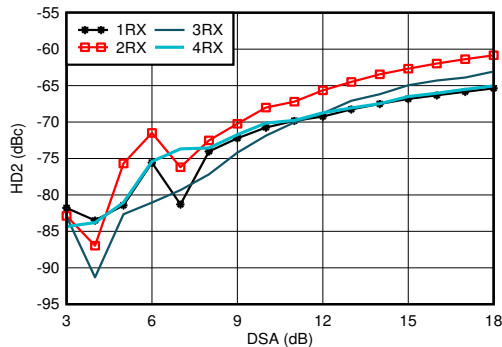


With 0.8GHz matching, tone spacing = 20MHz, DSA = 12dB

FIG 4-304. RX IMD5 vs Input Level and Temperature at 0.8GHz

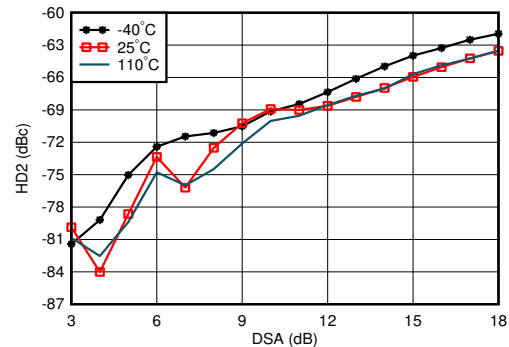
4.12.8 RX Typical Characteristics at 800MHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12MHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{IN}} = -3\text{dBFS}$, DSA setting = 4dB.



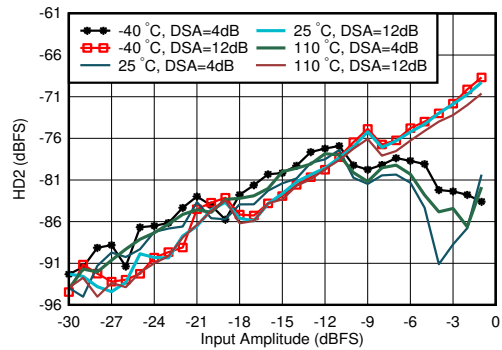
With 0.8GHz matching, measured after HD2 trim, DDC bypass mode (TI only mode for characterization)

FIG 4-305. RX HD2 vs DSA Setting and Channel at 0.8GHz



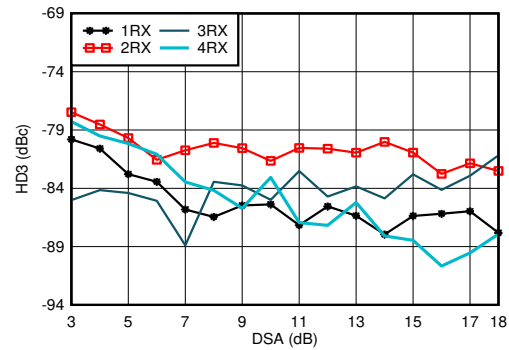
With 0.8GHz matching, measured after HD2 trim, DDC bypass mode (TI only mode for characterization)

FIG 4-306. RX HD2 vs DSA Setting and Temperature at 0.8GHz



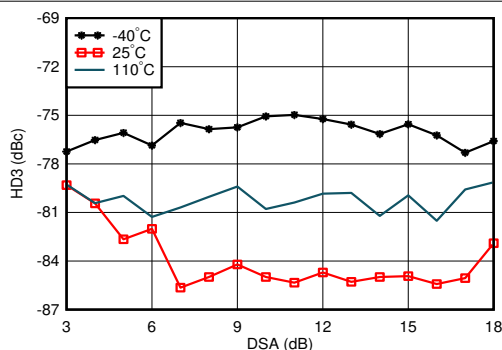
With 0.8GHz matching, measured after HD2 trim, DDC bypass mode (TI only mode for characterization)

FIG 4-307. RX HD2 vs Input Level and Temperature at 0.8GHz



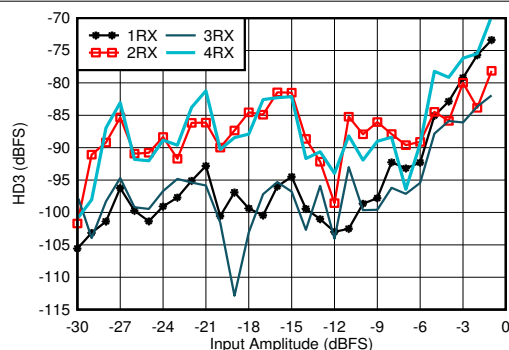
With 0.8GHz matching, DDC bypass mode (TI only mode for characterization)

FIG 4-308. RX HD3 vs DSA Setting and Channel at 0.8GHz



With 0.8GHz matching, DDC bypass mode (TI only mode for characterization)

FIG 4-309. RX HD3 vs DSA Setting and Temperature at 0.8GHz

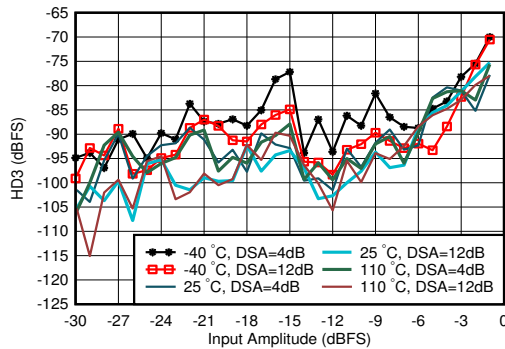


With 0.8GHz matching, DDC bypass mode (TI only mode for characterization)

FIG 4-310. RX HD3 vs Input Level and Channel at 0.8GHz

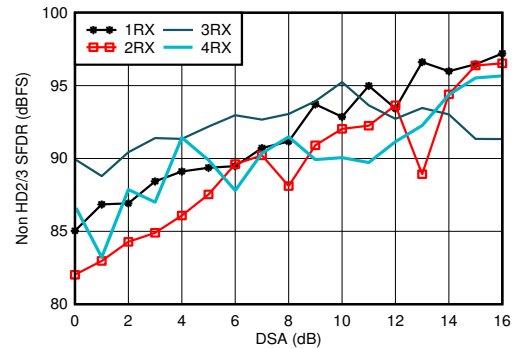
4.12.8 RX Typical Characteristics at 800MHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12GHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{IN}} = -3\text{dBFS}$, DSA setting = 4dB.



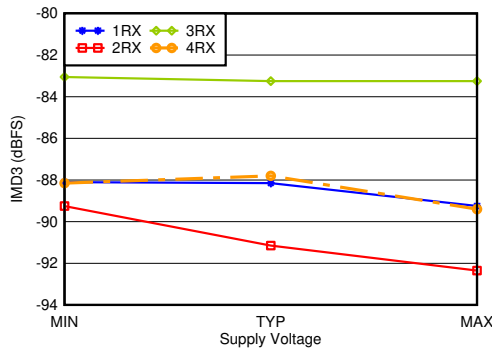
With 0.8GHz matching, DDC bypass mode (TI only mode for characterization)

FIG 4-311. RX HD3 vs Input Level and Temperature at 0.8GHz



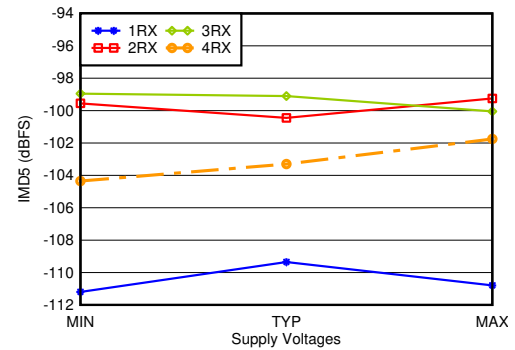
With 0.8GHz matching

FIG 4-312. RX Non-HD2/3 vs DSA Setting at 0.8GHz



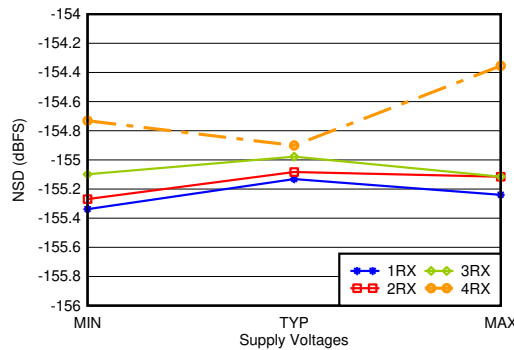
With 0.8GHz matching, -7dBFS each tone, 20MHz tone spacing, all supplies at MIN, TYP, or MAX recommended operating voltages

FIG 4-313. RX IMD3 vs Supply and Channel at 0.8GHz



With 0.8GHz matching, -7dBFS each tone, 20MHz tone spacing, all supplies at MIN, TYP, or MAX recommended operating voltages

FIG 4-314. RX IMD5 vs Supply and Channel at 0.8GHz

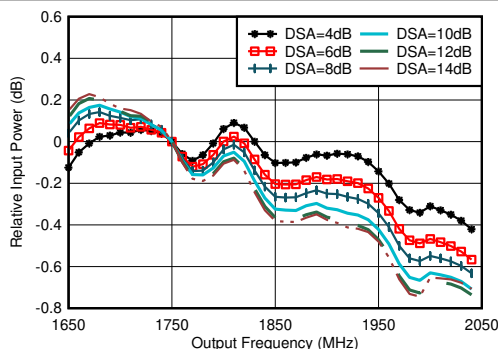


With 0.8GHz matching, 12.5MHz offset, all supplies at MIN, TYP, or MAX recommended operating voltages

FIG 4-315. RX Noise Spectral Density vs Supply and Channel at 0.8GHz

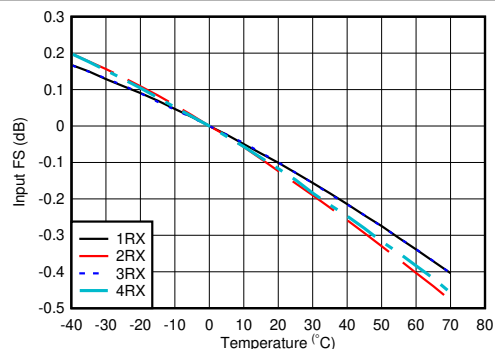
4.12.9 RX Typical Characteristics at 1.75-1.9GHz

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12MHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{IN}} = -3\text{dBFS}$, DSA setting = 4dB.



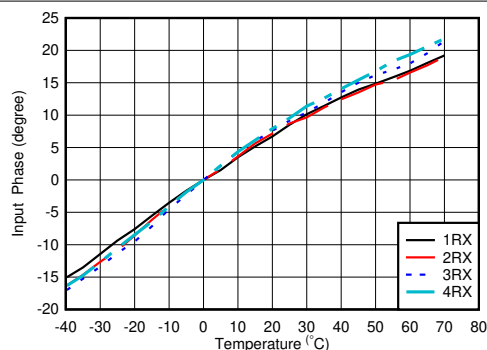
With 1.8GHz matching, normalized to 1.75GHz

Figure 4-316. RX In-Band Gain Flatness, $f_{\text{IN}} = 1750\text{MHz}$



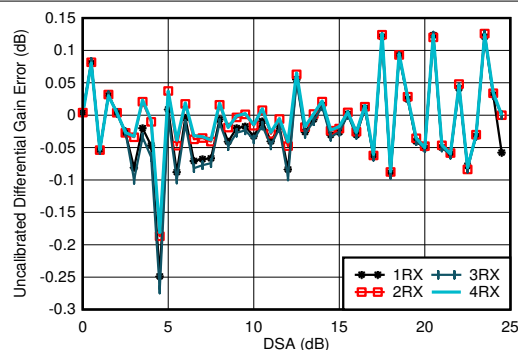
With 1.8GHz matching, normalized to fullscale at 25°C for each channel

Figure 4-317. RX Input Fullscale vs Temperature and Channel at 1.75GHz



With 2.6GHz matching, normalized to phase at 25°C

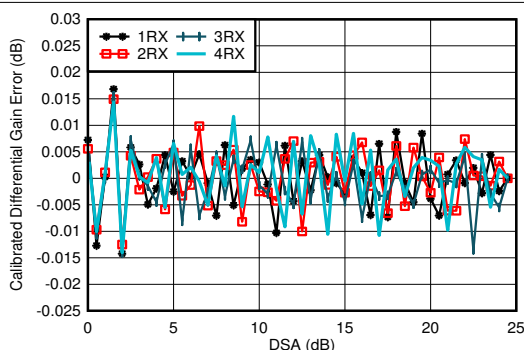
Figure 4-318. RX Input Phase vs Temperature and DSA at $f_{\text{IN}} = 1.75\text{GHz}$



With 1.8GHz matching

Differential Amplitude Error = $P_{\text{IN}}(\text{DSA Setting} - 1) - P_{\text{IN}}(\text{DSA Setting}) + 1$

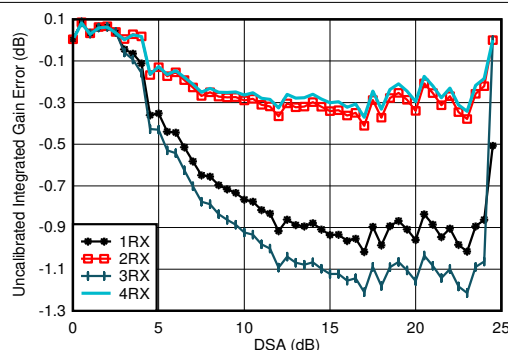
Figure 4-319. RX Uncalibrated Differential Amplitude Error vs DSA Setting at 1.75GHz



With 1.8GHz matching

Differential Amplitude Error = $P_{\text{IN}}(\text{DSA Setting} - 1) - P_{\text{IN}}(\text{DSA Setting}) + 1$

Figure 4-320. RX Calibrated Differential Amplitude Error vs DSA Setting at 1.75GHz



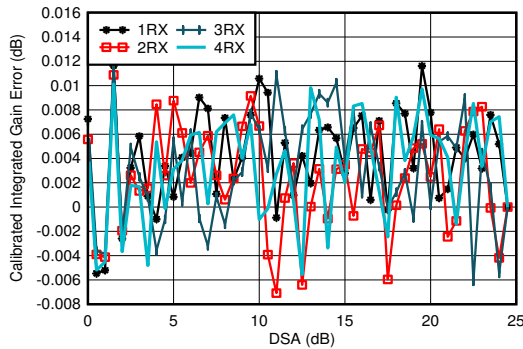
With 1.8GHz matching

Integrated Amplitude Error = $P_{\text{IN}}(\text{DSA Setting}) - P_{\text{IN}}(\text{DSA Setting} = 0) + (\text{DSA Setting})$

Figure 4-321. RX Uncalibrated Integrated Amplitude Error vs DSA Setting at 1.75GHz

4.12.9 RX Typical Characteristics at 1.75-1.9GHz (continued)

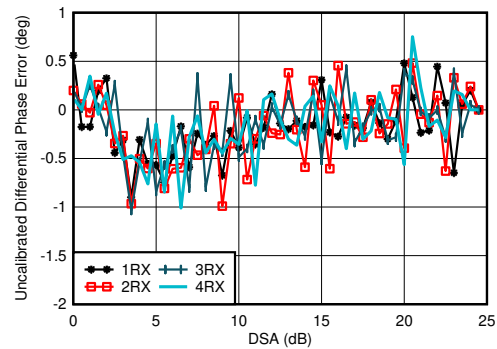
Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12MHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{IN}} = -3\text{dBFS}$, DSA setting = 4dB.



With 1.8GHz matching

Integrated Amplitude Error = $P_{\text{IN}}(\text{DSA Setting}) - P_{\text{IN}}(\text{DSA Setting} = 0) + (\text{DSA Setting})$

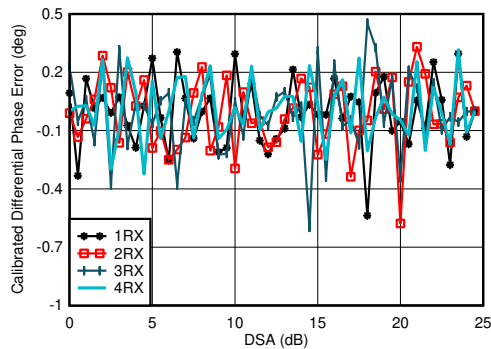
FIG 4-322. RX Calibrated Integrated Amplitude Error vs DSA Setting at 1.75GHz



With 1.8GHz matching

Differential Phase Error = $\text{Phase}_{\text{IN}}(\text{DSA Setting} - 1) - \text{Phase}_{\text{IN}}(\text{DSA Setting})$

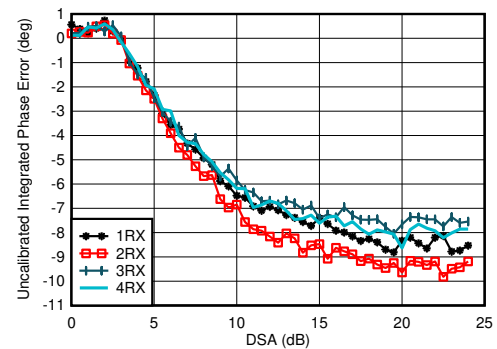
FIG 4-323. RX Uncalibrated Differential Phase Error vs DSA Setting at 1.75GHz



With 1.8GHz matching

Differential Phase Error = $\text{Phase}_{\text{IN}}(\text{DSA Setting} - 1) - \text{Phase}_{\text{IN}}(\text{DSA Setting})$

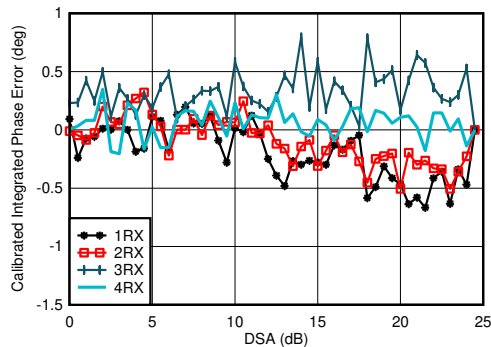
FIG 4-324. RX Calibrated Differential Phase Error vs DSA Setting at 1.75GHz



With 1.8GHz matching

Integrated Phase Error = $\text{Phase}(\text{DSA Setting}) - \text{Phase}(\text{DSA Setting} = 0)$

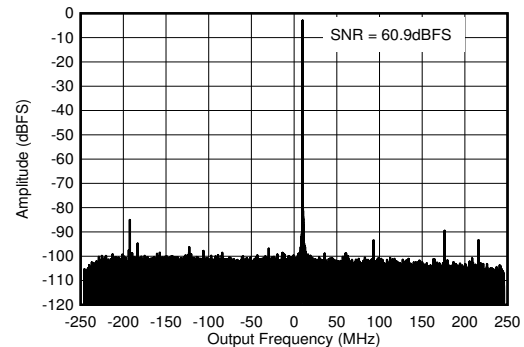
FIG 4-325. RX Uncalibrated Integrated Phase Error vs DSA Setting at 1.75GHz



With 1.8GHz matching

Integrated Phase Error = $\text{Phase}(\text{DSA Setting}) - \text{Phase}(\text{DSA Setting} = 0)$

FIG 4-326. RX Calibrated Integrated Phase Error vs DSA Setting at 1.75GHz

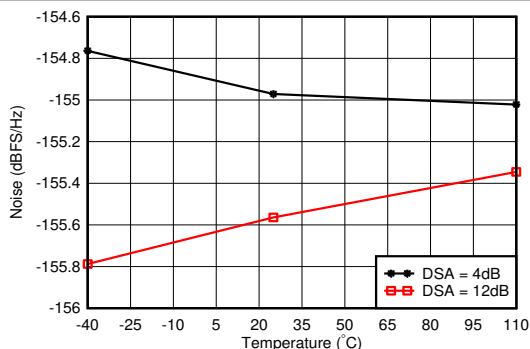


With 1.8GHz matching, $f_{\text{IN}} = 2610\text{MHz}$, $A_{\text{IN}} = -3\text{dBFS}$

FIG 4-327. RX Output FFT at 1.75GHz

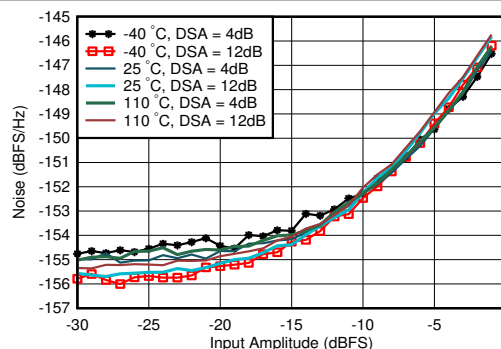
4.12.9 RX Typical Characteristics at 1.75-1.9GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12MHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{IN}} = -3\text{dBFS}$, DSA setting = 4dB.



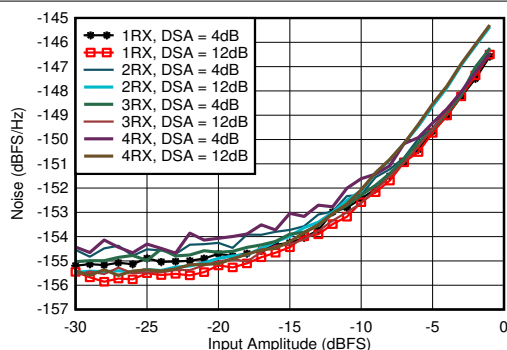
With 1.8GHz matching, 12.5MHz offset from tone

FIG 4-328. RX Noise Spectral Density vs Temperature at 1.75GHz



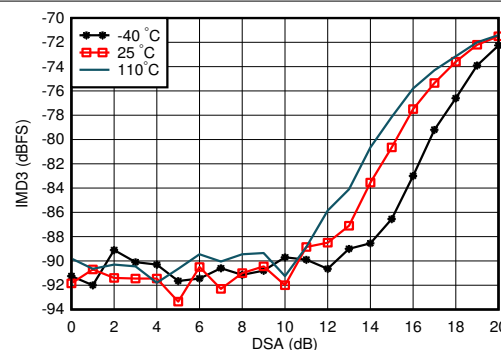
With 1.8GHz matching, DSA Setting = 12dB, 12.5MHz offset from tone

FIG 4-329. RX Noise Spectral Density vs Input Amplitude and Temperature at 1.75GHz



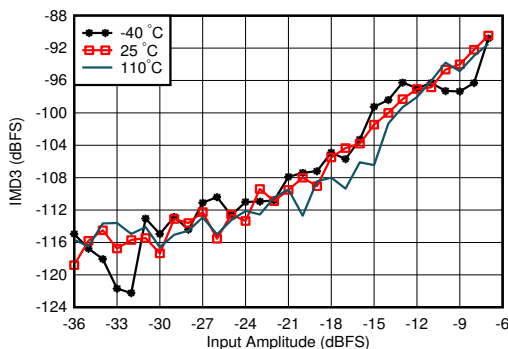
With 1.8GHz matching, 12.5MHz offset from tone

FIG 4-330. RX Noise Spectral Density vs Input Amplitude and Channel at 1.75GHz



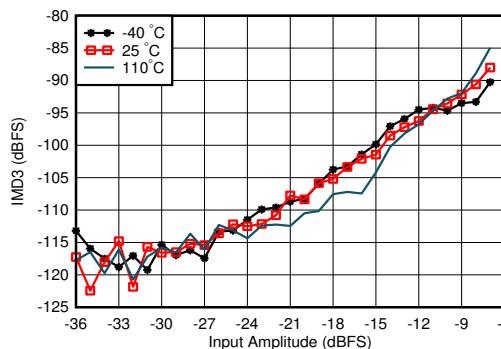
With 1.8GHz matching, each tone -7dBFS , tone spacing = 20MHz

FIG 4-331. RX IMD3 vs DSA Setting and Temperature at 1.75GHz



With 1.8GHz matching, tone spacing = 20MHz, DSA = 4dB

FIG 4-332. RX IMD3 vs Input Level and Temperature at 1.75GHz

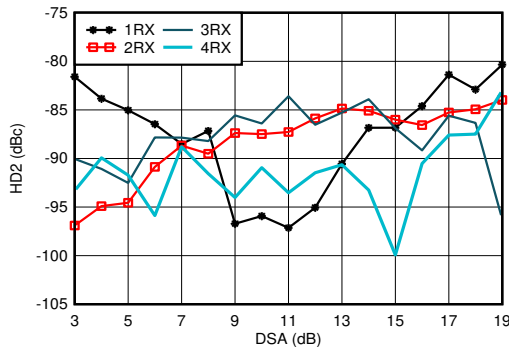


With 1.8GHz matching, tone spacing = 20MHz, DSA = 12dB

FIG 4-333. RX IMD3 vs Input Level and Temperature at 1.75GHz

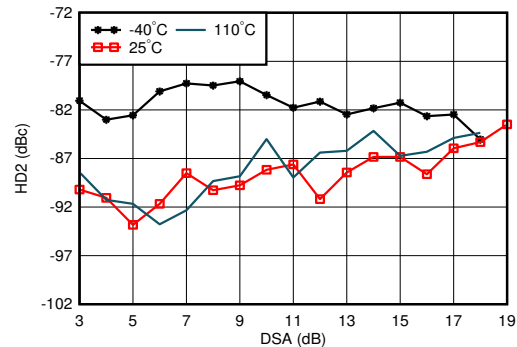
4.12.9 RX Typical Characteristics at 1.75-1.9GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12MHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{IN}} = -3\text{dBFS}$, DSA setting = 4dB.



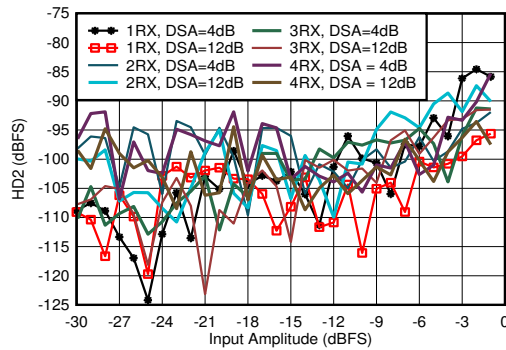
With 1.8GHz matching, $f_{\text{in}} = 1900\text{MHz}$, measured after HD2 trim, DDC bypass mode (TI only mode for characterization)

FIG 4-334. RX HD2 vs DSA Setting and Channel at 1.9 GHz



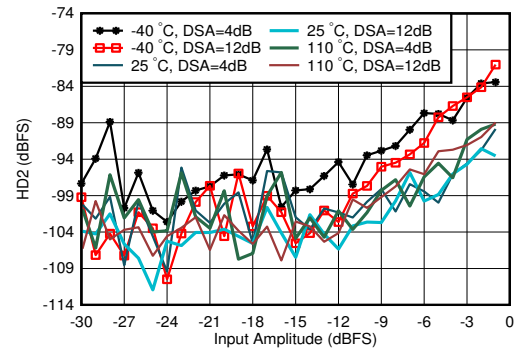
With 1.8GHz matching, $f_{\text{in}} = 1900\text{MHz}$, measured after HD2 trim, DDC bypass mode (TI only mode for characterization)

FIG 4-335. RX HD2 vs DSA Setting and Temperature at 1.9 GHz



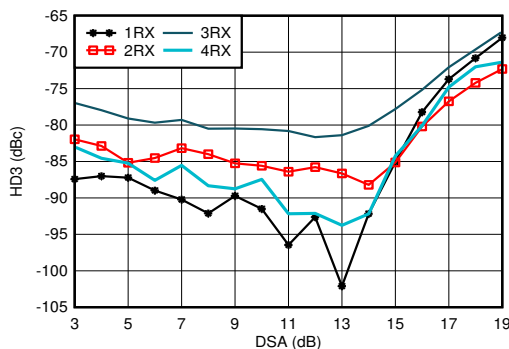
With 1.8GHz matching, $f_{\text{in}} = 1900\text{MHz}$, measured after HD2 trim, DDC bypass mode (TI only mode for characterization)

FIG 4-336. RX HD2 vs Input Amplitude and Channel at 1.9GHz



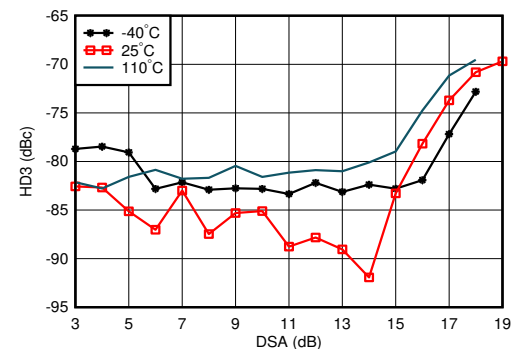
With 1.8GHz matching, $f_{\text{in}} = 1900\text{MHz}$, measured after HD2 trim, DDC bypass mode (TI only mode for characterization)

FIG 4-337. RX HD2 vs Input Amplitude and Temperature at 1.9GHz



With 1.8GHz matching, $f_{\text{in}} = 1900\text{MHz}$, DDC bypass mode (TI only mode for characterization)

FIG 4-338. RX HD3 vs DSA Setting and Channel at 1.9GHz

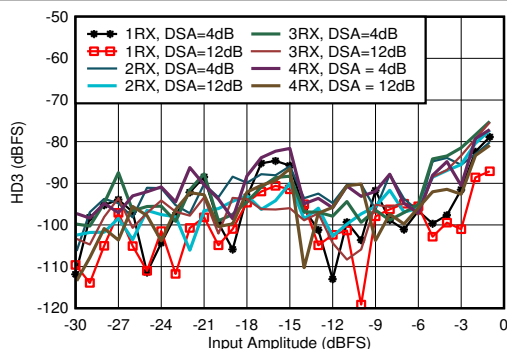


With 1.8GHz matching, $f_{\text{in}} = 1900\text{MHz}$, DDC bypass mode (TI only mode for characterization)

FIG 4-339. RX HD3 vs DSA Setting and Temperature at 1.9GHz

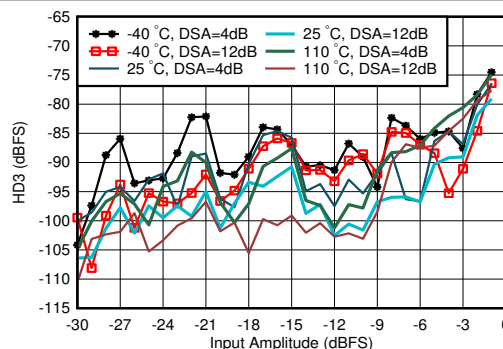
4.12.9 RX Typical Characteristics at 1.75-1.9GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12MHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{IN}} = -3\text{dBFS}$, DSA setting = 4dB.



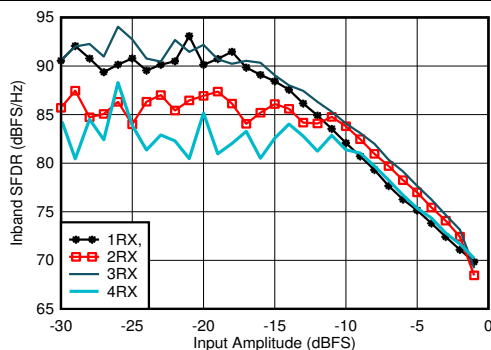
With 1.8GHz matching, $f_{\text{in}} = 1900\text{MHz}$, DDC bypass mode (TI only mode for characterization)

FIG 4-340. RX HD3 vs Input Level and Channel at 1.9GHz



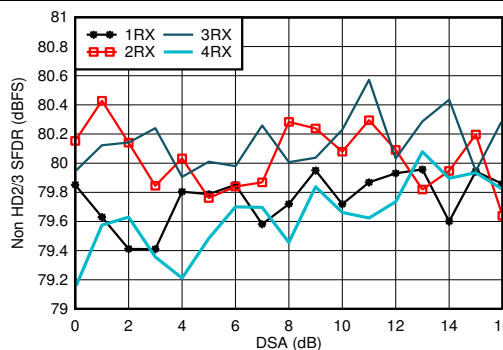
With 1.8GHz matching, $f_{\text{in}} = 1900\text{MHz}$, DDC bypass mode (TI only mode for characterization)

FIG 4-341. RX HD3 vs Input Level and Temperature at 1.9GHz



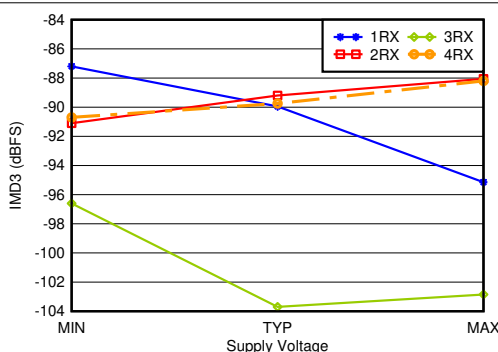
With 1.8GHz matching, decimated by 3

FIG 4-342. RX In-Band SFDR ($\pm 400\text{MHz}$) vs Input Amplitude at 1.75GHz



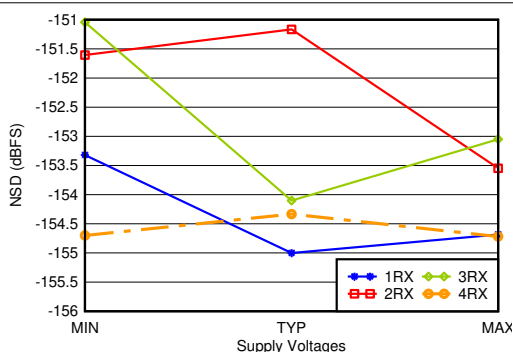
With 1.8GHz matching

FIG 4-343. RX Non-HD2/3 vs DSA Setting at 1.75GHz



With 1.8GHz matching, -7dBFS each tone, 20MHz tone spacing, all supplies at MIN, TYP, or MAX recommended operating voltages

FIG 4-344. RX IMD3 vs Supply and Channel at 1.75GHz

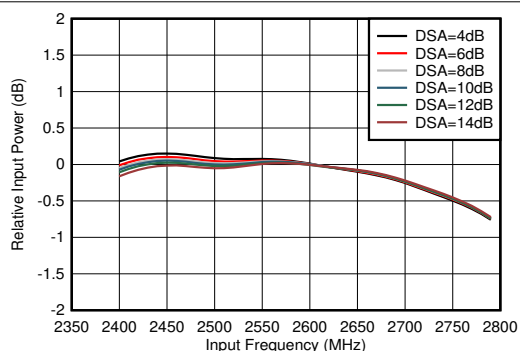


With 1.8GHz matching, 12.5MHz offset, all supplies at MIN, TYP, or MAX recommended operating voltages

FIG 4-345. RX Noise Spectral Density vs Supply and Channel at 1.75GHz

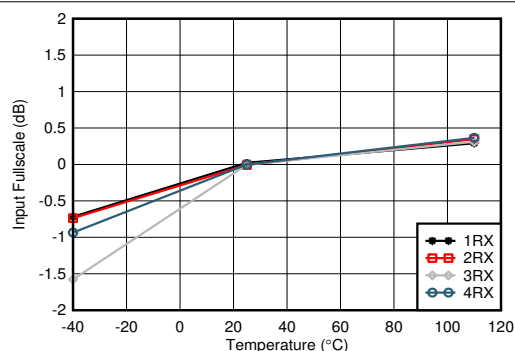
4.12.10 RX Typical Characteristics at 2.6GHz

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12MHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{IN}} = -3\text{dBFS}$, DSA setting = 4dB.



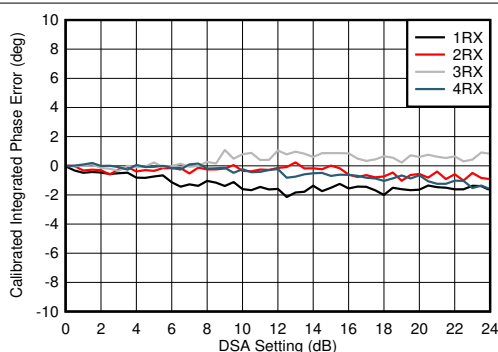
With matching, normalized to power at 2.6GHz for each DSA setting

図 4-346. RX Inband Gain Flatness, $f_{\text{IN}} = 2600\text{MHz}$



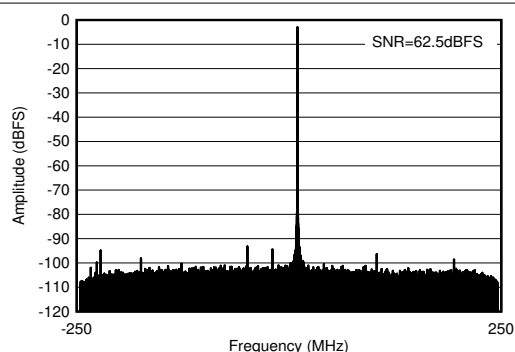
With 2.6GHz matching, normalized to fullscale at 25°C for each channel

図 4-347. RX Input Fullscale vs Temperature and Channel at 2.6GHz



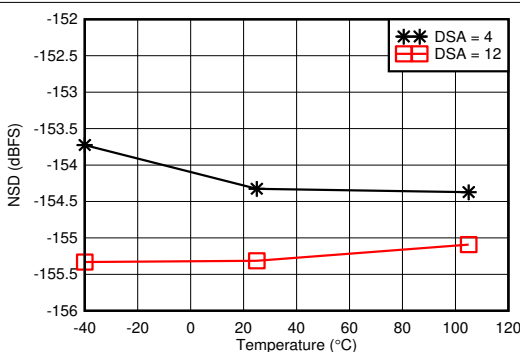
With 2.6GHz matching
Integrated Phase Error = Phase(DSA Setting) – Phase(DSA Setting = 0)

図 4-348. RX Calibrated Integrated Phase Error vs DSA Setting at 2.6GHz



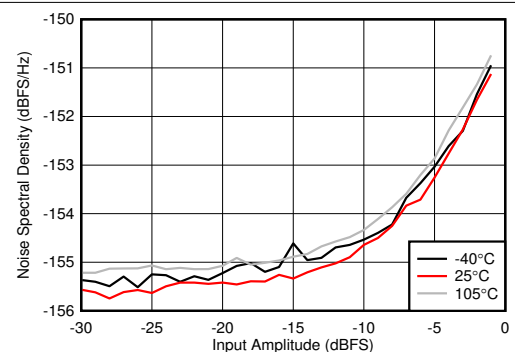
With 2.6GHz matching, $f_{\text{IN}} = 2610\text{MHz}$, $A_{\text{IN}} = -3\text{dBFS}$

図 4-349. RX Output FFT at 2.6GHz



With 2.6GHz matching, 12.5MHz offset from tone

図 4-350. RX Noise Spectral Density vs Temperature at 2.6GHz

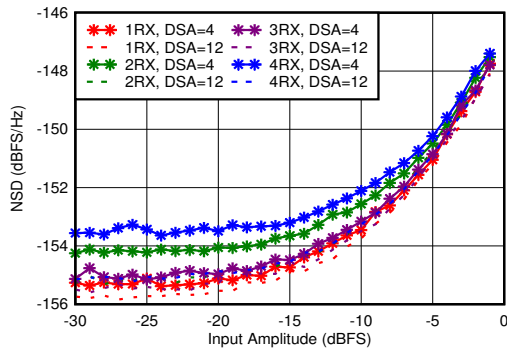


With 2.6GHz matching, DSA Setting = 12dB, 12.5MHz offset from tone

図 4-351. RX Noise Spectral Density vs Input Amplitude and Temperature at 2.6GHz

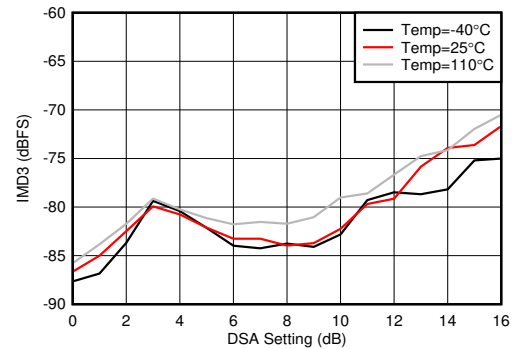
4.12.10 RX Typical Characteristics at 2.6GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12MHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{IN}} = -3\text{dBFS}$, DSA setting = 4dB.



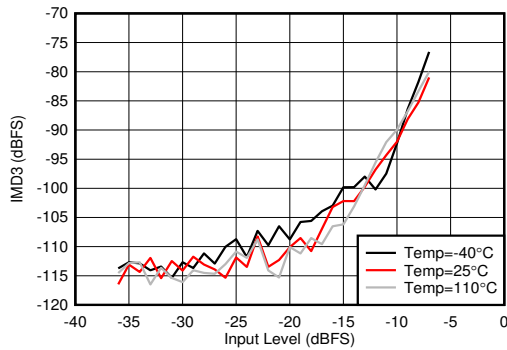
With 2.6GHz matching, 12.5MHz offset from tone

FIG 4-352. RX Noise Spectral Density vs Input Amplitude and Channel at 2.6GHz



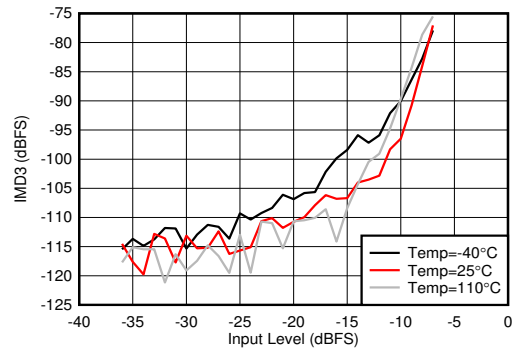
With 2.6GHz matching, each tone -7dBFS , tone spacing = 20MHz

FIG 4-353. RX IMD3 vs DSA Setting and Temperature at 2.6GHz



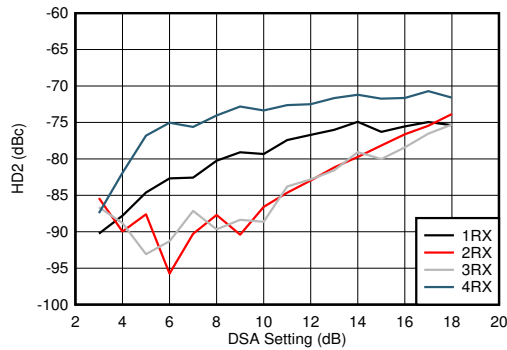
With 2.6GHz matching, tone spacing = 20MHz, DSA = 4dB

FIG 4-354. RX IMD3 vs Input Level and Temperature at 2.6GHz



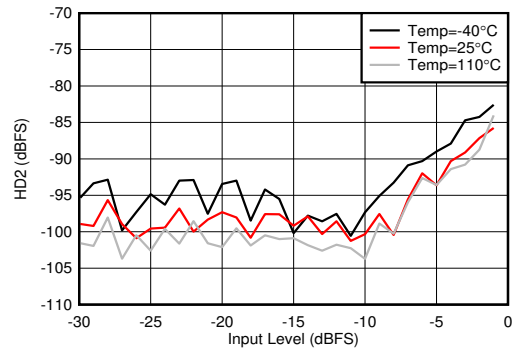
With 2.6GHz matching, tone spacing = 20MHz, DSA = 12dB

FIG 4-355. RX IMD3 vs Input Level and Temperature at 2.6GHz



With 2.6GHz matching, DDC bypass mode (TI only mode for characterization)

FIG 4-356. RX HD2 vs DSA Setting and Channel at 2.6GHz

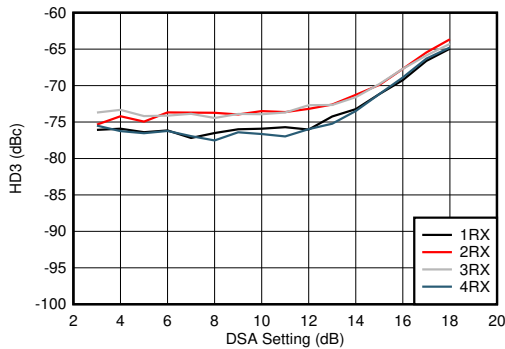


With 2.6GHz matching, DDC bypass mode (TI only mode for characterization)

FIG 4-357. RX HD2 vs Input Level and Temperature at 2.6GHz

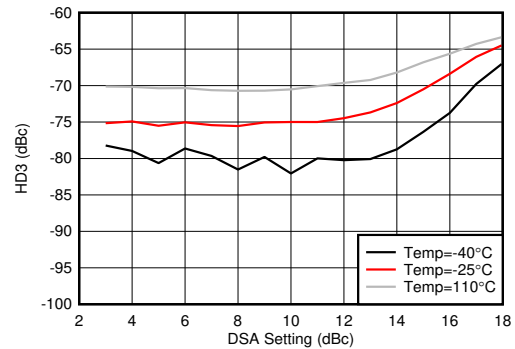
4.12.10 RX Typical Characteristics at 2.6GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12MHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{IN}} = -3\text{dBFS}$, DSA setting = 4dB.



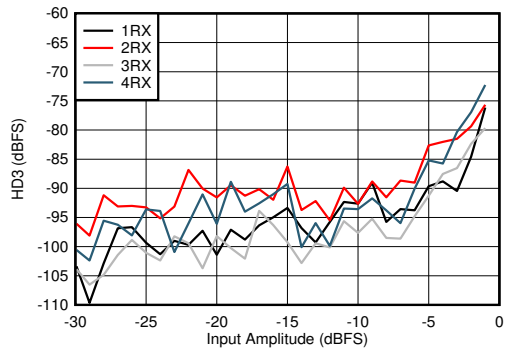
With 2.6GHz matching, DDC bypass mode (TI only mode for characterization)

FIG 4-358. RX HD3 vs DSA Setting and Channel at 2.6GHz



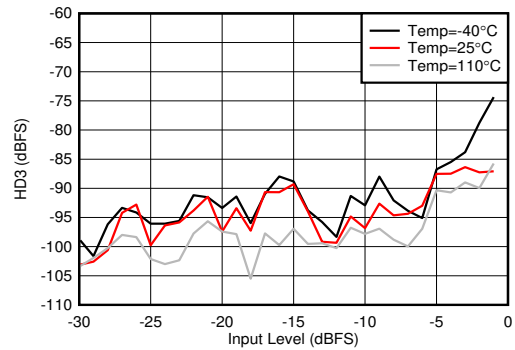
With 2.6GHz matching, DDC bypass mode (TI only mode for characterization)

FIG 4-359. RX HD3 vs DSA Setting and Temperature at 2.6GHz



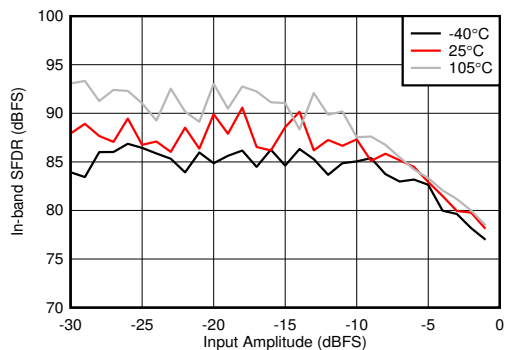
With 2.6GHz matching, DDC bypass mode (TI only mode for characterization)

FIG 4-360. RX HD3 vs Input Level and Channel at 2.6GHz



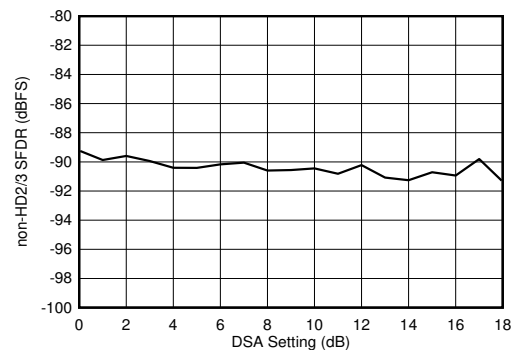
With 2.6GHz matching, DDC bypass mode (TI only mode for characterization)

FIG 4-361. RX HD3 vs Input Level and Temperature at 2.6GHz



With 2.6GHz matching, decimate by 4

FIG 4-362. RX In-Band SFDR ($\pm 300\text{ MHz}$) vs Input Amplitude and Temperature at 2.6GHz

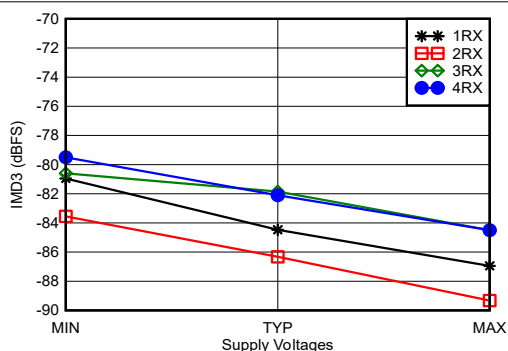


With 2.6GHz matching

FIG 4-363. RX Non-HD2/3 vs DSA Setting at 2.6GHz

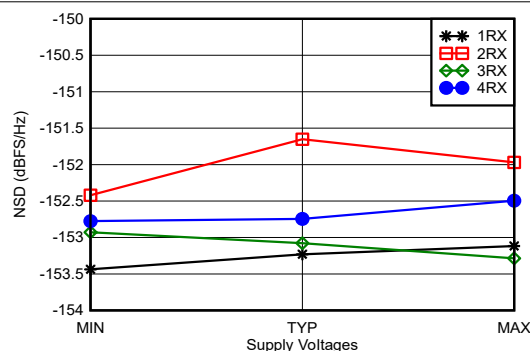
4.12.10 RX Typical Characteristics at 2.6GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12GHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{IN}} = -3\text{dBFS}$, DSA setting = 4dB.



With 2.6GHz matching, -7dBFS each tone, 20MHz tone spacing, all supplies at MIN, TYP, or MAX recommended operating voltages

図 4-364. RX IMD3 vs Supply and Channel at 2.6GHz

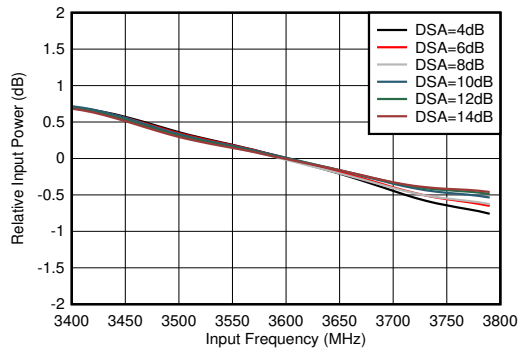


With 2.6GHz matching, 12.5MHz offset, all supplies at MIN, TYP, or MAX recommended operating voltages

図 4-365. RX Noise Spectral Density vs Supply and Channel at 2.6GHz

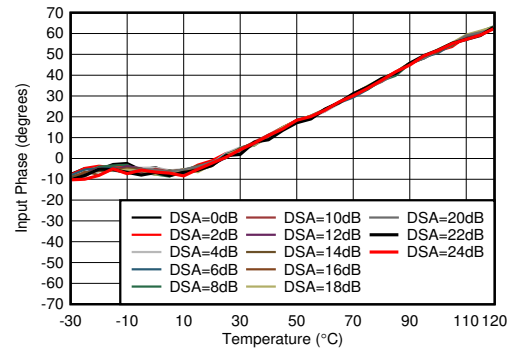
4.12.11 RX Typical Characteristics at 3.5GHz

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12MHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{IN}} = -3\text{dBFS}$, DSA setting = 4dB.



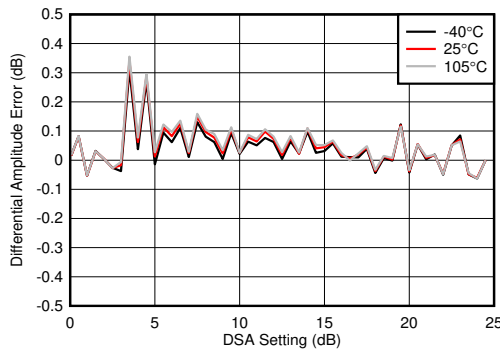
With 3.6GHz matching, normalized to 3.6GHz

FIG 4-366. RX In-Band Gain Flatness, $f_{\text{IN}} = 3600\text{MHz}$



With 3.6GHz matching, normalized to phase at 25°C

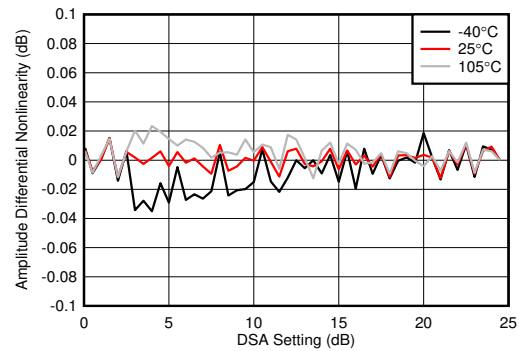
FIG 4-367. RX Input Phase vs Temperature at 3.6GHz



With 3.6GHz matching

Differential Amplitude Error = $P_{\text{IN}}(\text{DSA Setting} - 1) - P_{\text{IN}}(\text{DSA Setting}) + 1$

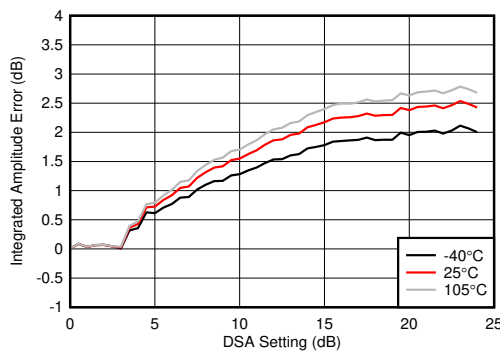
FIG 4-368. RX Uncalibrated Differential Amplitude Error vs DSA Setting at 3.6GHz



With 3.6GHz matching

Differential Amplitude Error = $P_{\text{IN}}(\text{DSA Setting} - 1) - P_{\text{IN}}(\text{DSA Setting}) + 1$

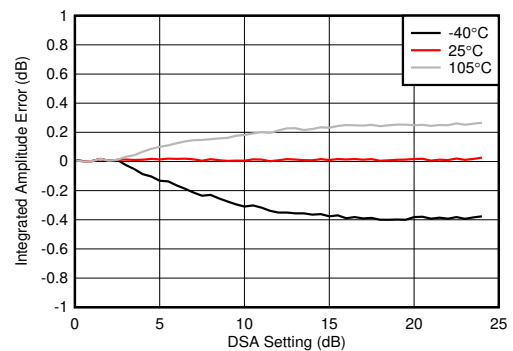
FIG 4-369. RX Calibrated Differential Amplitude Error vs DSA Setting at 3.6GHz



With 3.6GHz matching

Integrated Amplitude Error = $P_{\text{IN}}(\text{DSA Setting}) - P_{\text{IN}}(\text{DSA Setting} = 0) + (\text{DSA Setting})$

FIG 4-370. RX Uncalibrated Integrated Amplitude Error vs DSA Setting at 3.6GHz



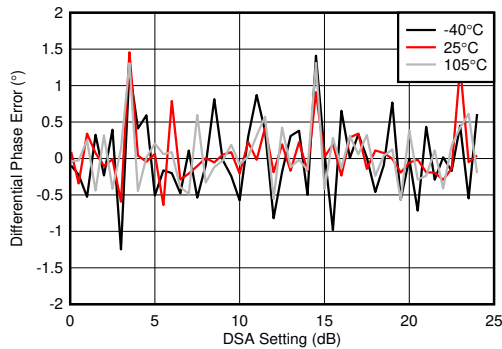
With 3.6GHz matching

Integrated Amplitude Error = $P_{\text{IN}}(\text{DSA Setting}) - P_{\text{IN}}(\text{DSA Setting} = 0) + (\text{DSA Setting})$

FIG 4-371. RX Calibrated Integrated Amplitude Error vs DSA Setting at 3.6GHz

4.12.11 RX Typical Characteristics at 3.5GHz (continued)

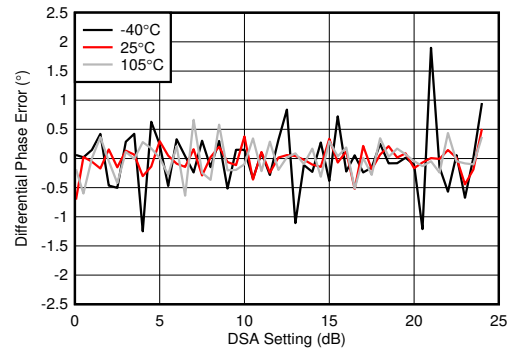
Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12GHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{IN}} = -3\text{dBFS}$, DSA setting = 4dB.



With 3.6GHz matching

$$\text{Differential Phase Error} = \text{Phase}_{\text{IN}}(\text{DSA Setting} - 1) - \text{Phase}_{\text{IN}}(\text{DSA Setting})$$

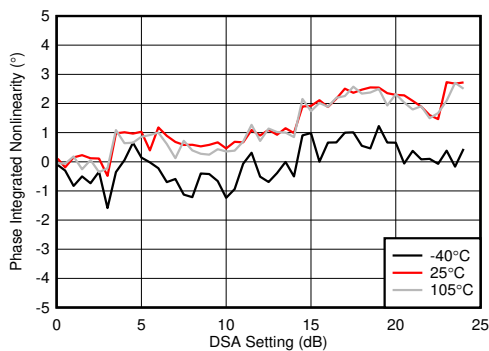
FIG 4-372. RX Uncalibrated Phase Error vs DSA Setting at 3.6GHz



With 3.6GHz matching

$$\text{Differential Phase Error} = \text{Phase}_{\text{IN}}(\text{DSA Setting} - 1) - \text{Phase}_{\text{IN}}(\text{DSA Setting})$$

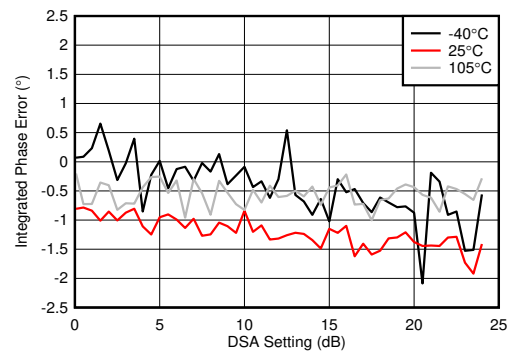
FIG 4-373. RX Calibrated Differential Phase Error vs DSA Setting at 3.6GHz



With 3.6GHz matching

$$\text{Integrated Phase Error} = \text{Phase}(\text{DSA Setting}) - \text{Phase}(\text{DSA Setting} = 0)$$

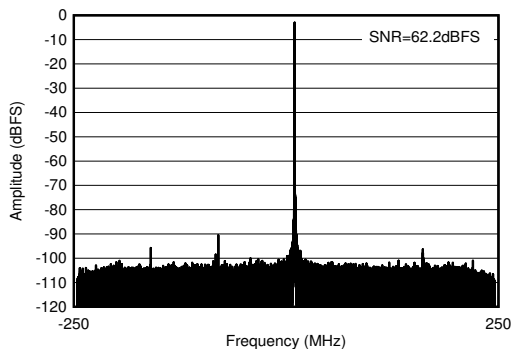
FIG 4-374. RX Uncalibrated Integrated Phase Error vs DSA Setting at 3.6GHz



With 3.6GHz matching

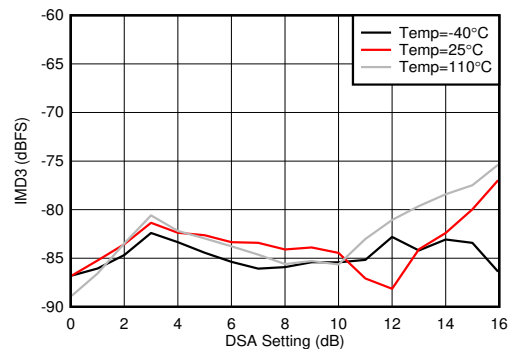
$$\text{Integrated Phase Error} = \text{Phase}(\text{DSA Setting}) - \text{Phase}(\text{DSA Setting} = 0)$$

FIG 4-375. RX Calibrated Integrated Phase Error vs DSA Setting at 3.6GHz



With 3.6GHz matching, $f_{\text{IN}} = 3610\text{MHz}$, $A_{\text{IN}} = -3\text{dBFS}$

FIG 4-376. RX Output FFT at 3.6GHz

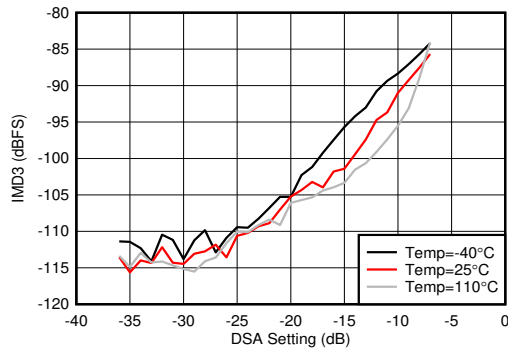


With 3.5 GHz matching, each tone at -7dBFS , 20MHz tone spacing

FIG 4-377. RX IMD3 vs DSA Setting and Temperature at 3.6GHz

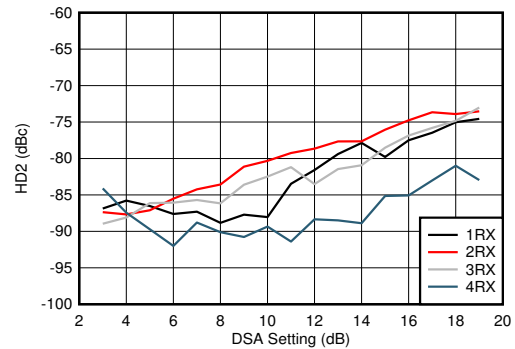
4.12.11 RX Typical Characteristics at 3.5GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12MHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{IN}} = -3\text{dBFS}$, DSA setting = 4dB.



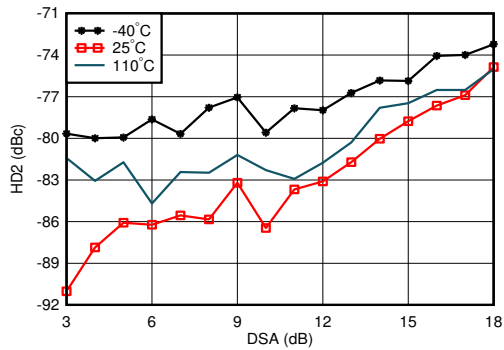
With 3.5GHz matching, 20MHz tone spacing

Figure 4-378. RX IMD3 vs Input Level and Temperature at 3.6GHz



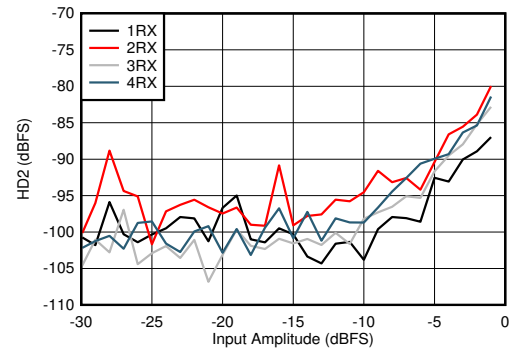
With 3.5GHz matching, DDC bypass mode (TI only mode for characterization)

Figure 4-379. RX HD2 vs DSA Setting and Channel at 3.6GHz



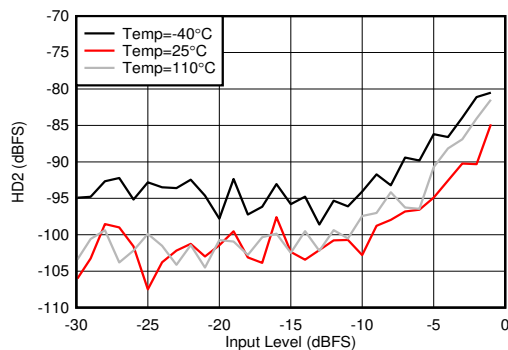
With 3.5GHz matching, DDC bypass mode (TI only mode for characterization)

Figure 4-380. RX HD2 vs DSA Setting and Temperature at 3.6GHz



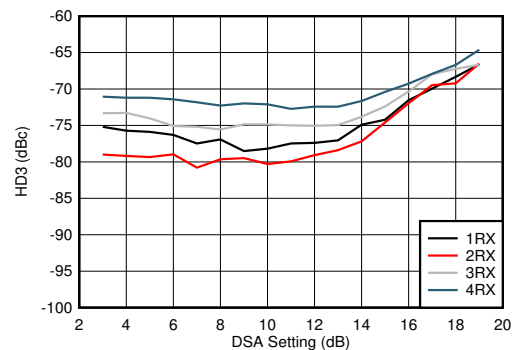
With 3.5GHz matching, DDC bypass mode (TI only mode for characterization)

Figure 4-381. RX HD2 vs Input Level and Channel at 3.6GHz



With 3.5GHz matching, DDC bypass mode (TI only mode for characterization)

Figure 4-382. RX HD2 vs Input Level and Temperature at 3.6GHz

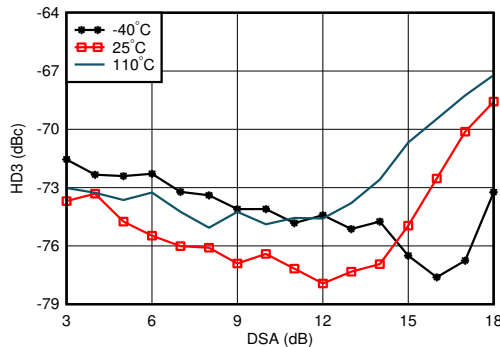


With 3.5GHz matching, DDC bypass mode (TI only mode for characterization)

Figure 4-383. RX HD3 vs DSA Setting and Channel at 3.6GHz

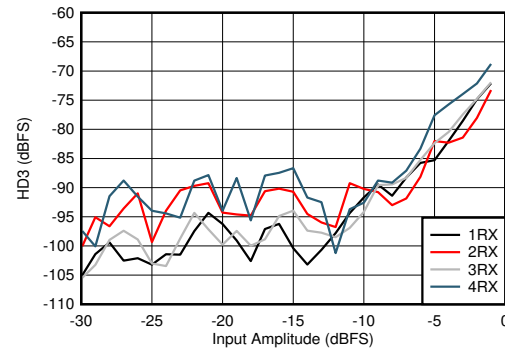
4.12.11 RX Typical Characteristics at 3.5GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12MHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{IN}} = -3\text{dBFS}$, DSA setting = 4dB.



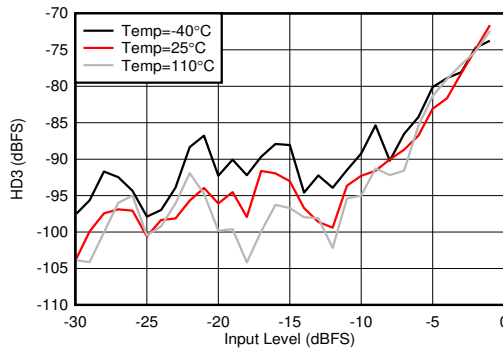
With 3.5GHz matching, DDC bypass mode (TI only mode for characterization)

FIG 4-384. RX HD3 vs DSA Setting and Temperature at 3.6GHz



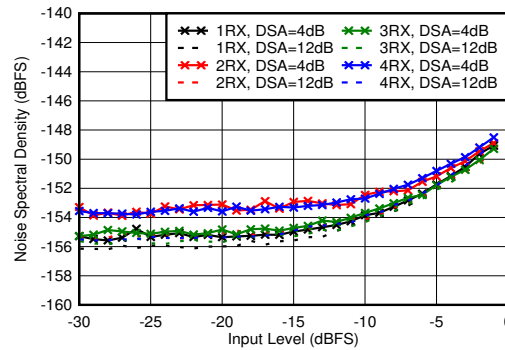
With 3.5GHz matching, DDC bypass mode (TI only mode for characterization)

FIG 4-385. RX HD3 vs Input Level and Channel at 3.6GHz



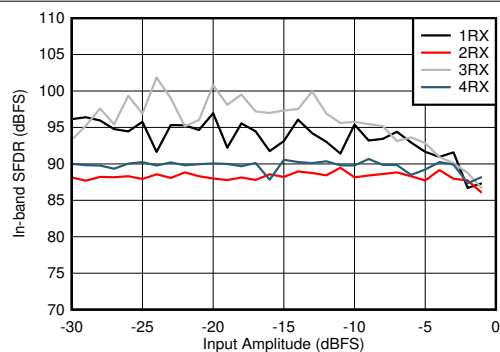
With 3.5GHz matching, DDC bypass mode (TI only mode for characterization)

FIG 4-386. RX HD3 vs Input Level and Temperature at 3.6GHz



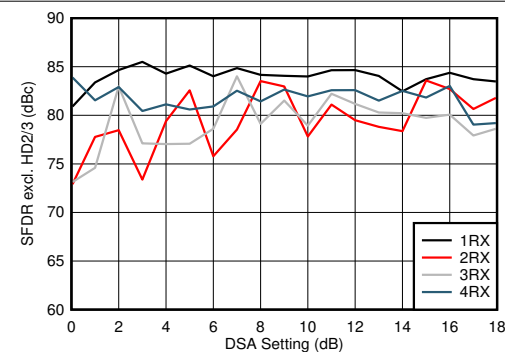
With 3.5GHz matching, 12.5-MHz offset from tone

FIG 4-387. RX Noise Spectral Density vs Input Level and DSA Setting at 3.6GHz



With 3.5GHz matching

FIG 4-388. RX In-Band SFDR ($\pm 200\text{MHz}$) vs Input Level and Channel at 3.6GHz

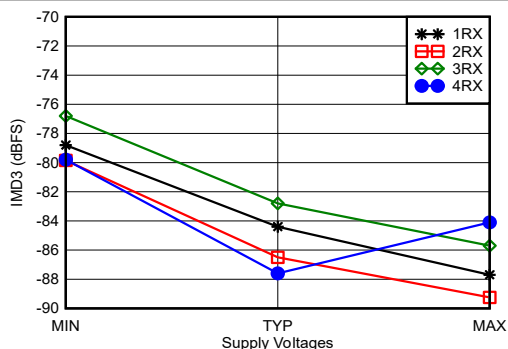


With 3.5GHz matching

FIG 4-389. RX SFDR Excluding HD2/3 vs DSA Setting and Channel at 3.6GHz

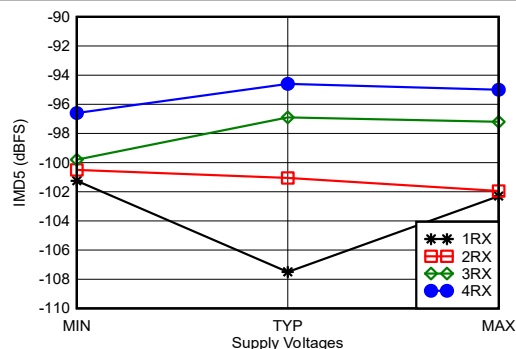
4.12.11 RX Typical Characteristics at 3.5GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12GHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{IN}} = -3\text{dBFS}$, DSA setting = 4dB.



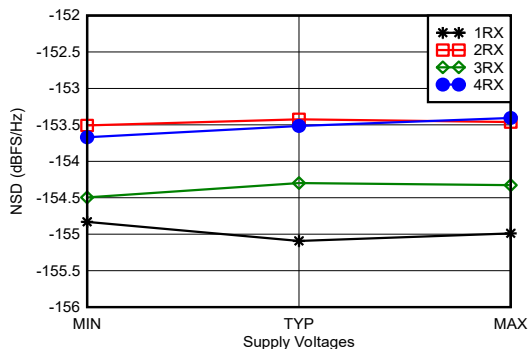
With 3.6GHz matching, -7dBFS each tone, 20MHz tone spacing, all supplies at MIN, TYP, or MAX recommended operating voltages

Figure 4-390. RX IMD3 vs Supply Voltage and Channel at 3.6GHz



With 3.6GHz matching, -7dBFS each tone, 20-MHz tone spacing, all supplies at MIN, TYP, or MAX recommended operating voltages

Figure 4-391. RX IMD5 vs Supply Voltage and Channel at 3.6GHz

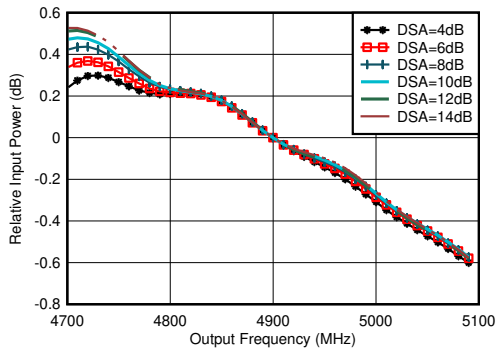


With 3.6GHz matching, tone at 20 dBFS, 12.5MHz offset frequency, all supplies at MIN, TYP, or MAX recommended operating voltages

Figure 4-392. RX Noise Spectral Density vs Supply Voltage and Channel at 3.6GHz

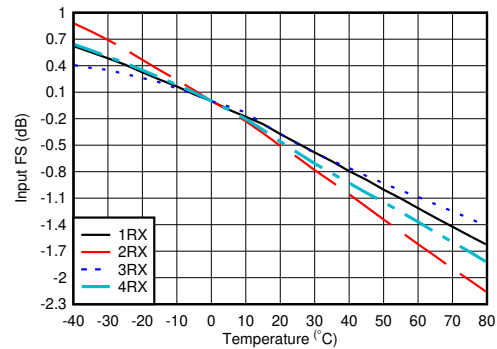
4.12.12 RX Typical Characteristics at 4.9GHz

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12GHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{IN}} = -3\text{dBFS}$, DSA setting = 4dB.



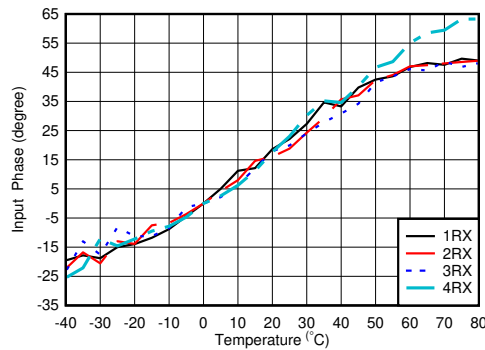
With matching, normalized to power at 4.9GHz for each DSA setting

FIG 4-393. RX Inband Gain Flatness, $f_{\text{IN}} = 4900\text{MHz}$



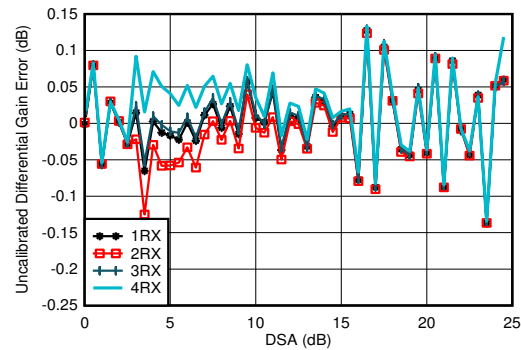
With 4.9GHz matching, normalized to fullscale at 25°C for each channel

FIG 4-394. RX Input Fullscale vs Temperature and Channel at 4.9GHz



With 4.9GHz matching, normalized to phase at 25°C

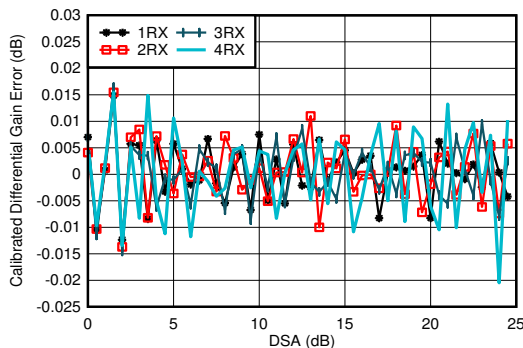
FIG 4-395. RX Input Phase vs Temperature and DSA at $f_{\text{OUT}} = 4.9\text{GHz}$



With 4.9GHz matching

Differential Amplitude Error = $P_{\text{IN}}(\text{DSA Setting} - 1) - P_{\text{IN}}(\text{DSA Setting}) + 1$

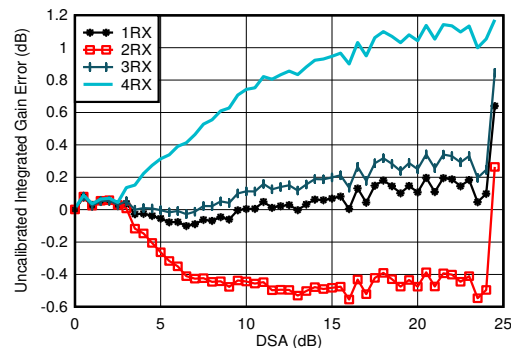
FIG 4-396. RX Uncalibrated Differential Amplitude Error vs DSA Setting at 4.9GHz



With 4.9GHz matching

Differential Amplitude Error = $P_{\text{IN}}(\text{DSA Setting} - 1) - P_{\text{IN}}(\text{DSA Setting}) + 1$

FIG 4-397. RX Calibrated Differential Amplitude Error vs DSA Setting at 4.9GHz



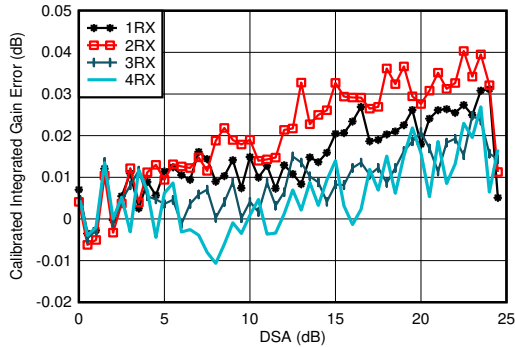
With 4.9GHz matching

Integrated Amplitude Error = $P_{\text{IN}}(\text{DSA Setting}) - P_{\text{IN}}(\text{DSA Setting} = 0) + (\text{DSA Setting})$

FIG 4-398. RX Uncalibrated Integrated Amplitude Error vs DSA Setting at 4.9GHz

4.12.12 RX Typical Characteristics at 4.9GHz (continued)

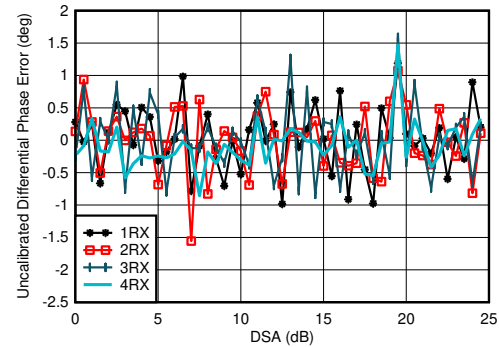
Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12GHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{IN}} = -3\text{dBFS}$, DSA setting = 4dB.



With 4.9GHz matching

Integrated Amplitude Error = $P_{\text{IN}}(\text{DSA Setting}) - P_{\text{IN}}(\text{DSA Setting} = 0) + (\text{DSA Setting})$

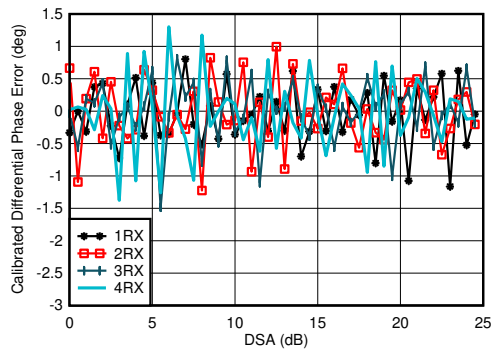
FIG 4-399. RX Calibrated Integrated Amplitude Error vs DSA Setting at 4.9GHz



With 4.9GHz matching

Differential Phase Error = $\text{Phase}_{\text{IN}}(\text{DSA Setting} - 1) - \text{Phase}_{\text{IN}}(\text{DSA Setting})$

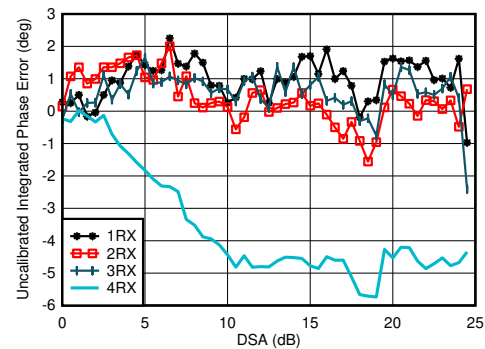
FIG 4-400. RX Uncalibrated Differential Phase Error vs DSA Setting at 4.9GHz



With 4.9GHz matching

Differential Phase Error = $\text{Phase}_{\text{IN}}(\text{DSA Setting} - 1) - \text{Phase}_{\text{IN}}(\text{DSA Setting})$

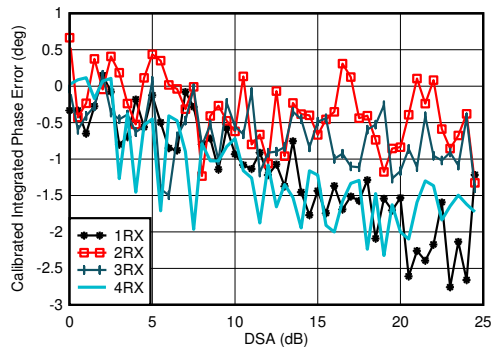
FIG 4-401. RX Calibrated Differential Phase Error vs DSA Setting at 4.9GHz



With 4.9GHz matching

Integrated Phase Error = $\text{Phase}(\text{DSA Setting}) - \text{Phase}(\text{DSA Setting} = 0)$

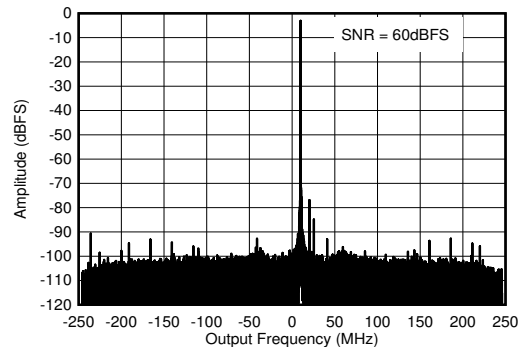
FIG 4-402. RX Uncalibrated Integrated Phase Error vs DSA Setting at 4.9GHz



With 4.9GHz matching

Integrated Phase Error = $\text{Phase}(\text{DSA Setting}) - \text{Phase}(\text{DSA Setting} = 0)$

FIG 4-403. RX Calibrated Integrated Phase Error vs DSA Setting at 4.9GHz

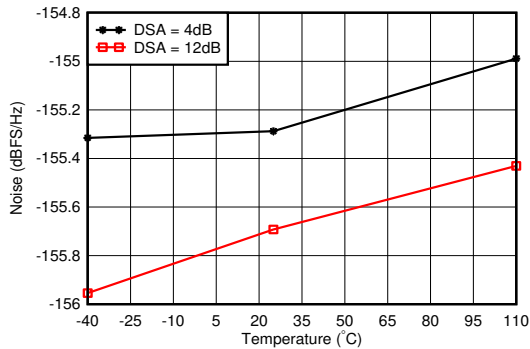


With 4.9GHz matching, $f_{\text{IN}} = 4910\text{MHz}$, $A_{\text{IN}} = -3\text{dBFS}$

FIG 4-404. RX Output FFT at 4.9GHz

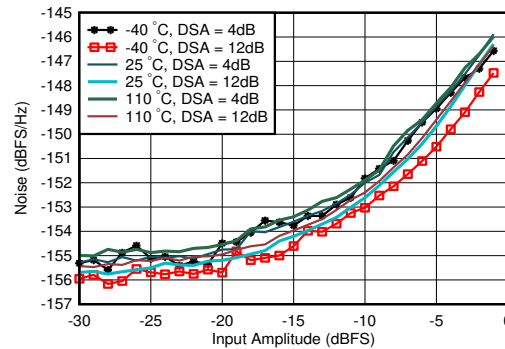
4.12.12 RX Typical Characteristics at 4.9GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12GHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{IN}} = -3\text{dBFS}$, DSA setting = 4dB.



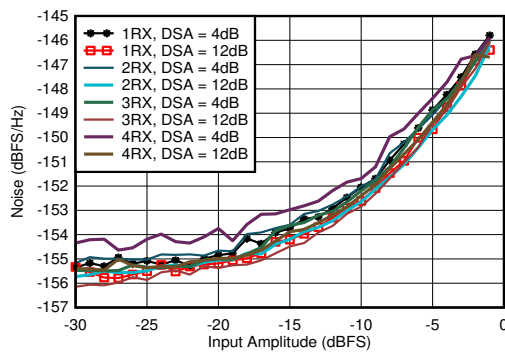
With 4.9GHz matching, 12.5-MHz offset from tone

FIG 4-405. RX Noise Spectral Density vs Temperature at 4.9GHz



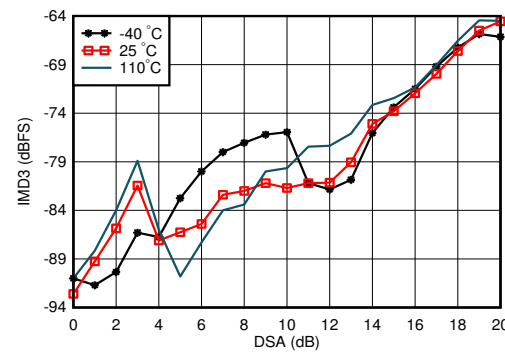
With 4.9GHz matching, DSA Setting = 12dB, 12.5MHz offset from tone

FIG 4-406. RX Noise Spectral Density vs Input Amplitude and Temperature at 4.9GHz



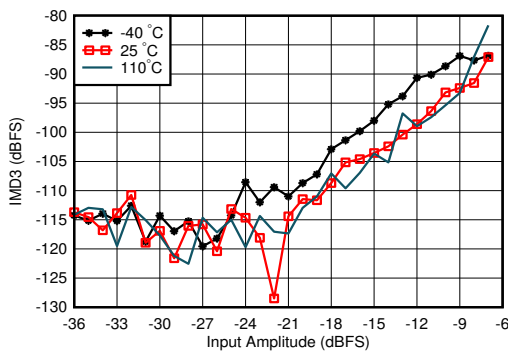
With 4.9GHz matching, 12.5MHz offset from tone

FIG 4-407. RX Noise Spectral Density vs Input Amplitude and Channel at 4.9GHz



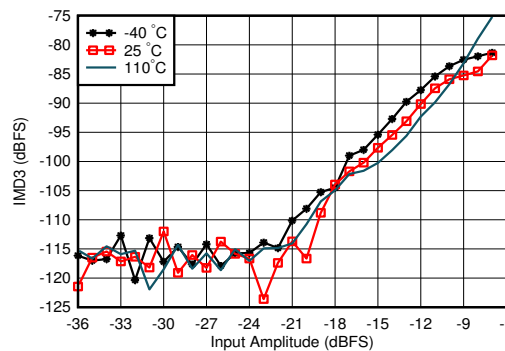
With 4.9GHz matching, each tone -7dBFS , tone spacing = 20MHz

FIG 4-408. RX IMD3 vs DSA Setting and Temperature at 4.9GHz



With 4.9GHz matching, tone spacing = 20MHz, DSA = 4dB

FIG 4-409. RX IMD3 vs Input Level and Temperature at 4.9GHz

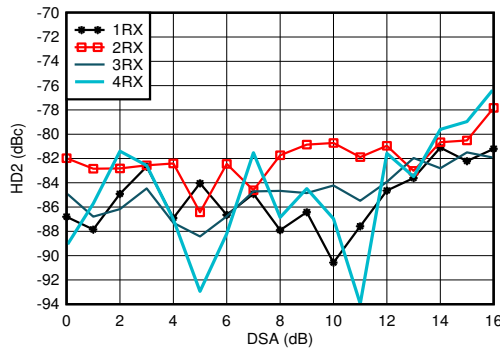


With 4.9GHz matching, tone spacing = 20MHz, DSA = 12dB

FIG 4-410. RX IMD3 vs Input Level and Temperature at 4.9GHz

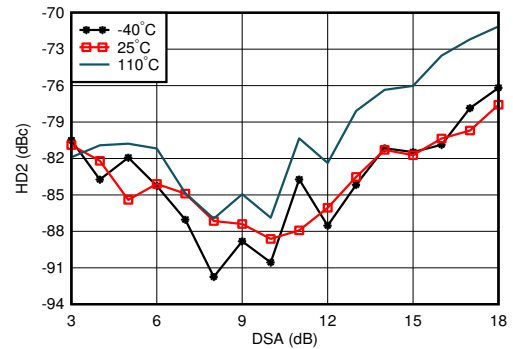
4.12.12 RX Typical Characteristics at 4.9GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12MHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{IN}} = -3\text{dBFS}$, DSA setting = 4dB.



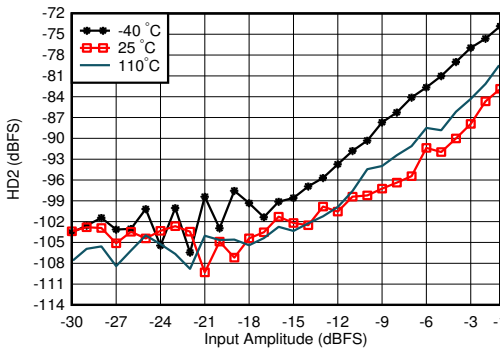
With 4.9GHz matching, measured after HD2 trim, DDC bypass mode (TI only mode for characterization)

FIG 4-411. RX HD2 vs DSA Setting and Channel at 4.9GHz



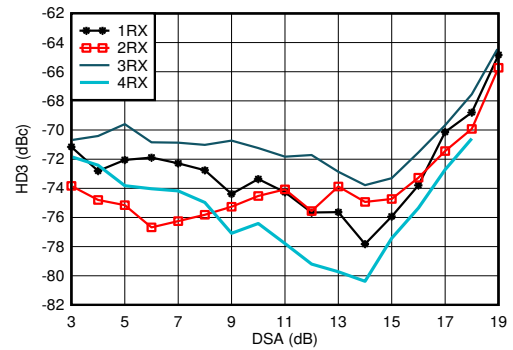
With 4.9GHz matching, measured after HD2 trim, DDC bypass mode (TI only mode for characterization)

FIG 4-412. RX HD2 vs DSA and Temperature at 4.9GHz



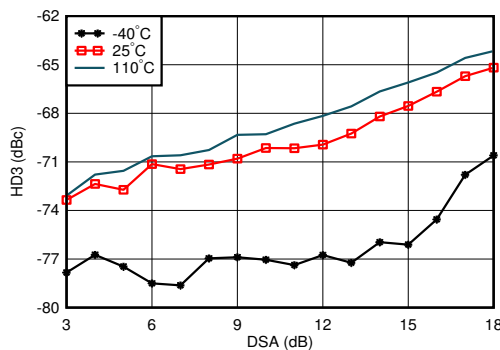
With 4.9GHz matching, measured after HD2 trim, DDC bypass mode (TI only mode for characterization)

FIG 4-413. RX HD2 vs Input Level and Temperature at 4.9GHz



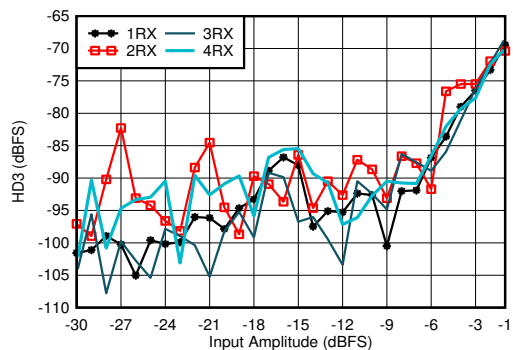
With 4.9GHz matching, DDC bypass mode (TI only mode for characterization)

FIG 4-414. RX HD3 vs DSA Setting and Channel at 4.9GHz



With 4.9GHz matching, DDC bypass mode (TI only mode for characterization)

FIG 4-415. RX HD3 vs DSA Setting and Temperature at 4.9GHz

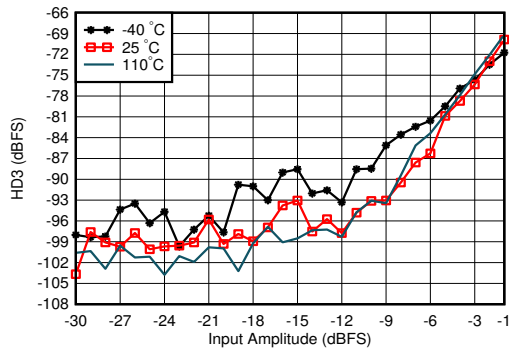


With 4.9GHz matching, DDC bypass mode (TI only mode for characterization)

FIG 4-416. RX HD3 vs Input Level and Channel at 4.9GHz

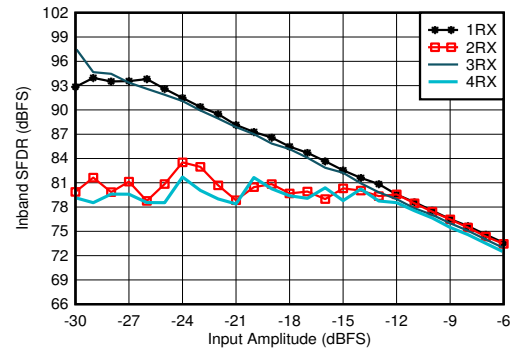
4.12.12 RX Typical Characteristics at 4.9GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12GHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$, $A_{\text{IN}} = -3\text{dBFS}$, DSA setting = 4dB.



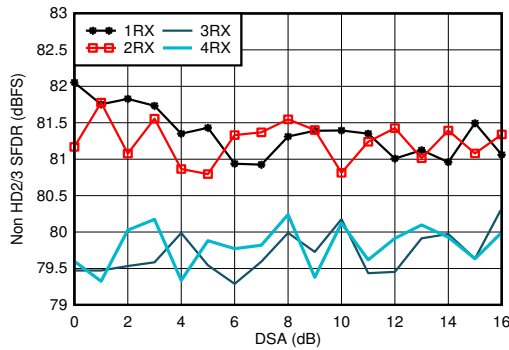
With 4.9GHz matching, DDC bypass mode (TI only mode for characterization)

FIG 4-417. RX HD3 vs Input Level and Temperature at 4.9GHz



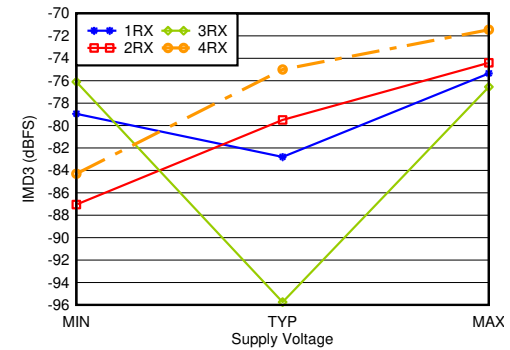
With 4.9GHz matching, decimate by 3

FIG 4-418. RX In-Band SFDR (± 400 MHz) vs Input Amplitude and Channel at 4.9GHz



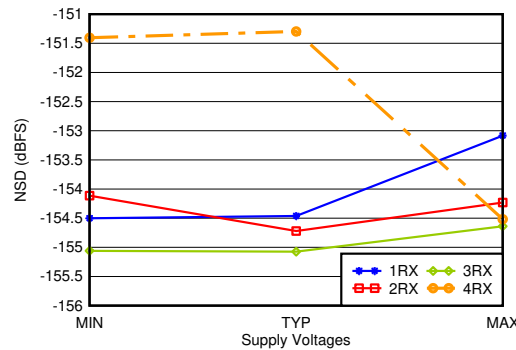
With 4.9GHz matching

FIG 4-419. RX Non-HD2/3 vs DSA Setting at 4.9GHz



With 4.9GHz matching, -7dBFS each tone, 20MHz tone spacing, all supplies at MIN, TYP, or MAX recommended operating voltages

FIG 4-420. RX IMD3 vs Supply and Channel at 4.9GHz



With 4.9GHz matching, 12.5MHz offset, all supplies at MIN, TYP, or MAX recommended operating voltages

FIG 4-421. RX Noise Spectral Density vs Supply and Channel at 4.9GHz

4.12.13 RX Typical Characteristics at 8.1GHz

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12MHz. Default conditions: output sample rate = 1474.56MSPS (decimate by 2), External clock mode with $f_{\text{CLK}} = 11796.48\text{MHz}$, $A_{\text{IN}} = -3\text{dBFS}$, DSA setting = 3 dB, 8.1GHz matching.

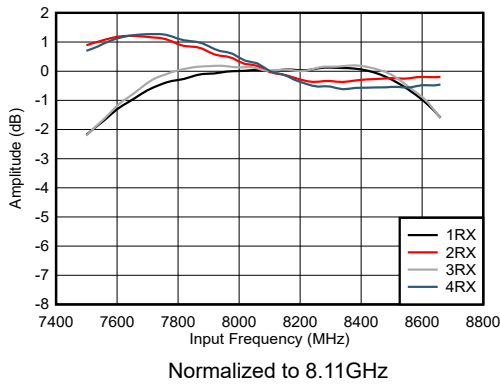


Figure 4-422. RX Amplitude vs Frequency and Channel

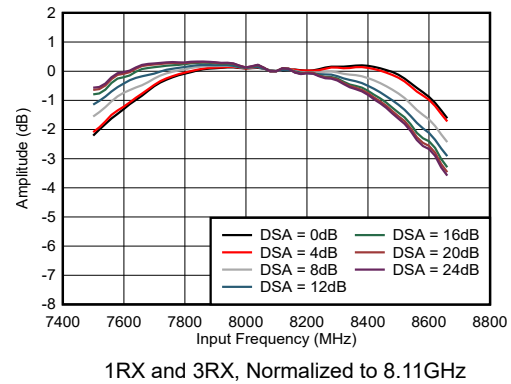


Figure 4-423. RX Amplitude vs Frequency and DSA Setting

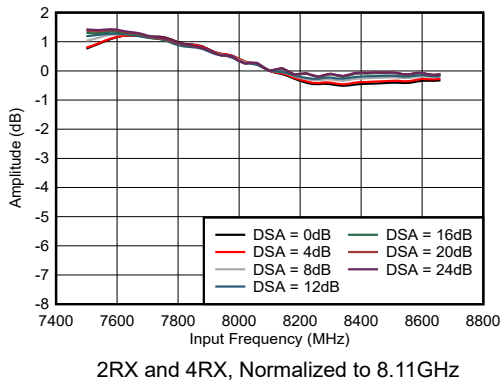


Figure 4-424. RX Amplitude vs Frequency and DSA Setting

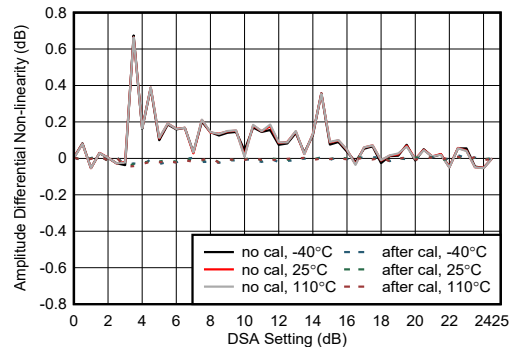


Figure 4-425. RX Amplitude Differential Nonlinearity at 8.1GHz

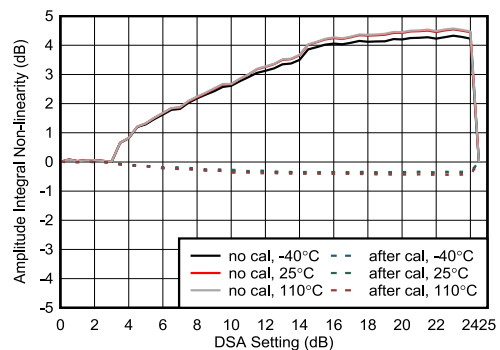


Figure 4-426. RX Amplitude Integrated Nonlinearity at 8.1GHz

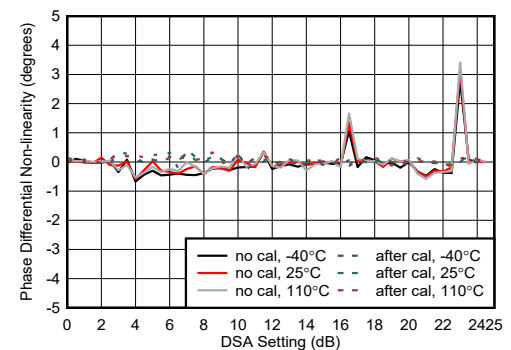
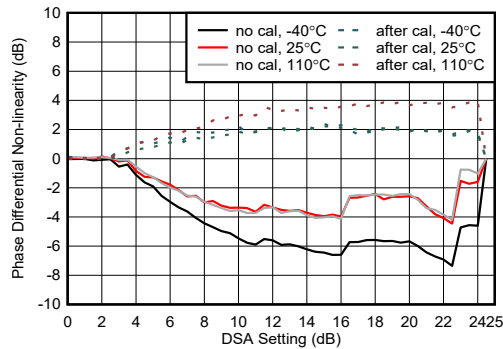


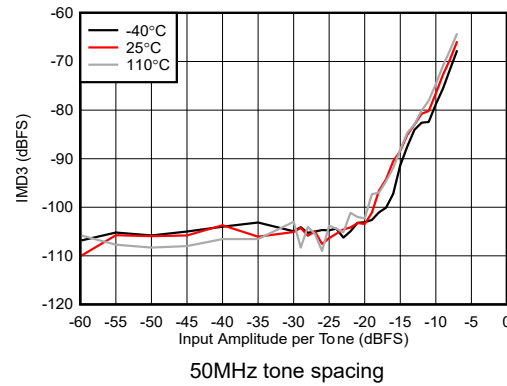
Figure 4-427. RX Phase Differential Nonlinearity at 8.1GHz

4.12.13 RX Typical Characteristics at 8.1GHz (continued)

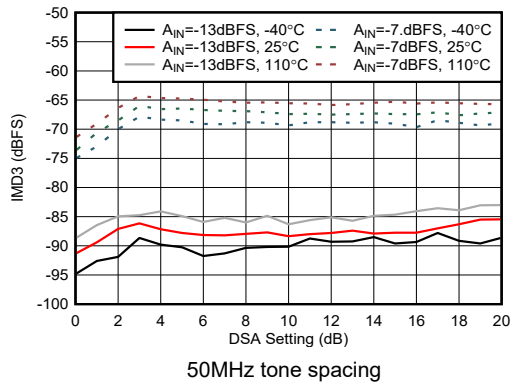
Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12MHz. Default conditions: output sample rate = 1474.56MSPS (decimate by 2), External clock mode with $f_{\text{CLK}} = 11796.48\text{MHz}$, $A_{\text{IN}} = -3\text{dBFS}$, DSA setting = 3 dB, 8.1GHz matching.



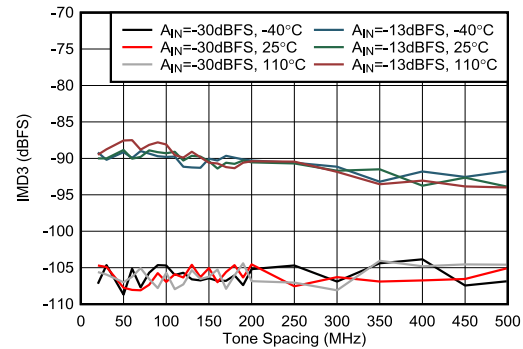
4-428. RX Phase Differential Nonlinearity at 8.1GHz



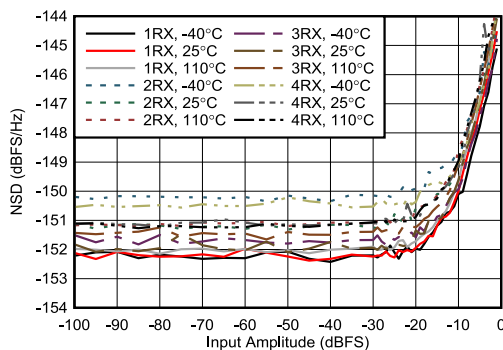
4-429. RX IMD3 vs Input Amplitude at 8.1GHz



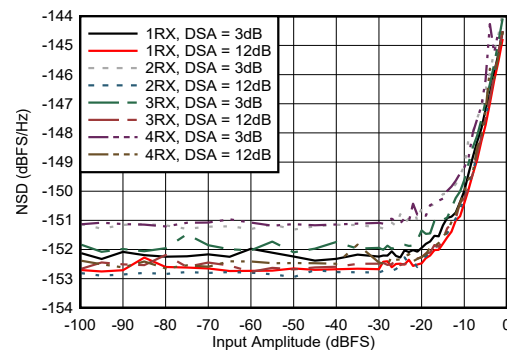
4-430. RX IMD3 vs DSA Setting at 8.1GHz



4-431. RX IMD3 vs Tone Spacing at 8.1GHz



4-432. RX NSD vs Digital Amplitude at 8.1GHz



4-433. RX NSD vs Digital Amplitude at 8.1GHz

4.12.13 RX Typical Characteristics at 8.1GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12MHz. Default conditions: output sample rate = 1474.56MSPS (decimate by 2), External clock mode with $f_{\text{CLK}} = 11796.48\text{MHz}$, $A_{\text{IN}} = -3\text{dBFS}$, DSA setting = 3 dB, 8.1GHz matching.

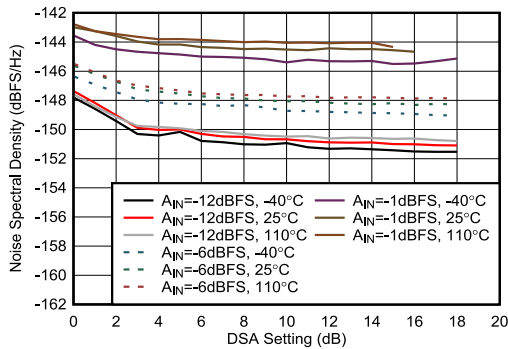
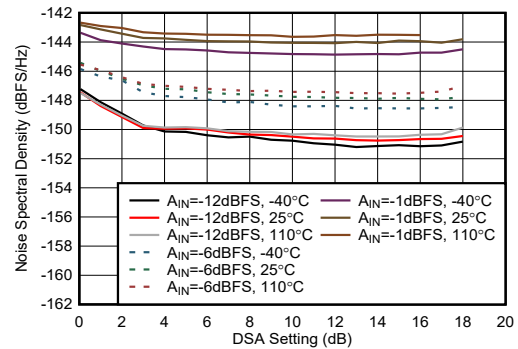


FIG 4-434. RX NSD vs DSA Setting at 8.1GHz



External clock mode

FIG 4-435. RX NSD vs DSA Setting at 8.1GHz

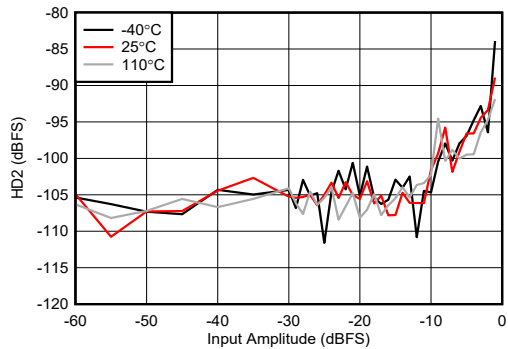


FIG 4-436. RX HD2 vs Digital Amplitude at 8.1GHz

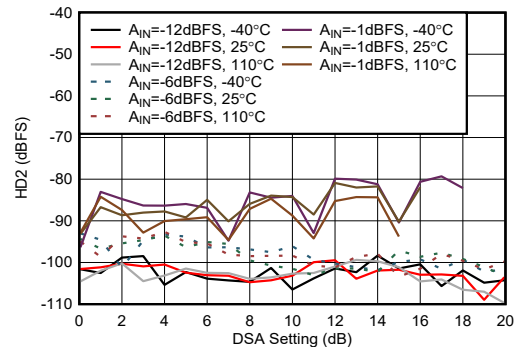


FIG 4-437. RX HD2 vs DSA Setting at 8.1GHz

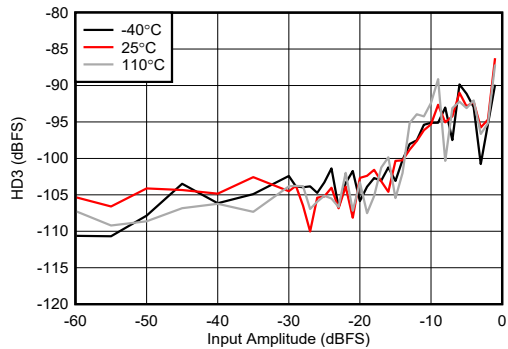


FIG 4-438. RX HD3 vs Digital Amplitude at 8.1GHz

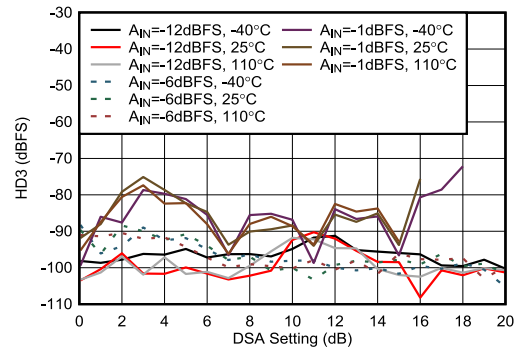


FIG 4-439. RX HD3 vs DSA Setting at 8.1GHz

4.12.13 RX Typical Characteristics at 8.1GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12MHz. Default conditions: output sample rate = 1474.56MSPS (decimate by 2), External clock mode with $f_{\text{CLK}} = 11796.48\text{MHz}$, $A_{\text{IN}} = -3\text{dBFS}$, DSA setting = 3 dB, 8.1GHz matching.

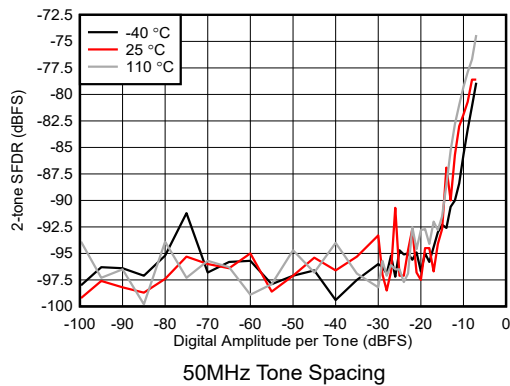


図 4-440. RX 2-tone SFDR vs Digital Amplitude at 8.1GHz

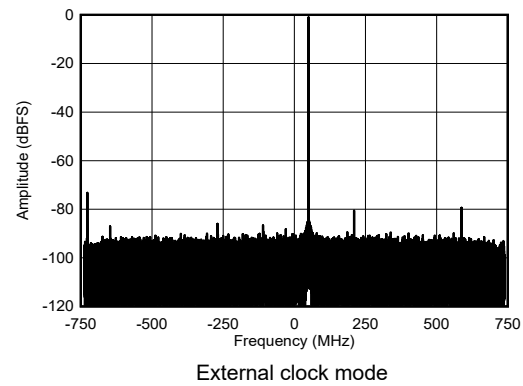


図 4-441. RX Single Tone Output FFT at 8.1GHz, -1dBFS

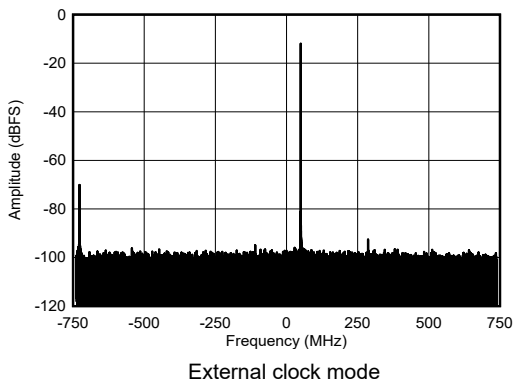


図 4-442. RX Single Tone Output FFT at 8.1GHz, -12dBFS

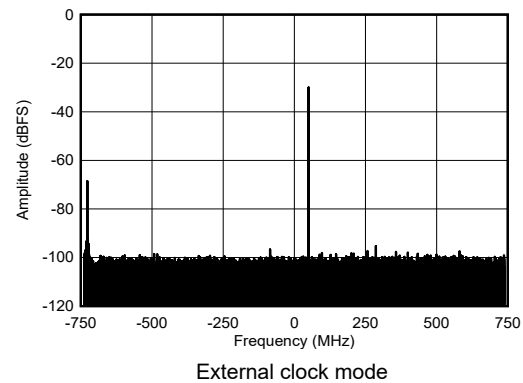


図 4-443. RX Single Tone Output FFT at 8.1GHz, -30 dBFS

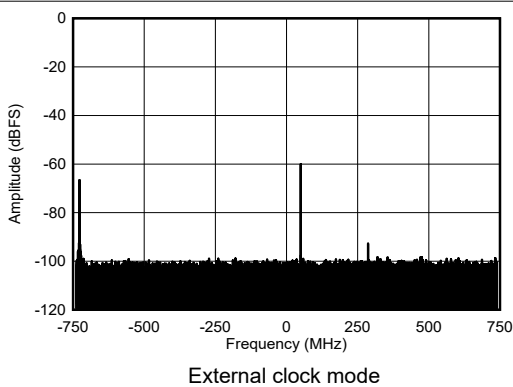


図 4-444. RX Single Tone Output FFT at 8.1GHz, -60 dBFS

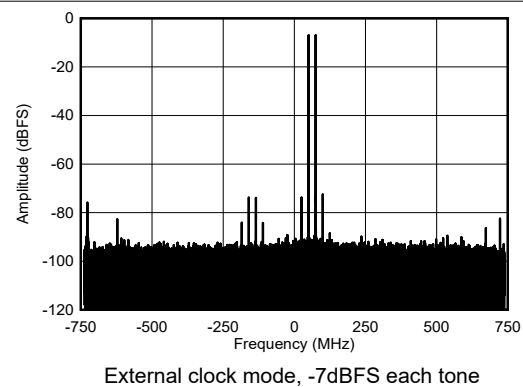
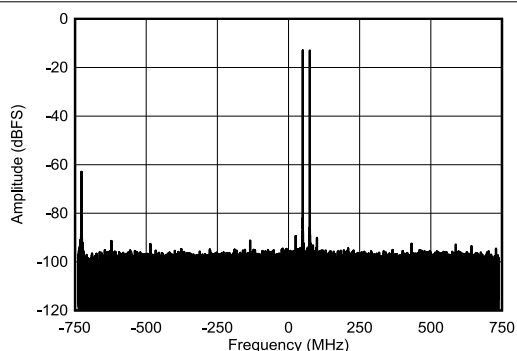


図 4-445. RX Dual Tone Output FFT at 8.1GHz

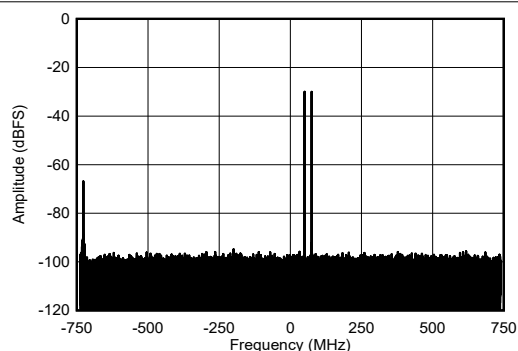
4.12.13 RX Typical Characteristics at 8.1GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12MHz. Default conditions: output sample rate = 1474.56MSPS (decimate by 2), External clock mode with $f_{\text{CLK}} = 11796.48\text{MHz}$, $A_{\text{IN}} = -3\text{dBFS}$, DSA setting = 3 dB, 8.1GHz matching.



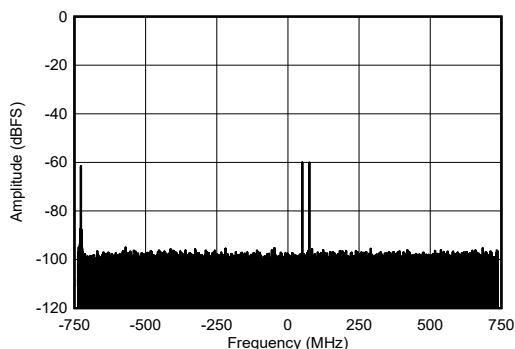
External clock mode, -13dBFS each tone

Figure 4-446. RX Dual Tone Output FFT at 8.11GHz



External clock mode, -30dBFS each tone

Figure 4-447. RX Dual Tone Output FFT at 8.11GHz



External clock mode, -60dBFS each tone

Figure 4-448. RX Dual Tone Output FFT at 8.11GHz

4.12.14 RX Typical Characteristics at 9.6GHz

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12MHz. Default conditions: output sample rate = 1474.56MSPS (decimate by 2), External clock mode with $f_{\text{CLK}} = 11796.48\text{MHz}$, $A_{\text{IN}} = -3\text{dBFS}$, DSA setting = 3 dB, 9.6GHz matching.

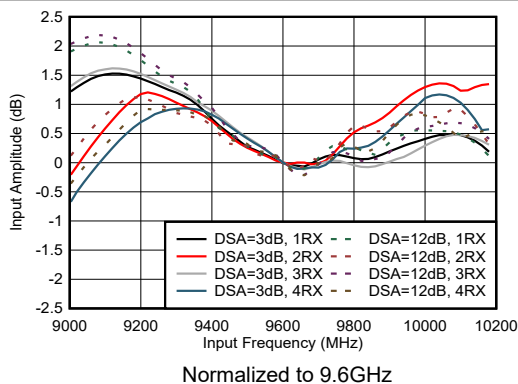


Figure 4-449. RX Input Amplitude vs Frequency

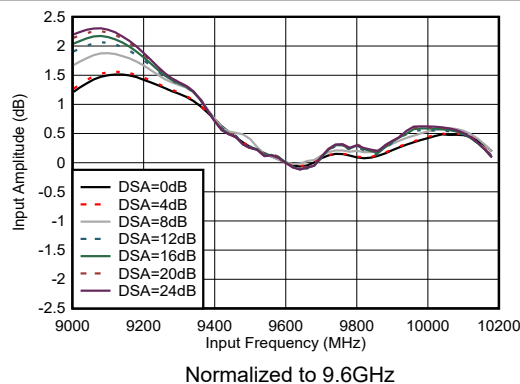


Figure 4-450. RX Input Amplitude vs Frequency at 9.6GHz

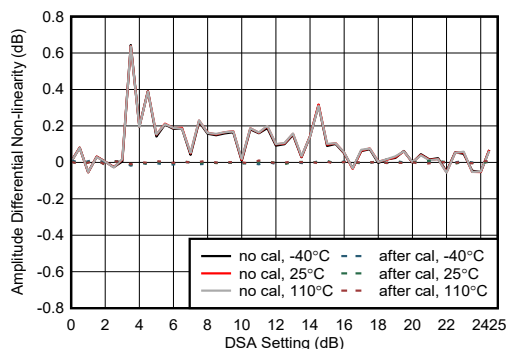


Figure 4-451. RX Amplitude Differential Non-linearity at 9.6GHz

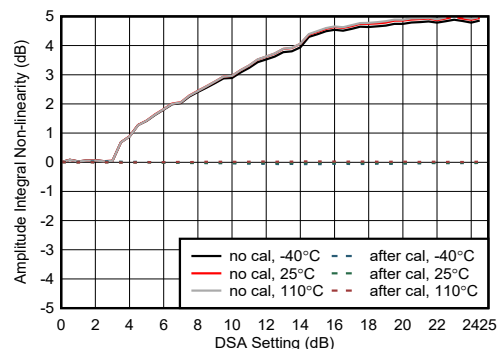


Figure 4-452. RX Amplitude Integrated Non-linearity at 9.6GHz

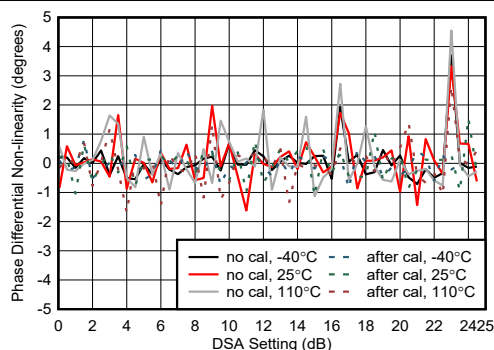


Figure 4-453. RX Phase Differential Non-linearity at 9.6GHz

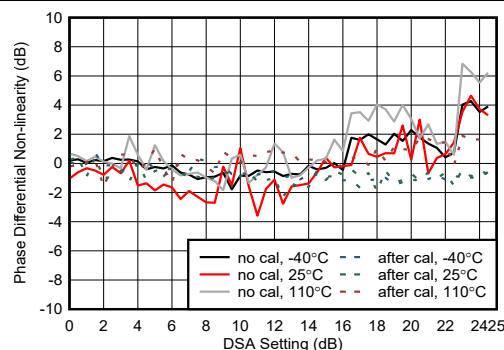


Figure 4-454. RX Phase Integrated Non-linearity at 9.6GHz

4.12.14 RX Typical Characteristics at 9.6GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12MHz. Default conditions: output sample rate = 1474.56MSPS (decimate by 2), External clock mode with $f_{\text{CLK}} = 11796.48\text{MHz}$, $A_{\text{IN}} = -3\text{dBFS}$, DSA setting = 3 dB, 9.6GHz matching.

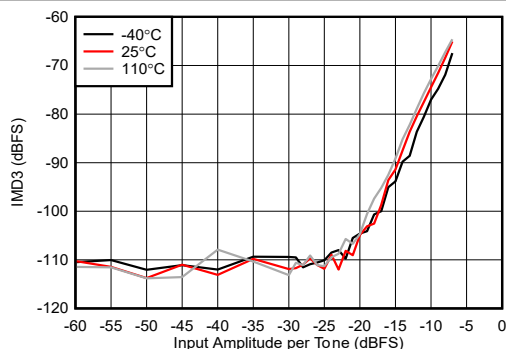


図 4-455. RX IMD3 vs Digital Amplitude at 9.6GHz

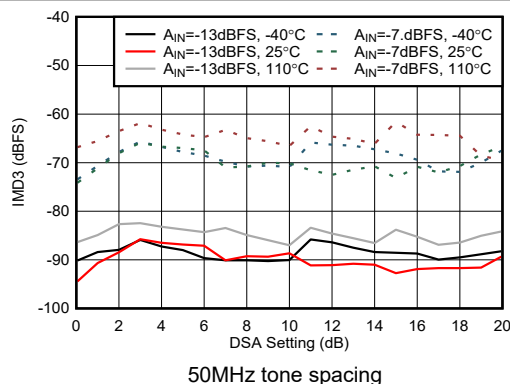


図 4-456. RX IMD3 vs DSA Setting at 9.6GHz

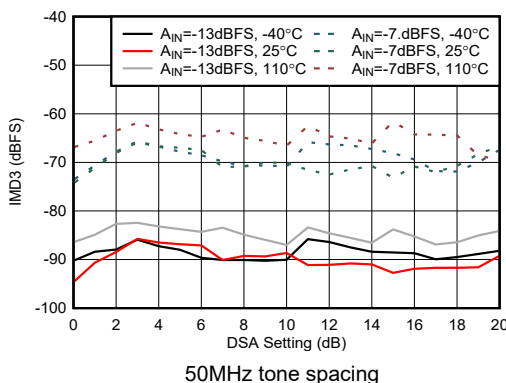


図 4-457. RX IMD3 vs DSA Setting at 9.6GHz

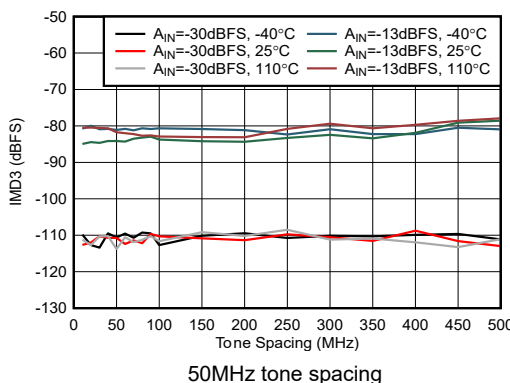


図 4-458. RX IMD3 vs Tone Spacing at 9.6GHz

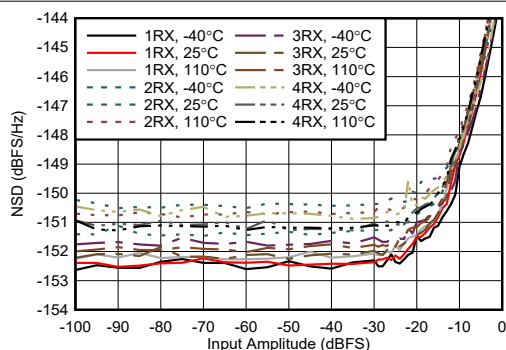


図 4-459. RX NSD vs Digital Amplitude at 9.6GHz

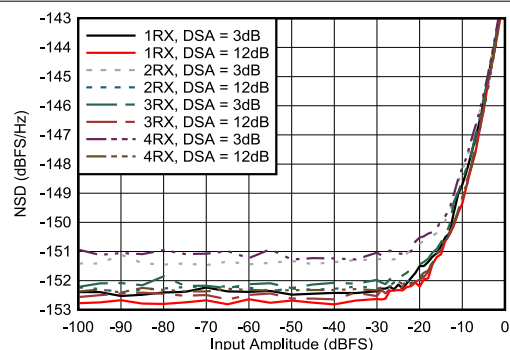


図 4-460. RX NSD vs Digital Amplitude at 9.6GHz

4.12.14 RX Typical Characteristics at 9.6GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12MHz. Default conditions: output sample rate = 1474.56MSPS (decimate by 2), External clock mode with $f_{\text{CLK}} = 11796.48\text{MHz}$, $A_{\text{IN}} = -3\text{dBFS}$, DSA setting = 3 dB, 9.6GHz matching.

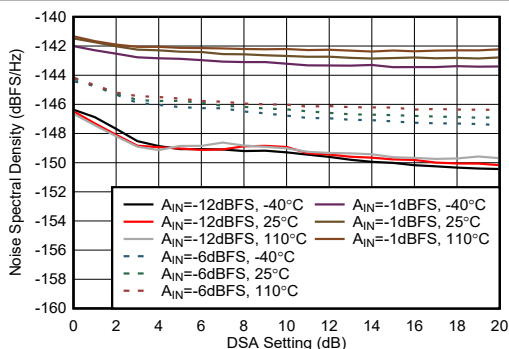


Figure 4-461. RX NSD vs DSA Setting at 9.6GHz

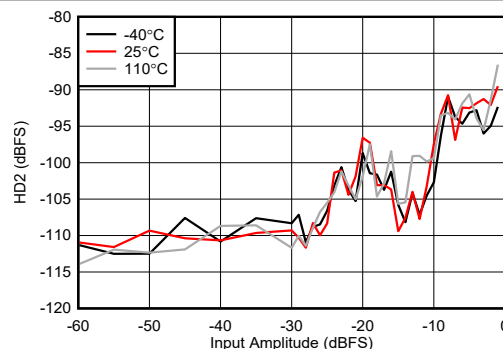


Figure 4-462. RX HD2 vs Digital Level at 9.6GHz

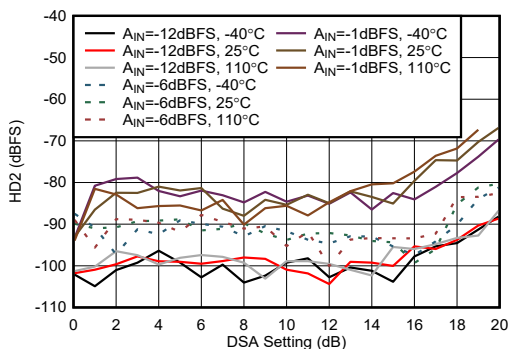


Figure 4-463. RX HD2 vs DSA Setting at 9.6GHz

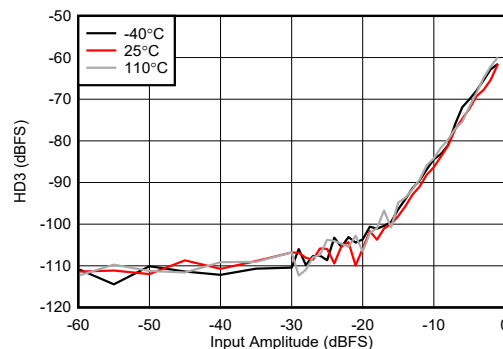


Figure 4-464. RX HD3 vs Digital Level at 9.6GHz

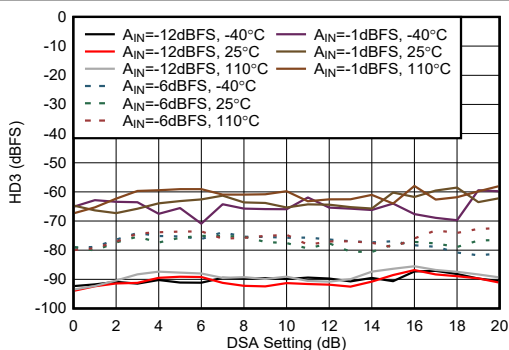
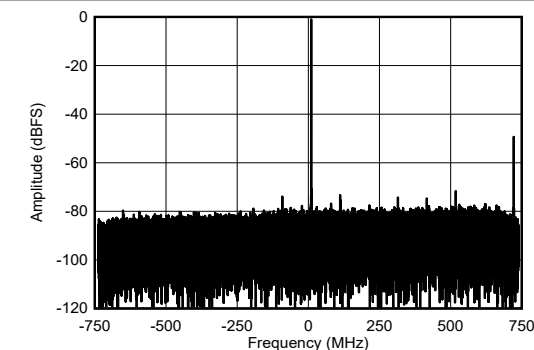


Figure 4-465. RX HD3 vs DSA Setting at 9.6GHz

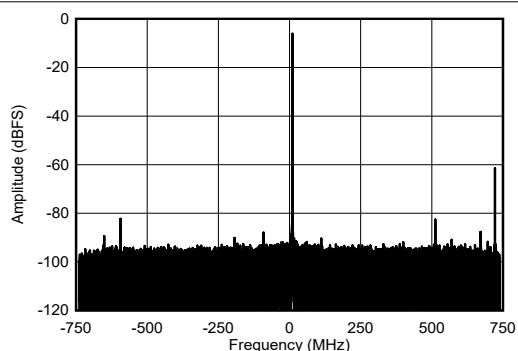


-1dBFS

Figure 4-466. RX Single Tone Output FFT at 9.61 GHz

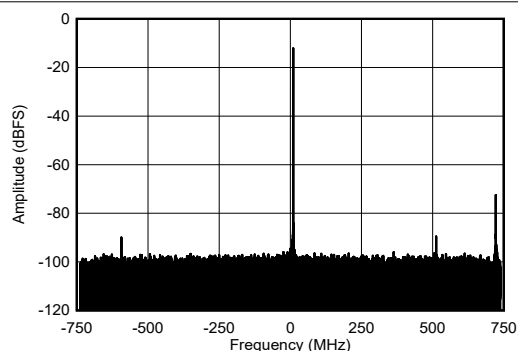
4.12.14 RX Typical Characteristics at 9.6GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12GHz. Default conditions: output sample rate = 1474.56MSPS (decimate by 2) , External clock mode with $f_{\text{CLK}} = 11796.48\text{MHz}$, $A_{\text{IN}} = -3\text{dBFS}$, DSA setting = 3 dB, 9.6GHz matching.



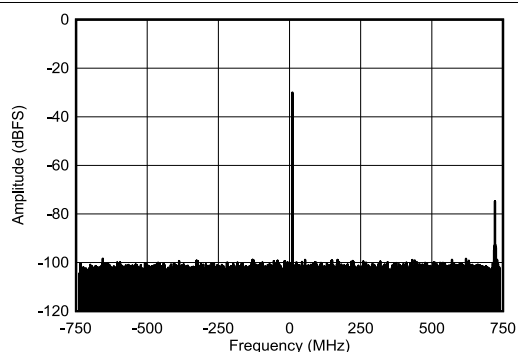
-6dBFS

FIG 4-467. RX Single Tone Output FFT at 9.61GHz



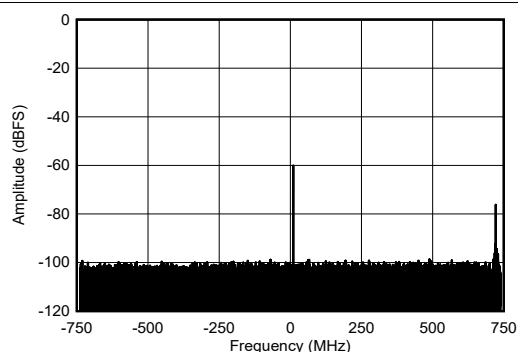
-12 dBFS.

FIG 4-468. RX Single Tone Output FFT at 9.61GHz



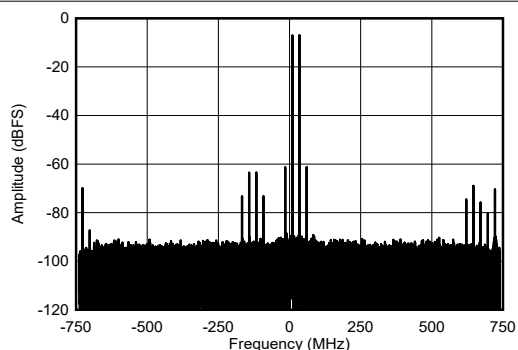
-30dBFS

FIG 4-469. RX Single Tone Output FFT at 9.61GHz



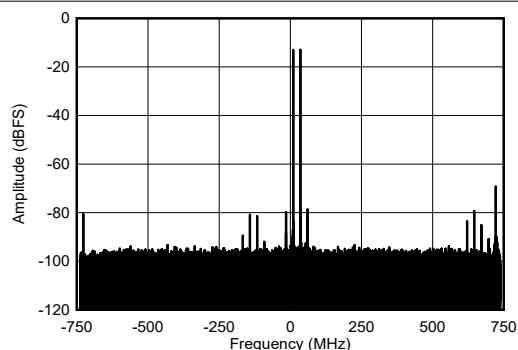
-60 dBFS

FIG 4-470. RX Single Tone Output FFT at 9.61GHz



9.61 and 9.635GHz , -7dBFS each tone

FIG 4-471. RX Two Tone Output FFT at 9.61GHz

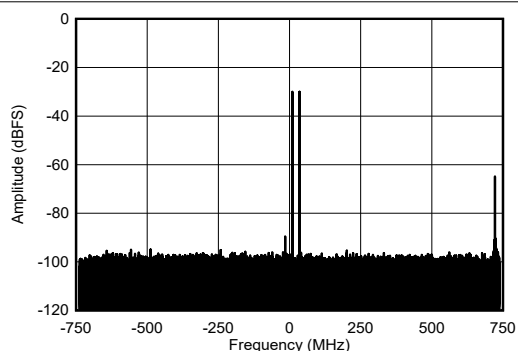


9.61 and 9.635GHz , -13dBFS each tone

FIG 4-472. RX Two Tone Output FFT at 9.61GHz

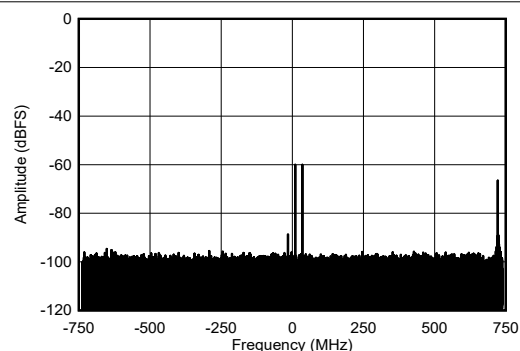
4.12.14 RX Typical Characteristics at 9.6GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12MHz. Default conditions: output sample rate = 1474.56MSPS (decimate by 2), External clock mode with $f_{\text{CLK}} = 11796.48\text{MHz}$, $A_{\text{IN}} = -3\text{dBFS}$, DSA setting = 3 dB, 9.6GHz matching.



9.61 and 9.635GHz, -30dBFS each tone

図 4-473. RX Two Tone Output FFT at 9.61GHz



9.61 and 9.635GHz, -60dBFS each tone

図 4-474. RX Two Tone Output FFT at 9.61GHz

5 Device and Documentation Support

5.1 ドキュメントの更新通知を受け取る方法

ドキュメントの更新についての通知を受け取るには、www.tij.co.jp のデバイス製品フォルダを開いてください。[通知] をクリックして登録すると、変更されたすべての製品情報に関するダイジェストを毎週受け取ることができます。変更の詳細については、改訂されたドキュメントに含まれている改訂履歴をご覧ください。

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5.5 用語集

[テキサス・インスツルメンツ用語集](#)

この用語集には、用語や略語の一覧および定義が記載されています。

6 Revision History

資料番号末尾の英字は改訂を表しています。その改訂履歴は英語版に準じています。

Changes from March 6, 2024 to August 1, 2024 (from Revision * (March 2024) to Revision A (August 2024))

	Page
• 「特長」の RF 周波数範囲を 10.2GHz から 12GHz (標準値) に変更	1
• 「概要」の RF 周波数範囲を 10.2GHz から 12GHz に変更	1
• Changed the RF frequency range to 12000MHz.....	6
• Changed the RF frequency range to 12000MHz.....	13

7 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

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PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
AFE7950ALKSHP	Active	Production	FCBGA (ALK) 400	90 JEDEC TRAY (5+1)	No	Call TI	Call TI	-40 to 85	AFE7950SHP SNPB

- (1) **Status:** For more details on status, see our [product life cycle](#).
- (2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.
- (3) **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.
- (4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.
- (5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.
- (6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

Important Information and Disclaimer:The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

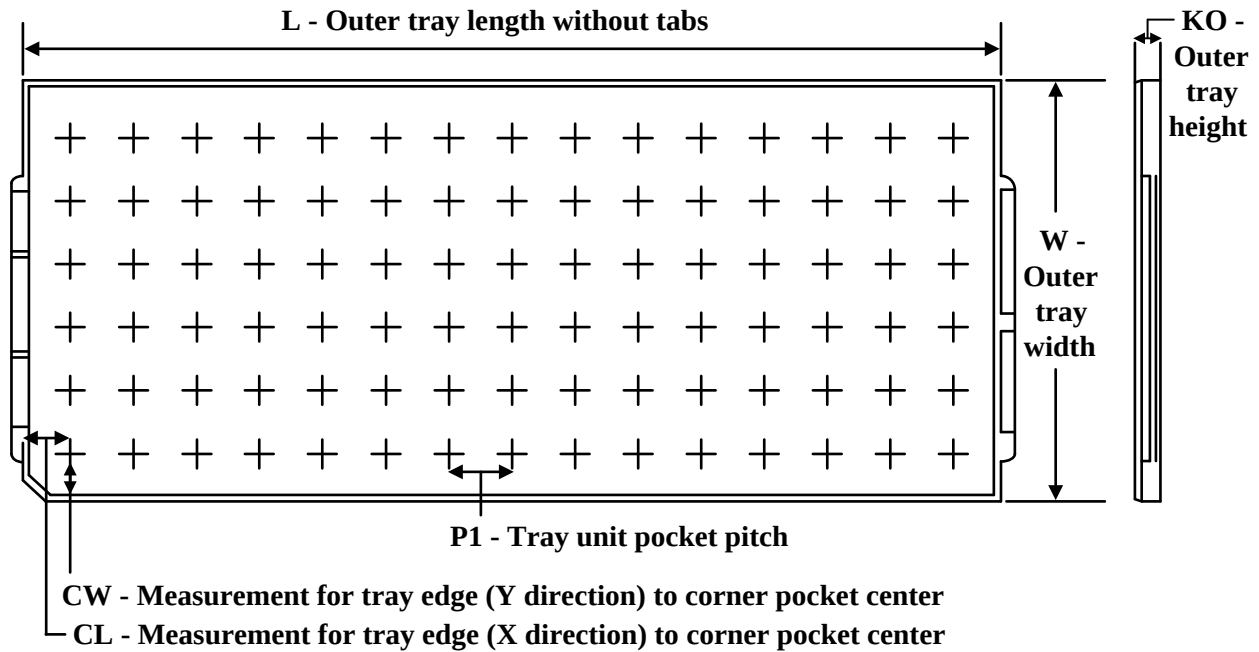
OTHER QUALIFIED VERSIONS OF AFE7950-SP :

- Catalog : [AFE7950](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product

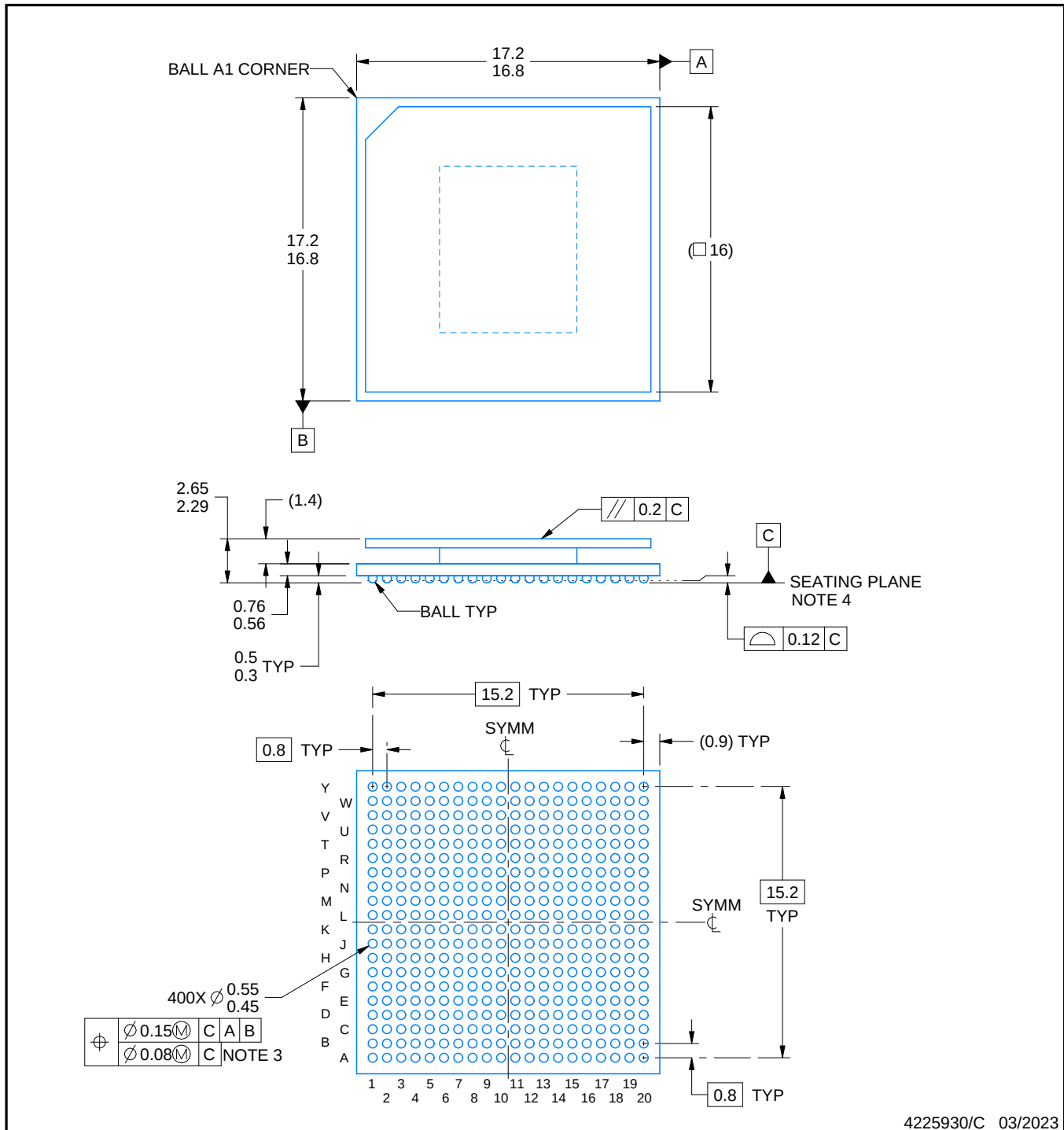
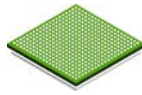
TRAY



Chamfer on Tray corner indicates Pin 1 orientation of packed units.

*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	Unit array matrix	Max temperature (°C)	L (mm)	W (mm)	K0 (µm)	P1 (mm)	CL (mm)	CW (mm)
AFE7950ALKSHP	ALK	FCBGA	400	90	6 x 15	150	315	135.9	7620	19.5	21	19.2



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NOTES:

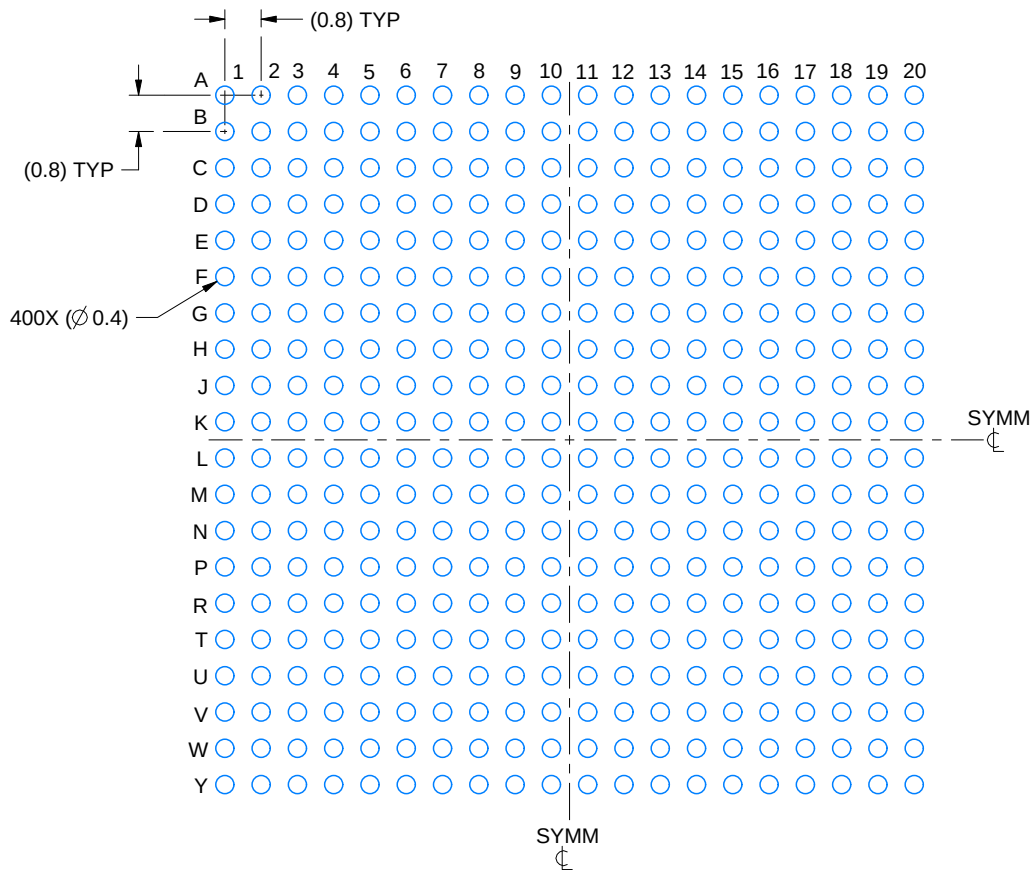
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Dimension is measured at the maximum solder ball diameter, parallel to primary datum C.
4. Primary datum C and seating plane are defined by the spherical crowns of the solder balls.
5. Pb-Free die bump and SnPb solder ball.
6. The lids are electrically floating (e.g. not tied to GND).

EXAMPLE BOARD LAYOUT

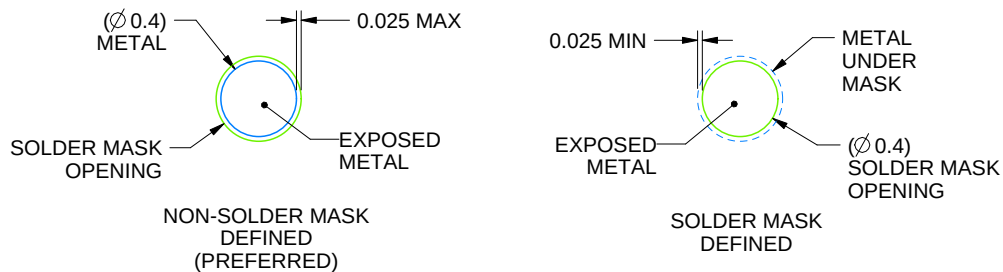
ALK0400A

FCBGA - 2.65 mm max height

BALL GRID ARRAY



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:6X



SOLDER MASK DETAILS
NOT TO SCALE

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NOTES: (continued)

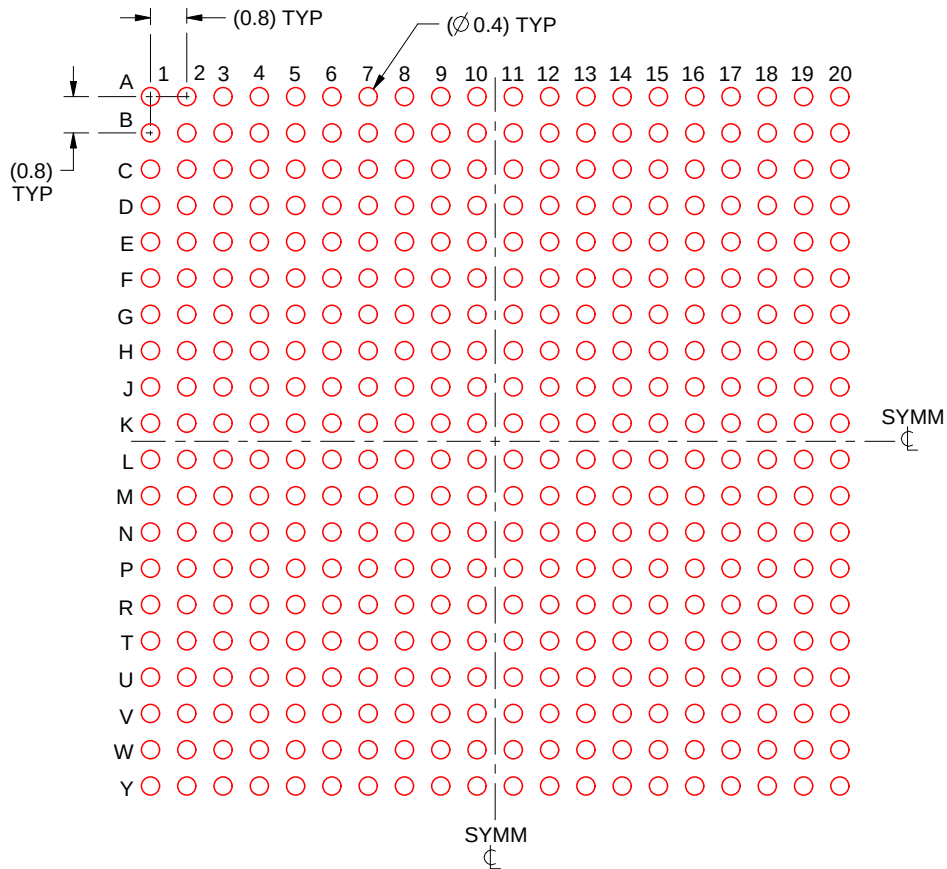
7. Final dimensions may vary due to manufacturing tolerance considerations and also routing constraints.
For more information, see Texas Instruments literature number SPRU811 (www.ti.com/lit/spru811).

EXAMPLE STENCIL DESIGN

ALK0400A

FCBGA - 2.65 mm max height

BALL GRID ARRAY



SOLDER PASTE EXAMPLE
 BASED ON 0.15 mm THICK STENCIL
 SCALE:6X

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NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release.

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